The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group



# The Bipolar Microcomputer Components Data Book

for

**Design Engineers** 

DECEMBER 1977



# The Bipolar Microcomputer Components Data Book

# for Design Engineers

DECEMBER 1977



TEXAS INSTRUMENTS

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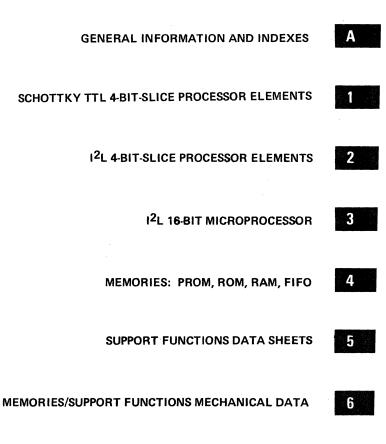
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# THE BIPOLAR MICROCOMPUTER COMPONENTS DATA BOOK



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# THE BIPOLAR MICROCOMPUTER COMPONENTS DATA BOOK

This data book describes a series of high complexity bipolar digital building blocks designed specifically for implementing high performance computer or controller systems. The series offers a system designer the maximum flexibility for achieving cost-effective hardware designs from dedicated, highly specialized unique systems with tailored instructions to general-purpose computers capable of emulating existing machine instructions, or programs, without loss of software investment.

In addition to a choice between the high-performance Schottky<sup>†</sup> TTL 4-bit slice processor element, the unique performance flexibility of an I<sup>2</sup>L 4-bit slice processor element, or a 16-bit computer central processing unit (CPU), the system designer can pick from a full family of Schottky TTL memories (RAMs, PROMs and ROMs), and state-of-the-art support functions needed to meet all control and interface requirements.

The SN74S481, with a typical clock cycle time of 90 ns, and the SN54LS481/SN74LS481 at 120 ns, are the industry's highest complexity Schottky TTL processor elements, and the only bipolar micro/macroprogrammable elements featuring automatically sequenced iterative multiply and divide and cyclical-redundancy algorithms.

The SBP0400A and the SBP0401A, integrated injection logic ( $I^2L$ ) bit slices with complete TTL/MOS compatibility, can operate at a constant speed-power product over a wide range of supply current therein offering an unmatched level of performance flexibility.

The SBP 9900 microprocessor, a ruggedized monthlithic parallel 16-bit (I<sup>2</sup>L) central processing unit (CPU), combines an advanced memory-to-memory architecture, a powerful minicomputer instruction set, user-programmable speed/power performance with the simplicity of a single power supply and static logic with a single phase clock to thrust its capabilities beyond those of existing microprocessors.

The family of high-performance Schottky TTL memories offers a wide variety of organizations providing efficient solutions for virtually any size microcontrol or program memory.

System control is simplified to a very low package count with the expandable SN54S/74S482 4-bit slice controller performing next-address generation functions coupled with system status decoding performed by the industry's most versatile field-programmable logic arrays.

A number of advanced high-complexity I/O and interface circuits have been added to the series. Most of these I/O and interface functions as well as a number of the other processor support functions are offered in space saving 20-pin packages which reduce package count and enhance system density.

Although this volume offers design and specification data only for bipolar computer components, complete technical data for any TI semiconductor/component product are available from your nearest TI field sales office, local authorized TI distributor, or by writing direct to: Marketing and Information Services, Texas Instruments Incorporated, P. O. Box 5012, MS 308, Dallas, Texas 75222.

We sincerely hope you will find the Bipolar Microcomputer Components Data Book a meaningful addition to your technical library.

<sup>†</sup>Integrated Schottky-Barrier diode-1277 clamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

TEXAS INSTRUMENTS

NOTICE

Some products described in this document are in the developmental stage, and Texas Instruments reserves the right to change these specifications in any manner, without notice.

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#### INTRODUCTION

This glossary consists of two parts: (1) general concepts for digital circuits including types of bipolar memories, and (2) operating conditions and characteristics (including letter symbols). The terms, symbols, abbreviations, and definitions used with memory integrated circuits have not, as yet, been standardized. All are currently under consideration by the EIA/JEDEC (Electronic Industries Association) and the IEC (International Electrotechnical Commission). The following are as consistent with the past and future work of these organizations as is possible to anticipate at this time.

## PART I - GENERAL CONCEPTS INCLUDING TYPES OF BIPOLAR MEMORIES

#### **Chip-Enable Input**

A control input that when active permits operation of the integrated circuit for input, internal transfer, manipulation, refreshing, and/or output of data and when inactive causes the integrated circuit to be in a reduced-power standby mode.

NOTE: See "chip-select input".

#### Chip-Select Input

A gating input that when inactive prevents input or output of data to or from an integrated circuit. NOTE: See "chip-enable input".

#### Dynamic (Read/Write) Memory

A read/write memory in which the cells require the repetitive application of control signals in order to retain stored data.

NOTES: 1. The words "read/write" may be omitted from the term when no misunderstanding will result.

- 2. Such repetitive application of the control signals is normally called a refresh operation.
- 3. A dynamic memory may use static addressing or sensing circuits.
- 4. This definition applies whether the control signals are generated inside or outside the integrated circuit.

#### First-In First-Out (FIFO) Memory

A memory from which data bytes or words can be read in the same order, but not necessarily at the same rate, as that of the data entry.

#### Gate Equivalent Circuit

A basic unit-of-measure of relative digital-circuit complexity. The number of gate equivalent circuits is that number of individual logic gates that would have to be interconnected to perform the same function.

#### Large-Scale Integration, LSI

A concept whereby a complete major subsystem or system function is fabricated as a single microcircuit. In this context a major subsystem or system, whether digital or linear, is considered to be one that contains 100 or more equivalent gates or circuitry of similar complexity.

#### Mask-Programmed Read-Only Memory

A read-only memory in which the data content of each cell is determined during manufacture by the use of a mask, the data content thereafter being unalterable.

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#### Medium-Scale Integration, MSI

A concept whereby a complete subsystem or system function is fabricated as a single microcircuit. The subsystem or system is smaller than for LSI, but whether digital or linear, is considered to be one that contains 12 or more equivalent gates or circuitry of similar complexity.

#### Memory Cell

The smallest subdivision of a memory into which a unit of data has been or can be entered, in which it is or can be stored, and from which it can be retrieved.

#### **Memory Integrated Circuit**

An integrated circuit consisting of memory cells and usually including associated circuits such as those for address selection, amplifiers, etc.

#### **Output-Enable Input**

A gating input that when active permits the integrated circuit to output data and when inactive causes the integrated circuit output(s) to be at a high impedance (off).

#### Programmable Read-Only Memory (PROM)

A read-only memory that after being manufactured can have the data content of each memory cell altered once only.

#### Random-Access Memory (RAM)

A memory that permits access to any of its address locations in any desired sequence with similar access time for each location.

NOTE: The term RAM, as commonly used, denotes a read/write memory.

#### Read-Only Memory (ROM)

A memory in which the contents are not intended to be altered during normal operation. NOTE: Unless otherwise qualified, the term "read-only memory" implies that the content is unalterable and defined by construction.

#### **Read/Write Memory**

A memory in which each cell may be selected by applying appropriate electronic input signals and the stored data may be either (a) sensed at appropriate output terminals, or (b) changed in response to other similar electronic input signals.

#### Small-Scale Integration, SSI

Integrated circuits of less complexity than medium-scale integration (MSI).

#### Very-Large-Scale Integration, VLSI

A concept whereby a complete system function is fabricated as a single microcircuit. In this context, a system, whether digital or linear, is considered to be one that contains 1000 or more gates or circuitry of similar complexity.

#### Volatile Memory

A memory the data content of which is lost when power is removed.

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# PART II - OPERATING CONDITIONS AND CHARACTERISTICS (INCLUDING LETTER SYMBOLS)

The symbols for quantities involving time use upper and lower case letters according to the following historically evolved principles:

- a. Time itself, is always represented by a lower case t.
- b. Subscripts are lower case when one or more letters represent single words, e.g., d for delay, su for setup, rd for read, wr for write.
- c. Multiple subscripts are upper case when each letter stands for a different word, e.g., SR for sense recovery and PLH for propagation delay from low to high.

#### Access Time (of a memory)

The time between the application of a specified input pulse during a read cycle and the availability of valid data signals at an output.

Example symbology:

| <sup>t</sup> a(ad) | Access time from address     |
|--------------------|------------------------------|
| t <sub>a</sub> (E) | Access time from chip enable |
| t <sub>a(S)</sub>  | Access time from chip select |

# **Clock Frequency**

# Maximum clock frequency, fmax

The highest rate at which the clock input of a bistable circuit can be driven through its required sequence while maintaining stable transistions of logic level at the output with input conditions established that should cause changes of output logic level in accordance with the specification.

# Current

#### High-level input current, IIH

The current into\* an input when a high-level voltage is applied to that input.

#### High-level output current, IOH

The current into<sup>\*</sup> an output with input conditions applied that according to the product specification will establish a high level at the output.

#### Low-level input current, IIL

The current into\* an input when a low-level voltage is applied to that input.

#### Low-level output current, IOL

The current into<sup>\*</sup> an output with input conditions applied that according to the product specification will establish a low level at the output.

#### Off-state output current, IO(off)

The current flowing into<sup>\*</sup> an output with input conditions applied that according to the product specification will cause the output switching element to be in the off state.

Note: This parameter is usually specified for open-collector outputs intended to drive devices other than logic circuits.

\*Current out of a terminal is given as a negative value.

#### Off-state (high-impedance-state) output current (of a three-state output), IOZ

The current into<sup>\*</sup> an output having three-state capability with input conditions applied that according to the product specification will establish the high-impedance state at the output.

#### Short-circuit output current, IOS

The current into<sup>\*</sup> an output when that output is short-circuited to ground (or other specified potential) with input conditions applied to establish the output logic level farthest from ground potential (or other specified potential).

#### Supply current, ICC

The current into\* the VCC supply terminal of an integrated circuit.

#### Cycle Time

#### Read cycle time, tc(rd) (see note)

The time interval between the start and end of a read cycle.

# Read-write cycle time, tc(rd,wr) (see note)

The time interval between the start of a cycle in which the memory is read and new data are entered, and the end of that cycle.

#### Write cycle time, t<sub>c(wr)</sub> (see note)

The time interval between the start and end of a write cycle.

NOTE: The read, read-write, or write cycle time is the actual interval between two impulses and may be insufficient for the completion of operations within the memory. A minimum value is specified that is the shortest time in which the memory will perform its read and/or write function correctly.

#### Hold Time

#### Hold time, th

The interval during which a signal is retained at a specified input terminal after an active transition occurs at another specified input terminal.

- NOTES: 1. The hold time is the actual time between two events and may be insufficient to accomplish the intended result. A minimum value is specified that is the shortest interval for which correct operation of the logic element is guaranteed.
  - The hold time may have a negative value in which case the minimum limit defines the longest interval (between the release of data and the active transition) for which correct operation of the logic element is guaranteed.

# **Output Enable and Disable Time**

#### Output enable time (of a three-state output) to high level, tPZH (or low level, tPZL)

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from a high-impedance (off) state to the defined high (or low) level.

#### Output enable time (of a three-state output) to high or low level, tpzx

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from a high-impedance (off) state to either of the defined active levels (high or low).

#### Output disable time (of a three-state output) from high level, tpHZ (or low level, tpLZ)

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from the defined high (or low) level to a high-impedance (off) state.

\* Current out of a terminal is given as a negative value.

# GLOSSARY TTL TERMS AND DEFINITIONS

#### Output disable time (of a three-state output) from high or low level, tpxz

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from either of the defined active levels (high or low) to a high-impedance (off) state.

#### **Propagation Time**

#### Propagation delay time, tpD

The time between the specified reference points on the input and output voltage waveforms with the output changing from one defined level (high or low) to the other defined level.

#### Propagation delay time, low-to-high-level output, tpLH

The time between the specified reference points on the input and output voltage waveforms with the output changing from the defined low level to the defined high level.

#### Propagation delay time, high-to-low-level output, tPHL

The time between the specified reference points on the input and output voltage waveforms with the output changing from the defined high level to the defined low level.

#### **Pulse Width**

# Pulse width, tw

The time interval between specified reference points on the leading and trailing edges of the pulse waveform.

Example symbology:

| <sup>t</sup> w(cir) | Clear pulse width |
|---------------------|-------------------|
| tw(wr)              | Write pulse width |

#### **Recovery Time**

#### Sense Recovery time, tSR

The time interval needed to switch a memory from a write mode to a read mode and to obtain valid data signals at the output.

#### **Release Time**

#### Release time, trelease

The time interval between the release from a specified input terminal of data intended to be recognized and the occurrence of an active transition at another specified input terminal.

Note: When specified, the interval designated "release time" falls within the setup interval and constitutes, in effect, a negative hold time.

### Setup Time

#### Setup time, t<sub>su</sub>

The time interval between the application of a signal that is maintained at a specified input terminal and a consecutive active transition at another specified input terminal.

- NOTES: 1. The setup time is the actual time between two events and may be insufficient to accomplish the setup. A minimum value is specified that is the shortest interval for which correct operation of the logic element is guaranteed.
  - 2. The setup time may have a negative value in which case the minimum limit defines the longest interval (between the active transition and the application of the other signal) for which correct operation of the logic element is guaranteed.

# **Transition Time**

# Transition time, low-to-high-level, tTLH

The time between a specified low-level voltage and a specified high-level voltage on a waveform that is changing from the defined low level to the defined high level.

#### Transition time, high-to-low-level, tTHL

The time between a specified high-level voltage and a specified low-level voltage on a waveform that is changing from the defined high level to the defined low level.

#### Voltage

#### High-level input voltage, VIH

An input voltage within the more positive (less negative) of the two ranges of values used to represent the binary variables.

NOTE: A minimum is specified that is the least positive value of high-level input voltage for which operation of the logic element within specification limits is guaranteed.

# High-level output voltage, VOH

The voltage at an output terminal with input conditions applied that according to the product specification will establish a high level at the output.

#### Input clamp voltage, VIK

An input voltage in a region of relatively low differential resistance that serves to limit the input voltage swing.

#### Low-level input voltage, VIL

An input voltage level within the less positive (more negative) of the two ranges of values used to represent the binary variables.

NOTE: A maximum is specified that is the most positive value of low-level input voltage for which operation of the logic element within specification limits is guaranteed.

#### Low-level output voltage, VOL

The voltage at an output terminal with input conditions applied that according to the product specification will establish a low level at the output.

#### Negative-going threshold voltage, VT-

The voltage level at a transition-operated input that causes operation of the logic element according to specification as the input voltage falls from a level above the positive-going threshold voltage,  $V_{T+}$ .

#### Off-state output voltage, VO(off)

The voltage at an output terminal with input conditions applied that according to the product specification will cause the output switching element to be in the off state.

Note: This characteristic is usually specified only for outputs not having internal pull-up elements.

#### On-state output voltage, VO(on)

The voltage at an output terminal with input conditions applied that according to the product specification will cause the output switching element to be in the on state.

Note: This characteristic is usually specified only for outputs not having internal pull-up elements.

#### Positive-going threshold voltage, VT+

The voltage level at a transition-operated input that causes operation of the logic element according to specification as the input voltage rises from a level below the negative-going threshold voltage,  $V_{T-}$ .

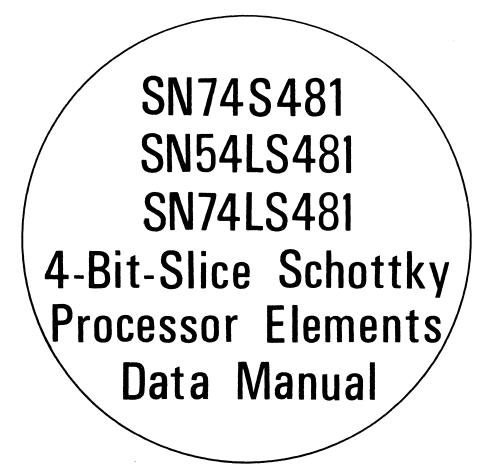
The following symbols are used in function tables on TI data sheets:

| н              | = | high level (steady state)  |
|----------------|---|--|
| L              | = | low level (steady state)   |
| ↑              | = | transition from low to high level  |
| ¥              | = | transition from high to low level  |
| $\rightarrow$  | = | value/level or resulting value/level is routed to indicated destination  |
| n              | = | value/level is re-entered  |
| х              | = | irrelevant (any input, including transitions)  |
| ah             | = | the level of steady-state inputs at inputs A through H respectively  |
| 0 <sub>0</sub> | = | level of Q before the indicated steady-state input conditions were established   |
| 0 <sup>0</sup> | = | complement of $\Omega_0$ or level of $\overline{\Omega}$ before the indicated steady-state input conditions were established   |
| Qn             | = | level of Q before the most recent active transition indicated by $\downarrow$ or $\uparrow$                                    |
| $\Box$         | = | one high-level pulse   |
| IJ             | = | one low-level pulse  |
| TOGGLE         | = | each output changes to the complement of its previous level on each active transition indicated by $\downarrow$ or $\uparrow.$ |

# TEXAS INSTRUMENTS

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# 1. INTRODUCTION

These Schottky TTL 4-bit expandable parallel binary micro/macroprogrammable processor element building blocks are designed specifically for implementing high-performance digital computers/controllers. With the ability to efficiently emulate existing systems, they can be used to upgrade hardware performance with full compatibility to protect software investments.

Two performance ranges are available:

- a. The SN74S481, Schottky TTL performs typically at a clock cycle time of 90 nanoseconds at 345 milliamperes of supply current.
- b. The SN54LS/74LS481, low-power Schottky TTL performs typically at a clock cycle time of 120 nanoseconds at 220 milliamperes of supply current.

#### 1.1 ARCHITECTURAL FEATURES

Designed with full parallel dual input/output ports, the memory-to-memory architecture provides a new dimension in interrupt processing or program context switching flexibilities. Static bipolar logic performs each microinstruction within a single clock cycle.

Primary among the architectural features are:

- Microprogrammable, bit-slice design is expandable in 4-bit multiples
- Full parallel dual input/output ports for use in advanced memory-to-memory architecture
- Full-function ALU with carry look-ahead, magnitude, and overflow decision capabilities
- Double-length accumulator with full shifting capability and sign-bit handling
- Dual memory address generators on-chip.

# 1.2 OPERATIONAL FEATURES

The functional capabilities, characterized by the 24,780 unique operations, coupled with the macroprogrammable multiply and divide algorithms, make these processor elements particularly attractive for implementing advanced high performance computers and controllers.

In addition to the full parallel data bus structure, the 'S481 architecture also features asynchronous access to data routing and counter updating controls which, when combined with the most versatile instruction set available (see operational description) maximizes flexibility, efficiency, and performance. Simultaneous compound operations in the form of an ALU function with shift, plus destination selection with address/iteration updating, plus address and present data to memory can be accomplished in a single microcyle. Some other operational features are:

- Simultaneous one-clock compound operations, with status, can reduce microcycles and improve throughput
- Pre-programmed CRG and double-precision multiply/divide algorithms
- Double length accumulator with full bidirectional single/double precision arithmetic/logical/circulate shift capabilities include sign protection
- Full micro-operational control is provided for programming: address updating, data and address source selection, and direct transfer of data to working register or working memory
- Relative position control defines bit-slice rank and sign handling in N-bit applications.

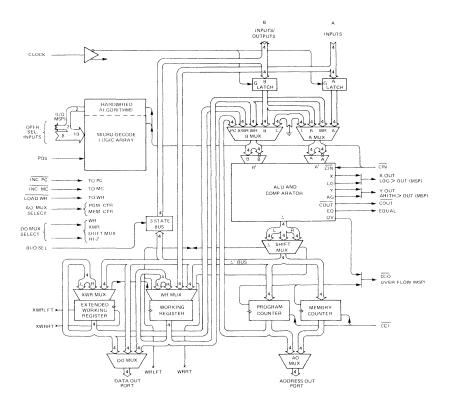
#### 1.3 MECHANICAL FEATURES

These processor elements are supplied in either a high-density quad-in-line ceramic package or a plastic dual-in-line package. The high-density 48-pin ceramic package has quad pin rows formed on 600- and 800-mil centers. Within each of the four rows, the pin spacing is 100 mils, center-to-center. The plastic dual-in-line package has standard 100-mil spacing on 600-mil centers. Outline drawings are provided in Section 6 of this data book.

NOTE: Functional and operational descriptions through this data manual which reference the 'S481 are applicable to both the SN74S481 and the SN54LS/74LS481 processor elements.

| TAE        | BLE 1        |
|------------|--------------|
| FUNCTIONAL | DESCRIPTIONS |

| PIN NUMBER                                  | PIN NAME   | PIN FUNCTION   | INPUT, OUTPUT, OR<br>INPUT/OUTPUT |
|---|--|--|-----------------------------------|
| 46, 47<br>1, 2                              | BI/O0, BI/O1<br>BI/O2, BI/O3                             | 4-bit parallel data input port to the B latch, or 4-bit parallel data<br>output for the Σ-bus when not being used as an input.   | Inputs/Outputs                    |
| 6, 5<br>4, 3                                | AI0, AI1<br>AI2, AI3                                     | 4-bit parallel data input port to the A latch and WR.  | Inputs                            |
| 7, 8<br>9, 10<br>17, 14<br>13, 11<br>15, 16 | OP0, OP1<br>OP2, OP3<br>OP4, OP5<br>OP6, OP7<br>OP8, OP9 | OP0 through OP9 serve as a 10-bit parallel operation-select input to<br>the micro-decode logic array. In the most-significant position, OP8<br>and OP9 additionally serve as open-collector outputs during multi-<br>ply and divide algorithms. In the least-significant position, OP9<br>serves as an open-collector output during the CRC algorithm.   | Inputs                            |
| 12  | Vcc  | Single 5-volt power-supply terminal.   | Supply Voltage Pin                |
| 18  | CIN  | Receives low-active ripple carry input data.   | Input                             |
| 19  | POS  | Directs internal and input/output end-conditions required to define<br>the relative position of each bit-slice when N-SN74S481's are<br>cascaded to implement Nx4-bit word lengths. When biased at 2.4<br>volts, the package operates as the least-significant (LSP) slice; when<br>grounded, it functions as an intermediate (IP) slice; and when high, 5<br>volts, it functions as the most-significant (MSP) slice.                       | Input                             |
| 20  | Y/AG   | In least-significant and intermediate positions outputs arithmetic<br>carry generate (Y) for use with look-ahead. In most-significant<br>position outputs true arithmetically-greater-than signal.   | Output                            |
| 21  | X/LG   | In least-significant and intermediate positions outputs arithmetic<br>carry propagate (X) for use with look-ahead. In most-significant<br>position outputs true logically-greater-than signal.   | Output                            |
| 22  | COUT   | Outputs low-active ripple carry data.  | Output                            |
| 23  | EQ   | Outputs true (active-high) equality of $\Sigma'$ bus equals zero for each 4-bit slice. The open-collector output permits wire-AND to achieve Nx4-bit equality output.  | Open-Collector-Outpu              |
| 24  | LDWR   | When low, data applied at the AI port coincident with the ↑ clock transition is loaded into the WR.  | Input                             |
| 26<br>25                                    | WRRT,<br>WRLFT   | Working register and $\Sigma$ -bus shift interconnectivity pins. WRRT receives left-shift and outputs right-shift (true) data. WRLFT receives right-shift and outputs left-shift (true) data. Shift can be single-precision, double-precision, signed or unsigned.   | Bidirectional I/O                 |
| 28<br>27                                    | XWRRT,<br>XWRLFT   | Extended working register shift interconnectivity pins. XWRRT<br>receives left-shift and outputs right-shift (true) data. XWRLFT<br>receives right-shift and outputs left-shift (true) data. Shift can be<br>single-precision, double-precision, signed or unsigned.   | Bidirectional I/O                 |
| 29<br>30                                    | D0<br>D1   | Selects one of three DOP sources (WR, XWR, or $\Sigma$ -bus) or places the DOP outputs in a high-impedance state.  | Inputs                            |
| 34<br>33<br>32<br>31                        | DOP0<br>DOP1<br>DOP2<br>DOP3                             | 4-bit parallel, data-out port. DOP0 is LSB.  | 3-state outputs                   |
| 35  | INCMC  | When low, enables the MC to increment as directed by $\overline{\text{CCI}}$ on the next $\uparrow$ clock transition. When high, inhibits MC to hold mode. As $\overline{\text{CCO}}$ is common to MC and PC, the MC should be inhibited when PC is enabled.   | Input                             |
| 36  | GND  | Common or ground terminal for the supply voltage.  |                                   |
| 37  | <u>CCO</u> /OV   | In least-significant and intermediate positions a low-level output indicates that either the PC or MC is at maximum count. As CCO is common for both PC and MC ambiguous carry can be avoided if one or both counters is/are disabled by the INCPC and/or INCMC inputs. In the most-significant position, a high-level output, depending on the operation selected, indicates that the WR, XWR, or ALU will overflow (OV) on the next clock. | Output                            |





| TADLE T (Continueu) | т | AB | LE | 1 | (Continued) |
|---------------------|---|----|----|---|-------------|
|---------------------|---|----|----|---|-------------|

| PIN NUMBER       | PIN NAME                 | PIN FUNCTION   | INPUT, OUTPUT, OR<br>INPUT/OUTPUT |  |
|------------------|--------------------------|--|-----------------------------------|--|
| 38, 39<br>40, 41 | AOP0, AOP1<br>AOP2, AOP3 | 4-bit parallel address-out port.   | Outputs                           |  |
| 42               | A0                       | Selects one of two AOP sources (PC or MC).   | Input                             |  |
| 43               | INCPC                    | When low, enables the PC to increment as directed by $\overline{\text{CCI}}$ on the next $\uparrow$ clock transition. When high, inhibits PC to hold mode. As $\overline{\text{CCO}}$ is common to PC and MC, the PC should be inhibited when MC is enabled.                               | Input                             |  |
| 44               | CCI                      | In least-significant position, a low input directs enabled PC or<br>enabled MC to increment by one on next 1 clock transition. In the<br>LSP, a high directs enabled PC or enabled MC to increment by 2. In<br>other positions, a low is a carry input and a high inhibits the<br>counter. | Input                             |  |
| 45               | СК                       | When high, enables the transparency of A and B input latches. When<br>low, latches A and B input data. Clocks synchronous registers and<br>counters on the positive transition.  | Input                             |  |
| 48               | BI/O SEL                 | When low, enables BI/O to output $\Sigma$ -bus data. When high, the BI/O output drivers are placed in a high-impedance state permitting BI/O to be used as data inputs.  | Input                             |  |

# 2. DETAILED FUNCTIONAL DESCRIPTIONS

#### 2.1 MICRO-DECODING LOGIC ARRAY

The micro-decoding logic array is a dedicated 11 input PLA decoding 73 product terms to generate 24 control lines needed to implement the 14 operation forms. The eleven inputs consist of the ten operation select lines (OP0 through OP9) and the ALU carry input. The carry input, utilized as an additional operation select line during operation forms not performing arithmetic functions, maximizes system pin efficiency and functional density.

In an expanded word-length system (two or more 'S481's), operation select inputs 8 (OP8) and 9 (OP9) assume an input/output capability in the most-significant or least-significant package as a result of the position control and the type of operation being performed. During microprogrammable operation forms I through IX, OP8 and OP9 function simply as another input; but, during the macroprogrammable operations of forms X through XIV one or both become an output during iterations. Table 2 summarizes by operation form the control (output) package and the operation lines which are used as an output.

| 00.50044  |                   | CONTROL | OPERATION SELECT I/O |        |  |
|-----------|-------------------|---------|----------------------|--------|--|
| OP. FORM  | ALGORITHM         | PACKAGE | OP8                  | OP9    |  |
| I thru IX | All               | None    | INPUT                | INPUT  |  |
| х         | CRC ACCUMULATION  | LSP     | INPUT                | OUTPUT |  |
| XI        | SIGNED DIVIDE     | MSP     | OUTPUT               | OUTPUT |  |
| XII       | UNSIGNED DIVIDE   | MSP     | INPUT                | OUTPUT |  |
| хш        | UNSIGNED MULTIPLY | MSP     | INPUT                | OUTPUT |  |
| xıv       | SIGNED MULTIPLY   | MSP     | Ουτρυτ               | OUTPUT |  |

TABLE 2 MSP OP8 and OP9 ITERATIVE FUNCTION SUMMARY

If the macroinstructions are to be used in an expanded word length, OP8 and OP9 select lines of the MSP and the OP9 line of the LSP should be driven from either a 3-state output (which can be placed in high-impedance state) or an open-collector output (which can be wire-OR'ed with the OP select I/O lines). During an iterative function for which the OP line is designated as an open-collector output, the OP line driver should be placed in a high-impedance or off state permitting the output function to drive similar OP lines in the remaining packages.

The output state of OP8 or OP9 is a function of on-chip status decoder as enumerated in the flow diagrams illustrating the five algorithms.

#### 2.2 RELATIVE POSITION CONTROL (POS)

The single line position control, with the ability of decoding one of three input logic states, provides each 'S481 in an expanded word length system with the capability of identifying its relative position. The relative positions, with the corresponding input logic levels are enumerated in Table 3.

| POS INPUT<br>LOGIC LEVEL | RELATIVE POSITION                |
|--------------------------|----------------------------------|
| ≥ 3.6 V                  | MOST-SIGNIFICANT POSITION (MSP)  |
| 1.8 V to 3 V             | LEAST-SIGNIFICANT POSITION (LSP) |
| ≤ 0.8 V                  | INTERMEDIATE POSITION (IP)       |

TABLE 3 POSITION CONTROL FUNCTIONS

This relative position identification dictates how each 'S481 in the system handles the multi-purpose I/O accommodations and ALU sign and magnitude functions. See Table 4. Shift/Circulate interconnectivity bit transfers are explained in detail under shift/circulate transfer multiplexers.

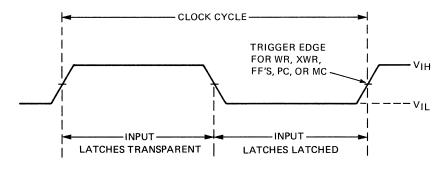
| PIN    | I MSP IP       |                  | LSP              |
|--------|----------------|------------------|------------------|
| X/LG   | LG (OUT)       | X                | х                |
| Y/LG   | AG (OUT)       | Y                | Ү                |
| CCO/OV | OVERFLOW (OUT) | <u>CCO</u> (OUT) | <u>ССО</u> (ОUT) |

TABLE 4 DUAL-FUNCTION LOGIC I/O PINS

X AND Y ARE CARRY LOOK-AHEAD FUNCTIONS

#### 2.3 CLOCK

The clock synchronizes the entry or change of data in the 'S481 registers and counters, and it controls the status of the A and B input latches. A typical clock cycle is illustrated in Figure 2. The low-to-high transition of the clock input is the clocking edge for any combination of either the working register, extended working register, flag flip-flops, and the program counter or the memory counter activated by the resident operation. During the low-level portion of the clock input, both input latches are latched ensuring data stability at the positive clock transition. After the clock has gone to a high level, the input latches are placed in a transparent mode to accept the next set of input data.





#### 2.4 LATCHED DATA INPUT PORTS

The SN54S/74S481 features dual input ports combined with data flow paths which are designed specifically to reduce the number of system clock cycles needed to enter operands and/or data. Both the A and B input ports are latched, eliminating the need for external registers, to simplify interfacing directly with system data bus paths.

The A input port data is made available to both the input latch and the working register which allows A data to be loaded into the working register directly.

The B port is configured to serve as an input/output data path providing the capability to:

- a. Input data to the B latch
- b. Output sum-bus data.

This I/O port is designed specifically to simplify implementation of data transfers to the external working memory.

Both the A and B latches are transparent when the 'S481 clock input is high. Data applied at the A and B inputs should be stable anytime prior to or at least coincident with the falling edge of the clock input (see Figure 3). After the clock falling edge, the data inputs should be held steady for  $t_{hold}(data)$  or longer to facilitate the on-chip clock buffers to latch the data.

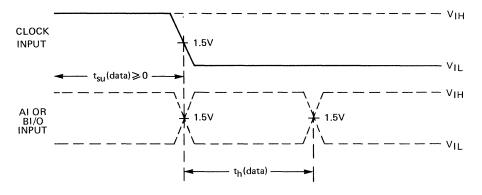


FIGURE 3 - INPUT LATCHES SETUP/HOLD TIMES

The A input port latch data is routed to the A input multiplexers, and the B input port latch data is sourced to both the A and B input multiplexers.

#### 2.5 A AND B OPERAND SOURCES

The A and B input multiplexers source the ALU A' and B' ports through true/complement conditional inverter circuits. Data routing for each, illustrated and listed in Figure 4, provides the ALU with access to the true or complement of:

#### ALU A' PORT

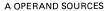
- 1. A input latch
- 2. B input latch
- 3. Working Register
- 4. Low logic level inputs
  - (force zeros)

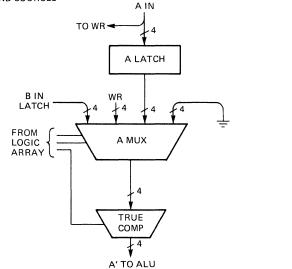
#### ALU B' PORT

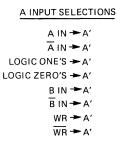
- 1. B input latch
- 2. Sum bus
- 3. Working register
- 4. Extended working register
- 5. Program counter
- Low logic level inputs (force zeros)

The A and B multiplexers and true complement circuits, under control of the resident operation code, are selectable at the microprogram level. The number of A or B multiplexer sources available depend upon the specific operation being performed by the 'S481. Operation form descriptions contain detailed microprogramming.

The A and B input multiplexers, with selectable true and complement operand sources, maximizes the processing power of the 'S481 by minimizing the active components needed to achieve both the simple but highly flexible data routing tasks and full ALU capabilities.







B IN 🍝 B' B IN → B' LOGIC ONE'S -B' LOGIC ZERO'S - B' (B IN) • (WR) - B' (B IN) · (WR) → B' WR 🍝 B' WR 🗲 B' (B IN) • (XWR) - B' (B IN) • (XWR) → B' XWR - B' XWR - B' (B IN) • (PC) → B' (B IN) • (PC) → B' PC →B' PC → B'

**B INPUT/OUTPUT SELECTIONS** 

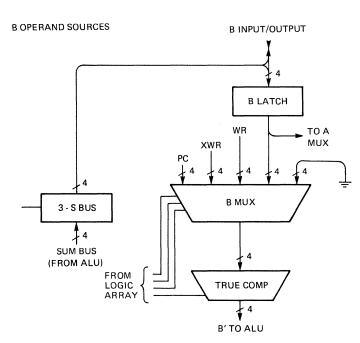


FIGURE 4 - ALU OPERAND SOURCES

1

#### 2.6 ARITHMETIC/LOGIC UNIT (ALU)

The 4-bit, parallel, binary arithmetic/logic unit provides the arithmetic/Boolean operand combination/modification mechanism including magnitude and overflow status. The ALU performs, as directed by the resident operation form, one of four basic functions which, when combined with the operand selections at the A and B multiplexers, extends the arithmetic/logic capabilities to that of a full 16-function ALU.

When compared to other bit-slice processor elements, unique to the 'S481 arithmetic architecture are the parallel input ports and fully microprogrammable symmetry for all ALU functions within the selections of the A and B input multiplexers.

Logical and arithmetic operation forms for the 'S481 are shown in Table 5. The full functional power of the 'S481 can be visualized only if it is understood that although both ALU's have parallel A and B input ports, the 'S481 architecture not only provides access to multiple sources but has the capability to route true or complement of any source to the A and B ALU port. This means that for a subtract operation, the subtrahend may be either an A or B input. In addition to maximizing data routing capabilities of the 'S481 at minimum logic/gate levels, this architecture permits fully symmetrical operations to be performed on the A or B sources within the selections offered by these 'S481 arithmetic/logical operation forms.

| DATA           | INPUT         | TWO'S COMPLEMENT IN                | LOGICAL OP'S (FORM VIII)<br>CIN = H OR L |                |                |               |
|----------------|---------------|------------------------------------|--|----------------|----------------|---------------|
| A PORT         | <b>B PORT</b> | CIN = L                            | CIN = H                                  | OR             | NOR            | EX-NOR        |
| ZEROS<br>ZEROS | ZEROS<br>ONES | 1                                  | 0<br>MINUS 1                             | ZEROS<br>ONES  | ONES<br>ZEROS  | ONES<br>ZEROS |
| ONES           | ZEROS         | 0<br>MINUS 1                       | MINUS 1<br>MINUS 2                       | ONES           | ZEROS          | ZEROS         |
| A              | ZEROS         | A PLUS 1                           | А  | А              | Ā              | Ā             |
| Ā              | ONES<br>ZEROS | A<br>MINUS A                       | A MINUS 1<br>MINUS A MINUS 1             | ONES<br>Ā      | ZEROS<br>A     | A<br>A        |
| ⊼<br>ZEROS     | ONES<br>B     | MINUS A MINUS 1<br>B PLUS 1        | MINUS A MINUS 2<br>B                     | ONES<br>B      | ZEROS<br>B     | Ā<br>B        |
| ONES<br>ZEROS  | B<br>B        | B<br>MINUS B                       | B MINUS 1<br>MINUS B MINUS 1             | ONES<br>B      | ZEROS<br>B     | B<br>B        |
| ONES<br>A      | В<br>В        | MINUS B MINUS 1<br>A PLUS B PLUS 1 | MINUS B MINUS 2<br>A PLUS B              | ONES<br>A + B  | ZEROS<br>Ā · Ē | B<br>A ⊕ B    |
| A<br>Ā         | B             | A MINUS B<br>B MINUS A             | A MINUS B MINUS 1<br>B MINUS A MINUS 1   | A + B<br>Ā + B | Ā · в<br>A · В | A             |
| Ā              | B             | MINUS A MINUS B MINUS 1            | MINUS A MINUS B MINUS 2                  | Ā + B          | A·B            | A O B         |

TABLE 5 'S481 ALU AND LOGIC FUNCTIONS

Some unique one-clock arithmetic/iterative capabilities of the 'S481 are listed in Table 6.

#### TABLE 6 EXTENDED ALU FUNCTIONS OF 'S481

| FORM NO. | FUNCTION   |
|----------|--|
| 1        | A (ALU) B · WR   |
|          | A (ALU) B · XWR  |
|          | A (ALU) B · PC   |
| 11       | A (ALU) B DOUBLE-PRECISION SHIFTED LOGICAL LEFT OR RIGHT |
| 111      | A (ALU) B SINGLE-PRECISION SHIFTED LOGICAL OR ARITHMETIC |
|          | LEFT OR RIGHT  |

Table 5 also indicates the 16 logical combinations of two Boolean variables which are selectable for the OR, NOR, and exclusive-NOR functions. Full symmetry of the ALU and the ability to select the complement of input data extends the logic functions for performance of:

- a. NAND
- b. AND
- c. Exclusive-OR
- d. Mixed combinations of each
- e. Transfer functions for true or inverted data
- f. All ones or all zeros.

#### 2.7 ALU MAGNITUDE AND CARRY FUNCTIONS

The 'S481 ALU is fully decoded on chip to generate three magnitude outputs (status lines) and both ripple and look-ahead carry functions. The magnitude outputs and their status indications are as follows:

#### 2.7.1 Equal (EQ, See Figure 5)

The results of the resident ALU operation are compared at the sum-bus for all bits high during subtract and left-shift arithmetic operations, or for all bits low during other operations.

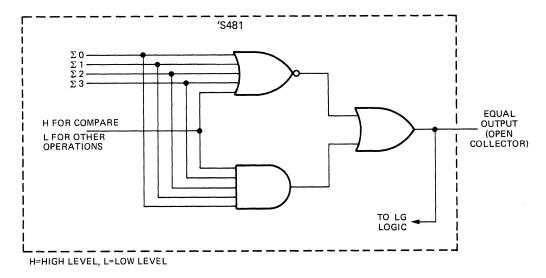
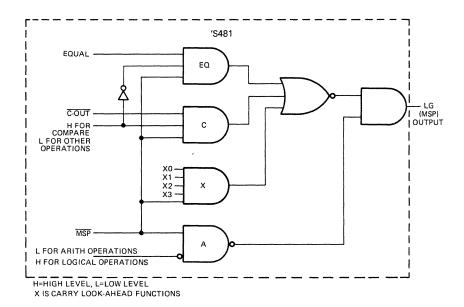


FIGURE 5 - EQUAL OUTPUT

#### 2.7.2 Logically-Greater Than (LG, See Figure 6)

In the most-significant package (MSP) the X look-ahead function from the ALU is inhibited and the logically-greater-than (LG) output is enabled. See Figure 6. The MSP LG output is active during arithmetic and shift operation forms to provide a status indication that can be used when it is desirable to compare two unsigned integer numbers. The specific status for each operation form is listed in Table 7.



#### FIGURE 6 - MSP LOGICALLY-GREATER-THAN (LG) OUTPUT

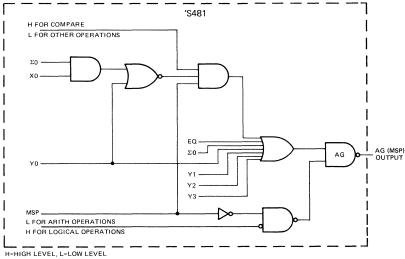
 TABLE 7

 MSP LOGICALLY-GREATER-THAN (LG) OUTPUT

| OP FORM                | TYPE OF OP           | LG = H INDICATES                           |
|------------------------|----------------------|--|
| I or II (ARITH)        | ALL                  | Σ-BUS ≠ ZERO (EQ ≈ L)                      |
| III (ARITH WITH SHIFT) | LSL, RSL             | $\Sigma$ -BUS $\neq$ ZERO (EQ $\approx$ L) |
|                        | LSA or RSA           | ADDER C-OUT                                |
| IV, V, or VI (SHIFTS)  | ALL                  | AI ≠ ZERO (EQ = L)                         |
| VII (COMPARE)          | A : B                | A IS LG THAN B                             |
|                        | B : A                | B IS LG THAN A                             |
| VIII (LOGICAL)         | ALL                  | $\Sigma$ -BUS $\neq$ ZERO (EQ = L)         |
| IX (NO OP) ZERO Σ-BUS  |                      | LG = L (EQ = H)                            |
| X THRU XIV             | HARDWIRED ALGORITHMS | SEE OPERATION FORM DESCRIPTION             |

#### 2.7.3 Arithmetically-Greater Than (AG, See Figure 7)

In the most-significant package (MSP) the Y look-ahead function from the ALU is inhibited and the arithmetically-greater-than (AG) output is enabled. The MSP AG output is active during arithmetic and shift operation forms to provide a status indication that can be used when it is desirable to compare two signed integer numbers. The specific status for each operation form is listed in Table 8.



X AND Y ARE CARRY LOOK-AHEAD FUNCTIONS

#### FIGURE 7 - MSP ARITHMETICALLY-GREATER-THAN (AG) OUTPUT

TABLE 8 ALU CARRY AND MSP ARITHMETICALLY-GREATER-THAN (AG) OUTPUTS

|                        | LSP AND IP |                |                   | MSP   |                        |                       |                    |       |
|------------------------|------------|----------------|-------------------|-------|------------------------|-----------------------|--------------------|-------|
| OPERATION FORM         | x          | Y              | EQ                | C-OUT | LG                     | AG                    | EQ                 | C-OUT |
| LOGICAL OPERATIONS     | L          | H <sub>.</sub> | Σ-BUS = 0         | C-IN  | $\Sigma$ -BUS $\neq 0$ | $\Sigma$ -BUS > 0     | Σ-BUS = 0          | C-IN  |
| ARITHMETIC OPERATIONS: |            |                |                   |       | A LG B                 | A LG B                |                    |       |
| COMPARE                | x          | Y              | A=B               | C-OUT | or<br>B LG A           | or<br>B LG A          | A = B              | C-OUT |
| ALL OTHER ARITHMETIC   | ×          | Y              | $\Sigma$ -BUS = 0 | C-OUT | $\Sigma$ -BUS $\neq 0$ | $\Sigma\text{-}BUS>0$ | $\Sigma$ -BUS AG 0 | C-OUT |

X and Y are carry look-ahead functions.

#### 2.8 OPERAND OVERFLOW

In the most-significant package (MSP) the counter-carry output ( $\overline{CCO}$ ) function from the program/memory counter is inhibited and the overflow (OV) output is enabled. The MSP OV output is active during arithmetic and shift operation forms to provide a status indication that the result of the operation cannot be correctly represented with the number of bit positions available. When the OV output goes high, it indicates that the next clock will:

- a. During arithmetic operations, cause the ALU to overflow.
- b. During left-shift arithmetic operations, cause the shifted register to overflow.

Table 9 enumerates the specific indicators generated.

#### TABLE 9 MSP OVERFLOW (OV) OUTPUT

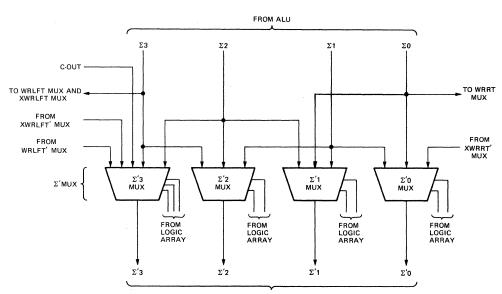
| OP FORM                | TYPE OF OP           | OV = H INDICATES      |
|------------------------|----------------------|-----------------------|
| i or II (ARITH)        | ADD or SUB           | ALU OVERFLOW          |
| III (ARITH WITH SHIFT) | LSL, RSL             | ALU OVERFLOW          |
|                        | RSA                  | OV = L                |
|                        | LSA                  | NEXT CLOCK WILL CAUSE |
|                        |                      | SHIFT OVERFLOW        |
| IV, V, or VI (SHIFTS)  | LSA                  | NEXT CLOCK WILL CAUSE |
|                        |                      | SHIFT OVERFLOW        |
|                        | ALL OTHERS           | OV ≡ L                |
| VII (COMPARE)          | A : B                | UNDEFINED             |
|                        | B : A                | UNDEFINED             |
| VIII (LOGICAL)         | ALL                  | OV ≡ L                |
| IX (NO OP)             | ZERO Ľ-BUS           | OV ≕ L                |
| X THRU XIV             | HARDWIRED ALGORITHMS | SEE OPERATION FORM    |
|                        |                      | DESCRIPTIONS          |

H = high level, L = low level

#### 2.9 SUM' BUS MULTIPLEXER

The sum'-bus multiplexer, sourced by the ALU, provides a means for accomplishing a shift operation on the ALU operand without affecting the contents of WR, XWR, PC or MC (See Figure 8). Functionally, this multiplexer can be used to:

- a. Shift the operand left or right (one bit position) arithmetic, logical, or circulate
- b. Pass the operand without shift to the  $\Sigma'$  bus.



TO: DO MUX, PC, MC, WR MUX, XWR MUX, 3-STATE BUS

FIGURE 8 - SUM BUS MULTIPLEXER

Full sign protection and fill-in is provided in the MSP and LSP under control of the relative position inputs.

Information on the  $\Sigma'$  bus can be accessed during some operations through the 3-state  $\Sigma'$  bus control buffer at the B input/output port.

The parallel data input ports and the I/O capability of the B port, combined with the  $\Sigma$ -bus access, provides considerable flexibility for performing simple shifts or combinations of **operation-and-shift** on data or operands resident in the external working memory locations.

# 2.10 B-INPUT/OUTPUT CONTROL

The B-input/output port is isolated from the sum' bus by a 3-state control buffer when the buffer outputs are at a high-impedance. Enabling the buffer routes the sum' bus data to the B-port. The low-current inputs of the B port latch minimizes loading effects, and the buffers can source 6.5 mA or sink 10 mA of drive current in the output mode. During the output mode, the 'bus data can be latched in the B input latch. Enabling or disabling is accomplished by the I/O control input. See Table 10 and Figure 9.

| I/O CONTROL | I/O BUFFER OUTPUT |
|-------------|-------------------|
| L           | SUM' BUS DATA     |
| н           | HIGH-IMPEDANCE    |

TABLE 10 B-INPUT/OUTPUT CONTROL

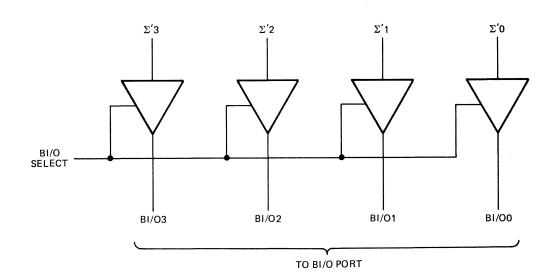
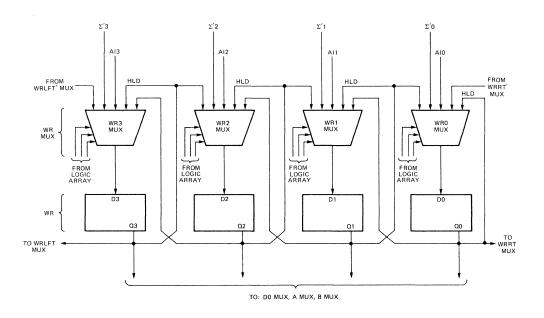


FIGURE 9 - B-INPUT/OUTPUT CONTROL

#### 2.11 WORKING REGISTER

The working register (WR) is a 4-bit D-type register which functions as an accumulator during iterative arithmetic operations or as a temporary holding register for intermediate operands (see Figure 10). It is sourced by the WR multiplexer. Storage of setup data, under control of the resident operation forms which permit the WR to be a destination, occurs on the positive transition of the clock. WR shifting capabilities are implemented in the WR multiplexer. The working register can be selected to source the data-out port multiplexer (DO MUX), A-input multiplexer (A MUX), or B-input multiplexer (B MUX). The MSB of the WR is sourced to the WRLFT MUX, and the LSB of the WR is sourced to the WRRT MUX to facilitate expansion.



#### FIGURE 10 - WORKING REGISTER (WR) AND WR MULTIPLEXER

An asynchronous control line, LDWR, is available to facilitate loading the working register directly from the A input port in combination with the resident micro-operation.

#### 2.12 WORKING REGISTER MULTIPLEXER (WR MUX)

The working register multiplexer provides source selection, including the bidirectional shifting capability, for the working register. See Figure 10. Under direction of the resident operation, the WR MUX asynchronously selects either:

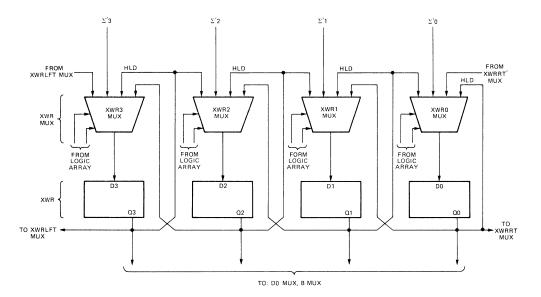
- a. A input port for direct loading
- b.  $\Sigma'$  bus for ALU operand results

- c. Hold mode for no change
- d. Shift left
- e. Shift right

End conditions for both shift left and shift right operations are routed to or from WR MSB (WR3) or WRLSB (WR0) to the WRLFT/WRLFT' multiplexers or to the WRRT/WRRT' multiplexers respectively.

#### 2.13 EXTENDED WORKING REGISTER

The extended working register (XWR) is a 4-bit D-type register which functions primarily as an extension of the working register to provide the double-precision operation capabilities needed for iterative multiply and divide routines (see Figure 11). Additionally, the storage capabilities of the XWR are available for use as another temporary holding register for intermediate operands during a number of the single-precision operation forms. It is sourced by the XWR multiplexer. Storage of setup data, under control of resident operation forms which permit the XWR to be a destination, occurs on the positive transition of the clock. XWR shifting capabilities are implemented in the XWR multiplexer. The XWR can be selected to source the data-out port multiplexer (DO MUX), B-input multiplexer (B MUX), or the XWR multiplexer (XWR MUX). The MSB of the XWR is sourced to the XWRLFT' MUX, and the LSB of the XWR is sourced to the XWRRT' MUX to facilitate expansion.





#### 2.14 EXTENDED WORKING REGISTER MULTIPLEXER (XWR MUX)

The extended working register multiplexer provides source selection, including the bidirectional shifting capability, for the extended working register (see Figure 11). Under direction of the resident operation, the XWR MUX asynchronously selects either:

- a.  $\Sigma'$  bus for ALU operand results
- b. Hold mode for no change

- c. Shift left
- d. Shift right.

End conditions for both shift left and shift right operations are routed to or from XWR MSB (XWR3) or XWR LSB (XWR0) to the XWRLFT/XWRLFT' multiplexers or to the XWRRT/XWRRT' multiplexers respectively.

#### 2.14.1 Σ-Bus, WR, XWR MSB Shift Transfer Multiplexers

The MSB shift transfers are accomplished by the WRLFT, XWRLFT input/output multiplexers and the WRLFT', XWRLFT' sum-bus/register MSB input multiplexers. All four multiplexers, and the impedance of the 3-state I/O lines of the WRLFT and XWRLFT multiplexer outputs are under control of the resident operation code and the relative position control (POS). Data paths of the multiplexers are illustrated in Figure 12, and bit transfers with respect to each of the shift operations are enumerated in Tables 11 through 14.

#### 2.14.2 WRLFT, XWRLFT Multiplexers

The WRLFT, XWRLFT input/output multiplexers facilitate routing of the working register, extended working register, or sum bus MSB out the WRLFT, XWRLFT I/O's during output modes. In an input mode, the three-state output is at a high impedance permitting the WRLFT and/or the XWRLFT pins to be used as inputs.

#### 2.14.3 WRLFT', XWRLFT' Multiplexers

The WRLFT' multiplexer selects the source for either the sum bus or working register MSB. Sign bit protection and right-shift bit-fill functions are all handled on-chip by these multiplexers under control of the operation code and relative position. The WRLFT' sources are:

- a. WRLFT (input)
- b. ALU carry out (for sign-fill)
- c. Low level (for zero-fill)
- d. XWRLFT input
- e. XWR MSB
- f. WR MSB (sign-fill in for RSA)
- g. Sign fill in for RSA (see Figure 12)

The XWRLFT multiplexer selects the source for XWR MSB and provides sign-bit protection and right-shift-fill functions for the XWR. The XWRLFT sources are:

- a. XWRLFT (input)
- b. WRLFT
- c. XWR MSB (sign-fill in for RSA)

## 2.14.4 WR, XWR LSB Shift Transfer Multiplexers

The LSB shift transfers are accomplished by the WRRT, XWRRT input/output multiplexers and the WRRT', XWRRT' sum-bus/register LSB input multiplexers. All four multiplexers, and the impedance of the 3-state I/O lines of the WRRT and XWRRT multiplexer outputs, are under control of the resident operation code and the relative position control (POS). Data paths of the multiplexers are illustrated in Figure 13.

## 2.14.5 WRRT Multiplexer, XWRRT Buffer

The WRRT input/output multiplexer facilitates routing of sum-bus or working register LSB out the WRRT I/O during output modes. The XWRRT I/O buffer can access and source the XWR LSB. In an input mode, the three-state output is at a high impedance permitting the WRRT and/or XWRRT pins to be used as inputs.

# 2.14.6 WRRT', XWRRT' Multiplexers

The WRRT' multiplexer selects either the WRRT input or a low logic level (fill) input as the LSB source for either the working register or the sum-bus. The XWRRT' multiplexer selects between the XWRRT input and low logic level (fill) input as the XWR LSB source.

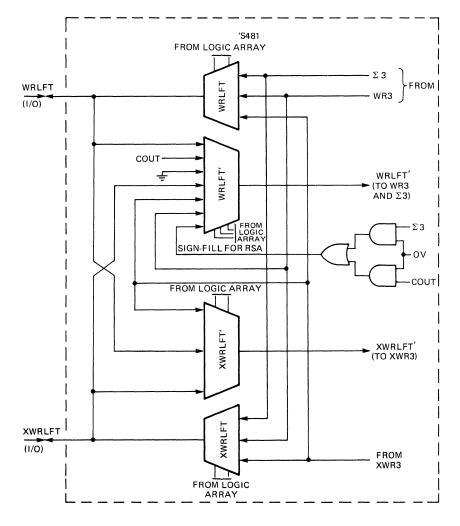


FIGURE 12 - SUM-BUS, WR, XWR MSB SHIFT TRANSFER MULTIPLEXERS

| SHIFT     | MOS   | IN     | ITERMEDIAT | E POSITIO | N     | LEAST-SIGNIFICANT POSITION |      |      |       |        |       |      |
|-----------|-------|--------|------------|-----------|-------|----------------------------|------|------|-------|--------|-------|------|
| MODE      | WRLFT | WRLFT' | WRRT'      | WRRT      | WRLFT | WRLFT'                     | WRRT | WRRT | WRLFT | WRLFT' | WRRT' | WRRT |
| LSL (SP)  | z     | x      | WRRT       | z         | WR3   | x                          | WRRT | z    | WR3   | x      | WRRT  | z    |
| LSL (DP)  | XWR3  | х      | WRRT       | z         | WR3   | ×                          | WRRT | Z    | WR3   | x      | WRRT  | z    |
| LSA (SP)  | WR3   | х      | WRRT       | Z         | WR3   | x                          | WRRT | Z    | WR3   | X      | L     | Z    |
| LSA (DP)  | XWR3  | х      | WRRT       | z         | WR3   | ×                          | WRRT | z    | WR3   | X      | WRRT  | Z    |
| LCIR (SP) | WR3   | x      | WRRT       | z         | WR3   | x                          | WRRT | Z    | WR3   | X      | WRRT  | Z    |
| LCIR (DP) | XWR3  | х      | WRRT       | z         | WR3   | ×                          | WRRT | z    | WR3   | ×      | WRRT  | Z    |
| RSL (SP)  | Z     | WRLFT  | х          | WR0       | Z     | WRLFT                      | x    | WR0  | Z     | WRLFT  | х     | Z    |
| RSL (DP)  | Z     | L      | х          | WR0       | z     | WRLFT                      | х    | WR0  | z     | WRLFT  | х     | WR0  |
| RSA (SP)  | Z     | WR3    | x          | WR0       | Z     | WRLFT                      | x    | WR0  | Z     | WRLFT  | х     | WR0  |
| RSA (DP)  | z     | WR3    | х          | WR0       | z     | WRLFT                      | х    | WR0  | Z     | WRLFT  | х     | WR0  |
| RCIR (SP) | Z     | WRLFT  | x          | WR0       | Z     | WRLFT                      | х    | WR0  | Z     | WRLFT  | х     | WR0  |
| RCIR (DP) | z     | WRLFT  | х          | WR0       | z     | WRLFT                      | х    | WR0  | z     | WRLFT  | х     | WRO  |

TABLE 11 WORKING REGISTER BIT TRANSFERS TO WRLFT/WRRT

 TABLE 12

 SUM-BUS BIT TRANSFERS TO WRLFT/WRRT

| SHIFT     | MOS   | T-SIGNIFICA | ANT POSIT | ION  | IN    | TERMEDIAT | E POSITIO | N          | LEAST-SIGNIFICANT POSITION |        |       |            |  |
|-----------|-------|-------------|-----------|------|-------|-----------|-----------|------------|----------------------------|--------|-------|------------|--|
| MODE      | WRLFT | WRLFT'      | WRRT'     | WRRT | WRLFT | WRLFT'    | WRRT      | WRRT       | WRLFT                      | WRLFT' | WRRT' | WRRT       |  |
| LSL (SP)  | z     | x           | WRRT      | z    | Σ3    | x         | WRRT      | Z          | Σ3                         | x      | WRRT  | z          |  |
| LSL (DP)  | XWR3  | х           | WRRT      | z    | Σ3    | x         | WRRT      | z          | Σ3                         | ×      | WRRT  | Z          |  |
| LSA (SP)  | ະນ3   | х           | WRRT      | z    | Σ3    | ×         | WRRT      | Z          | Σ3                         | ×      | L     | Z          |  |
| LSA (DP)  | XWR3  | х           | WRRT      | z    | Σ3    | х         | WRRT      | z          | Σ3                         | ×      | WRRT  | Ż          |  |
| LCIR (SP) | Σ3    | x           | WRRT      | Z    | Σ3    | x         | WRRT      | Z          | Σ3                         | x      | WRRT  | Z          |  |
| LCIR (DP) | XWR3  | х           | WRRT      | z    | Σ3    | x         | WRRT      | z          | Σ3                         | ×      | WRRT  | Z          |  |
| RSL (SP)  | Z     | WRLFT       | х         | Σ0   | Z     | WRLFT     | х         | <u>۲</u> 0 | Z                          | WRLFT  | х     | Σ0         |  |
| RSL (DP)  | z     | C-OUT       | х         | Σ0   | z     | WRLFT     | х         | ΣO         | z                          | WRLFT  | х     | 20         |  |
| RSA (SP)  | Z     | *           | х         | Σ0   | Z     | WRLFT     | х         | Σ0         | Z                          | WRLFT  | х     | Σ0         |  |
| RSA (DP)  | z     | *           | х         | Σ0   | z     | WRLFT     | х         | Σ0         | z                          | WRLFT  | х     | $\Sigma 0$ |  |
| RCIR (SP) | Z     | WRLFT       | х         | Σ0   | Z     | WRLFT     | х         | Σ0         | Z                          | WRLFT  | х     | Σ0         |  |
| RCIR (DP) | z     | XWRLFT      | х         | Σ0   | z     | WRLFT     | х         | Σ0         | z                          | WRLFT  | х     | Σ <b>0</b> |  |

\*VARIABLE = ( $\Sigma$ 3 · ALU OVERFLOW) + (C-OUT · ALU OVERFLOW)

TABLE 13

## EXTENDED WORKING REGISTER BIT TRANSFERS TO XWRLFT/XWRRT

| SHIFT     | SHIFT MOST-SIGNIFICANT POSITION |         |        |       |        | NTERMEDIA | TE POSITIO | N     | LEAST-SIGNIFICANT POSITION |         |        |       |  |
|-----------|---------------------------------|---------|--------|-------|--------|-----------|------------|-------|----------------------------|---------|--------|-------|--|
| MODE      | XWRLFT                          | XWRLFT' | XWRRT' | XWRRT | XWRLFT | XWRLFT'   | XWRRT'     | XWRRT | XWRLFT                     | XWRLFT' | XWRRT' | XWRRT |  |
| LSL (SP)  | z                               | x       | XWRRT  | z     | XWR3   | ×         | XWRRT      | z     | XWR3                       | x       | XWRRT  | z     |  |
| LSL (DP)  | z                               | ×       | XWRRT  | z     | XWR3   | ×         | XWRRT      | z     | XWR3                       | х       | XWRRT  | z     |  |
| LSA (SP)  | XWR3                            | ×       | XWRRT  | Z     | XWR3   | ×         | XWRRT      | Z     | XWR3                       | х       | L      | z     |  |
| LSA (DP)  | WR3                             | ×       | XWRRT  | z     | XWR3   | ×         | XWRRT      | z     | XWR3                       | х       | L      | z     |  |
| LCIR (SP) | XWR3                            | ×       | XWRRT  | Z     | XWR3   | ×         | XWRRT      | Z     | XWR3                       | x       | XWRRT  | Z     |  |
| LCIR (DP) | WR3                             | ×       | XWRRT  | z     | XWR3   | ×         | XWRRT      | Z     | XWR3                       | х       | XWRRT  | Z     |  |
| RSL (SP)  | Z                               | XWRLFT  | x      | XWR0  | Z      | XWRLFT    | x          | XWR0  | z                          | XWRLFT  | x      | Z     |  |
| RSL (DP)  | z                               | WRLFT   | х      | XWR0  | z      | XWRLFT    | х          | XWR0  | z                          | XWRLFT  | х      | XWR0  |  |
| RSA (SP)  | Z                               | XWR3    | x      | XWR0  | z      | XWRLFT    | х          | XWR0  | z                          | XWRLFT  | x      | XWR0  |  |
| RSA (DP)  | z                               | WRLFT   | х      | XWR0  | z      | XWRLFT    | x          | XWR0  | z                          | XWRLFT  | x      | XWR0  |  |
| RCIR (SP) | Z                               | XWRLFT  | х      | XWR0  | z      | XWRLFT    | x          | XWR0  | z                          | XWRLFT  | х      | XWR0  |  |
| RCIR (DP) | z                               | WRLFT   | ×      | XWR0  | z      | XWRLFT    | ×          | XWR0  | z                          | XWRLFT  | ×      | XWR0  |  |

| SHIFT     |        | MOST-SIGNIFIC | CANT POSITION |       |
|-----------|--------|---------------|---------------|-------|
| MODE      | XWRLFT | XWRLFT'       | XWRRT'        | XWRRT |
| LSL (SP)  | Z      | x             | XWRRT         | Z     |
| LSL (DP)  | Z      | x             | XWRRT         | z     |
| LSA (SP)  | XWR3   | x             | XWRRT         | z     |
| LSA (DP)  | Σ3     | x             | XWRRT         | z     |
| LCIR (SP) | XWR3   | x             | XWRRT         | Z     |
| LCIR (DP) | Σ3     | х             | XWRRT         | Z     |
| RSL (SP)  | Z      | XWRLFT        | x             | XWR0  |
| RSL (DP)  | z      | WRLFT         | х             | XWR0  |
| RSA (SP)  | Z      | XWR3          | x             | XWR0  |
| RSA (DP)  | Z      | WRLFT         | х             | XWR0  |
| RCIR (SP) | Z      | XWRLFT        | x             | XWR0  |
| RCIR (DP) | Z      | WRLFT         | x             | XWR0  |

TABLE 14 SUM-BUS BIT TRANSFERS TO XWRLFT (MSP)

NOTE: Intermediate and Least-Significant Positions are the same as shown in Table 13.

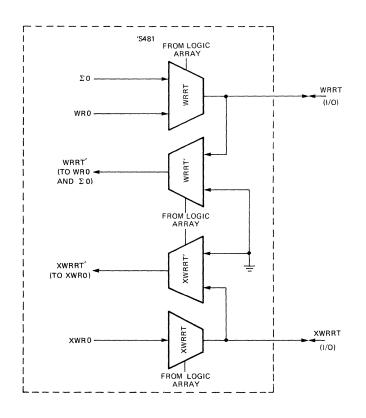


FIGURE 13 - SUM-BUS, WR, XWR LSB SHIFT TRANSFER MULTIPLEXERS

#### 2.15 SHIFT FUNCTIONS

The 'S481 contains the necessary controls and data paths to perform single or double length logical, arithmetic, or circulate bidirectional shift functions in a single clock cycle. Each of the six shift functions implemented are selectable by a single microinstruction; and, additionally two single clock operation forms are included which provide the capability of performing an add/subtract in conjunction with a shift. The six shift functions and the basic operation forms offering them are enumerated in Table 15.

| OPERATION FORMS  |  |   |   |  |  |  |  |  |  |  |
|------------------|--|---|---|--|--|--|--|--|--|--|
| SIMPL            | E SHIFT  | ADD/SUBTRACT<br>WITH SHIFT  |   |  |  |  |  |  |  |  |
| SINGLE<br>LENGTH | DOUBLE<br>LENGTH   | SINGLE<br>LENGTH  | DOUBLE<br>LENGTH  |  |  |  |  |  |  |  |
| IV, V            | VI   |   |   |  |  |  |  |  |  |  |
| IV, V            | VI   |   |   |  |  |  |  |  |  |  |
| IV, V            | VI   | 111   | н   |  |  |  |  |  |  |  |
| IV, V            | VI   |   |   |  |  |  |  |  |  |  |
| IV, V            | VI   | III   |   |  |  |  |  |  |  |  |
| IV, V            | VI   | 111   | н   |  |  |  |  |  |  |  |
|                  | SINGLE<br>LENGTH<br>IV, V<br>IV, V<br>IV, V<br>IV, V<br>IV, V<br>IV, V | SIMPLE SHIFT           SINGLE         DOUBLE           LENGTH         LENGTH           IV, V         VI           IV, V         VI | SIMPLE SHIFT     ADD/SU WITH       SINGLE     DOUBLE     SINGLE       LENGTH     LENGTH     LENGTH       IV, V     VI     III       IV, V     VI     III |  |  |  |  |  |  |  |

TABLE 15 MICROPROGRAMMABLE SHIFT FUNCTIONS

#### 2.15.1 CIRCULATE (SHIFT) FUNCTIONS (MICROPROGRAMMABLE)

Operation forms IV and V provide the system designer with the capability of programming a single precision circulate (or rotate) of the  $\Sigma'$  bus, working register, or extended working register and operation form VI provides the capability of circulating or rotating a double-length word resident in the WR/XWR. A single-bit-position left or right circulate is accomplished on each clock without the loss of any bits as the shift transfer multiplexers, under control of the resident operation and position input, interconnect the bus or register as illustrated in Figure 14.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for MSB  $\rightarrow$  LSB for single precision circulates and for transfers to or from the  $\Sigma'$  bus or working register and the extended working register during double-precision circulates. Data flow between packages in an expanded word-length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

#### 2.15.2 ARITHMETIC SHIFT FUNCTIONS (MICROPROGRAMMABLE)

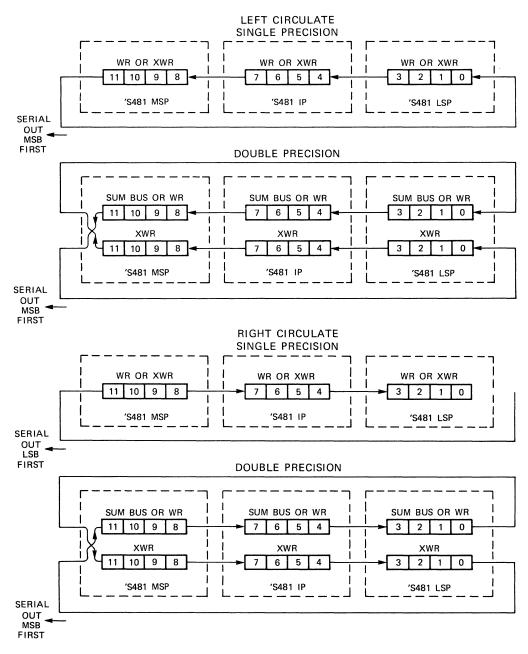
Operation forms III, IV, V and VI provide the system designer with the capability of programming the following arithmetic shifts.

Form III - A single-precision arithmetic left or sign-protected right shift of the sum or difference of the A and B operands destined for either the WR or XWR.

Form IV – A single-precision arithmetic left or sign-protected right shift of the A operand destined for the  $\Sigma'$  bus.

Form V - A single-precision arithmetic left or sign-protected right shift of the WR or XWR contents.

Form VI – A double-precision arithmetic left or sign-protected right shift of the WR and XWR contents.



## SN74S481 4-BIT-SLICE SCHOTTKY PROCESSOR ELEMENT

FIGURE 14 - CIRCULATE FUNCTIONS

A single-bit-position shift is accomplished on each clock with right-shift sign-protection and left shift LSB zero-fill operations controlled by the shift transfer multiplexers under direction of the resident operation and the position input. See Figure 15.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for transfers to or from the  $\Sigma'$  bus or working register and the extended working register during double-precision arithmetic shifts. Data flow between packages in an expanded word-length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

## 2.15.3 LOGICAL SHIFT FUNCTIONS (MICROPROGRAMMABLE)

Operation Forms II, III, IV, V and VI provide the system designer with the capability of programming the following logical shifts:

Form II - A double-precision left or right shift of the sum or difference of the A and B operands destined for the WR in conjunction with the XWR.

Form III - A single-precision left or right logical shift of the sum or difference of the A and B operands destined for the WR or the XWR.

Form IV – A single-precision left or right logical shift of the A operand destined for the  $\Sigma'$  bus.

Form V – A single-precision left or right logical shift of the WR or XWR contents.

Form VI – A double-precision left or right logical shift of the WR and XWR contents.

A single-bit-position shift is accomplished on each clock with MSB and LSB fill operations controlled by the shift transfer multiplexers under direction of the resident operation and the position input. See Figure 16.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for transfers to and from the  $\Sigma'$  bus or working register and the extended working register during double-precision logical shifts. Data flow between packages in an expanded word length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

#### 2.16 DATA-OUT PORT MULTIPLEXER (DO MUX)

The data-out port multiplexer, Figure 17, provides selection for routing the contents of either the sum'-bus, working register, or extended working register to the parallel output port. Additionally, the multiplexer is equipped with 3-state outputs providing the capability to isolate the 'S481 from the system data bus. Source selections and high-impedance controls are detailed in Table 16.

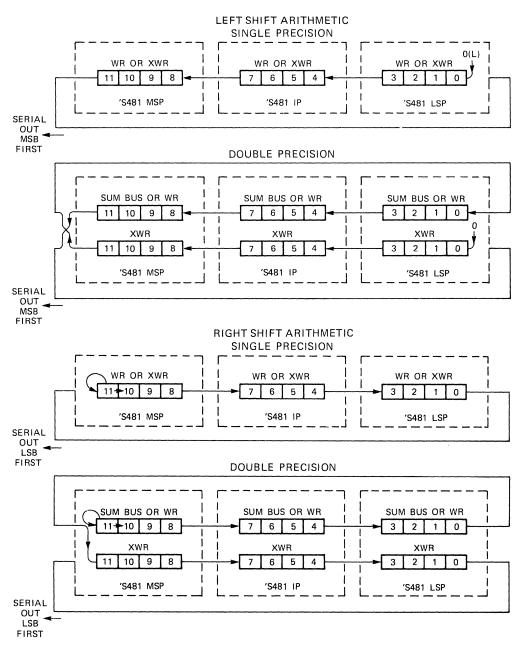
Each data output is capable of sourcing 6.5 and sinking 10 milliamperes of drive current.

#### 2.17 MEMORY AND PROGRAM COUNTERS

Dual counters provide the system designer with a processor element containing both an iteration counter and the capability of generating and/or storing locations of operands/data.

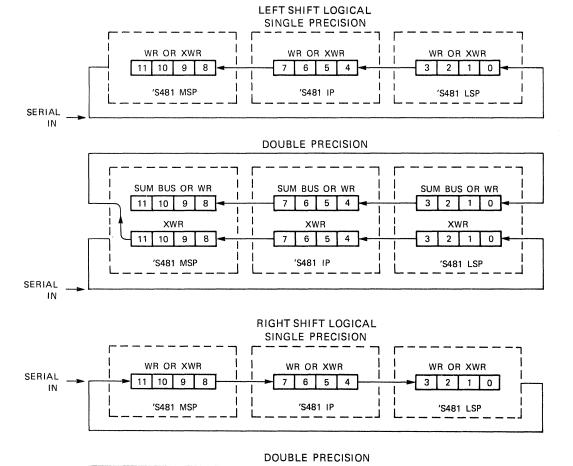
Either counter can be loaded or preset to any value or result from the sum bus in operations forms as follows:

|         | SELECTABLE AS<br>DESTINATION |     |  |  |  |
|---------|------------------------------|-----|--|--|--|
| OP FORM | PC                           | MC  |  |  |  |
| 1       | Yes                          | Yes |  |  |  |
| 111     | No                           | Yes |  |  |  |
| VIII    | Yes                          | No  |  |  |  |



## SN74S481 4-BIT-SLICE SCHOTTKY PROCESSOR ELEMENT

FIGURE 15 - ARITHMETIC SHIFT FUNCTIONS



## SN74S481 4-BIT-SLICE SCHOTTKY PROCESSOR ELEMENT

FIGURE 16 - LOGICAL SHIFT FUNCTIONS

7

7

SUM BUS OR WR

6 5

XWR

'S481 IP

6 5 4

4

SUM BUS OR WR

XWR

'S481 LSP

2 1 0

2 1 0

3

3

IC OUT

OR O

XWR

11 10 9 8

'S481 MSP

11 10 9 8

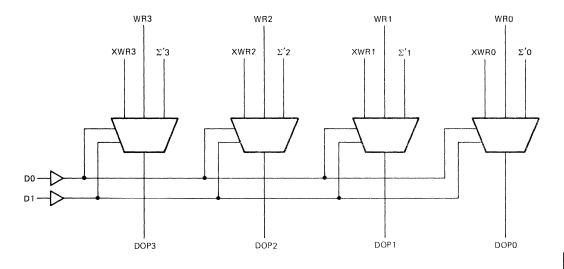


FIGURE 17 - DATA-OUT PORT MULTIPLEXER (DO MUX)

Under control of the position (POS) input and the resident operation code, the  $\overline{CCO}/OV$  output facilitates cascading the program and memory counters. In the least-significant and intermediate positions, the  $\overline{CCO}$  pins of lesser significant packages are connected to the  $\overline{CCI}$  pins of more significant packages to complete the counter interconnections to the bit-size of the processor element.

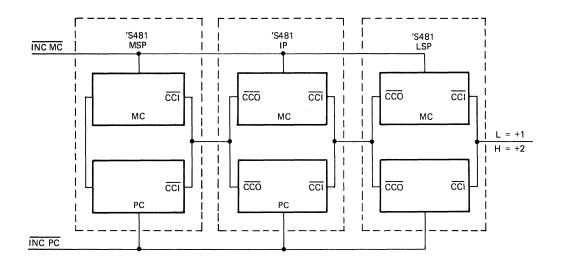
The functionally identical program and memory counters, sharing a

|    | TABLE 16<br>DATA-OUT PORT CONTROL |                           |  |  |  |  |  |  |  |  |  |
|----|-----------------------------------|---------------------------|--|--|--|--|--|--|--|--|--|
|    | TROL                              | SOURCE OR FUNCTION        |  |  |  |  |  |  |  |  |  |
| D1 | D0                                |                           |  |  |  |  |  |  |  |  |  |
| L  | L                                 | Σ'-BUS                    |  |  |  |  |  |  |  |  |  |
| L  | н                                 | EXTENDED WORKING REGISTER |  |  |  |  |  |  |  |  |  |
| н  | L                                 | WORKING REGISTER          |  |  |  |  |  |  |  |  |  |
| н  | н                                 | HIGH-IMPEDANCE            |  |  |  |  |  |  |  |  |  |

common counter carry input ( $\overline{CCI}$ ) control pin and a common counter carry output ( $\overline{CCO}$ ) pin, feature individual control lines ( $\overline{INC PC}$ ,  $\overline{INC MC}$ ) which can be used to instruct either (but normally not both) or neither counter to increment on the next clock transition in any of the 14 operation forms. Additionally, the counter in the LSP, under command of the POS input, has the capability of incrementing its value by one or by two to facilitate the generation of even or odd address locations in a single clock cycle. Contents of the counters can be read out from the address out port asynchronously under control of the address output multiplexer (AO MUX) select input.

Typical counter functions with respect to package relative positions are shown in Figure 18.

In the MSP, the CCO/OV output, as a result of the position (POS) control, becomes the ALU/shift overflow (OV) status output.



|        | INPUTS |     | ск       |        | CO     | UNTER VALUE |            |
|--------|--------|-----|----------|--------|--------|-------------|------------|
| INC PC | INC MC | CCI | UK       | LSP MC | LSP PC | MSP, IP MC  | MSP, IP PC |
| н      | Н      | х   | A        | NO CHG | NO CHG | NO CHG      | NO CHG     |
| L      | н      | L   | <b>A</b> | NO CHG | +1     | NO CHG      | +1         |
| L      | н      | н   | 4        | NO CHG | +2     | NO CHG      | NO CHG     |
| н      | L      | L   | A        | +1     | NO CHG | +1          | NO CHG     |
| н      | L      | н   | <b>A</b> | +2     | NO CHG | NO CHG      | NO CHG     |
| x      | х      | x   | L        | NO CHG | NO CHG | NO CHG      | NO CHG     |
| ×      | х      | x   | н        | NO CHG | NO CHG | NO CHG      | NO CHG     |

H=HIGH LEVEL, L=LOW LEVEL, X=IRRELEVANT , ↓ =LOW-TO-HIGH TRANSITION

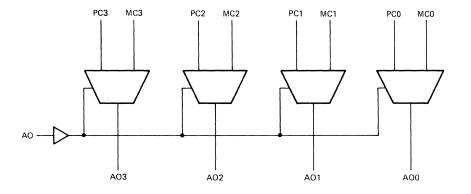
#### FIGURE 18 - PROGRAM AND MEMORY COUNTER FUNCTIONS

# 2.18 ADDRESS-OUT PORT MULTIPLEXER (AO MUX)

The address-out port multiplexer, Figure 19, provides for direct parallel access to the contents of either the program or memory counter contents. A single line controls selection as shown in Table 17.

| TABLE 17                 |   |
|--------------------------|---|
| ADDRESS-OUT PORT CONTROL | 1 |

| CONTROL<br>INPUT A0 | COUNTER SELECTED |
|---------------------|------------------|
| L                   | MEMORY           |
| H                   | PROGRAM          |



#### FIGURE 19 - ADDRESS-OUT PORT MULTIPLEXER (AO MUX)

## 2.19 EXPANDING THE WORD LENGTH

The 'S481 processor element contains on-chip personality circuitry designed specifically to minimize the external discrete components required to cascade 4-bit slices to form larger word lengths. At the processor-element level, three external resistors are all that is required: one to pull-up the open-collector outputs and two to establish the position control input voltage at the LSP. Figure 20 shows a typical 16-bit processor element and illustrates the parallel bus arrangements for I/O and control with an SN74S182 performing ALU look-ahead across the 16-bit word. Interconnectivity for the shift, arithmetic, and counter functions is accomplished by hardwiring the functions as shown.

At the system level, standard techniques commonly employed for power-supply bypass, termination of unused pins, and system grounding of high-performance Schottky TTL systems are recommended.

## 3. OPERATIONAL DESCRIPTIONS

## 3.1 MICRO/MACRO-OPERATIONS

The micro/macro-operations resident in the micro-decode logic array can be accessed with an eleven-bit operation-select word. Operational flexibility is maximized by the fact that the op-select word format has been defined individually for each of the 14 different operation forms.

Operation Forms I, II, and III are primarily ALU functions. Forms II and III combine logical or arithmetic shifting functions with the ALU result. Form II can be used for double-precision shifting. Sources, specific ALU function, shift format, and destinations are detailed for each op-select word format.

Forms IV, V, and VI perform either logical or arithmetic, bidirectional shifting of the single- and doubleprecision buses and registers.

Form VII can be used to compare the magnitude of A source to B source, or B source to A source.

Form VIII provides the capability to logically combine the values of the A and B sources.

Form IX zeros the  $\Sigma'$  bus with the effect of providing no operation.

Forms X through XIV are macroprogrammable operations which provide:

- a. CRC partial sum update (normally  $\frac{N}{2}$  clocks)
- b. Signed Divide (N + 3 clocks)
- c. Unsigned Divide (N + 1 clocks)
- d. N-bit-by-N-bit double-precision unsigned multiply (N clocks)
- e. N-bit-by-N-bit double-precision signed multiply (N clocks)

The 14 operation forms, symbols, and number of unique operations are detailed in Table 18.

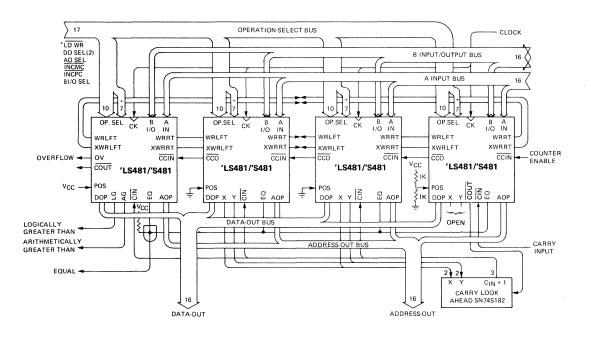


FIGURE 20 - TYPICAL 16-BIT PROCESSOR

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|           | OPERATION FORM  |                         |                            |  |   | COMMANE  | FORMAT  |  |                   |   |                  |   |            |                         |   | TEST O                       | UTPUTS                       |            |                 |   |
|-----------|---|-------------------------|----------------------------|--|---|--|---|--|-------------------|---|------------------|---|------------|-------------------------|---|------------------------------|------------------------------|------------|-----------------|---|
|           |   |                         |                            | 1  |   |  |   | 1  |                   | Γ   | 1                | LSP                                     | M          | SP                      | A   | LL                           | M                            | SP         | MSP             | MSP   |
| NO.       | OPERATION   | OP0<br>(7) <sup>1</sup> | OP1<br>(8)                 | OP2<br>(9)   | OP3<br>(10)                                   | OP4<br>(17)  | OP5<br>(14)   | OP6<br>(13)  | OP7<br>(11)       | OP8<br>(15)                                       | OP9<br>(16)      | CIN<br>(18)                             | LG<br>(21) | AG<br>(20)              | EQ<br>(23)  | C-OUT<br>(22)                | X<br>(21)                    | Y<br>(20)  | OVFL<br>(37)    | CCO<br>(37)                                 |
| IA        | $(\pm A \pm B + \overline{CIN}) \rightarrow \Sigma' BUS ONLY^2$   | н                       | L                          | L  | A SOL   | JRCE   |   | B SOURCE   | -                 | A' FNCT   | B' FNCT          | L=CARRY                                 | Σ'≠ZERO    | Σ'>ZERO                 | Σ'=ZERO   | COUT                         | X4                           | ¥4         | OVFL            | CCO   |
| IΒ        | (±A ±B + CIN) → REGISTER  | L                       | LL = 2<br>LH = 2<br>HL = 2 | $\begin{array}{l} \text{ISTER} \\ \Sigma' \rightarrow \text{WR} \\ \Sigma' \rightarrow \text{XWR} \\ \Sigma' \rightarrow \text{PC} \\ \Sigma' \rightarrow \text{MC} \end{array}$ | LL = Al -<br>LH = H'S<br>HL = Bl -<br>HH = WR | → A<br>→ A   | LLI<br>LH<br>HL<br>HL<br>HL   | $L = BI \rightarrow B$ $H = H'S \rightarrow B$ $L = BI \cdot WR$ $H = WR \rightarrow B$ $L = BI \cdot XW$ $H = XWR \rightarrow$ $L = BI \cdot PC$ $H = PC \rightarrow B$ | →B<br>R→B<br>B    | L = A → A'<br>H = Â → A'                          | H = B → B'       | H=NO<br>CARRY                           |            |                         |   |                              |                              |            |                 |   |
|           | (A + B + CIN) > WR, XWR <sup>2</sup>  | н                       | н                          | н  | L   | н  | L   | $\frac{FUNCT}{L = A \rightarrow A'}$   | L=BI→B'           | L = AI → A  |                  | L = SUB                                 | S≠ZERO     | Σ'>ZE RO                | Σ'=ZERO   | COUT                         | ×                            | Y          | OVFL            | cco   |
| НВ        | (B – A – 1) & WR, XWR   | н                       | н                          | н  | L   | н  | L   | H = Ā → A'   | H≖WR→B'           | H ≈ BI → A  | H = RT           | H = ADD                                 |            |                         |   |                              |                              |            |                 |   |
| ш         | (A + B + CIN) S REGISTER  | н                       | н                          | L  | н   | A' SRC   | REGISTER  | -  |                   | SHIFT   | TYPE             | L = CARRY                               |            | Σ">ZERO                 | 1   | COUT                         | ×                            | Y          | OVFL            | cco   |
|           |   |                         |                            |  |   | $L = AI \rightarrow A'$<br>$H = BI \rightarrow A'$ | $L = \Sigma' \rightarrow MC$<br>$H = \Sigma' \rightarrow$           | LL = BI<br>LH = WI   |                   | L = LOG<br>H = ARITH                              | L = LFT          | H = NO<br>CARRY                         | DURIN      | IG ARITHN               | IETIC SHIF  | TS A' + C IS<br>I            | COMPARE                      | D TO -1    | SHIFT           |   |
|           |   |                         |                            |  |   |  | XWR   | HL = XV<br>HH* = L   | 'S → B'           |   |                  |   | Σ′≠1       | $\Sigma' > -1$          | Σ'= -1  | <u>cout</u>                  | ×                            | Y          | OVFL            | 600   |
| ١v        | Al ԳΣ' BUS  | н                       | н                          | н  | L   | н  | н   | LL = AI  |                   | LL = LOG  |                  | L = LFT                                 | AI≠ZERO    | AI>ZERO                 | AI=ZERO   | CIN                          | x                            | Y          | L<br>(FOR       | 000   |
|           | WR SH WR  | н                       | н                          | н  | L   | н  | н   | LH = WR  |                   | LH = ARIT   |                  | H = RT                                  |            |                         |   |                              |                              |            | LSA             |   |
| VB<br>VI  | XWR SXWR<br>WR, XWR SYWR, XWR   | н                       | н<br>н                     | н  |   | н  | н   | HL = XW  |                   | HH (NOT C   |                  |   |            |                         |   |                              |                              |            | OVFL)           |   |
| -         |   |                         |                            |  |   |  | 1   | B' SOURCE  |                   | A' SRC  | OPER             | н                                       | N1>N2      | N1>N2                   | N1=N2   | -LG                          | x                            | Y          | _               | cco   |
|           | A:B (N1:N2)   | н                       | н                          | н  | L   | L  | (SAME /   | AS FORM I  | ABOVE)            | L = AI → A'                                       | L=A:B            |   |            |                         |   |                              |                              |            |                 |   |
|           | B:A (N1:N2)<br>NOR/AND LOGICAL OPERATIONS<br>OR/NAND LOGICAL OPERATIONS<br>EX OR/EX NOR LOGICAL<br>OPERATIONS | н<br>н<br>н             | LH                         | H<br>FUNCTION<br>HL = NOR<br>HH = OR<br>LL = XOR   | L   | L<br>L≖AI→A<br>H≖WR→A                              | $\frac{REG^{\dagger}}{LL = WR}$ $LH = XWR$ $HL = PC$ $HH = \Sigma'$ | B SO<br>LL = BI<br>LH = WI<br>HL = XV<br>HH = PC   | →B<br>R→B<br>VR→B | H = WR →A'<br>A' FNCT<br>L = A → A'<br>H = Ā → A' | B'FNCT<br>L=B→B' | REGT<br>(SEE<br>UNDER<br>OP5<br>COLUMN) | ∑≠ZERO     | Σ'>ZERO                 | Σ'=ZERO   | -CIN                         | ×                            | Y          | L               | 033   |
| IX        | NO OPERATION (ZERO $\rightarrow \Sigma'$ BUS)   | н                       | н                          | н  | н   | н  | HorL  | H or L   | HorL              | HorL  | HorL             | HorL                                    | L          | L                       | н   | =CIN                         | ×                            | Y          | L               | CCO   |
| х         | CRC ACCUMULATION  | н                       | н                          | н  | н   | L  | L   | L  | L                 | L   | O/I5             | н                                       | -          | -                       | -   | -                            | ×                            | Y          | L               | cco   |
| xı        | A. START<br>SIGNED B. ITERATE (N-1 CLKS)  | тт                      | н                          | Н  | н   | L  | L<br>H  | H  | L<br>H            | H<br>0/16   | H<br>0/16        | н                                       | -          | -                       | DIV=ZERO  | _                            | -                            | -          | -               | -   |
| <u>^'</u> | INTEGER C. ITERATE FINISH   | н                       | н                          | н  | H   | i i  | H   | H H  | L                 | 0/16  | 0/16             | н                                       | _          | -                       | _   | _                            | -                            | -          | _               |   |
|           | DIVIDE D. FIX REMAINDER   | н                       | н                          | н  | н   | L  | н   | L  | L                 | 0/16  | 0/16             | , н                                     |            | -                       | -   | -                            | -                            |            | -               | -   |
|           | E. ADJUST QUOTIENT  | н                       | н                          | н  | н   | L  | L   | н  | н                 | 0/16  | 0/16             | н                                       | -          | -<br>DIV OVFL           | -   |                              | ~                            |            |                 |   |
| XII       | UNSIGNED A. START<br>DIVIDE B. ITERATE (N-1 CLKS)   | H                       | н                          | н  | H<br>H  |  | L.  | L  | L<br>H            | <u>н</u>  | н<br>0/16        | L .                                     | -          | -                       | _   | -                            | -                            | -          | _               |   |
|           | C. FINISH   | н                       | н                          | н  | н   | L L  | L   | L .  | н                 | L   | 0/16             | L                                       | ~          | -                       | -   | -                            | -                            | -          | -               | -   |
| XIII      | UNSIGNED MULTIPLY   | н                       | н                          | н  | н   | L  | L   | н  | L                 | L   | 0/16             | н                                       | ~          | -                       | -   | -                            | -                            | -          |                 | -   |
| XIV       | SIGNED INTEGER MULTIPLY   | н                       | н                          | н  | н   | L  | н   | н  | н                 | 0/16  | O/16             | н                                       |            | -                       | -   |                              | -                            |            | <u> </u>        | -   |
|           | DO1 SEL (29)<br>SEL (42) DO2 SEL (30)   | BI/O SEL (              | 201                        | 041  | inic  | MC (35)  | 5) INC PC (43) CCI (44)   |  |                   |   |                  | 000 (10                                 |            |                         |   |                              |                              |            | PIN ASSIGNMENTS |   |
|           |   |                         |                            | LD WR (24)   |   |  | -   |  |                   |   |                  | POS (19                                 | -          |                         | DATA PORTS  |                              | BIT (2 <sup>n</sup> )        | _          |                 |   |
|           |   | L OUTPL<br>H INPUT      |                            | L AI→W<br>H NOLO   |   | INC<br>HOLD  | н   | INC<br>HOLD  | LSP<br>MID<br>L   | L: x 1<br>H: x 2<br>OR MSP<br>CARRY<br>NO CARR    |                  | 0 V = MID<br>2.4 V = LSP<br>5 V = MSP   |            | (6) (4<br>(5) (4<br>(4) | I/O         DOP           46)         (34)           47)         (33)           (1)         (32)           (2)         (31) | (38)<br>(39)<br>(40)<br>(41) | 0 (LSB)<br>1<br>2<br>3 (MSB) | WRL<br>XWR | FT (25)         | CK (45)<br>V <sub>CC</sub> (12)<br>GND (36) |

#### TABLE 18 - OPERATION FORM, COMMAND FORMAT, AND TEST OUTPUTS

 NOTES:
 1. NUMERALS IN PARENTHESIS ARE PIN NUMBERS
 5. O IS OUTPUT ON LSP, I IS INPUT ON LSP

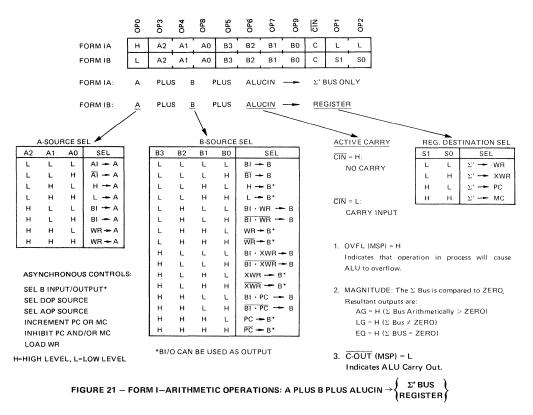
 2. → DESTINED FOR ← SHIFTED AND DESTINED FOR
 6. O IS OUTPUT ON MSP, I IS INPUT ON MSP

 3. H → HIGH VOLTAGE LEVEL, L = LOW VOLTAGE LEVEL
 7. VOLTAGE VALUES ARE NOMINAL

 4. X AND Y ARE CARRY LOOK-AHEAD FUNCTIONS
 5. O IS OUTPUT ON LSP, I IS INPUT ON MSP

#### 3.2 OPERATION FORM I – ADD/SUBTRACT → REGISTER

Operation Form I is designed specifically to perform the addition or symmetrial subtraction of two operands. The operation form shown in Figure 21, is composed of two distinct capabilities:



a. Form IA provides the capability of adding or subtracting two operands and routing the results to the  $\Sigma'$  bus. Symbolically, this operation can be expressed as:

$$\mathsf{A} \quad \left\{ \begin{matrix} \mathsf{PLUS} \\ \mathsf{MINUS} \end{matrix} \right\} \quad \mathsf{B} \; \mathsf{PLUS} \; \mathsf{ALUCIN} \to \Sigma' \; \mathsf{BUS}$$

This form provides the capability of choosing from any one of the A and any one of the B sources listed in Figure 21 as the operands to accomplish the add/subtract. The example illustrated in Figure 22 utilizes the I/O capability of the B input/output port. Input data at the AI or B I/O is setup and then latched into the 'S481 A or B input latch on the negative transition of the 'S481 clock.

During Form IA operations, the contents of the extended working register are not changed and the working register may be saved or loaded directly. The program or memory counters under control of the asynchronous increment, inhibit, and LSP CCI can be saved or either may be incremented by one or two. Sources for the DOP and AOP are also selectable.

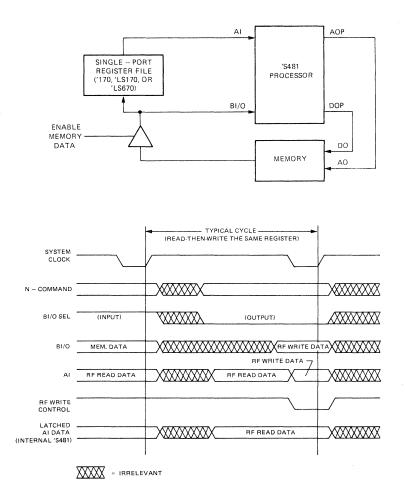


FIGURE 22 – 'S481 OPERATION WITH SINGLE-PORT REGISTER FILE

The overflow and magnitude status lines are active as enumerated in Figure 21.

b. Form IB provides the capability of adding or subtracting two operands and routing the results to one of the four 'S481 storage destinations: the working register (WR), the extended working register (XWR), the program counter (PC), or the memory counter (MC). Symbolically, this operation can be expressed as:

$$A \left\{ \begin{array}{c} \mathsf{PLUS} \\ \mathsf{MINUS} \end{array} \right\} \quad \mathsf{B} \ \mathsf{PLUS} \ \mathsf{ALUCIN} \rightarrow \mathsf{REGISTER}$$

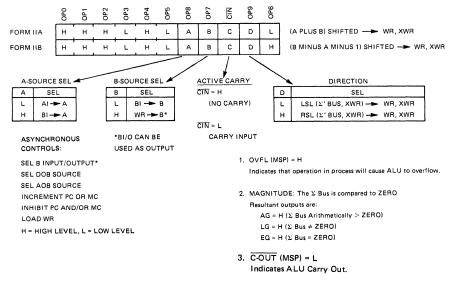
This form provides the capability of choosing from any one of the A and any one of the B sources listed in Figure 21 as the operands to accomplish the add/subtract.

#### 3.3 OPERATION FORM II – ADD/SUBTRACT WITH DOUBLE-PRECISION SHIFT

Operation Form II is designed specifically to perform one of two classical iterations used frequently to implement microprogrammed multiply and divide algorithms. This form provides the system designer with the capability of selecting a single microinstruction which will complete both the add-and-shift or subtract-and-shift functions in a single clock cycle. Available microinstructions are illustrated in Figure 23. Symbolically, Form II operations can be represented as:

| (A PLUS B PLUS ALUCIN) | SHIFTED $\rightarrow$ WR, XWR |
|------------------------|-------------------------------|
| (B MINUS A MINUS 1)    | SHIFTED $\rightarrow$ WR, XWR |

Hardwired algorithms for double-precision multiply and divide routines can be selected in operation forms XI, XII, XIII, or XIV.



During Form II operations the status, overflow, and asynchronous controls are the same as described for Form I.

FIGURE 23 - FORM II-ARITHMETIC WITH DOUBLE-PRECISION SHIFT

 $\left\{ \begin{array}{c} \mathsf{A} \\ \mathsf{B} \end{array} \right\} \mathsf{PLUS} \left\{ \begin{array}{c} \mathsf{B} \\ \mathsf{A} \end{array} \right\} \mathsf{PLUS} \mathsf{CARRY} \mathsf{SHIFTED} \rightarrow \mathsf{WR}, \mathsf{XWR}$ 

(MULTIPLY AND DIVIDE SHIFT OPERATIONS WITHOUT AUTOMATIC CONTROL)

#### 3.4 OPERATION FORM III – ADD WITH SINGLE-PRECISION SHIFT

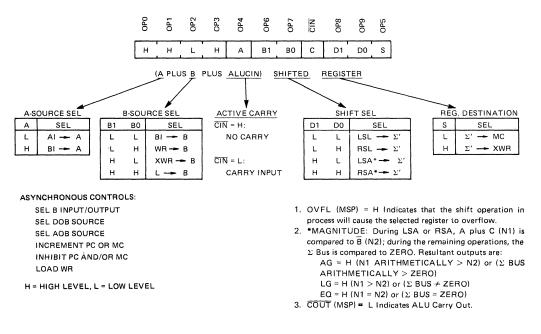
Operation Form III is a universal microinstruction providing the designers with the capability of performing an add-and-shift function in a single clock cycle. Sources and destinations are shown in Figure 24. Also enumerated are the shift functions which are selectable as part of the microinstruction.

Magnitude and overflow status indicators are active as enumerated in Figure 24. Form III can be represented symbolically as:

(A PLUS B PLUS ALUCIN)

SHIFTED → XWR, OR MC

During Form III operation the contents of the working register are not changed unless an asynchronous load is selected. If not selected as the destination, the extended working register will be saved. The memory counter can be the operand destination, or it and the program counter can be saved, or one can be incremented by one or two on selection. Sources for the DOP and AOP are also selectable.

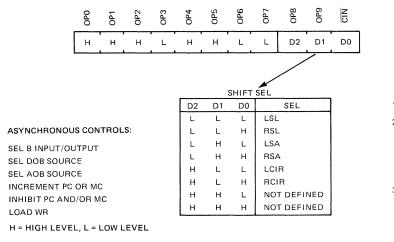


## FIGURE 24 – FORM III-ARITHMETIC WITH SINGLE-PRECISION SHIFT (A PLUS B PLUS ALUCIN) SHIFTED → XWR OR MC

## 3.5 OPERATION FORM IV – AI SHIFTED $\rightarrow \Sigma'$ BUS

Operation Form IV is designed specifically for performing a single bit-position logical, arithmetic, or circular shift of the data applied at the A input port. This single clock operation can be used to shift information residing in any of the external working memory register locations simply by enabling the output capability of the BI/O port and writing the shifted word back into the same (or any other selected) memory location.

Asynchronous controls are the same as described for Operation Form IA, and the magnitude status lines are active and overflow is active during left-shift arithmetic (LSA) operation as enumerated in Figure 25.



#### 1. COUT = CIN

- OVFL (MSP = H) Indicates that LSA operation in process will cause shift overflow. For all other operations, OVFL = L.
- 3. MAGNITUDE: All is compared to ZERO. Resultant outputs are:
  - AG = H (AI > ZERO) $LG = H (AI \neq ZERO)$ EQ = H (AI = ZERO)

#### FIGURE 25 – FORM IV–AI SHIFTED $\rightarrow \Sigma'$ BUS

## 3.6 OPERATION FORM V - SINGLE-LENGTH SHIFT

Operation Form V performs a single-bit position, logical, arithmetic, or circular shift of either the working register or extended working register. Magnitude status indicators are active and overflow is active during left-shift arithmetic (LSA) operations as enumerated in Figure 26. Asynchronous controls are the same as described for Operation Form IA.

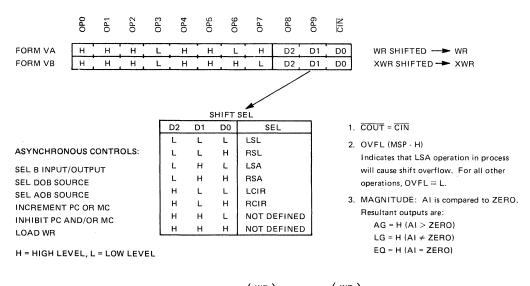
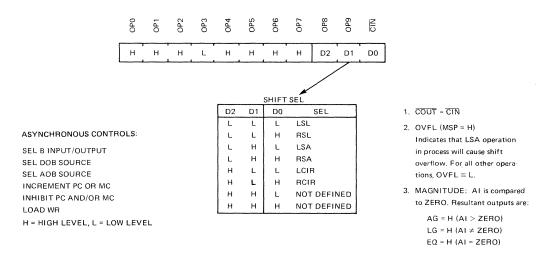


FIGURE 26 – FORM V:  $\begin{cases} WR \\ XWR \end{cases}$  SHIFTED  $\rightarrow \begin{cases} WR \\ XWR \end{cases}$ 

#### 3.7 OPERATION FORM VI - DOUBLE-PRECISION SHIFTS

Operation Form VI performs a double-precision logical, arithmetic, or circular shift of a double-length word residing in the working register and extended working register. Magnitude status indicators are active and overflow is active during left-shift arithmetic (LSA) operations as enumerated in Figure 27. Asynchronous controls are the same as described for operation form IA.



#### FIGURE 27 – FORM VI–DOUBLE-PRECISION SHIFTS: (WR, XWR)SHIFTED →(WR, XWR)

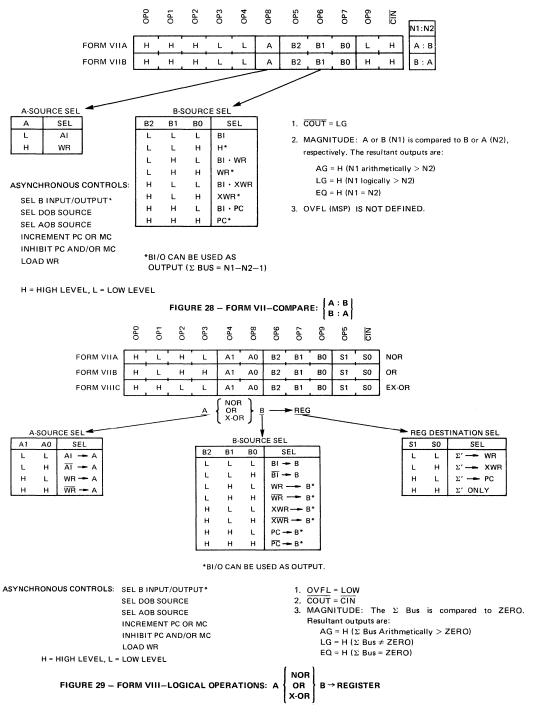
## 3.8 OPERATION FORM VII - COMPARE (A:B OR B:A)

Operation Form VII is designed specifically to provide the system designer with the capability of symmetrically comparing either operands A-to-B or operands B-to-A. The operands selectable are enumerated in Figure 28 as the A source select or B source select. The carry output, overflow, and magnitude status lines decode and indicate the logical and arithmetic relationship of the operands being compared as shown in Figure 28. Asynchronous controls are the same as described for Operation Form IA.

#### 3.9 OPERATION FORM VIII – LOGICAL FUNCTIONS

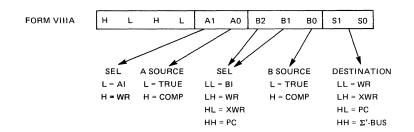
The ALU with its carry circuit functionally inactivated in Form VIII operations can be microprogrammed in conjunction with the source operands to perform any of the possible combinatorial Boolean functions on two binary variables. See Figure 29. Simple transfer functions are performed with the arithmetic operations in Form I, and combinatorial transfer and shift operations are available in Form III.

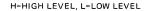
As with the arithmetic operations, a highly flexible source selection extends performance of single clock combinatorial logical operations between two (external) operands applied at the A and B input ports, or combinations of resident data in 'S481 registers or counters can be combined logically with another register or external source. The specific combinations selectable are enumerated in the following paragraphs.



## 3.9.1 NOR/AND Logical Operations

Operation Form VIIIA can be used to perform the NOR or AND logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:





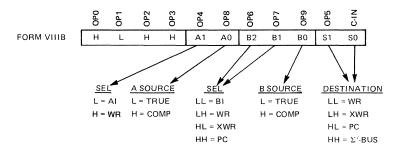
As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate performing the NOR, mixed NOR/AND, and the AND functions. As implemented, see Figure 30, the NOR function is performed when the sources are both true, mixed NOR/AND functions are performed with one source complemented, and the AND function is performed when both sources are selected in their complement form. Both implementation and other/equal logic symbols are shown in Figure 30. Also provided are the function tables and Boolean equations.

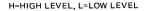
|   |  | SELECTIONS AVAILABLE  |   |   |  |  |  |  |  |  |  |
|---|--|---|---|---|--|--|--|--|--|--|--|
|   | TRUE   | A = COMP  | B = COMP  | A and B = COMP  |  |  |  |  |  |  |  |
| IMPLEMENTATION  | Α  | B   |   |   |  |  |  |  |  |  |  |
| FUNCTION TABLES<br>(H = HIGH LEVEL,<br>L = LOW LEVEL) | A         B         Σ'           L         L         H           H         L         L           L         H         L           H         L         L           H         L         L           H         H         L           OP8 = OP9 = L         OP9 = L | A         Ā         B         Σ'           L         H         L         L           H         L         L         H           L         H         L         H           L         H         L         H           L         H         L         H           L         H         L         H           L         H         L         H           H         L         H         L           OP8 = H, OP9 = L | B         B         A         2'           L         H         L         L           L         H         L         L           H         L         H         L           H         L         L         H           H         L         H         L           OP8 = L, OP9 = H         L         L | A         B         Ā         B         ½''           L         L         H         H         L           H         L         L         H         L           H         H         L         L         H           H         H         L         L         H           H         H         L         L         H           OP8 = OP9 = H         OP8 = OP9 = H         OP8 = OP9 = H         OP8 = OP9 = H |  |  |  |  |  |  |  |
| OTHER OR<br>EQUAL SYMBOLS                             |  | $B \longrightarrow D $ MIXED  | $\begin{array}{c} A \longrightarrow \mathbf{C} \\ B \longrightarrow \mathbf{D} \\ MIXED \end{array} \Sigma'$  | $\begin{array}{c} A & & \\ B & & \\ \end{array} \\ AND \\ \end{array} \\ \begin{array}{c} \Sigma' \\ \end{array}$   |  |  |  |  |  |  |  |
| BOOLEAN FUNCTIONS                                     | $\Sigma' = \overline{A + B}$   | Σ′ = AB   | Σ' = ĀB   | Σ' = AB   |  |  |  |  |  |  |  |

FIGURE 30 - FORM VIIIA NOR/AND LOGICAL OPERATIONS

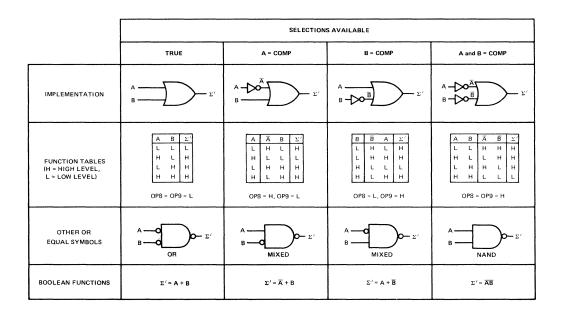
#### 3.9.2 OR/NAND Logical Operations

Operation Form VIIIB can be used to perform the OR or NAND logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:





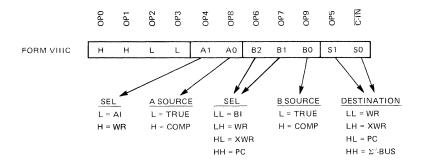
As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate performing the OR, mixed OR/NAND, and the NAND functions. As implemented, see Figure 31, the OR function is performed when the sources are both true, mixed OR/NAND functions are performed with one source' complemented, and the NAND function is performed when both sources are selected in their complement form. Both implementation and other/equal logic symbols are shown in Figure 31. Also provided are the function tables and Boolean equations.





## 3.9.3 Exclusive-OR/Exclusive-NOR Logical Operations

Operation Form VIIIC can be used to perform the exclusive-OR/exclusive-NOR logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:



H = HIGH LEVEL, L = LOW LEVEL

As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate both exclusive-OR and exclusive-NOR operations. As implemented, see Figure 32, the exclusive-NOR function is performed when the sources are both true or both complemented. When either the A or the B source (not both) are complemented, the exclusive-OR function is performed. Both implementation and other/equal logic symbols are shown in Figure 32. Also provided are the function tables and Boolean equations.

|   | ALL TRUE OR ALL<br>COMPLEMENT SOURCES  | ONE SOURCE COMPLEMENTED  |  |  |  |  |  |  |
|---|--|--|--|--|--|--|--|--|
| IMPLEMENTATION  | Α Σ'   |  |  |  |  |  |  |  |
| FUNCTION TABLES<br>(H = HIGH LEVEL,<br>L = LOW LEVEL) | $\begin{array}{c ccc} A & B & \Sigma' \\ L & L & H \\ H & L & L \\ L & H & L \\ H & H & H \end{array}$ $OP8 = OP9 = L$ | A A B ∑'<br>L H L L<br>H L L H<br>L H H H<br>H L H L<br>OP8 - H, OP9 = L | B     B     A     2'       L     H     L     L       L     H     H       H     L     L       H     L     H       H     L     H       H     L     H       H     L     H       H     L     H       H     L     H       H     L     H       H     H     H |  |  |  |  |  |
| OTHER OR<br>EQUAL SYMBOLS                             |  | $\begin{array}{c} A \\ B \\ \hline \\ EX-OR \end{array} \Sigma'$         |  |  |  |  |  |  |
| BOOLEAN FUNCTIONS                                     | $\Sigma' = A \Theta B$ $\Sigma' = \overline{A \Theta B}$   | $\Sigma' = A \Theta B$   | Σ′=Α ⊕ Β   |  |  |  |  |  |

FIGURE 32 - FORM VIIIC EXCLUSIVE-OR/EXCLUSIVE-NOR OPERATIONS

## 3.10 OPERATION FORM IX - NO OP

Operation Form IX is designed specifically to clear the  $\Sigma'$  bus force AG and LG low, and force EQ high; and, during this operation form data in the 'S481 registers, counters and latches remain unchanged unless directed to do otherwise by the asynchronous control inputs as shown in Figure 33.

The memory or program counter can be incremented (by one or two) on each clock transition, or the working register can be loaded on each clock. Additionally, the B input/output can be specified, as well as sources for the address or data out ports. States of the carry and overflow outputs are not interrupted.

| 0P0                    | 0P1   | 0P2   | 0P3    | 0P4 | OP5    | 940   | 0P7  | 0P8 | 640 | CIN |  |
|------------------------|-------|-------|--------|-----|--------|-------|------|-----|-----|-----|--|
| н                      | н     | н     | н      | н   | ×      | ×     | х    | ×   | ×   | ×   |  |
| H = HI                 | GH LE | EVEL, | L = LO | WLE | /EL, X | = IRR | ELEV | ANT | •   |     |  |
|                        |       |       |        |     |        |       |      |     |     |     |  |
| ASYNCHRONOUS CONTROLS: |       |       |        |     |        |       |      |     |     |     |  |
| SEL B INPUT/OUTPUT     |       |       |        |     |        |       |      |     |     |     |  |

| SEL DOB SOURCE       | AG = ZERO |
|----------------------|-----------|
| SEL AOB SOURCE       | LG = ZERO |
| INCREMENT PC OR MC   |           |
| INHIBIT PC AND/OR MC | EQ = HIGH |
| LOAD WR              |           |

FIGURE 33 – FORM IX–NO OPERATION: ZERO  $\rightarrow \Sigma'$  BUS

## 3.11 OPERATION FORM X - CYCLIC REDUNDANCY CHARACTER ACCUMULATION

Operation Form X is a macroinstruction which can be used to update a 16-bit cyclic redundancy character (CRC) partial sum in eight clock cycles, assuming 8-bit data characters. The updated CRC partial sum resides in the working register. The flow diagram of this algorithm is illustrated in Figure 34.

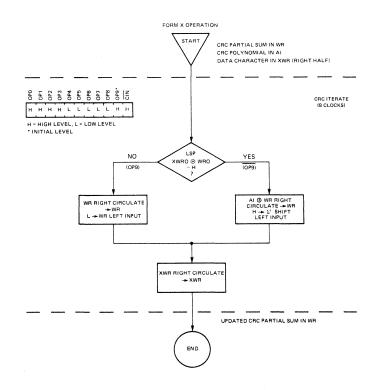


FIGURE 34 - CYCLIC REDUNDANCY CHARACTER ACCUMULATION

Setup conditions include the existence or placement of the previous CRC partial sum in the working register, the CRC polynomial at the A input port, and the data character in the eight least significant bits of the extended working register. All decisions after setup are decoded on chip for each of the eight iterations. Microcontrol open-collector output OP9 of the LSP assumes control during the iterations to generate one of two microinstructions requires to accomplish the CRC update.

## 3.12 OPERATION FORM XI - SIGNED INTEGER DIVIDE

Operation Form XI consists of the micro/macroinstructions needed to perform the signed division of a double length dividend by an N-bit divisor in N + 3 clock times. After the division routine the quotient will reside in the extended working register (XWR) and the remainder will be in the working register (WR). Negative results are in two's complement. The flow diagram of this algorithm is illustrated in Figure 35.

Setup conditions include the existence or placement of the double length dividend in the WR, XWR and application of the divisor at the A input port. To obtain a legitimate result, the divisor must not be arithmetically zero as indicated during the start command by the EQ output being low. The dividend must be of a nature that it could be generated by a signed multiply and add operation on the divisor. Status outputs LG, AG, C-OUT and OV are undefined, as is EQ after the start command.

After setup, all decisions are decoded on chip for start, iterate, iteration finish, fix remainder, and adjust quotient. The iterate macroinstruction (Form XIB) internally decodes the status of the stored signs, carry out, and working register and the OP8 and OP9 microcontrol open-collector outputs of the MSP assume control generating one of four microinstructions required to accomplish the signed divide.

#### 3.13 OPERATION FORM XII - UNSIGNED DIVIDE

Operation Form XII consists of micro/macroinstructions needed to perform the unsigned division of a double length dividend by an N-bit divisor in N + 1 clock times. After the division routine the binary magnitude quotient will reside in the extended working register (XWR) and the binary magnitude remainder will be in the working register (WR). The flow diagram of this algorithm is illustrated in Figure 36.

Setup conditions include the existence or placement of the double length dividend in the WR, XWR; application of the divisor at the A input port and that the last operation was not a divide command. To obtain a legitimate result, the N-bit divisor must be logically greater than the most-significant N-bits resident in the working register. A direct status on the arithmetically-greater-than (AG) output indicates that a valid (start) [AG = H], or invalid (abort) [AG = L] setup condition exists.

After setup, all decisions are decoded on chip for start, iterate and finish. The iterate macroinstruction (Form XIIB) internally decodes the status of C-OUT or FORCE LOAD FLAG and the OP9 microcontrol open-collector output of the MSP assumes control generating one of two microinstructions required to accomplish the unsigned divide.

## 3.14 OPERATION FORM XIII - UNSIGNED MULTIPLY

Operation Form XIII consists of a macroinstruction which performs the unsigned multiplication of two N-bit words in N clock times. After the multiply routine the double length product is residing in the working register (most-significant N-bits) and the extended working register (least-significant N-bits). The flow diagram of this algorithm is illustrated in Figure 37.

Setup conditions include clearing the working register to all zeros, loading (not shifting) the multiplier into the extended working register, and applying the multiplicand at the A input port. Arithmetic shift commands must not occur between multiplier load and the first iteration. Status outputs (EQ, AG, LG, C-OUT and OV) are undefined during this algorithm.

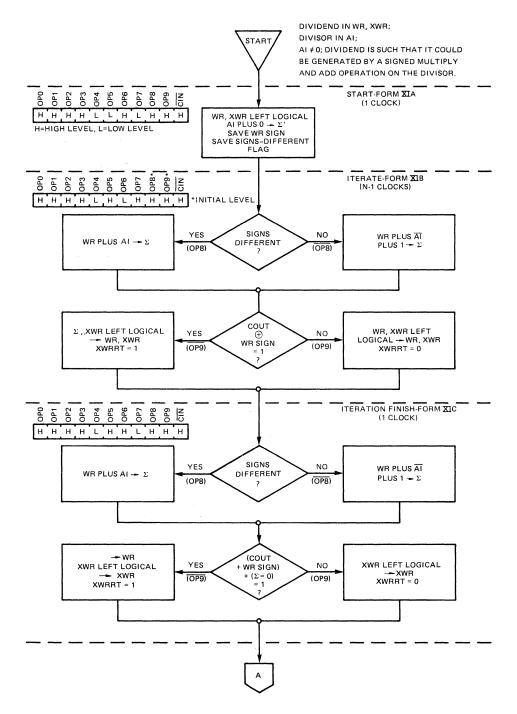


FIGURE 35 - FORM XI-SIGNED INTEGER DIVIDE (SHEET 1 OF 2)

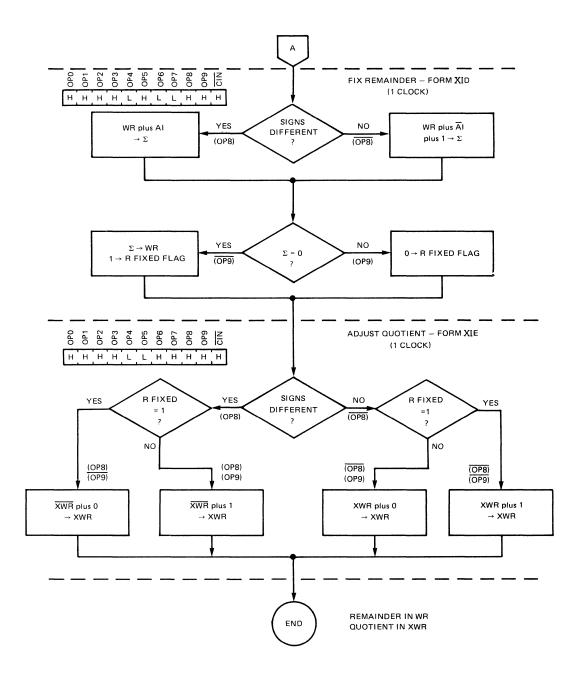
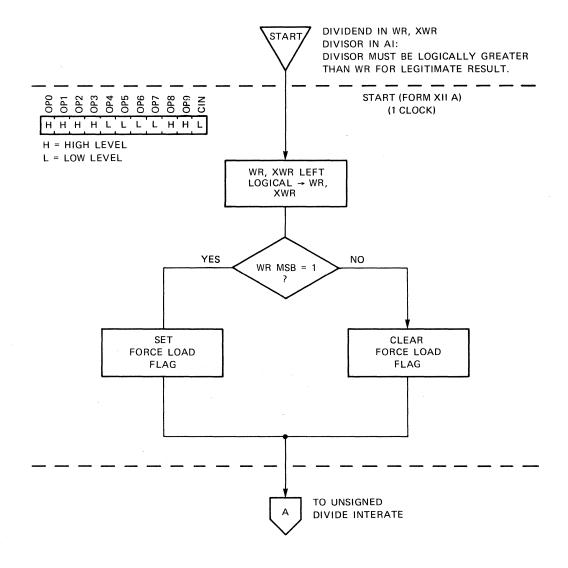


FIGURE 35 - FORM XI-SIGNED INTEGER DIVIDE (SHEET 2 OF 2)



#### FIGURE 36 - FORM XII-UNSIGNED DIVIDE (SHEET 1 OF 2)

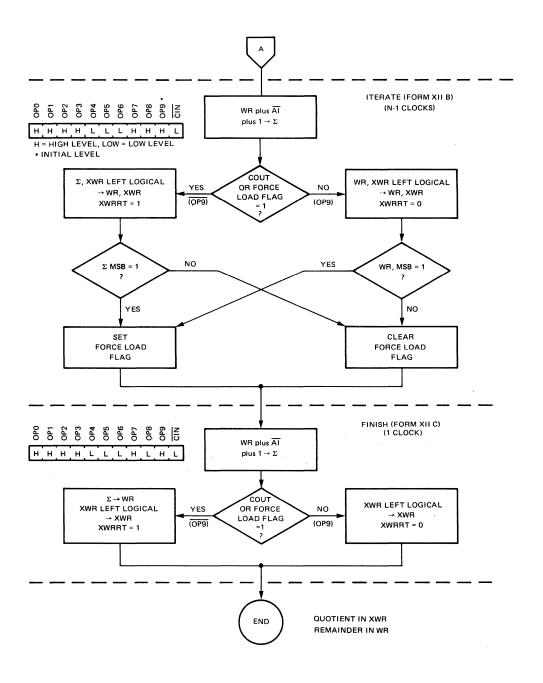


FIGURE 36 - FORM XII-UNSIGNED DIVIDE (SHEET 2 OF 2)

í.

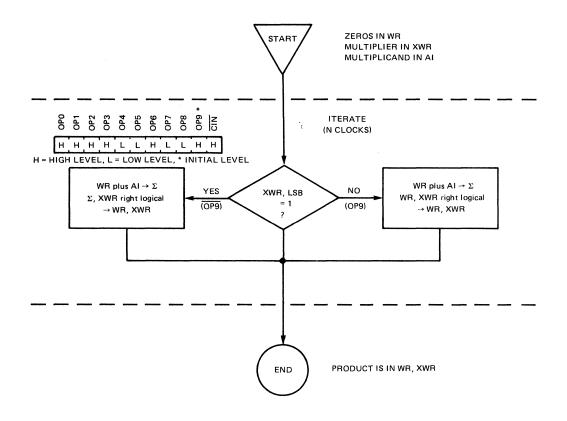


FIGURE 37 - FORM XIII-UNSIGNED MULTIPLY

The iterate macroinstruction internally decodes the status of the XWR LSB and the OP9 microcontrol open-collector output of the MSP assumes control generating one of two microinstructions required to accomplish the unsigned multiply.

# 3.15 OPERATION FORM XIV - SIGNED INTEGER MULTIPLY

Operation Form XIV consists of a macroinstruction which performs the signed multiplication of two N-bit signed integers in N clock times. After the multiply routine, the double precision signed product resides in the working register (most-significant N-bits) and the extended working register (least-significant N-bits). Negative products are in two's complement. The flow diagram of this algorithm is illustrated in Figure 38.

Setup conditions include clearing the working register to all zeros, loading (not shifting) the multiplier into the extended working register, and applying the multiplicand at the A input port. Arithmetic shifts must not occur between multiplier load and the first iteration. Status outputs (EO, AG, LG, C-OUT, and OV) are undefined during this algorithm.

The iterate macroinstruction internally decodes the status of the multiplier (XWR) sign-bit flag, the multiplier LSB, and the multiplier LSB flag and the OP8 and OP9 microcontrol open-collector outputs of the MSP assume control generating one of four microinstructions required to accomplish the signed multiply.

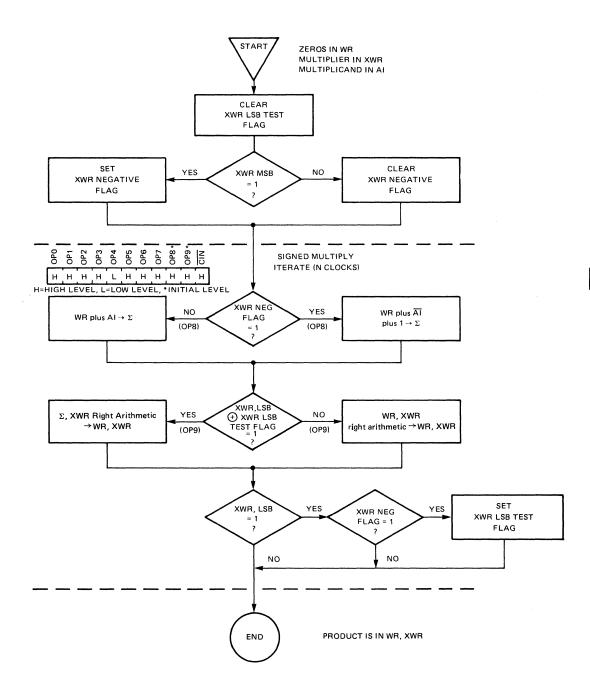


FIGURE 38 - FORM XIV-SIGNED INTEGER MULTIPLY

# 4. SPECIFICATIONS

Recommended operating conditions, electrical characteristics, and switching characteristics are provided in Tables 19 through 21.

|                                  |  | SM   | SN54LS481 |      | S    | N74LS | 481  | SN74S481 |     |      |      |
|----------------------------------|--|------|-----------|------|------|-------|------|----------|-----|------|------|
|                                  |  | MIN  | NOM       | MAX  | MIN  | NOM   | MAX  | MIN      | NOM | MAX  | UNIT |
| Supply voltage, VC               | C  | 4.5  | 5         | 5.5  | 4.75 | 5     | 5.25 | 4.75     | 5   | 5.25 | V    |
| High-level output v              | oltage at EQ, OP8, OP9; VO                             |      |           | 5.5  |      |       | 5.5  |          |     | 5.5  | V    |
| Low-level output<br>current, IOL | AOP, BI/O, DOP, CCO/OV, COUT                           |      |           | 10   |      |       | 10   |          |     | 10   |      |
|                                  | EQ, OP8, OP9   |      |           | 8    |      |       | 8    |          |     | 8    | mA   |
|                                  | WRLFT, WRRT, XWRLFT, XWRRT                             |      |           | 4    |      |       | 4    |          |     | 4    | - mA |
|                                  | X/LG, Y/AG   |      |           | 16   |      |       | 16   |          |     | 16   |      |
| High-level output                | BI/O, DOP  |      |           | 2    |      |       | 6.5  |          |     | 6.5  | mA   |
| current, IOH                     | All other outputs or I/O except EQ, OP8, OP9           |      |           | 1    |      |       | 1    |          |     | 1    | IIIA |
| Width of clock                   | High logic level                                       | 35   |           |      | 35   |       |      | 35       |     |      | ns   |
| puise, t <sub>w</sub>            | Low logic level  | 25   |           |      | 25   |       |      | 25       |     |      | 115  |
| Clock frequency                  | · · · · · · · · · · · · · · · · · · ·                  |      |           | 7    |      |       | 8    |          |     | 10   | MHz  |
|                                  | AI, BI/O Latch   | 25↓  |           |      | 20↓  |       |      | 15↓      |     |      |      |
|                                  | AI→WR  | 25↑  |           |      | 251  |       |      | 15↑      |     |      |      |
|                                  | AI, $BI/O \rightarrow ALU \rightarrow MC, PC, WR, XWR$ | 901  |           |      | 801  |       |      | 651      |     |      |      |
| Setup time, t <sub>su</sub>      | CCI, INCMC, INCPC, LDWR                                | 501  |           |      | 401  |       |      | 301      |     |      | ns   |
|                                  | OP0 thru OP9   | 1401 | 90        |      | 1201 | 90    |      | 901      | 60  |      | 1    |
|                                  | CIN  | 601  |           |      | 501  |       |      | 401      |     |      |      |
|                                  | WRLFT, WRRT, XWRLFT, XWRRT                             | 401  |           |      | 401  |       |      | 301      |     |      |      |
|                                  | AI, $BI/O \rightarrow Latch$                           | 5↓   |           |      | 5↓   |       |      | 10↓      |     |      |      |
|                                  | AI→WR  | 101  |           |      | 101  |       |      | 101      |     |      |      |
|                                  | AI, $BI/O \rightarrow ALU \rightarrow MC, PC, WR, XWR$ |      |           | -201 |      |       | -201 |          |     | -201 |      |
| Hold time, th                    | CCI, INCMC, INCPC, LDWR                                | 10   |           |      | 01   |       |      | 101      |     |      | ns   |
|                                  | OP0 thru OP9   |      |           | -101 |      |       | -101 | 0Ť       |     |      |      |
|                                  | CIN  |      |           | -5↑  | 01   |       |      | 01       |     |      |      |
|                                  | WRLFT, WRRT, XWRLFT, XWRRT                             | 01   |           |      | 0Ť   |       |      | 51       |     |      |      |
| Operating free-air t             | emperature range, TA                                   | 55   | 25        | 125  | 0    | 25    | 70   | 0        | 25  | 70   | °C   |

TABLE 19 RECOMMENDED OPERATING CONDITIONS

14The arrow indicates the transition of the clock input used for reference; 1 for the low-to-high transition, 4 for the high-to-low transition.

TABLE 20

#### ELECTRICAL CHARACTERISTICS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE (UNLESS OTHERWISE NOTED)

|      |   | TEST CONDITIONS+                          |   | 'LS481 |      | 'S481 |       |      | UNIT |      |
|------|---|---|---|--------|------|-------|-------|------|------|------|
|      | PARAME  | ICK                                       | TEST CONDITIONS†  | MIN    | TYP‡ | МАХ   | MIN 1 | ГҮР‡ | ΜΑΧ  | UNIT |
| ViH  | VIH High-level input voltage (any input except POS) |   |   | 2      |      |       | 2     |      |      | V    |
| VIL  | VIL Low-level input voltage (any input except POS)  |   |   |        |      | 0.8   |       |      | 0.8  | V    |
| VIK  | Input clamp voltage                                 |   | V <sub>CC</sub> =MIN, I <sub>I</sub> =-18 mA  |        |      | -1.2  |       |      | -1.2 | V    |
| Vон  | High-level output                                   | Any I/O or output                         | V <sub>CC</sub> =MIN, V <sub>IH</sub> =2V, 54S'   | 2.5    | 3.4  |       |       |      |      | v    |
| •0H  | voltage   | except EQ, OP8, OP9                       | VIL=0.8V, 10H=MAX 74S'  | 2.7    | 3.4  |       | 2.7   | 3.4  |      | 1    |
| VOL  | VOL Low-level output voltage                        |   | V <sub>CC</sub> =MIN, V <sub>IH</sub> =2V,<br>V <sub>IL</sub> =0.8V, I <sub>OH</sub> =MAX |        |      | 0.5   |       |      | 0.5  | v    |
| юн   | High-level output current                           | EQ, OP8, OP9                              | V <sub>CC</sub> =MAX, V <sub>O</sub> =5.5V  |        |      | 100   |       |      | 100  | μA   |
| 4    | Input current at maximum                            | POS                                       | V <sub>CC</sub> =MAX, V <sub>I</sub> =V <sub>CC</sub>                                     |        |      | 1     |       |      | 1    | mA   |
| '1   | input voltage                                       | Any Other                                 | VCC=MAX, VI=5.5V  |        |      | 1     |       |      | 1    |      |
| Чн   | High-level input current                            | OP0, OP1, OP2, OP3, CIN                   | V <sub>CC</sub> =MAX, V <sub>I</sub> =2.7V  |        |      | 200   |       |      | 200  | μA   |
| .161 |   | Any other except POS                      |   |        |      | 100   |       |      | 100  | μA   |
|      |   | OP0, OP1, OP2, OP3, CIN                   |   |        |      | 4     |       |      | 8    |      |
| hΕ   | Low-level input<br>current                          | WRRT, WRLFT, XWRRT,<br>XWRLFT, CCI, CLOCK | V <sub>CC</sub> =MAX,<br>V₁=0.5V  |        |      | -2    |       |      | -4   | mA   |
|      |   | Any Other                                 |   |        |      | -1    |       |      | -2   | 1    |
| los  | Short-circuit<br>output current§                    | Any output or 1/O<br>except EQ, OP8, OP9  | V <sub>CC</sub> =MAX  | -30    |      | -100  | -30   |      | -100 | mA   |
| 1cc  | Supply current                                      |   | V <sub>CC</sub> =MAX  |        | 220  | 325   |       | 345  | 425  | mA   |

<sup>1</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at  $V_{CC}$ = 5 V,  $T_A$ =25°C.

\$ Not more than one output should be shorted at a time.

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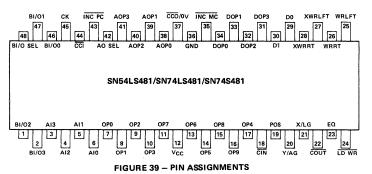
|                  |                   |                         | OPERATION                   | SN54 | LS481 | SN74 | LS481 | SN7 | 45481 |      |
|------------------|-------------------|-------------------------|-----------------------------|------|-------|------|-------|-----|-------|------|
| PARAMETER        | FROM (INPUT)      | TO (OUTPUT)             | ROUTING                     | ТҮР  | мах   | ТҮР  | МАХ   | ТҮР | МАХ   | UNIT |
|                  | АІ, ВІ/О          | DOP                     | LATCH → ALU<br>DOP          | 56   | 100   | 56   | 80    | 42  | 65    | ns   |
|                  |                   | Х, Ү                    | LATCH → ALU                 | 40   | 65    | 40   | 55    | 32  | 45    | ns   |
| tPD              |                   | COUT                    | LATCH→ALU                   | 35   | 65    | 35   | 55    | 30  | 40    | ns   |
|                  |                   | EQ                      | LATCH → ALU                 | 55   | 100   | 55   | 85    | 45  | 65    | ns   |
|                  |                   | ov                      | LATCH → ALU                 | 45   | 75    | 45   | 65    | 35  | 45    | ns   |
|                  |                   | AG, LG                  | LATCH→ALU                   | 73   | 125   | 73   | 105   | 60  | 80    | ns   |
|                  |                   | WRLFT,WRRT,XWRLFT,XWRRT | LATCH → ALU                 | 60   | 105   | 60   | 85    | 45  | 65    | ns   |
|                  |                   | WRLFT,WRRT,XWRLFT,XWRRT |                             | 100  | 160   | 100  | 140   | 75  | 105   | ns   |
|                  |                   | X,Y,COUT, EQ            |                             | 75   | 130   | 75   | 115   | 55  | 80    | ns   |
| tPD              | OP0 thru OP9      | ov                      |                             | 75   | 135   | 75   | 120   | 60  | 90    | ns   |
|                  |                   | AG, LG                  |                             | 100  | 165   | 100  | 135   | 75  | 105   | ns   |
|                  |                   | DOP                     |                             | 90   | 150   | 90   | 130   | 70  | 100   | ns   |
| <sup>t</sup> PD  | AI,BI/O           | BI/O                    | LATCH→ALU                   | 75   | 120   | 75   | 100   | 50  | 70    | ns   |
| <sup>t</sup> PD  | CIN               | COUT                    |                             | 35   | 60    | 35   | 50    | 30  | 40    | ns   |
| <sup>t</sup> PD  | CCI               | cco                     |                             | 55   | 90    | 55   | 70    | 37  | 50    | ns   |
| <sup>t</sup> PD  | A0                | AOP                     |                             | 20   | 45    | 20   | 40    | 15  | 30    | ns   |
| <sup>t</sup> PD  | D0, D1            | DOP ,                   |                             | 20   | 45    | 20   | 40    | 15  | 30    | ns   |
| <sup>t</sup> PXZ | BI/O SEL or D0,D1 | BI/O or DOP             |                             | 20   | 35    | 20   | 30    | 15  | 30    | ns   |
| <sup>t</sup> PXZ | OP0 thru OP9      | WRLFT,WRRT,XWRLFT,XWRRT |                             | 60   | 120   | 60   | 100   | 45  | 80    | ns   |
| <sup>t</sup> PZX | BI/O SEL or D0,D1 | BI/O or DOP             |                             | 20   | 35    | 20   | 30    | 15  | 30    | ns   |
| <sup>t</sup> PZX | OP0 thru OP9      | WRLFT,WRRT,XWRLFT,XWRRT |                             | 55   | 120   | 55   | 100   | 45  | 80    | ns   |
|                  |                   | AOP, DOP                | NO SHIFT                    | 32   | 70    | 32   | 60    | 26  | 40    | ns   |
|                  |                   | WRLFT,WRRT,XWRLFT,XWRRT | [WR, XWR,<br>ΣBUS]          | 50   | 90    | 50   | 85    | 40  | 65    | ns   |
|                  |                   | AOP, DOP                | →SHIFTED                    | 40   | 60    | 40   | 55    | 35  | 45    | ns   |
| <sup>t</sup> PD  | CLOCK             | DOP, BI/O               | [WR,XWR,PC]→<br>ALU→SHIFTED | 50   | 90    | 50   | 85    | 40  | 65    | ns   |
|                  |                   | ov                      |                             | 75   | 125   | 75   | 100   | 50  | 70    | ns   |
|                  |                   | cco                     |                             | 35   | 65    | 35   | 55    | 25  | 45    | ns   |
|                  |                   | COUT                    |                             | 60   | 105   | 60   | 85    | 47  | 65    | ns   |
|                  |                   | OP8, OP9                |                             | 85   | 140   | 85   | 120   | 75  | 90    | ns   |
| <sup>t</sup> PD  | CIN               | DOP                     |                             | 56   | 100   | 56   | 75    | 42  | 60    | ns   |

TABLE 21 SWITCHING CHARACTERISTICS (OVER OPERATING RANGE OF V<sub>CC</sub> AND T<sub>A</sub>)

 $t_{PD} \equiv Propogation delay$ 

<sup>t</sup>PXZ<sup>≡</sup>Disable time to Hi-Z

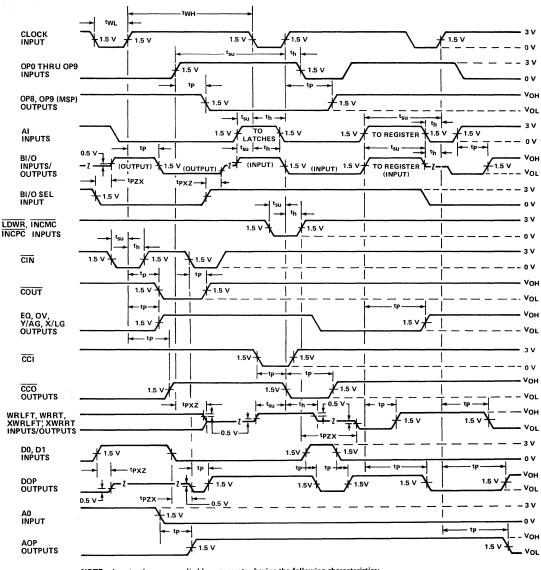
 $t_{PZX} \equiv E_{nable time (Hi-Z-To-Enable)}$ 



1.74

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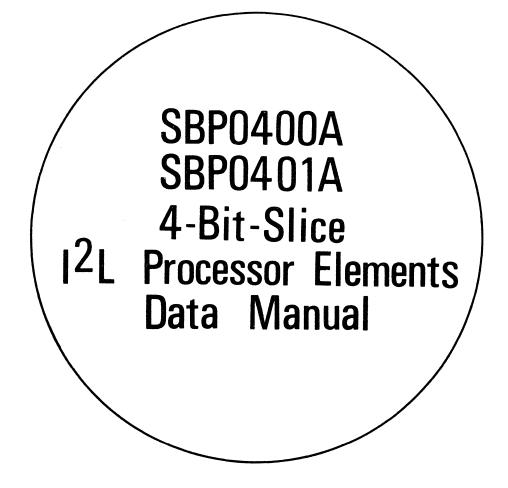
A0001385

NOTE: Input pulses are supplied by a generator having the following characteristics: tr  $\leqslant$  5 ns, tp  $\leqslant$  5 ns, PRR  $\geqslant$  1 MHz, ZOUT  $\approx$  50  $\Omega$ 

FIGURE 40. - SWITCHING TIMES - VOLTAGE WAVEFORMS

The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group





OCTOBER 1976

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# 1. INTRODUCTION

The SBP0400A and SBP0401A are 4-bit expandable parallel binary processor elements, each monolithically integrating 1660 functional gates. These controller/processor building blocks combine the unique properties of Integrated Injection Logic ( $I^2L$ ) with a microprogrammable bit-slice architecture to offer a high degree of performance and design flexibility. Each can provide the basis for efficient, low-cost solutions to a wide range of applications, from basic sequential controllers to advanced multiprocessor systems for either industrial or military environments.

# 1.1 ARCHITECTURAL FEATURES

Primary among the SBP0400A and SBP0401A architectural features are:

- Microprogrammable, bit-slice design expandable in 4-bit multiples
- Separate data-in, data-out, address-out and control ports provide flexible parallel device access
- 16-function arithmetic/logic unit (ALU) with symmetrical subtraction and fully carry look-ahead capability
- 8-word general register file including program counter with independent incrementor
- Two 4-bit working registers for both single- and double-length operations
- Dual scaled-shifters with on-chip handling of end conditions
- Versatile factory programmable logic array (PLA) generates on-chip control transformation
- The SBP0400A features an on-chip pipelining operation register
- The SBP0401A, with asynchronous microinstruction decode, is designed for use in externally pipelined systems

# 1.2 OPERATIONAL FEATURES

The functional power of the SBP0400A or SBP0401A is characterized by their ability to perform, within a single clock cycle, any one of a repertoire of 512 standard operations:

- Operand modifications or combinations via eight arithmetic or eight Boolean functions of the ALU
- Double length accumulator with full bidirectional single/double precision arithmetic/logical/circulate shift capabilities, including sign protection
- Single clock ALU/shift combinations simplify implementation of iterative multiple and non-restore divide algorithms
- Special select operations and transfers

# 1.3 ADDITIONAL FEATURES

When provided with external control for sequencing of its operation set, either an SBP0400A or SBP0401A based system design can efficiently emulate a large number of existing systems with full software compatibility and no loss of software investment. Or complete application-tailoring of custom instructions may be accomplished for any design. Additional features are:

- Independent program counter with independent access controls (and the internal operation register of the SBP0400A) provide instruction look-ahead capability (pipelining)
- Relative position control defines bit-slice rank in N-bit applications

#### TENTATIVE DATA SHEET

This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

1

- Serial and parallel access to or from working registers
- Word or byte incrementation of program counter
- ALU bypass for direct register-file access

# 1.4 TECHNOLOGICAL FEATURES

These processor elements, fabricated with Integrated Injection Logic (I<sup>2</sup>L), feature an extremely wide performance range.

- Constant speed-times-power performance over an injector current range covering three orders of magnitude (10<sup>3</sup>)
- Operates from a single dc power source capable of 1.1 volt minimum at desired injector current
- ALU/shift operation time . . . 240 nanoseconds typical at 200 mW nominal power
- Fully TTL compatible at nominal injector current
- Static operation with positive (1) edge-triggered storage
- SBP0400AC and SBP0401AC operate over 0°C to 70°C industrial temperature range
- SBP0400AM and SBP0401AM operate over full --55°C to 125°C military temperature range

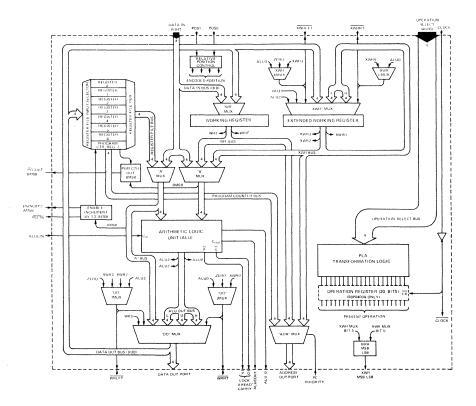


FIGURE 1 - FUNCTIONAL BLOCK DIAGRAM

2

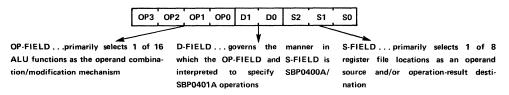
# 2. FUNCTIONAL PIN DESCRIPTIONS

| PIN NUMBER  | PIN NAME          | PIN FUNCTION   | INPUT, OUTPUT, OR<br>INPUT/OUTPUT         |
|---|-------------------|--|---|
| 1<br>2  | D1<br>D0          | 2-bit, "D" field of the Operation-Select Word.   | Input<br>Input                            |
| 3   | S2                | 3-bit, "S" field of the Operation-Select Word designates, in general,  | Input                                     |
| 4   | S1                | a particular RF as an operand source/destination.  | Input                                     |
| 5   | S0                |  | Input                                     |
| 6   | XWRLFT            | Bidirectional I/O, low active, shift accommodation for the XWR.<br>Receives double-precision right-shift data; outputs double-precision<br>left-shift data. Becomes XWRLFT (high active) internally.   | Bidirectional Input/output                |
| 7   | XWRRT             | Bidirectional I/O, low active, shift accommodation. Receives double-precision left-shift data; outputs double-precision right-shift data. Becomes XWRRT (high active) internally.  | Bidirectional Input/output                |
| 8   | XWR<br>MSB/LSB    | MSB of the input to the XWR if in the most-significant 4 bit slice<br>position (MSP) and LSB input to the XWR if in the least-significant<br>4-bit slice position (LSP).   | Output                                    |
| 9 WRRT Bidirectional I/O, low-active, shift accommodation for ALU o<br>data. Receives left-shift data. Outputs right-shift data. Be<br>WRRT (high active) internally. |                   |  | Bidrectional Input/output                 |
| 10  | WRLFT             | Bidirectional I/O, Iow-active, shift accommodation for ALU output<br>data. Receives right-shift data; outputs left-shift data. Becomes<br>WRLFT (high active) internally.  | Bidirectional Input/output                |
| 11  | ALUCIN            | Receives, high-active, ALU ripple carry-in data.   | Input                                     |
| 12  | DOP0              | 4-bit, parallel, high active, data-out port.   | Output                                    |
| 13  | DOP1              | $(DOP3 \rightarrow DOP0)$  | Output                                    |
| 14  | DOP2              |  | Output                                    |
| 15  | DOP3              |  | Output                                    |
| 16  | DIP3              | 4-bit, parallel, high active, data-in port   | Input                                     |
| 17  | DIP2              | $(DIP3 \rightarrow DIP0)$  | Input                                     |
| 24  | DIP1              |  | Input                                     |
| 25  | DIPO              |  | Input                                     |
| 18  | PCCIN             | In all positions, directs the program counter to increment by 1 or 2,<br>depending on the level applied to ENINCBY2, on the next<br>low-to-high clock transition.  | Input                                     |
| 19  | PCCOUT/<br>BMSB   | In any position but MSP, PCCOUT is the program counter output<br>applied to the next more significant package PCCIN. In the MSP,<br>outputs the MSB of the "B" bus.  | Output                                    |
| 20  | GND               | Common or ground terminal.   | Supply Common                             |
| 21  | POS0              | Directs internal and input/output end-conditions required to define  | Input                                     |
| 22  | POS1              | the relative position of each SBP0400A/SBP0401A when a number is cascaded to implement $>$ 4-bit word lengths. See double-precision shift data flow.   | Input                                     |
| 23  | ENINCBY2/<br>AMSB | In the least-significant 4-bit slice position (LSP), ENINCBY2 = H in conjunction with PCCIN = L directs the PROGRAM COUNTER to increment by a displacement of 2 on the next clock. In the most-significant 4-bit slice position (MSP), outputs the MSB of the "A" bus. | Bidirectional Input/output<br>(LSP) (MSP) |
| 26  | CLOCK             | Clocks all synchronous registers on positive transition.   | Input (Edge-triggered)                    |
| 27  | ALU=0             | Active high open-collector output indicates that the four ALU outputs are low (equal zero).  | Output                                    |
| 28  | AOP3              | 4-bit, parallel, high-active, address-out port.  | Output                                    |
| 29  | AOP2              | $(AOP3 \rightarrow AOP0)$  | Output                                    |
| 31  | AOP1              |  | Output                                    |
| 32  | AOP0              |  | Output                                    |
| 30  | PC<br>PRIORITY    | Selects program counter to the address-out port (high active).<br>Overrides internal direction of address-out port.  | Input                                     |
| 33  | P                 | ALU Carry-propagate  | Output                                    |
| 34  | Ğ                 | ALU Carry-generate   | Output                                    |
| 35  | ALUCOUT           | Outputs, high active, ALU ripple carry-out data.   | Output                                    |
| 36  | OP3               | This 4-bit "OP" field of the Operation-Select Word designates in   | Input                                     |
| 37  | OP2               | general, 1 of 16 ALU functions.  | Input                                     |
| 38  | OP1               |  | Input                                     |
| 39  | OP0               |  | Input                                     |
| 40  | INJECTOR          | Supply current source.   | Supply input                              |

# 3. DETAILED FUNCTIONAL DESCRIPTION

The SBP0400A and SBP0401A architectures are formed by the various functional blocks and interconnecting data/control paths shown in Figure 1. Parallel data/control flow to/from the processor element is accomplished through 1) the data-in port (DIP) via the 4-bit data-in bus (DIB), 2) the data-out port (DOP) via the 4-bit data-out bus (DOB), 3) the address-out port (AOP) via the 4-bit address-out bus (AOB), and 4) the operation-select port (OSP) via the nine operation-select inputs. The format of the op-select word is:

#### 9-BIT OPERATION-SELECT WORD



NOTE

A complete discussion of the operation-select word is provided in section 5.

The SBP0400A contains a 20-bit operation register which stores, on the clock positive transition, the present (resident) operation decoded by the transformation PLA. The SBP0401A, containing the identical operation decode 20-output PLA, derives the present (resident) operation from the steady-state input at the nine op-select inputs. The '0401A is designed specifically for use in systems utilizing the SN54S/74S482 control element which, in addition to generating next control-memory addresses and storing interrupt/subroutine addresses, contains an on-chip control memory address register to assist with the system pipelining functions. Thus, the need for an operation register in the SBP0401A processor element is eliminated.

# 3.1 PROGRAMMABLE LOGIC ARRAY (PLA)

#### 3.1.1 PLA Description

The programmable logic array (PLA) is a factory-programmable block of combinational logic which forms the control operation transformation center. Nine bits of encoded microinstruction data are presented to the PLA via the 9-bit operation-select word input lines. The PLA decodes/translates this encoded data to generate a 20-bit internal microinstruction. The various micro-operation fields of this microinstruction condition the appropriate functional blocks and buses for microinstruction execution.

On the positive going  $(\uparrow)$  transition at the clock input, this 20-bit microinstruction is stored in the operation register (OR) of the SBP0400A.

#### 3.1.2 PLA Factory Programming

The standard factory PLA program provides a flexible, universal, repertoire of 459 unique operations. However, the PLA can be factory programmed to provide, within the constraint of 62 AND terms and 20 OR terms, a personality tailored to meet custom requirements.

#### 3.2 SBP0400A OPERATION REGISTER (OR)

The 20-bit operation register (OR) of the SBP0400A is a D-type edge-triggered register which, on each positive transition at the clock input, loads the present PLA output. The OR, as loaded, continuously enables the various

'0400A functional blocks for execution of the "present" microinstruction while the PLA may be simultaneously decoding/translating the "next" microinstruction.

# 3.3 STATUS OUTPUTS

Status outputs for the operation in process are designed specifically to simplify system implementation by providing direct access to those status bits used with the classical and highly efficient multiply and divide algorithms. The status outputs consist of:

- a. AMSB and BMSB In the MSP these outputs provide direct access to the sign bits of data/operands entering the ALU.
- b. XWR MUX MSB In the MSP this output provides direct access to the data bit which can become the XWR sign bit during left-shift operations. It is useful for determining overflow (impending change of the XWR sign bit) in double-signed arithmetic operations, shifting operations, or fix-up routines in iterative sign-magnitude divide algorithms.
- c. XWR MUX LSB In the LSP this output provides direct access to the data bit which can become the XWR LSB during right-shift operations. It is useful for looking ahead during iterative multiply and divide routines to setup the next micro-operation.
- d. ALU = 0 In the LSP, IP, and MSP this output provides a direct indication that all four of the ALU outputs are low. In an expanded word length system all of the ALU = 0 outputs can be dot-AND connected to provide, on a single-line, an indication that all of the ALU outputs are low (equal zero).
- e. ALUCOUT In the LSP, IP, and MSP this output provides a direct carry out from each of the 4-bit slices. In the MSP the ALUCOUT can be used for determining ALU overflow.

#### 3.4 ARITHMETIC/LOGIC UNIT (ALU) DESCRIPTION

The 4-bit parallel, binary, arithmetic/logic unit (ALU) is the operand combination/modification mechanism. Under direction of the present micro-operation, the ALU performs 1 of 16 arithmetic/Boolean operations on either or both of two operands present at it's A and B input ports. Operand sources which may access the A input port of the ALU via the A multiplexer are the register file (RF) and data-in port (DIP); operand sources which may access the B input port of the ALU via the B multiplexer are the data-in port (DIP), working register (WR), and extended working register (XWR).

#### 3.4.1 ALU Function Selection

In general, an ALU function is specified via the 4-bit OP-field (OP3  $\rightarrow$  OP0) of the operation-select word as shown in Table 1. This field is presented to the PLA via the operation-select word input lines. The PLA translates OP3, OP2, OP1, OP0 into a 4-bit micro-operation field which ultimately selects the ALU mode. The OP3 bit functions similarly to an ALU mode control in that 1) a low-logic level places the ALU in an arithmetic mode, and 2) a high-logic level places the ALU in a logic mode. OP2  $\rightarrow$  OP0 selects a particular function within the specified ALU mode.

# 3.4.2 ALU Arithmetic Mode

Functionally similar to the popular TTL ALU's, such as the SN54S/74S181 and SN54S/74S281, the arithmetic functions (see Table 1) include symmetrical subtraction whereby either A minus B or B minus A may be employed to simplify data flow. Other arithmetic-type functions include simple A plus B, A plus B plus carry-in, preset all high, clear all low, and direct symmetrical generation of complements (1's or 2's) for either A or B.

## TABLE 1 ALU FUNCTION-SELECT TABLE

|            |     | Д                                 | LU   |   | ACTIVE-H                | IGH DATA                |  |  |  |  |  |
|------------|-----|-----------------------------------|------|---|-------------------------|-------------------------|--|--|--|--|--|
|            |     | OP-I                              | IELD |   | ALUCIN = H              | ALUCIN = L              |  |  |  |  |  |
|            | OP3 | P3 OP2 OP1 OP0 (WITH CARRY, NO BO |      |   | (WITH CARRY, NO BORROW) | (WITH CARRY, NO BORROW) |  |  |  |  |  |
|            | L   | L                                 | L    | L | Fn = L                  | Fn = H                  |  |  |  |  |  |
| <u>i</u>   | L   | L                                 | L    | н | Fn = B minus A          | Fn = B minus A minus 1  |  |  |  |  |  |
| Arithmetic | L   | L                                 | н    | L | Fn = A minus B          | Fn = A minus B minus 1  |  |  |  |  |  |
| ith        | L   | L                                 | н    | н | Fn = A plus B plus 1    | Fn = A plus B           |  |  |  |  |  |
| Ā          | L   | н                                 | L    | L | Fn = B plus 1           | Fn = B                  |  |  |  |  |  |
|            | L   | н                                 | L    | н | Fn = B plus 1           | $Fn = \overline{B}$     |  |  |  |  |  |
|            | L   | н                                 | н    | L | Fn = A plus 1           | Fn = A                  |  |  |  |  |  |
|            | L   | н                                 | н    | н | Fn = Ā plus 1           | $Fn = \overline{A}$     |  |  |  |  |  |
|            | н   | L                                 | L    | L | Fn = A                  | nBn                     |  |  |  |  |  |
|            | н   | L                                 | L    | н | Fn = A                  | n⊕Bn                    |  |  |  |  |  |
|            | н   | L                                 | н    | L | Fn = Ā                  | n⊕Bn                    |  |  |  |  |  |
| υ          | н   | L                                 | н    | H | $Fn = \overline{A}$     | nBn                     |  |  |  |  |  |
| Logic      | н   | н                                 | L    | L | Fn = A                  | nBn                     |  |  |  |  |  |
| -          | н   | н                                 | L    | н | Fn = A                  | n + Bn                  |  |  |  |  |  |
|            | н   | н                                 | н    | L | Fn = Ā                  | n + Bn                  |  |  |  |  |  |
|            | н   | н                                 | н    | н | Fn = An + Bn            |                         |  |  |  |  |  |

#### 3.4.3 ALU Logical (Boolean) Mode

Functionally similar to the popular ALUs such as the SN54S/74S181 and SN54S/74S281, the ALU logical functions (see Table 1) include AND, OR, exclusive OR, exclusive NOR, and four symmetrical mixed combinational functions of the ALU's A and B operands.

# 3.4.4 ALU Carry and Look-Ahead Generator Functions

These processor elements have accommodations for ALU ripple carry-in (ALUCIN) and ALU ripple carry-out (ALUCOUT); and in order to facilitate look-ahead carry generation across expanded word sizes, each has output accommodations for ALU carry-generate data ( $\overline{G}$ ) and ALU carry-propagate data (P). When these accommodations are utilized in conjunction with SN54/74182 look-ahead carry generators, ALU add/subtract times may be significantly improved over those times where only ripple-carry techniques are employed. Only one SN54/74182 (Figure 2) is required to provide look-ahead carry generation across an expanded system of from two to four 4-bit slice processor elements. A second level of look-ahead carry generation may be employed (Figure 3) for systems expanded up to 64 bits. Typical ALU add times are shown in Table 2, and are illustrated in Figure 4.

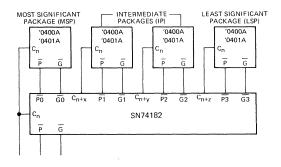
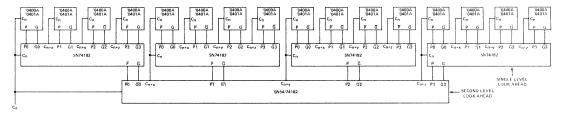


FIGURE 2 – SINGLE-LEVEL ALU CARRY LOOK-AHEAD AND BIT-SLICE RELATIVE POSITIONS



#### FIGURE 3 - 64-BIT SYSTEM WITH ALU FULL-CARRY LOOK-AHEAD

TABLE 2 TYPICAL SBP0400A ADD TIMES (DIP PLUS WR) FROM † CLOCK TO DOB

| TYPE OF CARRY            | TWO 4-BIT<br>WORDS | TWO 8-BIT<br>WORDS | TWO 16-BIT<br>WORDS | TWO 32-BIT<br>WORDS | TWO 64-BIT<br>WORDS |
|--------------------------|--------------------|--------------------|---------------------|---------------------|---------------------|
| RIPPLE                   | 240 ns             | 285 ns             | 405 ns              | 645 ns              | 1.1 μs              |
| SINGLE-LEVEL LOOK-AHEAD* | NA                 | 300 ns             | 300 ns              | 405 ns              | 525 ns              |
| SECOND-LEVEL LOOK-AHEAD* | NA                 | NA                 | NA                  | 315 ns              | 315 ns              |

\*LOOK-AHEAD IS SN54/74182, AND INJECTOR CURRENT IS 200 mA.

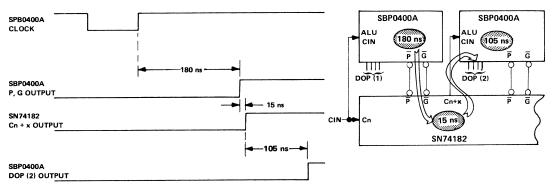


FIGURE 4 - EXECUTION OF TYPICAL ALU MICRO-OPERATION

# 3.5 RELATIVE POSITION CONTROL (POS1, POS0)

The 2-bit relative position control (POS1, POS0) encodes the relative positional rank of each individual processor element in an expanded word length system. As shown in Figure 2, the three positional rank possibilities are: 1) most significant position/ package (MSP), 2) intermediate position/package (IP), and 3) least significant position/package (LSP). Consequent to encoded positional rank, the relative position control (POS1, POS0), as shown in Table 3 dictates for each individual 4-bit slice in an expanded word length system: 1) the manner in which data shifts/circulates are to be accomplished, and 2) a particular assignment for each individual multifunction I/O accommodation.

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#### TABLE 3 POSITION CONTROL FUNCTIONS

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| IN   | PUTS |   |                 | MULTIFUNCTION     | I/O                |
|------|------|---|-----------------|-------------------|--------------------|
| POS1 | POS0 | RELATIVE POSITION   | PCCOUT/<br>BMSB | ENINCBY2/<br>AMSB | XWR MUX<br>MSB/LSB |
| L    | н    | LEAST SIGNIFICANT POSITION (LSP)  | PCCOUT          | ENINCBY2          | XWR LSB            |
| L    | L    | INTERMEDIATE POSITION (IP)  | PCCOUT          | Hi-Z              | ZERO               |
| Н    | L    | MOST SIGNIFICANT POSITION (MSP);<br>DOUBLE-SIGNED/DOUBLE-PRECISION<br>(DS/DP) ARITHMETIC SHIFTS | BMSB            | AMSB              | XWR MSB            |
| н    | H    | MOST SIGNIFICANT POSITION (MSP);<br>SINGLE-SIGNED/DOUBLE-PRECISION<br>(SS/DP) ARITHMETIC SHIFTS | BMSB            | AMSB              | XWR MSB            |

# 3.6 REGISTER FILE (RF0 → RF7)

# 3.6.1 RF General Description

The register file (RF) is an 8-word by 4-bit set of D-type edge-triggered registers. Any one of the eight registers may be selected as an operand source and/or operation-result destination. Register selection is accomplished via the 3-bit, S-field ( $S2 \rightarrow S0$ ) of the operation-select word. This field is presented to the PLA via the operation-select word input lines. The PLA translates S2, S1, S0 into a 3-bit micro-operation field which ultimately selects a particular register within the file.

## 3.6.2 RF Source/Destination Operands

Register file source and destination operands are listed in Tables 4 and 5 respectively. When the register file is used as a destination, the source data is recognized only when a low-level condition exists at the clock input. As shown in Figure 5, source data can change during the low-level clock condition as long as the setup time prior to the low-to-high transition of the clock input is satisfied.

| OPERATION                                  | OP FORM | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0    |
|--|---------|-----------------------|--------------------|-----------------------|
| RF → DOP                                   | Шь      | LLLL                  | HL                 | LLL → HHH             |
| $RF \rightarrow XWR$                       | IIIc    | LLLH                  | HL                 | $LLL \rightarrow HHH$ |
| RF ALU WR → RF                             | la      | LLLL → HHHH           | LL                 | $LLL \rightarrow HHH$ |
| RF ALU WR → WR                             | lb      | LLLL → HHHH           | LH                 | $LLL \rightarrow HHH$ |
| RF plus DIP plus ALUCIN → RF               | lld     | LHHH                  | HL                 | $LLL \rightarrow HHH$ |
| RF plus DIP plus ALUCIN → WR               | ПЬ      | LHLL                  | HL                 | LLL → HHH             |
| RF plus DIP plus ALUCIN → XWR              | llc     | LHLH                  | HL                 | LLL → HHH             |
| (RF plus WR plus ALUCIN,XWR) LCIR → WR,XWR | IVd     | HLLH                  | HL                 | LLL → HHH             |
| (RF plus WR plus ALUCIN,XWR) RSA → WR,XWR  | IVi     | нінн                  | HL                 | $LLL \rightarrow HHH$ |
| RF plus WR plus ALUCIN → XWR               | lla     | LLHH                  | HL                 | LLL → HHH             |
| RF plus XWR plus ALUCIN → WR               | lle     | HHLL                  | HL                 | LLL → HHH             |
| RF plus XWR plus ALUCIN → XWR              | 111     | HHLH                  | HL                 | LLL → HHH             |

TABLE 4 RF SOURCE OPERANDS

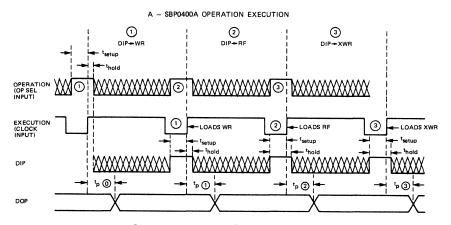
NOTE: When PC priority is low WR  $\rightarrow$  AOP

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# TABLE 5 RF DESTINATION OPERANDS

| OPERATION                                | OP FORM | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0 |
|--|---------|-----------------------|--------------------|--------------------|
| DIP → RF                                 | IIIa    | нннн                  | HL                 | LLL → HHH          |
| XWR plus ALUCIN → RF                     | llg     | нннг                  | HL                 | LLL → HHH          |
| $RFALUWR \rightarrow RF$                 | la      | LLLL → HHHH           | LL                 | LLL → HHH          |
| RF plus DIP plus ALUCIN $\rightarrow$ RF | lld     | LHHH                  | HL                 | LLL → HHH          |

NOTE: When PC priority is low WR  $\rightarrow$  AOP



NOTE: THE SAME CLOCK () THAT EXECUTES OPERATION () LOADS OPERATION () INTO THE '0400A OR.

#### B - SBP0401A OPERATION EXECUTION

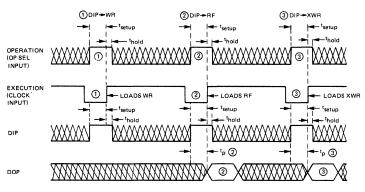


FIGURE 5-TYPICAL OPERATION EXECUTIONS

# 3.7 PROGRAM COUNTER (PC) - REGISTER FILE SEVEN (RF7)

#### 3.7.1 General Description

RF7 of the register file features the added flexibility of performing as a program counter (PC). Independent of the "present" microinstruction, RF7 may be incremented by a displacement of 1 or 2. Incrementation is accomplished synchronously with the clock and selected, as shown in Table 6, via the multifunction PCCIN and ENINCBY2 inputs as defined by the relative-position control (see Table 3). For cascading purposes, RF7 overflow is provided via the PCCOUT output. Furthermore, RF7 features an independent output bus which allows direct access at the AOP via the ADR multiplexer. When the PC PRIORITY input is taken to a high-logic level, operation select control of the ADR multiplexer is overridden allowing the PC to source the AOP.

| RE  | LATIVE POSI | TION |             | INPUT       | PC IS<br>INCREMENTED |
|-----|-------------|------|-------------|-------------|----------------------|
| LSP | IP          | MSP  | PCCIN       | ENINCBY2    | ON NEXT CLOCK<br>BY  |
| YES | NO          | NO   | H<br>L<br>L | X<br>L<br>H | 0<br>1<br>2          |
| NO  | YES         | NO   | H<br>L      | x<br>x      | 0<br>1               |
| NO  | NO          | YES  | H<br>L      | x<br>x      | 0                    |

TABLE 6 PROGRAM COUNTER INCREMENTATION

Instruction look-ahead techniques may be employed to boost the system-level efficiency. While the internal operation register of the SBP0400A is directing execution of the "present" microinstruction, the PC may be independently updated to address/fetch data for the "next" microinstruction. In this manner, when the "next" microinstruction becomes the "present" microinstruction as evidenced by its residence in the 0400A OR, steps will have already been taken to fetch an associated data operand.

The SBP0401A, designed for use with the SN54S/74S482 control element, can employ the control memory address register of the 'S482 and other system registers to implement instruction look-ahead or overlap.

# 3.7.2 PC Configurations

Typical configurations for use of the program counter in an expanded wordlength system are illustrated in Figures 6 and 7. The BMSB/ $\overline{PCCOUT}$  multifunction output may be time multiplexed (see Figure 6) to provide both BMSB and PC overflow (maximum count) status. Under direction of the relative position control (POS1, POS0), the BMSB is available (see Table 3) when POS1 is high, but if POS1 is taken low,  $\overline{PCCOUT}$  is available. After time t<sub>0</sub> the PC contents of the most significant (MSP) will persist until the next L-to-H clock transition. Thus, the BMSB, then  $\overline{PCCOUT}$  data may both be obtained within a single microcycle (1 clock period).

The PC technique shown in Figure 7 may be employed if the required PC wordlength is 4-bits shorter than the processor wordlength. In this situation, the PC's maximum count status is available from the PCCOUT output of the next-to-MSP (IP) package.

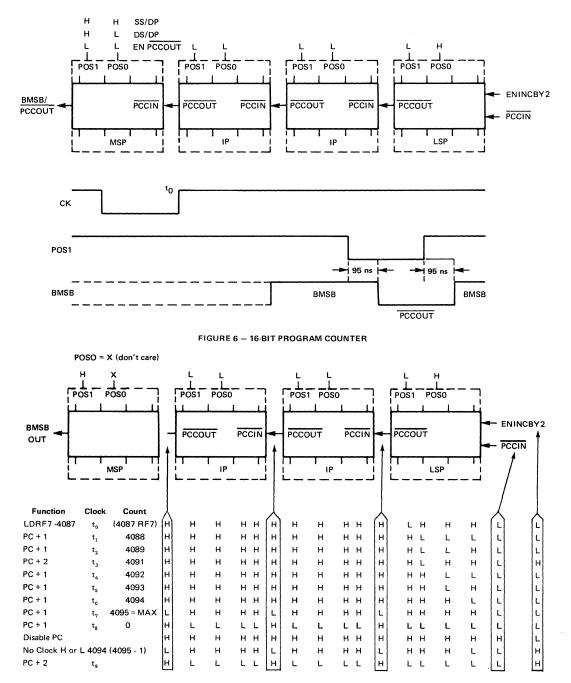


FIGURE 7 - 12-BIT PROGRAM COUNTER

# 3.7.3 PC Count Sequences

PC count sequences initiated at the  $\overrightarrow{PCCIN}$  and  $\overrightarrow{ENINCBY2}$  inputs of the LSP of an expanded wordlength system are shown in Figure 7. An increment-by-1 command ( $\overrightarrow{PCCIN} = L$ ,  $\overrightarrow{ENINCBY2} = L$ ) advances the PC from 4088 to 4089 synchronously with the  $t_2$  clock; an increment-by-2 command ( $\overrightarrow{PCCIN} = L$ ,  $\overrightarrow{ENINCBY2} = H$ ) advances the PC from 4089 to 4091 synchronously with the  $t_3$  clock; a PC disable-increment command ( $\overrightarrow{PCCIN} = L$ ,  $\overrightarrow{ENINCBY2} = H$ ) retains the PC at its present count status. When the PC is at maximum count, an increment-by-1 command ( $\overrightarrow{PCCIN} = L$ ,  $\overrightarrow{ENINCBY2} = H$ ) conditions the  $\overrightarrow{PCCOUT}/\overrightarrow{PCCIN}$  interpackage carry accommodations such that the PC will increment to zero synchronously with the  $t_8$  clock; when the PC is at maximum-count-minus-1 (N-1), an increment-by-2 command ( $\overrightarrow{PCCIN} = L$ ,  $\overrightarrow{ENINCBY2} = H$ ) conditions the  $\overrightarrow{PCCOUT}/\overrightarrow{PCCIN}$  interpackage carry accommodations such that the PC will increment to zero synchronously with the  $t_9$  clock. A maximum count output will be generated at N-1 if the PC is instructed to count by two. This is shown in the supplementary state table of Figure 7.

# 3.8 ADDRESS-OUT MULTIPLEXER (ADR MUX)

The address-out multiplexer (ADR MUX) is a multiport multiplexer which selects either the WR, XWR, or program counter (PC) for transfer to the address-out port (AOP) via the address-out bus (AOB). When the PC PRIORITY input is logic-level low, ADR MUX transfer of the WR or XWR is selected by the resident operation; when the PC PRIORITY input is logic-level high, resident operation direction of the ADR MUX is overridden allowing the PC to source the AOP.

#### 3.9 A BUS

In addition to 4-bit parallel data transfers, the most significant bit (MSB) of the A bus is available at the multifunction AMSB output if the SBP0400A or SBP0401A is in the most significant position (MSP) as defined by the relative-position control. The AMSB output may be used to monitor the sign-bit of A bus data, or in conjunction with the BMSB and DOP3 (MSP) outputs, to detect an impending ALU overflow condition.

#### 3.10 B BUS

In addition to 4-bit parallel data transfers, the most significant bit (MSB) of the B bus is available at the multifunction BMSB output in the most significant-position (MSP) as defined by the relative-position control. When used with shifts or circulates, this output may be used to extract B-bus data serially from the selected source. The BMSB output may be used to monitor the sign-bit of B bus data, or in conjunction with the AMSB and DOP3 (MSP) outputs, to detect an impending ALU overflow condition.

# 3.11 WORKING REGISTER (WR)

#### 3.11.1 General Description

The 4-bit working register (WR) is a D-type edge-triggered register which functions as an accumulator for intermediate operands. The WR sources the ALU via the B multiplexer and the address-out-port (AOP) via the ADR multiplexer; the WR is a destination, via the WR multiplexer, for either the data-out bus (DOB) or data-in port (DIP).

#### 3.11.2 WR Source/Destination Operands

Working register source and destination operands are listed in Tables 7 and 8 respectively. When the WR is used as a destination, the source data is recognized only when a low-level condition exists at the clock input. As shown in Figure 5, the source data may change during the low-level clock condition as long as the setup time prior to the low-to-high transition of the clock input is satisfied.

| OPERATION  | OP FORM<br>(See 5.3) | OP FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0    |
|--|----------------------|-----------------------|--------------------|-----------------------|
| *WR ALU DIP→ DOP                                     | lc                   | LLLL → HHHH           | нн                 | LLL                   |
| *WR ALU DIP → WR                                     | Id                   | LLLL → HHHH           | нн                 | LLH                   |
| WR ALU DIP → XWR                                     | If                   | LLLL → HHHH           | нн                 | HLL                   |
| WR ALU RF → RF                                       | la                   | LLLL → HHHH           | LL                 | LLL → HHH             |
| WR ALU RF → WR                                       | lb                   | LLLL → HHHH           | LH                 | $LLL \rightarrow HHH$ |
| (WR minus DIP minus 1 plus ALUCIN,XWR) LCIR → WR,XWR | IVa                  | HLLL                  | нн                 | LHL                   |
| (WR minus DIP minus 1 plus ALUCIN,XWR) RSA → WR,XWR  | IVf                  | LLHL                  | нн                 | LHL                   |
| (WR minus RF minus 1 plus ALUCIN,XWR) LCIR → WR,XWR  | IVc                  | HLLL                  | HL                 | LLL → HHH             |
| (WR minus RF minus 1 plus ALUCIN,XWR) RSA → WR,XWR   | IVh                  | LLHL                  | HL                 | $LLL \rightarrow HHH$ |
| (WR plus ALUCIN) RSA → WR,XWR                        | IVe                  | HLHL                  | HL                 | xxx                   |
| (WR plus ALUCIN) RSA → WR,XWR                        | IVe                  | HLHL                  | нн                 | LHL                   |
| (WR plus ALUCIN) LCIR → WR                           | Vd                   | LLHH                  | нн                 | нгн                   |
| (WR plus ALUCIN) LCIR → WR                           | Vd                   | нінн                  | нн                 | HLH                   |
| (WR plus ALUCIN) LSA → WR                            | Vc                   | LLHL                  | нн                 | HLH                   |
| (WR plus ALUCIN) LSL → WR                            | Vf                   | HLHL                  | нн                 | нгн                   |
| (WR plus ALUCIN) RCIR → WR                           | ∨ь                   | LLLH                  | нн                 | HLH                   |
| (WR plus ALUCIN) RCIR → WR                           | Vb                   | HLLH                  | нн                 | HLH                   |
| (WR plus ALUCIN) RSA → WR                            | Va                   | LLLL                  | нн                 | HLH                   |
| (WR plus ALUCIN) RSL → WR                            | Ve                   | HLLL                  | нн                 | нгн                   |
| (WR plus ALUCIN, XWR) LCIR $\rightarrow$ (WR, XWR)   | Vid                  | нннн                  | нн                 | HLH                   |
| (WR plus ALUCIN, HWR) LCIR → (WR, XWR)               | VId                  | LHHH                  | нн                 | нін                   |
| (WR plus ALUCIN,XWR) LSA → (WR,XWR)                  | Vic                  | LHHL                  | нн                 | HLH                   |
| (WR plus ALUCIN,XWR) LSL → (WR,XWR)                  | VIf                  | ннн∟                  | нн                 | HLH                   |
| (WR plus ALUCIN,XWR) RCIR → (WR,XWR)                 | νір                  | HHLH                  | нн                 | HLH                   |
| (WR plus ALUCIN,XWR) RCIR → (WR,XWR)                 | VIb                  | LHLH                  | нн                 | HLH                   |
| (WR plus ALUCIN,XWR) RSA → (WR,XWR)                  | Vla                  | LHLL                  | нн                 | нін                   |
| (WR plus ALUCIN,XWR) RSL → (WR,XWR)                  | Vle                  | HHLL                  | нн                 | HLH                   |
| WR plus DIP plus ALUCIN → DOP                        | Hi                   | LHHH                  | нн                 | LHL                   |
| WR plus DIP plus ALUCIN → XWR                        | llh                  | LLHH                  | нн                 | LHL                   |
| (WR plus DIP plus ALUCIN) LCIR → WR,XWR              | і∨ь                  | HLLH                  | нн                 | LHL                   |
| (WR plus DIP plus ALUCIN) RSA → WR,XWR               | IVg                  | нінн                  | нн                 | LHL                   |
| WR plus RF plus ALUCIN → XWR                         | lla                  | LLHH                  | HL                 | $LLL \rightarrow HHH$ |
| (WR plus RF plus ALUCIN) LCIR $\rightarrow$ WR,XWR   | IVd                  | HLLH                  | HL                 | $LLL \rightarrow HHH$ |
| (WR plus RF plus ALUCIN) RSA → WR,XWR                | IVi                  | нінн                  | HL                 | LLL → HHH             |

TABLE 7 WORKING REGISTER SOURCE OPERANDS

NOTE: When PC priority is low WR  $\rightarrow$  AOP

\* XWR → AOP

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| OPERATION  | OP FORM<br>(See 5.3) | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0    |
|--|----------------------|-----------------------|--------------------|-----------------------|
| WR ALU RF → WR                                       | lb                   | LLLL → HHHH           | LH                 | $LLL \rightarrow HHH$ |
| (WR minus DIP minus 1 plus ALUCIN,XWR) LCIR → WR,XWR | IVa                  | HLLL                  | нн                 | LHL                   |
| (WR minus DIP minus 1 plus ALUCIN,XWR) RSA → WR,XWR  | IVd                  | LLHL                  | нн                 | LHL                   |
| (WR minus RF minus 1 plus ALUCIN,XWR) LCIR → WR,XWR  | IVc                  | HLLL                  | HL                 | $LLL \rightarrow HHH$ |
| (WR minus RF minus 1 plus ALUCIN,XWR) RSA → WR,XWR   | IVh                  | LLHL                  | HL                 | $LLL \rightarrow HHH$ |
| (WR plus ALUCIN) RSA → WR,XWR                        | IVe                  | HLHL                  | HL                 | XXX                   |
| (WR plus ALUCIN) RSA → WR,XWR                        | IVe                  | HLHL                  | нн                 | LHL                   |
| (WR plus ALUCIN) LCIR → WR                           | Vd                   | LLHH                  | нн                 | HLH                   |
| (WR plus ALUCIN) LCIR → WR                           | Vđ                   | нінн                  | нн                 | HLH                   |
| (WR plus ALUCIN) LSA → WR                            | Vc                   | LLHL                  | нн                 | HLH                   |
| (WR plus ALUCIN) LSL $\rightarrow$ WR                | Vf                   | HLHL                  | нн                 | HLH                   |
| (WR plus ALUCIN) RCIR → WR                           | Vb                   | LLLH                  | нн                 | HLH                   |
| (WR plus ALUCIN) RCIR → WR                           | Vb                   | HLLH                  | нн                 | нгн                   |
| (WR plus ALUCIN) RSA → WR                            | Va                   | LLLL                  | нн                 | HLH                   |
| (WR plus ALUCIN) RSL → WR                            | Ve                   | HLLL                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) LCIR $\rightarrow$ (WR, XWR)   | VId                  | нннн                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) LCIR $\rightarrow$ (WR, XWR)   | VId                  | LHHH                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) LSA → (WR, XWR)                | VIc                  | LHHL                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) LSL $\rightarrow$ (WR, XWR)    | VIf                  | НННС                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) $RCIR \rightarrow (WR, XWR)$   | VIb                  | ннін                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) RCIR → (WR, XWR)               | VIb                  | LHLH                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) RSA → (WR,XWR)                 | VIa                  | LHLL                  | нн                 | HLH                   |
| (WR plus ALUCIN, XWR) RSL $\rightarrow$ (WR, XWR)    | Vle                  | HHLL                  | нн                 | HLH                   |
| (WR plus DIP plus ALUCIN) LCIR → WR, XWR             | IVb                  | HLLH                  | нн                 | LHL                   |
| (WR plus DIP plus ALUCIN) RSA $\rightarrow$ WR, XWR  | IVg                  | нгнн                  | нн                 | LHL                   |
| (WR plus RF plus ALUCIN) LCIR → WR, XWR              | IVd                  | HLLH                  | HL                 | LLL → HHH             |
| (WR plus RF plus ALUCIN) RSA → WR, XWR               | IVi                  | нгнн                  | HL                 | $LLL \rightarrow HHH$ |

TABLE 8 WORKING REGISTER DESTINATION OPERANDS

NOTE: When PC PRIORITY is low WR  $\rightarrow$  AOP

\* XWR  $\rightarrow$  AOP

#### 3.11.3 WR Sourcing of ADR MUX

The resident operation directs the WR to source the AOP via the ADR multiplexer during 427 of the 459 possible unique operations. In the cases of operation form-type Ic and Id (see Table 27) which represent the remaining 32 of the 459 possible unique operations, the resident operation directs the XWR to source the AOP via the ADR. When the PC PRIORITY input is at a high-logic level, resident operation direction of the ADR multiplexer is overridden allowing the PC to source the AOP.

# 3.12 EXTENDED WORKING REGISTER (XWR)

#### 3.12.1 XWR General Description

The 4-bit extended working register (XWR) is a D-type edge-triggered register which functions as 1) an accumulator during address derivations and 2) a WR extension during operations where double-length operands are present/

accumulated (iterative non-restoring divide, double-precision shifts/circulates, iterative multiply, etc.). The XWR sources 1) the ALU via the B multiplexer, 2) the AOP via the ADR multiplexer, or 3) itself shifted right or left via the XWR multiplexer. The XWR is a destination via the XWR multiplexer for either the DOB or the XWR, itself, shifted right or left.

# 3.12.2 XWR Source/Destination Operands

Extended working register source and destination operands are listed in Tables 9 and 10 respectively.

TABLE 9 EXTENDED WORKING REGISTER SOURCE OPERANDS

| OPERATION                                 | OP FORM<br>(See 5.3) | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0    |
|---|----------------------|-----------------------|--------------------|-----------------------|
| XWB ALU DIP → DOP                         | lh                   | LLLL → HHHH           | нн                 | ннн                   |
|   |                      |                       |                    |                       |
| XWR ALU DIP → WR                          | le                   | LLLL → HHHH           | нн                 | LHH                   |
| XWR ALU DIP $\rightarrow$ XWR             | lg                   | LLLL → HHHH           | нн                 | ннс                   |
| XWR plus ALUCIN $\rightarrow$ DOP         | HI                   | нннг                  | нн                 | LHL                   |
| XWR plus ALUCIN → RF                      | Hj                   | HHHL                  | HL                 | $LLL \rightarrow HHH$ |
| XWR plus DIP plus ALUCIN $\rightarrow$ WR | lik                  | HHLL                  | нн                 | LHL                   |
| XWR plus DIP plus ALUCIN → XWR            | llf                  | ннін                  | нн                 | LHL                   |
| XWR plus RF plus ALUCIN $\rightarrow$ WR  | lle                  | HHLL                  | HL                 | LLL → HHH             |

NOTE: When PC PRIORITY is low WR  $\rightarrow$  AOP

TABLE 10 WORKING REGISTER DESTINATION OPERANDS

| OPERATION  | OP FORM<br>(See 5.3) | OP FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br><sup>←</sup> S2 → S0 |
|--|----------------------|-----------------------|--------------------|---------------------------------|
| DIP ALU XWR → XWR  | lg                   | LLLL HHHH             | нн                 | HHL                             |
| WR ALU DIP → XWR   | lf                   | LLLL → HHHH           | нн                 | HLL                             |
| (WR minus DIP minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | IVa                  | HLLL                  | нн                 | LHL                             |
| (WR minus DIP minus 1 plus ALUCIN, XWR) RSA → WR, XWR              | IVf                  | LLHL                  | нн                 | LHL                             |
| (WR minus RF minus 1 plus ALUCIN, XWR) LCIR → WR, XWR              | 1Vc                  | HLLL                  | HL                 | LLL → HHH                       |
| (WR minus RF minus 1 plus ALUCIN, XWR) RSA WR, XWR                 | l Vh                 | LLHL                  | HL                 | $LLL \rightarrow HHH$           |
| (WR plus ALUCIN) RSA → WR, XWR                                     | IVe                  | HLHL                  | HL                 | XXX                             |
| (WR plus ALUCIN) RSA → WR, XWR                                     | IVe                  | HLHL                  | нн                 | LHL                             |
| (WR plus ALUCIN, XWR) LCIR → (WR, XWR)                             | VId                  | нннн                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) LCIR → (WR, XWR)                             | Vld                  | Сннн                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) LSA → (WR, XWR)                              | VIc                  | LHHL                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) LSL → (WR, XWR)                              | VIf                  | HHHL                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) RCIR $\rightarrow$ (WR, XWR)                 | VIb                  | ннін                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) RCIR → (WR, XWR)                             | VIb                  | LHLH                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) RSA $\rightarrow$ (WR, XWR)                  | VIa                  | LHLL                  | нн                 | HLH                             |
| (WR plus ALUCIN, XWR) RSL → (WR, XWR)                              | Vle                  | HHLL                  | нн                 | HLH                             |
| WR plus DIP plus ALUCIN → XWR                                      | llh                  | LLHH                  | нн                 | LHL                             |
| (WR plus DIP plus ALUCIN) LCIR → WR, XWR                           | IVb                  | HLLH                  | нн                 | LHL                             |
| (WR plus DIP plus ALUCIN) RSA → WR, XWR                            | IVg                  | нінн                  | нн                 | LHL                             |
| WR plus RF plus ALUCIN → XWR                                       | Ha                   | LLHH                  | HL                 | $LLL\toHHH$                     |
| (WR plus RF plus ALUCIN) LCIR → WR, XWR                            | IVd                  | HLLH                  | HL                 | LLL → HHH                       |
| (WR plus RF plus ALUCIN) RSA → WR, XWR                             | 1Vi                  | HLHH                  | HL                 | $LLL\toHHH$                     |
| DIP plus XWR plus ALUCIN → XWR                                     | llk                  | ннгн                  | нн                 | LHL                             |
| $DIP \to XWR$  | Ille                 | LLLH                  | нн                 | LHL                             |

NOTE: When PC PRIORITY is low WR  $\rightarrow$  AOP

When the XWR is used as a destination, the source data is recognized only when a low-level condition exists at the clock input. As shown in Figure 5, the source data can change during the low-level clock condition as long as the setup time prior to the low-to-high transition of the clock input is satisfied.

# 3.12.3 XWR Sourcing of ADR MUX

Operation form-type Ic and Id (see Table 27) represent 32 of the 459 possible unique operations. During these operations the resident operation directs the XWR to source the AOP via the ADR multiplexer. During the remaining 427 of the 459 possible operations, the resident operation directs the WR to source the AOP via the ADR multiplexer. When the PC PRIORITY input is at a high-logic level, resident operation direction of the ADR multiplexer is overridden allowing the PC to source the AOP.

# 3.13 DATA-OUT MULTIPLEXER (DO MUX)

# 3.13.1 DO MUX General Description

The data-out multiplexer (DO MUX) is a multi-port, special purpose multiplexer which provides scaled shifting of the ALU output, and direct transfer of the A bus to the data-out bus, bypassing the ALU. The output port of the DO MUX provides, in accordance with Table 11, ALU output data not shifted, ALU output data shifted right one bit position, ALU output data shifted left one bit position, and A bus data not shifted. Control for the DO MUX is provided by the resident operation in conjunction with the relative position control.

|  |   | DO MUX OUTPUT   |   |   |   |
|--|---|---|---|---|---|
|  | OPERATION TYPE  | 3   | 2   | 1   | 0   |
| INTERMEDIATE AND<br>LEAST SIGNIFICANT<br>POSITIONS | RIGHT SHIFT ARITHMETIC<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE<br>ALU OUT BUS → DATA-OUT BUS<br>A BUS → DATA-OUT BUS<br>LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | WRLFT<br>WRLFT<br>ALU3<br>ABUS3<br>ALU2<br>ALU2<br>ALU2<br>ALU2 | ALU3<br>ALU3<br>ALU2<br>ABUS2<br>ALU1<br>ALU1<br>ALU1 | ALU2<br>ALU2<br>ALU1<br>ABUS1<br>ALU0<br>ALU0<br>ALU0 | ALU1<br>ALU1<br>ALU0<br>ABUS0<br>WRRT<br>WRRT<br>WRRT |
| MOST SIGNIFICANT<br>POSITION (MSP)                 | RIGHT SHIFT ARITHMETIC<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE<br>ALU OUT BUS → DATA-OUT BUS<br>A BUS → DATA-OUT BUS<br>LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | WR3<br>WRLFT<br>ALU3<br>ABUS3<br>ALU2<br>ALU2<br>ALU2<br>ALU2   | ALU3<br>ALU3<br>ALU2<br>ABUS2<br>ALU1<br>ALU1<br>ALU1 | ALU2<br>ALU2<br>ALU1<br>ABUS1<br>ALU0<br>ALU0<br>ALU0 | ALU1<br>ALU1<br>ALU0<br>ABUS0<br>WRRT<br>WRRT<br>WRRT |

TABLE 11 DO MUX TRANSFERS

#### 3.13.2 DO MUX Shift Accommodations

.

Special bidirectional shift accommodations are provided to or from each end of the DO MUX to facilitate interpackage data shifts in expanded word length systems. The direction of these shift accommodations is selected by the resident operation. Bit 3 (MSB) of the DO MUX for each processor element receives interpackage right shift data and transmits interpackage left shift data via the bidirectional shift accommodation WRLFT; bit 0 (LSB) receives interpackage left shift data and transmits interpackage right shift data via the bidirectional shift accommodation WRLFT; bit 0 (LSB) receives interpackage left shift data and transmits interpackage right shift data via the bidirectional shift accommodation WRRT. Both WRLFT and WRRT, low-active signals at the package terminals, become WRLFT and WRRT, respectively, high-active signals within the processor element.

# 3.14 DATA-OUT I-MULTIPLEXER (DO IMUX)

The data-out I-multiplexer (DO IMUX) is a special purpose multiplexer which outputs, in accordance with Table 12, appropriate left-shift data via the bidirectional shift accommodation WRLFT. Control for the DO IMUX is provided by the resident operation in conjunction with the relative position control.

|   | OPERATION TYPE  | DO IMUX OUTPUT<br>TO WRLFT |
|---|---|----------------------------|
| INTERMEDIATE (IP)<br>AND LEAST<br>SIGNIFICANT<br>POSITIONS<br>(LSP)   | LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | ALU3<br>ALU3<br>ALU3       |
| MOST<br>SIGNIFICANT<br>POSITION<br>(MSP)<br>SINGLE-<br>PRECISION<br>(SP)<br>SHIFTS/<br>CIRCULATES   | LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | HIGH<br>HIGH<br>ALU3       |
| MOST<br>SIGNIFICANT<br>POSITION<br>(MSP)<br>(MSP)<br>(MSP)<br>(MSP)<br>SINGLE-<br>SIGNED/<br>DOUBLE-<br>PRECISION<br>(SS/DP)<br>SHIFTS/<br>CIRCULATES | LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | XWR3<br>XWR3<br>XWR3       |
| MOST<br>SIGNIFICANT<br>POSITION<br>(MSP)<br>(MSP)<br>(MSP)<br>DOUBLE-<br>SIGNED/<br>DOUBLE-<br>PRECISION<br>(DS/DP)<br>SHIFTS/<br>CIRCULATES          | LEFT SHIFT ARITHMETIC<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | XWR2<br>XWR3<br>XWR3       |

#### TABLE 12 DO IMUX TRANSFERS TO WRLFT

# 3.15 DATA-OUT J-MULTIPLEXER (DO JMUX)

The data-out J-multiplexer (DO JMUX) is a special purpose multiplexer which outputs, as per Table 13, appropriate right shift data via the bidirectional shift accommodation  $\overline{WRRT}$ . Control for the DO JMUX is provided by the resident operation in conjunction with the relative position control.

TABLE 13 DO JMUX TRANSFERS TO WRRT

|  | OPERATION TYPE   | DO JMUX OUTPUT<br>TO WRRT |
|--|--|---------------------------|
| MOST-<br>SIGNIFICANT<br>(MSP)<br>OR INTER-<br>MEDIATE (IP)<br>POSITIONS                          | RIGHT SHIFT ARITHMETIC<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE | ALU0<br>ALU0<br>ALU0      |
| LEAST.<br>SIGNIFICANT<br>POSITION<br>(LSP)<br>SINGLE-<br>PRECISION (SP)<br>SHIFTS/<br>CIRCULATES | RIGHT SHIFT ARITHMETIC<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE | HIGH<br>HIGH<br>ALUO      |
| LEAST-<br>SIGNIFICANT<br>POSITION (LSP)<br>DOUBLE-<br>PRECISION (DP)<br>SHIFTS/<br>CIRCULATES    | RIGHT SHIFT ARITHMETIC<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE | HIGH<br>HIGH<br>XWRO      |

# 3.16 EXTENDED WORKING REGISTER MULTIPLEXER (XWR MUX)

#### 3.16.1 XWR MUX General Description

The extended working register multiplexer (XWR MUX) is a multi-port, special purpose multiplexer which provides scaled shifting of the XWR outputs and direct transfer of the data-out bus to the XWR input. The output port of the XWR MUX provides, in accordance with Table 14, XWR output data shifted left one bit position, XWR output data shifted right one bit position, and data-out bus data not shifted. The XWR MUX also sources the XWR MSB/LSB output. Under control of the relative position inputs, in the MSP the XWR MUX MSB (Bit 3) is available at the XWR MSB output and in the LSP the XWR MUX LSB (Bit 0) is available at the XWR LSB output. Control for the XWR MUX is provided by the resident operation in conjunction with the relative position control.

#### 3.16.2 XWR MUX Shift Accommodations

Special bidirectional shift accommodations are provided to or from each end of the XWR MUX to facilitate interpackage data shifts when the processor element is used in expanded word length systems. Bit 3 (MSB) or bit 2 of the XWR MUX is selected by the resident operation in conjunction with the relative position control to receive double-precision interpackage right shift data or transmit double-precision interpackage left shift data via the bidirectional shift accommodation XWRLFT; bit 0 (LSB) receives double-precision interpackage left shift data and

# TABLE 14 XWR MUX TRANSFERS

|   | OPERATION TYPE   | XWR MUX OUTPUT   |  |  |  |
|---|--|--|--|--|--|
|   | (DOUBLE-PRECISION)   |  | 2  | 1  | 0  |
| MOST-SIGNIFICANT<br>POSITION<br>(MSP)                 | RIGHT SHIFT ARITHMETIC SINGLE-SIGNED<br>RIGHT SHIFT ARITHMETIC DOUBLE-SIGNED<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE<br>DATA-OUT-BUS → XWR<br>LEFT SHIFT ARITHMETIC SINGLE-SIGNED<br>LEFT SHIFT ARITHMETIC DOUBLE-SIGNED<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | XWRLFT<br>XWR3<br>XWRLFT<br>DOB3<br>XWR2<br>ALU2<br>XWR2<br>XWR2<br>XWR2           | XWR3<br>XWRLFT<br>XWR3<br>DOB2<br>XWR1<br>XWR1<br>XWR1<br>XWR1 | XWR2<br>XWR2<br>XWR2<br>DOB1<br>XWR0<br>XWR0<br>XWR0<br>XWR0 | XWR1<br>XWR1<br>XWR1<br>DOB0<br>XWRRT<br>XWRRT<br>XWRRT<br>XWRRT |
| LEAST-SIGNIFICANT OR<br>INTERMEDIATE POSITION<br>(IP) | RIGHT SHIFT ARITHMETIC SINGLE-SIGNED<br>RIGHT SHIFT ARITHMETIC DOUBLE-SIGNED<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE<br>DATA-OUT-BUS → XWR<br>LEFT SHIFT ARITHMETIC SINGLE-SIGNED<br>LEFT SHIFT ARITHMETIC DOUBLE-SIGNED<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | XWRLFT<br>XWRLFT<br>XWRLFT<br>DOB3<br>XWR2<br>XWR2<br>XWR2<br>XWR2<br>XWR2<br>XWR2 | XWR3<br>XWR3<br>XWR3<br>DOB2<br>XWR1<br>XWR1<br>XWR1<br>XWR1   | XWR2<br>XWR2<br>XWR2<br>DOB1<br>XWR0<br>XWR0<br>XWR0<br>XWR0 | XWR1<br>XWR1<br>XWR1<br>DOB0<br>XWRRT<br>XWRRT<br>XWRRT<br>XWRRT |

transmits interpackage right shift data via the bidirectional shift accommodation  $\overline{XWRRT}$ . Both  $\overline{XWRLFT}$  and  $\overline{XWRRT}$ , low-active signals at the package terminals, become XWRLFT and XWRRT, respectively, high-active signals within the processor element.

# 3.17 EXTENDED WORKING REGISTER K-MULTIPLEXER (XWR KMUX)

The extended working register K-multiplexer (XWR KMUX) is a special purpose multiplexer which outputs, in accordance with Table 15, appropriate double-precision left-shift data via the bidirectional shift accommodation XWRLFT. Control for the XWR KMUX is provided by the resident operation in conjunction with the relative position control.

|  | OPERATION TYPE<br>(DOUBLE-PRECISION)   | XWR KMUX OUTPUT<br>TO XWRLFT |
|--|--|------------------------------|
| LEAST-<br>SIGNIFICANT<br>OR INTER-<br>MEDIATE<br>POSITIONS<br>(IP) | LEFT SHIFT ARITHMETIC SINGLE-SIGNED<br>LEFT SHIFT ARITHMETIC DOUBLE-SIGNED<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | XWR3<br>XWR3<br>XWR3<br>XWR3 |
| MOST-<br>SIGNIFICANT<br>POSITION                                   | LEFT SHIFT ARITHMETIC SINGLE-SIGNED<br>LEFT SHIFT ARITHMETIC DOUBLE-SIGNED<br>LEFT SHIFT LOGICAL<br>LEFT CIRCULATE | HIGH<br>HIGH<br>HIGH<br>ALU3 |

| TABLE 15              |        |
|-----------------------|--------|
| XWR KMUX TRANSFERS TO | XWRLFT |

#### 3.18 EXTENDED WORKING REGISTER L MULTIPLEXER (XWR LMUX)

The extended working register L multiplexer (XWR LMUX) is a special purpose multiplexer which outputs, in accordance with Table 16, appropriate double-precision right shift data via the bidirectional shift accommodation XWRRT. Control for the XWR LMUX is provided by the resident operation in conjunction with the relative position control.

|          | TABLE 16     |       |
|----------|--------------|-------|
| XWR LMUX | TRANSFERS TO | XWRRT |

|  | OPERATION TYPE<br>(DOUBLE-PRECISION)   | XWR LMUX OUTPUT<br>TO XWRRT  |
|--|--|------------------------------|
| MOST -<br>SIGNIFICANT (MSP)<br>OR INTER-<br>MEDIATE<br>POSITIONS<br>(IP) | RIGHT SHIFT ARITHMETIC SINGLE-SIGNED<br>RIGHT SHIFT ARITHMETIC DOUBLE-SIGNED<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE | XWRO<br>XWRO<br>XWRO<br>XWRO |
| LEAST-<br>SIGNIFICANT<br>POSITION<br>(LSP)                               | RIGHT SHIFT ARITHMETIC SINGLE-SIGNED<br>RIGHT SHIFT ARITHMETIC DOUBLE-SIGNED<br>RIGHT SHIFT LOGICAL<br>RIGHT CIRCULATE | ALUO<br>ALUO<br>ALUO<br>ALUO |

# 3.19 WORKING REGISTER MULTIPLEXER (WR MUX)

The working register multiplexer (WR MUX) is a multi-port multiplexer which, under control of the resident operation, selects either data-in port data or data-out bus data for direct transfer to the WR.

## 4. SHIFT/CIRCULATE OPERATIONS

The SBP0400A and the SBP0401A uses the DO MUX in conjunction with the DO IMUX and DO JMUX to accomplish single-bit WR shift/circulate operations; the XWR MUX in conjunction with the XWR KMUX and XWR LMUX to accomplish single-bit XWR shift/circulate operations. While single-precision shift/circulate operations involve the WR only, double-precision shift/circulate operations involve the WR in conjunction with the XWR. The standard operation set does not include single-precision XWR shift/circulate operations.

# 4.1 WR SINGLE-PRECISION SHIFTS/CIRCULATES

WR single-precision shift/circulate operations are directed by the resident operation with expanded wordlength "end" conditions handled by the relative position controls. These single-precision operations may best be represented by the generalized symbol:

## (WR plus ALUCIN) SHIFTED/CIRCULATED → WR

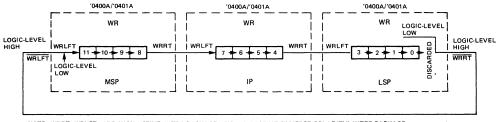
Within a single microcycle (1 clock period), each of six possible WR single-precision shift/circulate operations is capable of 1) asynchronously summing the WR with the ALUCIN input, then 2) asynchronously shifting/circulating the sum one bit position to the right/left, and finally 3) synchronously storing the shifted/circulated result back into the WR. The six WR single-precision shift/circulate possibilities, with data flow paths for expanded wordlengths, are listed in Table 17.

| SHIFT/CIRCULATE<br>OPERATION | SHIFT/CIRCULATE<br>FUNCTION  | EXPANDED<br>WORDLENGTH<br>DATA FLOW<br>PATHS | OP-<br>FORM<br>(See 5.3) | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0 |
|------------------------------|------------------------------|--|--------------------------|-----------------------|--------------------|--------------------|
| (WR plus ALUCIN) RSL → WR    | RIGHT-SHIFT-LOGICAL (RSL)    | Figure 8                                     | Ve                       | HLLL                  | нн                 | нгн                |
| (WR plus ALUCIN) LSL → WR    | LEFT-SHIFT-LOGICAL (LCL)     | Figure 9                                     | Vf                       | HLHL                  | нн                 | нгн                |
| (WR plus ALUCIN) RSA → WR    | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 10                                    | Va                       | LLLL                  | нн                 | нен                |
| (WR plus ALUCIN) LSA → WR    | LEFT-SHIFT-ARITHMETIC (LSA)  | Figure 11                                    | Vc                       | LLHL                  | нн                 | нен                |
| (WR plus ALUCIN) RCIR → WR   | RIGHT-CIRCULATE (RCIR)       | Figure 12                                    | νь                       | LLLH                  | нн                 | нен                |
| (WR plus ALUCIN) LCIR → WR   | LEFT-CIRCULATE (LCIR)        | Figure 13                                    | Vd                       | LLHH                  | нн                 | HLH                |

# TABLE 17 WR SINGLE-PRECISION SHIFTS/CIRCULATES

# 4.1.1 (WR Plus ALUCIN) RSL $\rightarrow$ WR

The WR single-precision logical right-shift operation, shown in Figure 8, displaces the entire contents of the WR one bit position to the right. In an expanded wordlength system, a logic-level low is automatically right-shifted into the WR's most-significant-bit (MSB) of the most-significant-package (MSP) as the WR's contents are displaced to the right. This logic-level low, sourced by the least-significant-package (LSP), exits the LSP via the bidirectional shift accommodation WRRT and enters the MSP via the bidirectional shift accommodation WRRT. During each WR RSL operation, the WR's displaced LSB of the LSP is discarded.

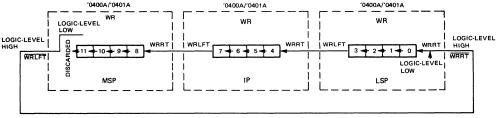


NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

#### FIGURE 8 - RIGHT SHIFT LOGICAL - SINGLE PRECISION (RSL - SP)

#### 4.1.2 (WR Plus ALUCIN) LSL → WR

The WR single-precision logical left-shift operation, shown in Figure 9, displaces the entire contents of the WR one bit position to the left. In an expanded wordlength system, a logic-level low is automatically left-shifted into the WR's LSB of the LSP as the WR's contents are displaced to the left. This logic-level low, sourced by the MSP, exits the MSP via the bidirectional shift accommodation WRLFT and enters the LSP via the bidirectional shift accommodation WRRT. During each WR LSL operation, the WR's displaced MSB of the MSP is discarded.

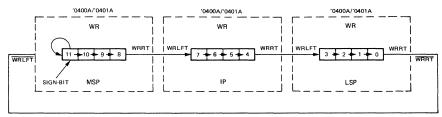


NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 9 - LEFT SHIFT LOGICAL - SINGLE PRECISION (LSL - SP)

#### 4.1.3 (WR Plus ALUCIN) RSA → WR

The WR single-precision arithmetic right-shift operation, shown in Figure 10, displaces the entire contents of the WR one bit position to the right. The MSB of the MSP is designated as a sign-bit. As the entire contents of the WR is displaced to the right, the sign-bit does *not* change. Rather the sign-bit is duplicated to the right. The displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation  $\overline{WRRT}$ .

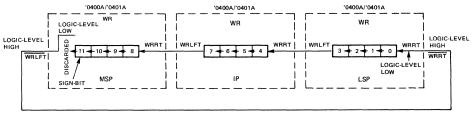


NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 10 - RIGHT SHIFT ARITHMETIC - SINGLE PRECISION (RSA - SP)

#### 4.1.4 (WR Plus ALUCIN) LSA $\rightarrow$ WR

The WR single-precision arithmetic left-shift operation, shown in Figure 11, is functionally identical to the WR single-precision logical left-shift operation. The WR's MSB of the MSP, although designated as a sign-bit, is discarded as the entire contents of the WR is displaced one bit position to the left. As each WR LSA operation is performed, the BMSB output (WR sign bit) may be compared to the MSB of the MSP's DOP (data displacing into WR sign bit) to detect an impending change in WR sign-bit polarity.

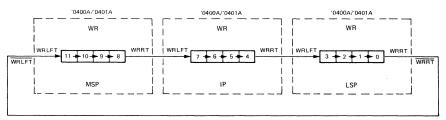


NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE

FIGURE 11 - LEFT SHIFT ARITHMETIC - SINGLE PRECISION (LSA - SP)

#### 4.1.5 (WR Plus ALUCIN) RCIR → WR

The WR single-precision right-circulate operation, shown in Figure 12, displaces the entire contents of the WR one bit position to the right. The displaced LSB of the LSP replaces the displaced MSB of the MSP. The displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation  $\overline{WRT}$  and enters the MSP via the bidirectional shift accommodation  $\overline{WRT}$ .

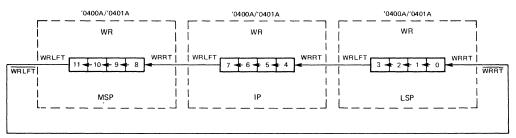


NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE

FIGURE 12 - RIGHT CIRCULATE - SINGLE PRECISION (RCIR - SP)

# 4.1.6 (WR Plus ALUCIN) LCIR $\rightarrow$ WR

The WR single-precision left-circulate operation, shown in Figure 13, displaces the entire contents of the WR one bit position to the left. The displaced MSB of the MSP replaces the displaced LSB of the LSP. The displaced MSB of the MSP exits the MSP via the bidirectional shift accommodation  $\overline{WRLFT}$  and enters the LSP via its bidirectional shift accommodation  $\overline{WRTT}$ .



NOTE: WRRT, WRLFT, ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

#### FIGURE 13 - LEFT CIRCULATE - SINGLE PRECISION (LCIR - SP)

#### 4.2 WR,XWR DOUBLE-PRECISION SHIFTS/CIRCULATES

WR,XWR double-precision shift/circulate operations are directed by the resident operation with expanded wordlength "end" conditions handled by the relative position controls. The double-precision shift/circulate operations may best be represented by the generalized symbol:

#### (WR plus ALUCIN, XWR) SHIFTED/CIRCULATED $\rightarrow$ WR, XWR

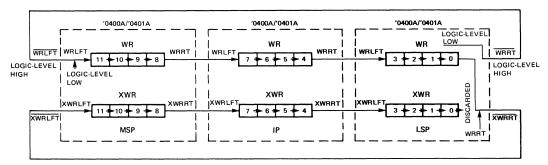
Within a single microcycle, each of eight possible WR,XWR double-precision shift/circulate operations is capable of 1) asynchronously summing the WR with the ALUCIN input, then 2) asynchronously double-precision shifting/ circulating the sum with the WR and XWR considered as one double-length register, and finally 3) synchronously storing the shifted/circulated result into the double-length register formed by WR in conjunction with the XWR. The eight WR,XWR double-precision shift/circulate possibilities, with data flow paths for expanded wordlengths, are listed in Table 18.

TABLE 18 WR, XWR DOUBLE-PRECISION SHIFTS/CIRCULATES

| SHIFT/CIRCULATE<br>OPERATION         |                              |               | OP-<br>FORM<br>(See 5.3) | OP-FIELD<br>OP3 → OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0 |
|--------------------------------------|------------------------------|---------------|--------------------------|-----------------------|--------------------|--------------------|
| (WR plus ALUCIN, XWR) RSL → WR, XWR  | RIGHT-SHIFT-LOGICAL (RSL)    | Figure 14     | Vle                      | HHLL                  | нн                 | HLH                |
| (WR plus ALUCIN, XWR) LSL → WR, XWR  | LEFT-SHIFT-LOGICAL (LSL)     | Figure 15     | Vlf                      | HHHL                  | нн                 | HLH                |
| (WR plus ALUCIN, XWR) RSA → WR, XWR  | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 16, 17 | VIa                      | LHLL                  | нн                 | HLH                |
| (WR plus ALUCIN, XWR) LSA → WR, XWR  | LEFT-SHIFT-ARITHMETIC (LSA)  | Figure 18, 19 | VIc                      | LHHL                  | нн                 | HLH                |
| (WR plus ALUCIN, XWR) RCIR → WR, XWR | RIGHT-CIRCULATE (RCIR)       | Figure 20     | VIb                      | LНLН                  | нн                 | HLH                |
| (WR plus ALUCIN, XWR) LCIR → WR, XWR | LEFT-CIRCULATE (LCIR)        | Figure 21     | VI3                      | LННН                  | нн                 | HLH                |

#### 4.2.1 (WR Plus ALUCIN, XWR) RSL → WR,XWR

The WR,XWR double-precision logical right-shift operation, shown in Figure 14, displaces the entire contents of the double-length register, formed by the WR in conjunction with the XWR, one bit position to the right. In an expanded wordlength system, the WR's displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation XWRRT and enters the XWR's MSB of the MSP via the bidirectional shift accommodation XWRLFT. A logic-level low is automatically right-shifted into the WR's MSB of the MSP. This logic-level low, sourced by the LSP, exits the LSP via the bidirectional shift accommodation WRRT and enters the MSP via the bidirectional shift accommodation WRRT. During each WR,XWR RSL operation, the XWR's displaced LSB of the LSP is discarded.

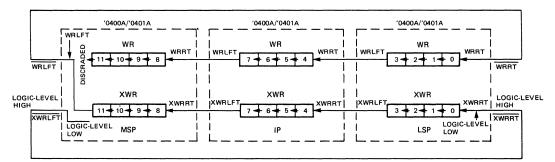


NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 14 - RIGHT SHIFT LOGICAL - DOUBLE PRECISION (RSL - DP)

# 4.2.2 (WR Plus ALUCIN, XWR) LSL $\rightarrow$ WR, XWR

The WR,XWR double-precision logical left-shift operation, shown in Figure 15, displaces the entire contents of the double length register, formed by the WR in conjunction with the XWR, one bit position to the left. In an expanded wordlength system, the XWR's displaced MSB of the MSP exits the MSP via the bidirectional shift accommodation WRLFT and enters WR's LSB of the LSP via the bidirectional shift accommodation WRRT. A logic-level low is automatically left-shifted into the XWR's LSB of the LSP. This logic-level low, sourced by the MSP, exits the MSP via the bidirectional shift accommodation XWRLFT and enters the LSP via the bidirectional shift accommodation XWRTT. During each WR, XWR LSL operation, the WR's displaced MSB is discarded.



NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

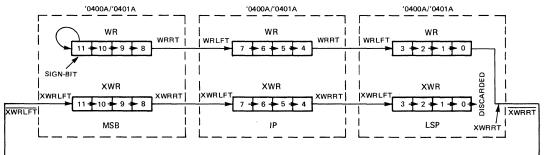
FIGURE 15 - LEFT SHIFT LOGICAL - DOUBLE PRECISION (LSL - DP)

# 4.2.3 (WR Plus ALUCIN, XWR) RSA → WR, XWR

The WR,XWR double-precision arithmetic right-shift operations, shown in Figures 16 and 17, displace the entire contents of the double-length register, formed by the WR in conjunction with the XWR, one bit position to the right. In an expanded wordlength system, the WR's displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation XWRRT and enters either the XWR's MSB or MSB-minus-1 of the MSP (see 4.2.3.1 and 4.2.3.2). The polarity of the MSP's relative position control input POSO selects between single-signed and double-signed double-precision arithmetic right-shift operations.

#### 4.2.3.1 Single-Signed Double-Precision RSA (MSP POSO=H)

For the single-signed WR,XWR double-precision right-shift operation, shown in Figure 16, the WR's MSB of the MSP only is designated as a sign-bit. As the entire contents of the WR,XWR is displaced one bit position to the right, the sign-bit does *not* change. Rather, the sign-bit is duplicated to the right. The WR's displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation XWRRT and enters the XWR's MSB of the MSP via the bidirectional shift accommodation XWRLFT. The XWR's displaced LSB of the LSP is discarded.

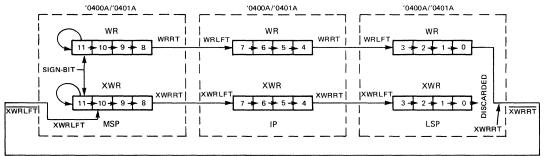


NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

#### FIGURE 16 – RIGHT SHIFT ARITHMETIC – SINGLE SIGN/DOUBLE PRECISION (RSA – SS/DP)

#### 4.2.3.2 Double-Signed Double-Precision RSA (MSP POSO=L)

For the double-signed WR,XWR double-precision right-shift operation, shown in Figure 17, both the WR's and XWR's MSB of the MSP are designated as a sign-bit. As the entire contents of the WR,XWR is displaced one bit position to the right, the sign-bits do not change. Rather, the WR's sign-bit is duplicated to the right while the XWR's sign-bit is held stationary. The WR's displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation XWRRT and enters the XWR's MSB-minus-1 of the MSP via the bidirectional shift accommodation XWRLFT. The XWR's displaced LSB of the LSP is discarded.



NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

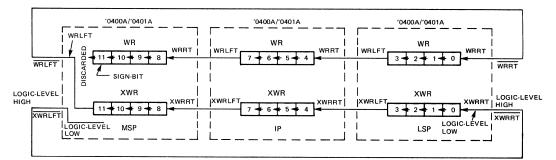
FIGURE 17 - RIGHT SHIFT ARITHMETIC - DOUBLE SIGN/DOUBLE PRECISION (RSA - DS/DP)

#### 4.2.4 (WR Plus ALUCIN, XWR) LSA → WR, XWR

The WR,XWR double-precision arithmetic left-shift operations, shown in Figures 18 and 19, displace the entire contents of the double-length register, formed by the WR in conjunction with the XWR, one bit position to the left. In an expanded wordlength system, either the XWR's displaced MSB or MSB-minus-1 of the MSP exits the MSP via the bidirectional shift accommodation WRLFT and enters the WR's LSB of the LSP via the bidirectional shift accommodation WRLFT and enters the WR's loss of the LSP via the bidirectional shift accommodation and double-precision arithmetic left-shift operations.

#### 4.2.4.1 Single-Signed Double-Precision LSA (MSP POSO=H)

The single-signed WR,XWR double-precision arithmetic left-shift operation, shown in Figure 18, is functionally identical to the WR,XWR double-precision logical left-shift operation. The WR's MSB of the MSP, although designated as a sign-bit, is discarded as the entire contents of the double-length WR,XWR register is displaced one bit position to the left. As each WR,XWR LSA operation is performed, the BMSB output (WR sign bit) may be compared to the MSB of the MSP's DOP (data displacing into WR sign bit) to detect an impending change in WR sign bit polarity.

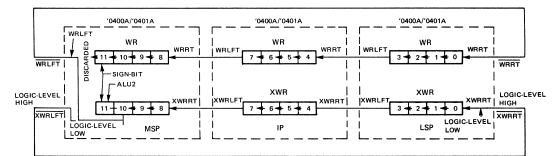


NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

# FIGURE 18 – LEFT SHIFT ARITHMETIC – SINGLE SIGN/DOUBLE PRECISION (LSA – SS/DP)

# 4.2.4.2 Double-Signed Double-Precision LSA (MSP POSO=L)

The double-signed WR,XWR double-precision arithmetic left-shift operation shown in Figure 19 is, with one exception, functionally identical to the WR,XWR double-precision left-shift operation. The exception is, the XWR's sign-bit is automatically forced to the polarity of the MSP's ALU2 output. As each double-signed double-precision LSA operation is performed, the WR's sign-bit is discarded. Consequently the BMSB output (WR sign bit) may be compared to the MSP's DOP (ALU2 data displacing into WR sign bit) to detect an impending change in WR sign bit polarity.

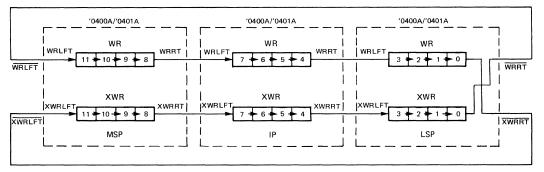


NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 19 - LEFT SHIFT ARITHMETIC - DOUBLE SIGN/DOUBLE PRECISION (LSA - DS/DP)

#### 4.2.5 (WR Plus ALUCIN, XWR) RCIR → WR, XWR

The WR,XWR double-precision right-circulate operation, shown in Figure 20, displaces the entire contents of the double-length register, formed by the WR in conjunction with the XWR, one bit position to the right. In an expanded wordlength system, the WR's displaced LSB of the LSP exits the LSP via the bidirectional shift accommodation \*WRRT and enters the XWR's MSB of the MSP via the bidirectional shift accommodation XWRLFT. The XWR's LSB of the LSP exits the LSP exits the LSP via the bidirectional shift accommodation with the SWR and enters the WR's MSB of the MSP via the bidirectional shift accommodation WRRT and enters the WR's MSB of the MSP via the bidirectional shift accommodation WRRT.

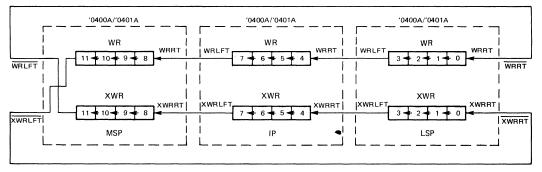


NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 20 - RIGHT CIRCULATE - DOUBLE PRECISION (RCIR - DP)

#### 4.2.6 (WR Plus ALUCIN, XWR) LCIR → WR,XWR

The WR,XWR double-precision left-circulate operation, shown in Figure 21, displaces the entire contents of the double-length register, formed by the WR in conjunction with the XWR, one bit position to the left. In an expanded wordlength system, the WR's displaced MSB of the MSP exits the MSP via the bidirectional shift accommodation  $\overline{XWRLFT}$  and enters the XWR's LSB of the LSP via the bidirectional shift accommodation  $\overline{XWRLFT}$  and enters the MSP via the bidirectional shift accommodation  $\overline{WRLFT}$  and enters the WR's LSB of the LSP via the bidirectional shift accommodation  $\overline{WRLFT}$  and enters the WR's LSB of the LSP via the bidirectional shift accommodation  $\overline{WRLFT}$  and enters the WR's LSB of the LSP via the bidirectional shift accommodation  $\overline{WRLFT}$  and enters the WR's LSB of the LSP via the bidirectional shift accommodation  $\overline{WRTT}$ .



NOTE: WRRT, WRLFT, XWRRT, XWRLFT ARE HIGH-ACTIVE INTRA-PACKAGE AND LOW-ACTIVE (INVERSE POLARITY) INTER-PACKAGE.

FIGURE 21 - LEFT CIRCULATE - DOUBLE PRECISION (LCIR - DP)

#### 4.3 COMPOUND-FUNCTION WR, XWR DOUBLE-PRECISION SHIFTS/CIRCULATES

Compound-function WR,XWR double-precision shift/circulate operations extend the processing power of the basic double-precision RSA and LCIR operations to boost systems-level efficiency in the assembly of iterative macro-instructions such as multiply and non-restoring divide. These compound-function shift/circulate operations, directed by the resident operation with expanded wordlength "end" conditions handled by the relative position controls, may best be represented by the generalized symbol:

# (WR plus/minus A plus ALUCIN, XWR) RSA/LCIR $\rightarrow$ WR,XWR where A is either the DIP or RF

Within a single microcycle, each of eight possible compound-function WR,XWR double-precision shift/circulate operations is capable of 1) asynchronously summing/subtracting either the RF or DIP with/from the WR, then 2) asynchronously adding the result to the ALUCIN input, then 3) asynchronously double-precision shifting/circulating (RSA/LCIR) the result with the WR and XWR considered as one double-length register, and finally 4) synchronously storing the shifted/circulated result into the double-length register formed by the WR in conjunction with the XWR. The eight compound-function WR,XWR double-precision shift/circulate possibilities, with data flow paths for expanded wordlengths, are listed in Table 19.

## TABLE 19 COMPOUND-FUNCTION WR, XWR DOUBLE-PRECISION SHIFTS/CIRCULATES

| SHIFT/CIRCULATE<br>OPERATION   | SHIFT/CIRCULATE<br>FUNCTION  | EXPANDED<br>WORDLENGTH<br>DATA FLOW<br>PATHS | OP-<br>FORM<br>(See 5.3) | OP-FIELD<br>OP3→OP0 | D-FIELD<br>D1 → D0 | S-FIELD<br>S2 → S0 |
|--|------------------------------|--|--------------------------|---------------------|--------------------|--------------------|
| (WR minus DIP minus 1 plus ALUCIN, XWR) LCIR → WR, XWR               | LEFT-CIRCULATE (LCIR)        | Figure 21                                    | IVa                      | HLLL                | нн                 | LHL                |
| (WR minus RF(n) minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | LEFT-CIRCULATE (LCIR)        | Figure 21                                    | IVc                      | HLLL                | HL                 | LLL → HHH          |
| (WR plus DIP plus ALUCIN, XWR) LCIR → WR, XWR                        | LEFT-CIRCULATE (LCIR)        | Figure 21                                    | ινь                      | HLLH                | нн                 | LHL                |
| (WR plus RF(n) plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR          | LEFT-CIRCULATE (LCIR)        | Figure 21                                    | IVd                      | HLLH                | HL                 | LLL → HHH          |
| (WR minus DIP minus 1 plus ALUCIN, XWR) RSA → WR, XWR                | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 16                                    | IVf                      | LLHL                | нн                 | LHL                |
| (WR minus RF(n) minus 1 plus ALUCIN, XWR) RSA → WR, XWR              | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 16                                    | IVh                      | LLHL                | HL                 | LLL → HHH          |
| (WR plus DIP plus ALUCIN, XWR) RSA → WR, XWR                         | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 16                                    | IVg                      | нснн                | нн                 | LHL                |
| (WR plus $RF(n)$ plus ALUCIN, XWR) $RSA \rightarrow WR$ , XWR        | RIGHT-SHIFT-ARITHMETIC (RSA) | Figure 16                                    | IVi                      | нснн                | HL                 | $LLL \to HHH$      |

# 5. OPERATION SET (MICROINSTRUCTION SET)

The SBP0400A and SBP0401A are supplied with an identical set of 459 non-redundant standard factory-defined operations (microinstructions). The only difference between the SBP0400A and the SBP0401A is the presence and absence of the operation register (OR):

- a. The SBP0400A contains a 20-bit operation register. After the 9-bit operation code is applied (and setup), the positive-going clock transition causes the resident operation to be stored in the OR. See Figure 5 and microinstruction overlap, paragraph 5.1.
- b. The SBP0401A, without the OR, derives its resident operation from a steady-state 9-bit code applied at the operation select inputs. See Figure 5.

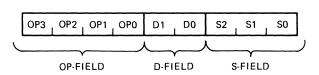
# 5.1 SBP0400A MICROINSTRUCTION OVERLAP

Within a single microcycle (1 clock period), any one of the '0400A's 459 unique operations may be both selected and executed. While the "present" microinstruction is directing the '0400A's functional blocks and data paths from the OR, the "next" microinstruction may be setup for entry into the OR. As the results of the "present" microinstruction are synchronously stored at their appointed destination, the "next" microinstruction simultaneously enters the OR where it becomes the "present" microinstruction. This technique of overlapping microinstruction setup with microinstruction (Figure 5) allows a string of successive microinstructions to be executed, one each, during successive microcycles.

## 5.2 OPERATION-SELECT WORD

Each of the 459 operations is selected by presenting 9-bits of encoded microinstruction data to the operation-select input lines which is then asynchronously decoded/translated by the PLA. In the SBP0400A this decoded/translated microinstruction enters the OR synchronous with the completion of the previous microinstruction (positive transition of the clock) to become the resident operation. In the SBP0401A this decoded/translated microinstruction is distributed directly from the 20 outputs of the PLA as the resident operation.

The 9-bit operation-select word is partitioned, as shown below, into three interacting fields: 1) the 2-bit D-field, 2) the 4-bit OP-field, and 3) the 3-bit S-field.



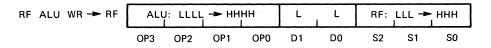
**OPERATION-SELECT WORD** 

#### 5.2.1 D-Field, Operation-Select Word

This 2-bit D-field (D1  $\rightarrow$  D0) of the operation-select word governs the manner in which the OP-field and S-field are interpreted to specify the operations. Four D-field possibilities exist. They are: LL, LH, HL, and HH.

#### 5.2.1.1 D-Field = LL

When the D-field is "LL", the RF and WR, as shown below, are designated as operand sources with the RF also designated as the operation-result destination.



The 3-bit S-field is interpreted to select 1 of 8 RF locations both as an operand source and an operation-result destination; the 4-bit OP-field is interpreted to select one of 16 ALU functions (micro-operations) as the operand combination/modification mechanism.

# 5.2.1.2D-Field = LH

When the D-field is "LH", the RF and WR, as shown below, are designated as operand sources with the WR also designated as the operation-result destination.

| RF ALU WR> WR | ALU | : LLLL | -> HH | нн  | L  | Н  | RF: | RF: LLL -> HI |    |  |
|---------------|-----|--------|-------|-----|----|----|-----|---------------|----|--|
|               | OP3 | OP2    | OP1   | OP0 | D1 | D0 | S2  | S1            | S0 |  |

The 3-bit S-field is interpreted to select 1 of 8 RF locations as an operand source; the 4-bit OP-field is interpreted to select one of 16 ALU functions (micro-operations) as the operand combination/modification mechanism.

#### 5.2.1.3 D-Field = HL

When the D-field is "HL", the ALU functions (micro-operations) available for the combination/modification of operands are limited to 1) plus, 2) minus, or 3) unconditional ALU-bypass (no ALU function).

As shown in Table 20, the 3-bit S-field is primarily interpreted to select one of eight RF locations as an operand source and/or operation-result destination; the 4-bit OP-field is interpreted to select a limited ALU function in conjunction with an operand source and/or operand-result destination.

| ٦   | ٢A | B  | LE | 2 | 0  |
|-----|----|----|----|---|----|
| D-I | FI | ΕL | .D | = | HL |

|   | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2         | S1        | <b>S</b> 0 |
|---|-----|-----|-----|-----|----|----|------------|-----------|------------|
|   |     |     |     |     |    |    |            |           |            |
| $RF \to DOP$  | L   | L   | L   | L   | н  | L  | RF: L      | _LL →     | ннн        |
| $RF \to XWR$  | L   | L   | L   | н   | н  | L  | RF: L      | LL →      | ннн        |
| (WR minus RF minus 1 plus ALUCIN, XWR) RSA $\rightarrow$ WR, XWR  | L   | L   | н   | L   | н  | L  | RF: L      | LL →      | ннн        |
| RF plus WR plus ALUCIN $\rightarrow$ XWR                          | L   | L   | н   | Н   | н  | L  | RF: L      | LL →      | ннн        |
| RF plus DIP plus ALUCIN $\rightarrow$ WR                          | L   | н   | L   | L   | н  | L  | RF: L      | LL →      | ннн        |
| RF plus DIP plus ALUCIN $\rightarrow$ XWR                         | L   | Н   | L   | Н   | н  | L  | RF: L      | LL →      | ннн        |
| DIP → WR  | L   | н   | н   | L   | н  | L  | Don't<br>X | Care<br>X | x          |
| RF plus DIP plus ALUCIN $\rightarrow$ RF                          | L   | н   | н   | Н   | н  | L  | RF: L      | LL →      | ннн        |
| (WR minus RF minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | н   | L   | L   | L   | н  | L  | RF: L      | LL →      | ннн        |
| (WR plus RF plus ALUCIN, XWR) LCIR → WR, XWR                      | н   | L   | L   | H.  | н  | L  | RF: L      | LL →      | ннн        |
| (WR plus ALUCIN, XWR) RSA $\rightarrow$ WR, XWR                   | н   | L   | н   | L   | н  | L  | Don't<br>X | Care<br>X | x          |
| (WR plus RF plus ALUCIN) RSA → WR, XWR                            | н   | L   | н   | н   | н  | L  | RF: L      | LL →      | ннн        |
| RF plus XWR plus ALUCIN $\rightarrow$ WR                          | н   | н   | L   | L   | Н  | L  | RF: L      | _LL →     | ннн        |
| RF plus XWR plus ALUCIN → XWR                                     | н   | н   | L   | н   | н  | L  | RF: L      | LL →      | ннн        |
| XWR plus ALUCIN $\rightarrow$ RF                                  | н   | Н   | н   | L   | н  | L  | RF: L      | LL→       | ннн        |
| $DIP \to RF$  | Н   | н   | Н   | н   | н  | L  | RF: L      | LL →      | ннн        |
|   | OP3 | OP2 | OP1 | OP0 | D1 | D0 | <b>S</b> 2 | S1        | S0         |

# 5.2.1.4 D-Field = HH

When the D-field is "HH", the RF is neither used as an operand source nor an operation-result destination. Rather, two S-field possibilities (LHL, HLH) are, as shown in Table 21, interpreted to extend the 4-bit OP-field to select one of 32 non-RF operations. The extended OP-field is interpreted to select a limited ALU function in conjunction with an operand source(s) and an operation-result destination.

#### TABLE 21 D-FIELD = HH

|  | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 | S1         | S0  |
|--|-----|-----|-----|-----|----|----|----|------------|-----|
| $DIP \to DOP$  | L   | L   | L   | L   | н  | н  | L  | н          | L   |
| $DIP \to XWR$  | L   | L   | L   | н   | н  | н  | L  | н          | L   |
| (WR minus DIP minus 1 plus ALUCIN, XWR) RSA → WR, XWR              | L   | L   | н   | L   | н  | н  | L  | н          | L   |
| DIP plus WR plus ALUCIN → XWR                                      | L   | L   | н   | н   | н  | н  | L  | н          | L   |
| $F_{1.6}$ plus ALUCIN $\rightarrow$ DOP                            | L   | н   | L   | L   | н  | н  | L  | н          | L   |
| DIP plus WR plus ALUCIN → DOP                                      | L   | н   | L   | н   | н  | н  | L  | н          | L   |
| $DIP \to WR$   | L   | н   | н   | L   | н  | н  | L  | н          | L   |
| DIP plus WR plus ALUCIN → DOP                                      | L   | н   | н   | н   | н  | н  | L  | н          | L   |
| (WR minus DIP minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | н   | L   | L   | L   | н  | н  | L  | н          | L   |
| (WR plus DIP plus ALUCIN, XWR) LCIR → WR, XWR                      | н   | L   | L   | н   | н  | н  | L  | н          | L   |
| (WR plus ALUCIN, XWR) RSA → WR, XWR                                | н   | L   | н   | L   | н  | н  | L  | н          | L   |
| (WR plus DIP plus ALUCIN, XWR) RSA $\rightarrow$ WR, XWR           | н   | L   | н   | н   | н  | н  | L  | н          | L   |
| DIP plus XWR plus ALUCIN $\rightarrow$ WR                          | н   | н   | L   | L   | н  | н  | L  | н          | L   |
| DIP plus XWR plus ALUCIN $\rightarrow$ XWR                         | н   | н   | L   | н   | н  | н  | L  | н          | L   |
| XWR plus ALUCIN → DOP  | н   | н   | н   | L   | н  | н  | L  | н          | L   |
| $DIP \to DOP$  | н   | н   | н   | н   | н  | н  | L  | н          | L   |
|  | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 | S1         | S0  |
| (WR plus ALUCIN) RSA → WR  | L   | L   | L   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN) RCIR → WR   | L   | L   | L   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN) LSA $\rightarrow$ WR                              | L   | L   | н   | L   | н  | н  | н  | L          | н [ |
| (WR plus ALUCIN) LCIR → WR   | L   | L   | н   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) RSA → WR, XWR                                | L   | н   | L   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) RCIR → WR, XWR                               | L   | н   | L   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) LSA $\rightarrow$ WR, XWR                    | L   | н   | н   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR                   | L   | н   | н   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN)RSL $\rightarrow$ WR                               | н   | L   | L   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN) RCIR $ ightarrow$ WR                              | н   | L   | L   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN) LSL → WR  | н   | L   | н   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN) LCIR → WR   | н   | L   | н   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) RSL → WR, XWR                                | н   | н   | L   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) RCIR $\rightarrow$ WR, XWR                   | н   | н   | L   | н   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) LSL → WR, XWR                                | н   | н   | н   | L   | н  | н  | н  | L          | н   |
| (WR plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR                   | н   | н   | н   | H   | н  | н  | н  | L          | н   |
|  | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 | <b>S</b> 1 | S0  |

#### 5.2.2 OP-Field, Operation-Select Word

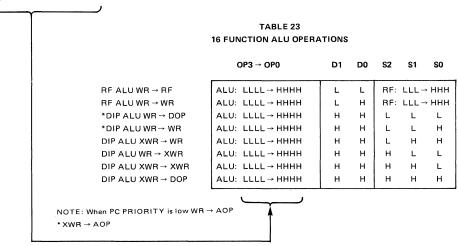
The 4-bit OP-field (OP3  $\rightarrow$  OP0) of the operation-select word interacts with the D-field and S-field to specify an ALU function as the operand combination/modification mechanism for operations (microinstructions).

# 5.2.2.1 OP-Field ALU Function (Micro-Operation) Selection

The most consistent utilization of the OP-field is realized when specifying one of 16 ALU functions, listed in Table 22, as the operand combination/modification mechanism for those particular operations listed in Table 23. For those

|     | А    | LU   |     | ACTIVE-HIGH DATA     |                        |  |  |  |
|-----|------|------|-----|----------------------|------------------------|--|--|--|
| 1   | OP-F | IELD |     | ALUCIN = H           | ALUCIN = L             |  |  |  |
| OP3 | OP2  | OP1  | OP0 | (WITH CARRY)         | (NO CARRY)             |  |  |  |
|     |      |      |     |                      |                        |  |  |  |
| L   | L    | L    | L   | Fn = L               | Fn ≃ H                 |  |  |  |
| L   | L    | L    | н   | Fn = B minus A       | Fn = B minus A minus 1 |  |  |  |
| L   | L    | н    | L   | Fn = A minus B       | Fn = A minus B minus 1 |  |  |  |
| L   | L    | н    | н   | Fn = A plus B plus 1 | Fn = A plus B          |  |  |  |
| L   | н    | L    | L   | Fn = B plus 1        | Fn≃B                   |  |  |  |
| L   | н    | L    | н   | Fn = B plus 1        | $Fn = \overline{B}$    |  |  |  |
| L   | н    | н    | L   | Fn ≈ A plus 1        | Fn = A                 |  |  |  |
| L   | н    | н    | н   | Fn = A plus 1        | $Fn = \overline{A}$    |  |  |  |
| н   | L    | L    | L   | Fn = 4               | \nBn                   |  |  |  |
| н   | L    | L    | н   | Fn = 4               | An 🕀 Bn                |  |  |  |
| н   | L    | н    | L   | Fn = 7               | An 🕀 Bn                |  |  |  |
| н   | L    | н    | н   | Fn = Ā               | ĀnBn                   |  |  |  |
| н   | н    | L    | L   | Fn = <i>F</i>        | AnBn                   |  |  |  |
| н   | н    | L    | н   | Fn = An + Bn         |                        |  |  |  |
| н   | н    | н    | L   | Fn = Ā               | Ān + Bn                |  |  |  |
| н   | н    | н    | н   | Fn = 4               | An + Bn                |  |  |  |

TABLE 22 ALU FUNCTION (MICRO-OPERATION SELECT)



operations, the D-field interacts with the S-field to specify two operand sources in combination with an operation-result destination. Either the DIP or RF is available as an operand source to the "A" input port of the ALU; either the DIP, WR or XWR is available as an operand source to the "B" input port of the ALU. Ultimate destinations for ALU output results include either the DOP, RF, WR or XWR.

An ALU function from Table 22 may be selected as the operand combination/modification mechanism for each operation in Table 23 by simply choosing the appropriate OP-field code. For example, a D-field code of "HH" interacts with an S-field code of "LLH" to specify the operation DIP ALU WR  $\rightarrow$  WR. If the WR is to be subtracted from the DIP, an OP-field code of "LLHL" ( $F_n = A$  minus B, ALUCIN = H) must be selected from Table 22 along with an ALUCIN = H forced into the LSP. The resulting operation-select word will then specify the operation DIP minus WR  $\rightarrow$  DOP.

| OP   | D  | S   |
|------|----|-----|
| LLHL | нн | LLL |

An OP-field choice of "LLLH" would automatically interchange the operands and specify the operation WR minus  $DIP \rightarrow DOP$ . In fact, any of eight arithmetic or eight Boolean ALU functions may be selected from Table 22 and impressed upon any operation in Table 23.

Although the ALU generally accepts two operand sources simultaneously as inputs, certain ALU functions may be selected from Table 22 which only consider one operand source. These ALU functions, when impressed upon the operations of Table 23, specify the register transfer operations of Table 24. These register transfer operations allow: 1) unconditioned transfers,  $X \rightarrow Y$  with the LSP's ALUCIN = L, 2) incrementing transfers, X plus  $1 \rightarrow Y$  with the LSP's ALUCIN = H, 3) one's-complement transfers,  $\overline{X} \rightarrow Y$  with the LSP's ALUCIN = L, and 4) two's-complement transfers,  $\overline{X}$  plus  $1 \rightarrow Y$  with the LSP's ALUCIN = H.

|   | OP3         | OP2      | OP1     | OPO | D1 | D0 | S2 S1 S0      |
|---|-------------|----------|---------|-----|----|----|---------------|
| WR plus ALUCIN 🕂 RF                                   | L           | н        | L       | Ļ   | L  | L  | RF: LLL → HHH |
| RF plus ALUCIN $\rightarrow$ WR                       | L           | н        | н       | L   | L  | н  | RF: LLL → HHH |
| WR plus ALUCIN → XWR                                  | L           | н        | L       | L   | н  | н  | ньь           |
| XWR plus ALUCIN $\rightarrow$ WR                      | L           | н        | L       | L   | н  | н  | ГНН           |
| DIP plus ALUCIN $\rightarrow$ WR                      | L           | н        | н       | L   | н  | н  | ГНН           |
| DIP plus ALUCIN $\rightarrow$ XWR                     | L           | н        | н       | L   | н  | н  | ньь           |
| DIP plus ALUCIN $\rightarrow$ DOP                     | L           | н        | н       | L   | н  | н  | ннн           |
| XWR plus ALUCIN $\rightarrow$ DOP                     | L           | н        | L       | L   | н  | н  | ннн           |
| *DIP plus ALUCIN → DOP                                | L           | н        | н       | L   | н  | н  | L L L         |
| *WR plus ALUCIN $\rightarrow$ DOP                     | L           | н        | L       | L   | н  | н  | LLL           |
| DIP plus ALUCIN $\rightarrow$ WR                      | L           | н        | н       | L   | н  | н  | ГГН           |
|   | OP3         | OP2      | OP1     | OP0 | D1 | D0 | S2 S1 S0      |
| $\overline{WR}$ plus ALUCIN $\rightarrow RF$          | L           | н        | L       | н   | L  | L  | RF: LLL → HHH |
| RF plus ALUCIN → WR                                   | L           | н        | н       | н   | L  | н  | RF: LLL → HHH |
| $\overline{WR}$ plus ALUCIN $\rightarrow XWR$         | L           | н        | L       | н   | н  | н  | нсь           |
| $\overline{XWR}$ plus ALUCIN $\rightarrow WR$         | L           | н        | L       | н   | н  | н  | ГНН           |
| $\overline{\text{DIP}}$ plus ALUCIN $\rightarrow$ WR  | L           | н        | н       | н   | н  | н  | СНН           |
| $\overline{\text{DIP}}$ plus ALUCIN $\rightarrow$ XWR | L           | н        | н       | н   | н  | н  | ніі           |
| $\overline{\text{DIP}}$ plus ALUCIN $\rightarrow$ DOP | L           | н        | н       | н   | н  | н  | ннн           |
| $\overline{XWR}$ plus ALUCIN $\rightarrow$ DOP        | L           | н        | L       | н   | н  | н  | ннн           |
| * DIP plus ALUCIN → DOP                               | L           | н        | н       | н   | н  | н  | LLL           |
| *₩R plus ALUCIN → DOP                                 | L           | н        | L       | н   | н  | н  | LLL           |
| *DIP plus ALUCIN → WR                                 | L           | н        | н       | н   | н  | н  | ГГН           |
|   | OP3         | OP2      | OP1     | OPO | D1 | D0 | S2 S1 S0      |
| * XWB $\rightarrow$ AOP, otherwise WB $\rightarrow$ A | OP. PC PRIC | BITY ove | rrides. |     |    |    |               |

# TABLE 24 REGISTER TRANSFER OPERATIONS

\* XWR  $\rightarrow$  AOP, otherwise WR  $\rightarrow$  AOP. PC PRIORITY overrides.

Certain ALU functions may be selected from Table 22 to facilitate register "clear" (all logic-level LOWs) and register "preset" (all logic-level HIGHs) operations. These ALU functions, when impressed upon the operations of Table 23, specify the register "clear" and "preset" operations of Table 25.

|                                       | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 S1 S0     |
|---------------------------------------|-----|-----|-----|-----|----|----|--------------|
| $LOW \rightarrow RF$ , ALUCIN = HIGH  | L   | L   | L   | L   | L  | L  | RF: LLL→ HHH |
| $LOW \rightarrow WR$ , ALUCIN = HIGH  | L   | L   | L   | L   | н  | н  | LНН          |
| *LOW → WR, ALUCIN = HIGH              | L   | L   | L   | L   | н  | н  | LLH          |
| LOW $\rightarrow$ XWR, ALUCIN = HIGH  | L   | L   | L   | L   | н  | н  | ннс          |
| LOW $\rightarrow$ DOP, ALUCIN = HIGH  | L   | L   | L   | L   | н  | н  | ннн          |
| *LOW $\rightarrow$ DOP, ALUCIN = HIGH | L   | L   | L   | L   | н  | н  | L L L        |
|                                       | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 S1 S0     |
| $HIGH \rightarrow RF$ , ALUCIN = LOW  | L   | L   | L   | L   | L  | L  | RF: LLL→ HHH |
| HIGH $\rightarrow$ WR, ALUCIN = LOW   | L   | L   | L   | L   | н  | н  | ГНН          |
| *HIGH → WR, ALUCIN = LOW              | L   | L   | L   | L   | н  | н  | LLH          |
| $HIGH \rightarrow XWR$ , ALUCIN = LOW | L   | L   | L   | L   | н  | н  | ннг          |
| HIGH $\rightarrow$ DOP, ALUCIN = LOW  | L   | L   | L   | L   | н  | н  | ннн          |
| *HIGH $\rightarrow$ DOP, ALUCIN = LOW | L   | L   | L   | L   | н  | н  | LLL          |
|                                       | OP3 | OP2 | OP1 | OP0 | D1 | D0 | S2 S1 S0     |

#### TABLE 25 REGISTER CLEAR AND PRESET OPERATIONS

\* XWR  $\rightarrow$  AOP, otherwise WR  $\rightarrow$  AOP. PC PRIORITY = HIGH overrides

#### 5.2.2.2 OP-Field Operand-Source/ALU Function/Operation-Result-Destination Selection

The 4-bit OP-field also interacts with the D-field and S-field to specify the operations of Tables 22 and 23. For these operations, the ALU functions available for operand combination/modification are limited to: 1) plus, 2) minus, and 3) unconditioned ALU-bypass (no ALU functions).
TABLE 26

#### 5.2.3 S-Field, Operation-Select Word

The 3-bit S-field  $(S2 \rightarrow S0)$  of the operation-select word either: 1) specifies one of eight RF locations, shown in Table 26, as an operand source and/or operation-result destination, or 2) extends the 4-bit OP-field to select one of 32 non-RF operations as listed in Table 23.

# 5.3 INDEX TO MICROINSTRUCTIONS BY OPERATION FORM

The operation (microinstruction) set may be sectioned into six operation-forms as described in Tables 27 through 32. Each operation-form may, in turn, be

| RF<br>LOCATION | S2   | S1 | S0 |
|----------------|------|----|----|
| RFO            | L    | L  | L  |
| RF1            | Γ. L | L  | н  |
| RF2            | L    | н  | L  |
| RF3            | L    | н  | н  |
| RF4            | н    | L  | L  |
| RF5            | н    | L  | н  |
| RF6            | н    | н  | L  |
| RF7 (PC)       | н    | н  | н  |

RF SELECTION

#### NOTE: D-FIELD is LL, LH, or HL

subsequently sectioned into a group of operation-types. In general, for each operation type, the WR is automatically selected by the OR to source the AOP via the ADR MUX. The exception to this statement is realized in operation-form I, operation-types a and b where the XWR is automatically selected by the OR to source the AOP via the ADR MUX. Of course, when the PC PRIORITY input is taken to a logic-level high, OR selection of the ADR MUX is overridden. In this situation, the PC is prioritized to source the AOP via the ADR MUX.

In general, the execution results of most operations may be monitored at the DOP whether the result destination is the RF, WR, XWR or DOP itself. The only exceptions are realized when the DOB is not involved in operation execution. These exceptions include the DIP  $\rightarrow$  WR transfer of operation-form III operation-type d, and the XWR portion of the double-precision shift/circulates involved throughout operation-forms IV and VI.

#### 5.3.1 Operation - Form I

Operation form I may be utilized to perform one of 16 ALU functions, selected by the Operation-Select Word OP-field, on two of four operand sources, (RF, WR, XWR, DIP). The result is transferred to one of four operation-result destinations (RF, WR, XWR, DOP).

TABLE 27 OPERATION FORM I

| I  | OPERATION TYPE                | OP3  | $\rightarrow$      | OP0 | D1 | D0 | S2  | S1    | S0    |
|----|-------------------------------|------|--------------------|-----|----|----|-----|-------|-------|
| a. | RF ALU WR → RF                | ALU: | LLLL →             | ннн | L  | L  | RF: | LLL - | → ННН |
| b. | RF ALU WR → WR                | ALU: | LLLL -             | ннн | L  | н  | RF: | LLL - | → ННН |
| c. | *DIP ALU WR → DOP             | ALU: | LLLL →             | ннн | н  | н  | L   | L     | L     |
| d. | *DIP ALU WR → WR              | ALU: | LLLL →             | ннн | н  | н  | L   | L     | н     |
| e. | DIP ALU XWR → WR              | ALU: | $LLLL \rightarrow$ | ннн | н  | н  | L   | н     | н     |
| f. | DIP ALU WR → XWR              | ALU: | LLLL →             | ннн | н  | н  | н   | L     | L     |
| g. | DIP ALU XWR → XWR             | ALU: | LLLL ->            | ннн | н  | н  | н   | н     | L     |
| h. | DIP ALU XWR $\rightarrow$ DOP | ALU: | LLLL →             | ннн | н  | н  | н   | н     | н     |

#### \* XWR $\rightarrow$ AOP, otherwise WR $\rightarrow$ AOP. PC PRIORITY = HIGH overrides

# 5.3.2 Operation -- Form II

Operation form II may be utilized to arithmetically sum one or two operand sources (RF, WR, XWR, DIP) and a ripple-carry-in (ALUCIN). The operationresult is transferred to one of four destinations (RF. WR, XWR, DOP).

| TABLE     | 28      |
|-----------|---------|
| OPERATION | FORM II |

| п  | OPERATION TYPE                            | OP3 → OP0 | D1 | D0 | S2  | S1    | S0  |
|----|---|-----------|----|----|-----|-------|-----|
| a. | RF plus WR plus ALUCIN → XWR              | ггнн      | н  | L  | RF: | LLL - | ннн |
| b. | RF plus DIP plus ALUCIN → WR              | LHLL      | н  | L  | RF: | LLL - | ннн |
| с. | RF plus DIP plus ALUCIN → XWR             | LHLH      | н  | L  | RF: | LLL - | ннн |
| d. | RF plus DIP plus ALUCIN $\rightarrow$ RF  | гннн      | н  | L  | RF: | LLL - | ннн |
| е. | RF plus XWR plus ALUCIN → WR              | ннгг      | н  | Ł  | RF: | LLL - | ннн |
| f. | RF plus XWR plus ALUCIN → XWR             | ннсн      | н  | L  | RF: | LLL - | ннн |
| g. | XWR plus ALUCIN → RF                      | нннг      | н  | L  | RF: | LLL - | ннн |
| h. | DIP plus WR plus ALUCIN $\rightarrow$ XWR | LLНН      | н  | н  | L   | н     | L   |
| i. | DIP plus WR plus ALUCIN $\rightarrow$ DOP | LННН      | н  | н  | L   | н     | L   |
| j. | DIP plus XWR plus ALUCIN → WR             | ннсс      | н  | н  | L   | н     | L   |
| k. | DIP plus XWR plus ALUCIN → XWR            | ннсн      | н  | н  | L   | н     | L   |
| 1. | XWR plus ALUCIN $\rightarrow$ DOP         | нннг      | н  | н  | L   | н     | L   |

NOTE: When PC PRIORITY is LOW, WR → AOP

## 5.3.3 Operation - Form III

Operation form III may be utilized to transfer one or two operand sources (RF, DIP) to one of four destinations (RF, WR, XWR, DOP).

| ш  | OPERATION TYPE       | OP3 → OP0 | D1 | DO | S2  | S1    | SO    |
|----|----------------------|-----------|----|----|-----|-------|-------|
| a. | DIP → RF             | нннн      | н  | L  | RF: | LLL - | → ннн |
| b. | $RF \rightarrow DOP$ | LLLL      | н  | L  | RF: | LLL - | ≁ннн  |
| с. | RF → XWR             | LLLH      | н  | L  | RF: | LLL - | →ннн  |
| d. | DIP → WR             | гннг      | н  | L  | х   | х     | х     |
| u. |                      | гннг      | н  | н  | L   | н     | L     |
| e. | $DIP \to XWR$        | LLLH      | н  | н  | L   | н     | L     |
| f. | DIP → DOP            | нннн      | н  | н  | L   | н     | L     |
| '. |                      | LLLL      | н  | н  | L   | н     | L     |

TABLE 29 **OPERATION FORM III** 

NOTE: When PC PRIORITY is LOW, WR → AOP

#### 5.3.4 Operation - Form IV

Operation form IV may be utilized to either:

- arithmetically sum the WR and the ripple carry-in (ALUCIN) with one of two operand sources (RF, DIP), arithmetically double-precision shift the result to the right, and transfer the shifted result to the WR and XWR;
- arithmetically sum the WR and the ripple carry-in (ALUCIN) with one of two operand sources (RF, DIP), double-precision circulate the result to the left, and transfer the circulated result to the WR and XWR;
- arithmetically subtract one of two operand sources (RF, DIP) and -1 from the WR, arithmetically add the ripple carry-in (ALUCIN), double-precision circulate the result to the left, and transfer the circulated result to the WR and XWR;
- arithmetically subtract one of two operand sources (RF, DIP) and -1 from the WR, arithmetically add the ripple carry-in (ALUCIN), arithmetically double-precision shift the result to the right and transfer the shifted result to the WR and XWR.

| IV | OPERATION TYPE  | OP3 | - | <b>,</b> | OP0 | D1 | D0 | S2  | S1    | S0    |
|----|---|-----|---|----------|-----|----|----|-----|-------|-------|
|    |   |     |   |          |     |    |    |     |       |       |
| a. | (WR minus DIP minus 1 plus ALUCIN, XWR) LCIR → WR, XWR            | н   | L | L        | L   | н  | н  | L   | н     | L     |
| b. | (WR plus DIP plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR         | н   | L | L        | н   | н  | н  | L   | н     | L     |
| с. | (WR minus RF minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | н   | L | L        | L   | н  | L  | RF: | LLL - | + ннн |
| d. | (WR plus RF plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR          | н   | L | L        | н   | н  | L  | RF: | LLL - | → ННН |
|    |   | н   | L | н        | L   | н  | L  | х   | х     | х     |
| e. | (WR plus ALALUCIN, XWR) RSA → XWR                                 | н   | L | н        | L   | н  | н  | L   | н     | L     |
| f. | (WR minus DIP minus 1 plus ALUCIN, XWR) RSA $\rightarrow$ WR, XWR | L   | L | н        | L   | н  | н  | L   | н     | L     |
| g. | (WR plus DIP plus ALUCIN, XWR) RSA → WR, XWR                      | н   | L | н        | н   | н  | н  | L   | н     | L     |
| h. | (WR minus RF minus 1 plus ALUCIN, XWR) RSA → WR, XWR              | L   | L | н        | L   | н  | L  | RF: | LLL - | → ннн |
| i. | (WR plus RF plus ALUCIN, XWR) RSA → WR, XWR                       | н   | L | н        | н   | н  | L  | RF: | LLL - | + ннн |

TABLE 30 OPERATION FORM IV

NOTE: When PC PRIORITY is LOW, WR  $\rightarrow$  AOP

#### 5.3.5 Operation - Form V

Operation form V may be utilized to perform singleprecision shifts on the contents of the WR, placing the result in the WR. The WR may be logically shifted left or right (LSL, RSL), arithmetically shifted left or right (LSA, RSA), or circulated left or right (LCIR, RCIR).

As the WR is passed through the ALU during form V and VI, the ALUCIN is active and should be held at a low logic level for true shifts.

| TABLE     | 31   |   |
|-----------|------|---|
| OPERATION | FORM | v |

| Σ  | OPERATION TYPE                         | OP3 → OP0 | D1 | D0 | S2 | S1 | SO |
|----|--|-----------|----|----|----|----|----|
| a. | (WR plus ALUCIN) RSA → WR              | LLLL      | н  | н  | н  | L  | н  |
|    | b. (WR plus ALUCIN) RCIR → WR          | LLLH      | н  | н  | н  | L  | н  |
| D. |  | нссн      | н  | н  | н  | L  | н  |
| c. | (WR plus ALUCIN) LSA → WR              | LLHL      | н  | н  | н  | L  | н  |
| d. | (WR plus ALUCIN) LCIR → WR             | LLHH      | н  | н  | н  | L  | н  |
| u. | (WR plus ALOCIN) LCIR $\rightarrow$ WR | нснн      | н  | н  | н  | L  | н  |
| e. | (WR plus ALUCIN) RSL → WR              | ньсь      | н  | н  | н  | L  | н  |
| f. | (WR plus ALUCIN) LSL → WR              | нгнг      | н  | н  | н  | L  | н  |

NOTE: When PC PRIORITY is LOW, WR → AOP

# 5.3.6 Operation - Form VI

Operation form VI may be utilized to perform doubleprecision shifts on the contents of WR in conjunction with XWR. The WR in conjunction with the XWR may be:

- logically shifted left or right (LSL, RSL);
- arithmetically shifted left or right (LSA, RSA) single- or doublesigned;
- circulated left or right (LCIR, RCIR).

| TABLE 32       |   |
|----------------|---|
| OPERATION FORM | v |

| V  | OPERATION TYPE                           | OP3 → OP0 | D1 | D0 | R2 | R1 | R0 |
|----|--|-----------|----|----|----|----|----|
| a. | (WR plus ALUCIN, XWR) RSA →<br>(WR, XWR) | ГНГГ      | н  | н  | н  | L  | н  |
| b. | (WR plus ALUCIN, XWR) RCIR →             | гнгн      | н  | н  | н  | L  | н  |
|    | (WR, XWR)                                | ннсн      | н  | н  | н  | L  | н  |
| c. | (WR plus ALUCIN, XWR) LSA →<br>(WR, XWR) | LННL      | н  | н  | н  | L  | н  |
| d. | (WR plus ALUCIN, XWR) LCIR →             | гннн      | н  | н  | н  | L  | н  |
|    | (WR, XWR)                                | нннн      | н  | н  | н  | L  | н  |
| e. | (WR plus ALUCIN, XWR) RSL →<br>(WR, XWR) | ннсс      | н  | н  | н  | L  | н  |
| f. | (WR plus ALUCIN, XWR) LSL →<br>(WR, XWR) | нннг      | н  | н  | н  | L  | н  |

NOTE: When PC PRIORITY is LOW, WR → DOP

# 5.4 INDEX TO MICROINSTRUCTIONS BY SOURCE OPERANDS

When the source operand is known, tables 33 through 36 can be used to obtain the form/type and microcode of the possible operations for that source operand.

| OPERATION                                | OP<br>FORM/TYPE | OP3 → OP0<br>OP FIELD   | D1 D0<br>D-FIELD | S2 → S0<br>S-FIELD |
|--|-----------------|-------------------------|------------------|--------------------|
| DIP → DOP                                | 1114            | нннн                    | НН               | LHL                |
| DIP → DOP                                | 111f            | LLLL                    | нн               | LHL                |
| DIP → RF                                 | Illa            | нннн                    | HL               | LLL →HHH           |
| DIP → WR                                 | IIId            | LHHL                    | HL               | xxx                |
| DIP → WR                                 | IIId            | LHHL                    | НН               | LHL                |
| DIP → XWR                                | llle            | LLLH                    | нн               | LHL                |
| *DIP ALU WR → DOP                        | lc              | LLLL → HHHH             | нн               | LLL                |
| *DIP ALU WR → WR                         | ld              | $LLLL \rightarrow HHHH$ | нн               | LLH                |
| DIP ALU WR → XWR                         | lf              | LLLL → HHHH             | нн               | HLL                |
| DIP ALU XWR → DOP                        | lh              | LLLL → HHHH             | нн               | ннн                |
| DIP ALU XWR → WR                         | le              | LLLL → HHHH             | нн               | LHH                |
| DIP ALU XWR → XWR                        | lg              | LLLL → HHHH             | нн               | HHL                |
| (DIP plus WR plus ALUCIN) LCIR → WR, XWR | IVb             | HLLH                    | нн               | LHL                |
| (DIP plus WR plus ALUCIN) RSA → WR, XWR  | IVq             | HLHH                    | нн               | LHL                |
| DIP plus RF plus ALUCIN → RF             | lid             | ЦННН                    | HL               | LLL → HHH          |
| DIP plus RF plus ALUCIN → WR             | lib             | LHLL                    | HL               | LLL → HHH          |
| DIP plus RF plus ALUCIN → XWR            | lic             | LHLH                    | HL               | LLL → HHH          |
| DIP plus WR plus ALUCIN → DOP            | lli,llh         | LHHH                    | нн               | LHL                |
| DIP plus WR plus ALUCIN → XWR            | llh             | LLHH                    | нн               | LHL                |
| DIP plus XWR plus ALUCIN → WR            | Hj              | HHLL                    | нн               | LHL                |
| DIP plus XWR plus ALUCIN → XWR           | lik             | HHLH                    | нн               | LHL                |

# TABLE 33 DIP SOURCE OPERANDS

\* XWR  $\rightarrow$  AOP, otherwise WR  $\rightarrow$  AOP. PC PRIORITY = HIGH overrides.

| OPERATION                                    | OP<br>FORM/TYPE | OP3 → OP0<br>OP FIELD | D1 D0<br>D-FIELD | S2 → S0<br>S-FIELD    |
|--|-----------------|-----------------------|------------------|-----------------------|
|  |                 |                       |                  |                       |
| $RF \rightarrow DOP$                         | IIIb            | LLLL                  | HL               | $LLL \rightarrow HHH$ |
| $RF \rightarrow XWR$                         | IIIc            | LLLH                  | HL               | LLL → HHH             |
| RF ALU WR → RF                               | la              | LLLL → HHHH           | LL               | LLL → HHH             |
| RFALUWR → WR                                 | lb              | LLLL → HHHH           | LH               | LLL → HHH             |
| RF plus DIP plus ALUCIN $\rightarrow$ RF     | lld             | LННН                  | HL               | LLL → HHH             |
| RF plus DIP plus ALUCIN → WR                 | Пр              | LHLL                  | HL               | LLL → HHH             |
| RF plus DIP plus ALUCIN → XWR                | llc             | LHLH                  | HL               | LLL → HHH             |
| (RF plus WR plus ALUCIN, XWR) LCIR → WR, XWR | IVd             | HLLH                  | HL               | LLL → HHH             |
| (RF plus WR plus ALUCIN, XWR) RSA → WR, XWR  | IVi             | нінн                  | HL               | $LLL \rightarrow HHH$ |
| RF plus WR plus ALUCIN → XWR                 | lla             | LLHH                  | HL               | LLL → HHH             |
| RF plus XWR plus ALUCIN → WR                 | lle             | HHLL                  | HL               | $LLL \rightarrow HHH$ |
| RF plus XWR plus ALUCIN → XWR                | llf             | ннін                  | HL               | $LLL \rightarrow HHH$ |

TABLE 34 RF SOURCE OPERANDS

NOTE: When PC PRLORITY is LOW, WR  $\rightarrow$  AOP.

# TABLE 35 XWR SOURCE OPERANDS

| OPERATION                      | OP<br>FORM/TYPE | OP3 → OP0<br>OP FIELD | D1 D0<br>D-FIELD | S2 → S0<br>S-FIELD    |
|--------------------------------|-----------------|-----------------------|------------------|-----------------------|
| XWR ALU DIP → DOP              |                 |                       |                  |                       |
|                                | lh              | LLLL → HHHH           | нн               | ннн                   |
| XWR ALU DIP → WR               | le              | LLLL → HHHH           | нн               | LHH                   |
| XWR ALU DIP → XWR              | lg              | LLLL → HHHH           | нн               | HHL                   |
| XWR plus ALUCIN → DOP          | 111             | HHHL                  | нн               | LHL                   |
| XWR plus ALUCIN → RF           | llj             | HHHL                  | HL               | $LLL \rightarrow HHH$ |
| XWR plus DIP plus ALUCIN → WR  | llk             | HHLL                  | нн               | LHL                   |
| XWR plus DIP plus ALUCIN → XWR | lle             | HHLH                  | нн               | LHL                   |
| XWR plus RF plus ALUCIN → WR   | 11f             | HHLL                  | HL               | LLL → HHH             |
| XWR plus RF plus ALUCIN → XWR  |                 | ннгн                  | HL               | LLL → HHH             |

NOTE: When PC PRIORITY is LOW, WR -> AOP.

| OPERATION  | OP<br>FORM/TYPE | OP3 → OP0<br>OP-FIELD | D1 D0<br>D-FIELD | S2 → S0<br>S-FIELD    |
|--|-----------------|-----------------------|------------------|-----------------------|
|  |                 |                       |                  |                       |
| *WR ALU DIP $\rightarrow$ DOP                                      | lc              | LLLL → HHHH           | нн               | LLL                   |
| *WR ALU DIP → WR   | ld              | LLLL → HHHH           | нн               | LLH                   |
| WR ALU DIP $\rightarrow$ XWR                                       | If              | LLLL → HHHH           | нн               | HLL                   |
| WR ALU RF → RF   | la              | LLLL → HHHH           | LL               | LLL → HHH             |
| WR ALU RF → WR   | lb              | $LLLL\toHHHH$         | LH               | $LLL \rightarrow HHH$ |
| (WR minus BIP minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR | IVa             | HLLL                  | нн               | LHL                   |
| (WR minus DIP minus 1 plus ALUCIN, XWR) RSA $\rightarrow$ WR, XWR  | IVf             | LLHL                  | нн               | LHL                   |
| (WR minus RF minus 1 plus ALUCIN, XWR) LCIR $\rightarrow$ WR, XWR  | IVc             | HLLL                  | HL               | $LLL \rightarrow HHH$ |
| (WR minus RF minus 1 plus ALUCIN, XWR) RSA → WR, XWR               | IVh             | LLHL                  | HL               | $LLL \rightarrow HHH$ |
| (WR plus ALUCIN) RSA $\rightarrow$ WR, XWR                         | IVe             | HLHL                  | HL               | xxx                   |
| (WR plus ALUCIN) RSA → WR, XWR                                     | IVe             | HLHL                  | нн               | LHL                   |
| (WR plus ALUCIN) LCIR → WR   | Vd              | LLHH                  | нн               | HLH                   |
| (WR plus ALUCIN) LCIR → WR   | Vd              | HLHH                  | нн               | HLH                   |
| (WR plus ALUCIN) LSA → WR  | Vc              | LLHL                  | нн               | HLH                   |
| (WR plus ALUCIN) LSL → WR  | Vf              | HLHL                  | нн               | HLH                   |
| (WR plus ALUCIN) RCIR → WR   | Vb              | LLLH                  | нн               | HLH                   |
| (WR plus ALUCIN) RCIR $\rightarrow$ WR                             | Vb              | HLLH                  | нн               | HLH                   |
| (WR plus ALUCIN) RSA → WR  | Va              | LLLL                  | нн               | HLH                   |
| (WR plus ALUCIN) RSL → WR  | Ve              | HLLL                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) LCIR → (WR, XWR)                             | VId             | нннн                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) LCIR → (WR, XWR)                             | VId             | LHHH                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) LSA → (WR,XWR)                               | VIc             | LHHL                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) LSL $\rightarrow$ (WR, XWR)                  | VIf             | нннг                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) RCIR → (WR, XWR)                             | VIb             | HHLH                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) RCIR → (WR, XWR)                             | VIb             | LHLH                  | нн               | нгн                   |
| (WR plus ALUCIN, XWR) RSA → (WR, XWR)                              | VIa             | LHLL                  | нн               | HLH                   |
| (WR plus ALUCIN, XWR) RSL → (WR,XWR)                               | Vle             | HHLL                  | нн               | HLH                   |
| WR plus DIP plus ALUCIN → DOP                                      | Hi              | LННН                  | нн               | LHL                   |
| WR plus DIP plus ALUCIN → XWR                                      | Ilh             | LLHH                  | нн               | LHL                   |
| (WR plus DIP plus ALUCIN) LCIR → WR, XWR                           | IVb             | HLLH                  | нн               | LHL                   |
| (WR plus DIP plus ALUCIN) RSA → WR, XWR                            | IVc             | нінн                  | нн               | LHL                   |
| WR plus RF plus ALUCIN → XWR                                       | lla             | LLHH                  | HL               | LLL HHH               |
| (WR plus RF plus ALUCIN) LCIR → WR, XWR                            | IVd             | HLLH                  | HL               | LLL HHH               |
| (WR plus RF plus ALUCIN) RSA → WR, XWR                             | IVi             | нінн                  | HL               | LLL HHH               |

TABLE 36 WR SOURCE OPERANDS

\* XWR  $\rightarrow$  AOP, otherwise WR  $\rightarrow$  AOP. PC PRIORITY = HIGH overrides.

# 6. INTERFACING

The input/output (I/O) accommodations of these processor elements have been designed for TTL and/or MOS compatibility. Direct interfacing, supportable by the entire families of catalog devices, is shown in Figure 22. Typical data/address flow and microcontrol are illustrated for an expanded wordlength system.

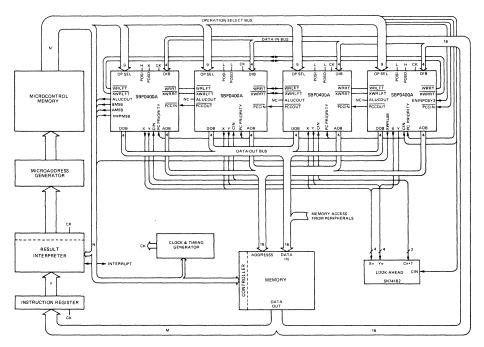


FIGURE 22 - TYPICAL 16-BIT MACHINE

# 6.1 INPUT CIRCUIT

The input circuit used on the '0400A/'0401A is basically an RTL configuration which has been modified for TTL/MOS compatibility as shown in Figure 23A. An input-clamping diode is incorporated to limit negative excursions (ringing) when the '0400A/'0401A is on the receiving end of a transmission line; an input switching threshold of nominally +1.5 volts has been specified for improved noise immunity. This threshold is achieved via two 10K ohm resistors which function as a voltage divider to increase the one VBE threshold of the  $I^2L$  input transistor to +1.5 volts. Since this input circuit is independent of injector current, input threshold compatibility is maintained over the entire speed X power performance spectrum.

The input circuit characteristics for input current versus input voltage are shown in Figure 24. The 10K and 20K ohm load lines and threshold knee at +1.5 volts provide a high-impedance characteristic to reduce input loading and improve the low-logic level input noise immunity over some standard TTL inputs. Full compatibility is maintained with virtually all 5 volt logic families even when the '0400A/'0401A is powered down (injector current reduced).

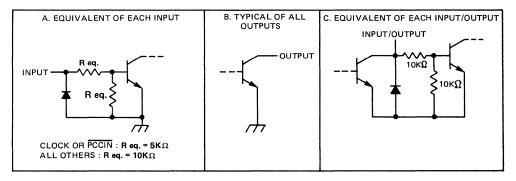


FIGURE 23 - SCHEMATICS OF EQUIVALENT INPUTS, OUTPUTS, INPUTS/OUTPUTS

#### 6.1.1 Sourcing Inputs

The inputs may be sourced directly by most 5 volt logic families. Five volt functions which feature internal pull-up resistors at their outputs require no external interface components; five volt functions which feature open-collector outputs generally require external pull-up resistors which may be specified as shown in Table 37.

#### 6.1.2 Terminating Unused Inputs

Inputs which are selected to be hardwired to a logic-level low may be connected directly to ground. Inputs which are selected to be hardwired to a logic-level high must be tied, via a current limiting (pull-up) resistor, to a logic-level-high low-impedance voltage source such as  $V_{CC}$ . A single transient protecting resistor, specified as shown in Table 38, may be utilized common to (N) inputs.



The output circuit selected for the '0400A/ '0401A is an injected open-collector transistor

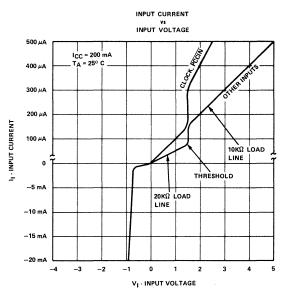


FIGURE 24 - TYPICAL INPUT CHARACTERISTICS

shown in Figure 23B. Since this transistor is injected, output sourcing capability is directly related to injector current. In other words, the number of loads which may be sourced by an '0400A/'0401A output is directly reduced as injector current is reduced.

The output circuit characteristic for logic-level low output voltage (VOL) versus logic-level low output current (IOL) is shown in Figure 25. At rated injector current; the '0400A/'0401A output circuit offers a low-level output voltage of typically 65mV.

#### TABLE 37 SOURCING SBP0400 INPUTS

|  | CLOCK OR PCCIN                              | ALL OTHER INPUTS                             |  |  |  |  |
|--|---|--|--|--|--|--|
| SOURCED BY OPEN-COLLECTOR<br>TTL, CMOS | $R_p = \frac{V_{CC} - 3.3}{.0005 (N)}$      | $R_{P} = \frac{V_{CC} - 3.3}{.00025 (N)}$    |  |  |  |  |
| SOURCED BY MOS, CMOS:<br>LOW-THRESHOLD | $R_B = \frac{V_{CC} - 2.4}{I_{OH}0005 (N)}$ | $R_B = \frac{V_{CC} - 2.4}{I_{OH}00025 (N)}$ |  |  |  |  |
| HIGH-THRESHOLD                         | NOT RECOMMENDED                             |  |  |  |  |  |
| SOURCED BY TTL WITH 5 V ACTIVE PULL-UP | DRIVE DIRECTLY                              |  |  |  |  |  |

TABLE 38 TERMINATING UNUSED INPUTS

|                             | PCCIN INPUT                            | ALL OTHER INPUTS                        |
|-----------------------------|--|---|
| HARDWIRE TO V <sub>IH</sub> | $R_p = \frac{V_{CC} - 3.3}{.0005 (N)}$ | $R_p = \frac{V_{CC} - 3.3}{.00025 (N)}$ |

The output circuit characteristics for 1) logic-level high output voltage ( $V_{OH}$ ) and current ( $I_{OH}$ ), 2) rise times, and 3) next stage input noise immunity, are a function of the load circuit being sourced. The load circuit may be either:

 A) the direct input, if no source current is required, of a five-volt logic family function,

or, for greater noise immunity and improved rise times,

B) the direct input of a five-volt logic family function in conjunction with a discrete pull-up resistor.

When a discrete pull-up resistor (RL) is utilized, the fanout requirements placed on a particular '0400A/ '0401A output restrict both the maximum and minimum value of RL. Techniques for calculating RL(max) and RL(min) respectively are explained in Figure 26. Table 39 provides RL(max) and RL(min) values for one, five, nine, or ten loads for the more popular five-volt logic families.

#### OUTPUT VOLTAGE vs OUTPUT CURRENT

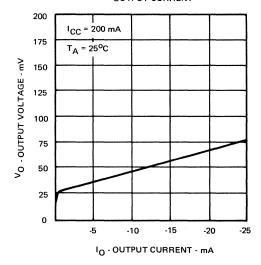


FIGURE 25 - TYPICAL OUTPUT CHARACTERISTICS

# 6.2.1 RL(max) Calculation for Output Source Current

The maximum load register  $R_{L(max)}$  value insures: 1) that sufficient current is available to satisfy both the fanout and logic-level-high output current requirements, and 2) that the voltage drop across  $R_{L}$  itself is insufficient to reduce the logic-level-high output voltage below 2.4 volts.  $R_{L(max)}$  can be calculated as shown in Figure 26A.

#### HIGH-LEVEL (OFF-STATE) CIRCUIT CALCULATIONS

The allowable voltage drop across the load resistor (V\_RL) is the difference between the pull-up source and the V\_OH level required at the load:

V<sub>RL</sub> = V<sub>source</sub> - V<sub>OH</sub> min

The total current through the load resistor (I\_RL) is the sum of the load current and the high-level output current (I\_OH):

 $I_{RL}$  = Load Current (into the load inputs +  $I_{OH}$ where:  $I_{OH}$  = 375  $\mu$ A max

Therefore, calculations for the maximum value of RL would be:

$$R_{L(max)}$$
 in ohms =  $\frac{V_{source} - V_{OH min}}{Amperes of Load Current + .000375}$ 

#### LOW-LEVEL (ON-STATE) CIRCUIT CALCULATIONS

The maximum current through the load resistor when the output is on, plus the amount of current from the low-level input load, must be limited to the  $I_{OL}$  capability of the output. Therefore, the equation is:

V<sub>source</sub>

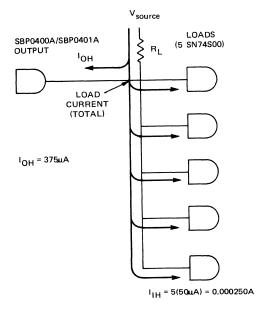
IRI

LOADS

(5 SN74S00)

SBP0400A/SBP0401A

OUTPUT

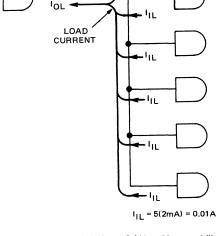




$$R_{L(max)} = \frac{V_{source} - V_{OH}}{I_{load} + 0.000375}$$

$$\mathsf{R}_{\mathsf{L}(\mathsf{max})} = \frac{5 - 2.4}{0.00025 + 0.000375} \ \Omega = \frac{2.6}{0.000625} \ \Omega = 4160$$

# A. RL MAXIMUM CALCULATIONS



Assume:  $V_{source} = 5 V$ ,  $V_{OL} = 0.4 V$ , and  $I_{OL}$  capability = 20 mA

$$R_{L(min)} = \frac{V_{source} - V_{OL}}{I_{OL} capability - I_{IL}}$$

$$\mathsf{R}_{\mathsf{L}(\mathsf{min})} = \frac{5 - .4}{0.02 - 0.01} \ \Omega = \frac{4.6}{0.01} \ \Omega = 460 \ \Omega$$

# B. RL MINIMUM CALMCLATIONS

# FIGURE 26 – OUTPUT LOAD RESISTOR CALCULATIONS

4

| SBP0400<br>OUTPUT | DRIVING<br>1 Load |                | DRIVING<br>5 Loads |                | DRI<br>10 I  | TYPE OF<br>LOGIC |           |
|-------------------|-------------------|----------------|--------------------|----------------|--------------|------------------|-----------|
| TYPE              | RL(MIN)           | RL(MAX)        | RL(MIN)            | RL(MAX)        | RL(MIN)      | RL(MAX)          |           |
|                   |                   |                |                    |                |              |                  |           |
|                   | <b>234</b> Ω      | <b>6190</b> Ω  | <b>252</b> Ω       | 5200 Ω         | <b>280</b> Ω | <b>4333</b> Ω    | 54LS/74LS |
| 20 mA             | 250 Ω             | 5909 Ω         | <b>383</b> Ω       | <b>4333</b> Ω  | 1150 Ω       | <b>3250</b> Ω    | 54/74     |
| SINK              | <b>256</b> Ω      | 5777 Ω         | <b>46</b> 0 Ω      | 4160 Ω         | 2300 Ω       | <b>2888</b> Ω    | 54S/74S   |
| OUTPUTS           | 230 Ω             | <b>634</b> 1 Ω | 230 \              | 5777 Ω         | 231 Ω        | <b>5200</b> Ω    | MOS       |
|                   | 230 Ω             | 6500 Ω         | 230 Ω              | 6500 Ω         | 231 Ω        | <b>6498</b> Ω    | C-MOS     |
|                   |                   |                |                    |                | TYPE OF LOGI | c                |           |
|                   | 477 Ω             | <b>6190</b> Ω  | 560 Ω              | 5200 Ω         | 54LS/74LS    |                  |           |
| 10 mA             | 547 Ω             | 5909 Ω         | <b>2300</b> Ω      | 4333 Ω         | 54/74        |                  |           |
| SINK              | 575 Ω             | 5777 Ω         | 4000 Ω             | 4000 Ω         | 54S/74S      |                  |           |
| OUTPUTS           | <b>464</b> Ω      | <b>6341</b> Ω  | <b>462</b> Ω       | 5777 Ω         | MOS          |                  |           |
|                   | <b>46</b> 0 Ω     | 6500 Ω         | 460 \2             | <b>6</b> 500 Ω | C-MOS        |                  |           |

# TABLE 39 OUTPUT LOAD RESISTOR VALUES (RL)

Specific designs can be tailored for minimum power or maximum performance by making the individual calculations as described in Figure 26.

# CONDITIONS:

V<sub>source</sub> = 5 V VOH = 2.4 V (Satisfies most 5 V logic) VOL = 0.4 V (Based on max noise margin provided by SBP0400A/SBP0401A  $I_{OH} = 375 \,\mu A$  (Maximum leakage of SBP0400A/SBP0401A) IOL as specified (20 mA, 10 mA) And unit loads of: **ηΓ** = ЧН = 54LS/74LS 0.36 mA 10 µA 54/74 1.6 mA 40 µA 54S/74S 2 mA 50 µA N-MOS 10 µA 10 µA C-MOS 10 pA 10 pA

# 6.2.2 RL(min) Calculation for Output Source Current

The minimum load resistor  $R_{L(min)}$  value insures that the arithmetic sum of the current through  $R_{L}$  itself plus the sink currents from the various loads will not exceed the low-level current rating (IOL) of the particular output being utilized.  $R_{L(min)}$  may be calculated as shown in Figure 26B.

# 6.3 BIDIRECTIONAL INPUT/OUTPUT CIRCUIT

The bidirectional input/output circuit, shown in Figure 23C, is simply a "marriage" of the separate input and output circuits, with the respective electrical characteristics described above.

# 7. POWER SOURCE

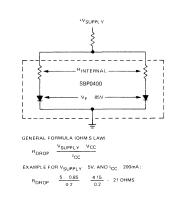
1<sup>2</sup>L is a current-injected logic. When placed across a curve tracer, the processor element will resemble a silicon switching diode. Any voltage or current source capable of supplying the desired current at the injector node voltage

required will suffice (see Table 40). A dry-cell battery, a 5-volt TTL power supply, a programmable current supply (for power-up/power-down operation) – literally whatever power source is convenient can be used for most cases. For example, if a 5-volt TTL power supply is to be used, a series dropping resistor would be connected between the 5-volt supply and the injector pins of the  $I^2L$  device, as illustrated in Figure 27, to select the desired operating current. In expanded systems using multiple 4 bit slices, an individual dropping resistor is required for each SBP0400A/ SBP0401A.

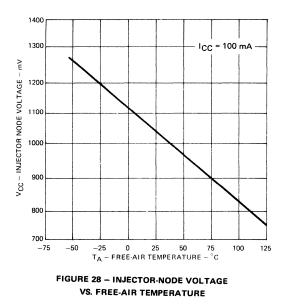
Figures 28 and 29 show the typical injector node voltages which occur across the temperature and injector current ranges. Table 40 provides the approximate resistor values for various combinations of supply voltages and operating injector currents.

| 0.01 mA 0.1 mA 10 mA 100 mA 200 mA |         |        |      |       |        |        |                   |  |  |  |
|------------------------------------|---------|--------|------|-------|--------|--------|-------------------|--|--|--|
|                                    | 0.01 mA | 0.1 mA | 1 mA | 10 mA | 100 mA | 200 mA | Supply<br>Voltage |  |  |  |
| (SM                                | 1,1M    | 114K   | 11K  | 1.1K  | 110    | 56     | 12V               |  |  |  |
| Ð                                  | 840K    | 84K    | 8.4K | 830   | 82     | 41     | 9V                |  |  |  |
|                                    | 540K    | 54K    | 5.4K | 530   | 52     | 26     | 6∨                |  |  |  |
| VALUE                              | 440K    | 44K    | 4.4K | 430   | 42     | 21     | 5V                |  |  |  |
|                                    | 390K    | 39K    | 3.9K | 380   | 37     | 18     | 4.5V              |  |  |  |
| RDROP                              | 240K    | 24K    | 2.4K | 230   | 22     | 11     | 3V                |  |  |  |
| <sup>2</sup> DF                    | 90K     | 9K     | 960  | 82    | 7      | 3.25   | 1.5V              |  |  |  |
| 1                                  | 63K     | 6K     | 550  | 50    | 4      | 1.75   | 1.2V              |  |  |  |

TABLE 40



#### FIGURE 27 – INJECTOR CURRENT CALCULATIONS



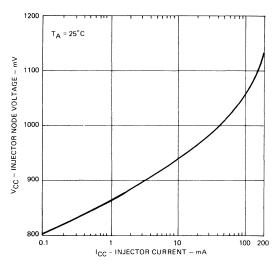


FIGURE 29 – INJECTOR-NODE VOLTAGE VS. INJECTOR CURRENT

# 8. ELECTRICAL AND MECHANICAL SPECIFICATIONS

# 8.1 RECOMMENDED OPERATING CONDITIONS, UNLESS OTHERWISE NOTED ICC = 200 mA

|                                       |                               | SE  | 3P0400/ | ٨M  | SI  | 3P0400/ | AC  | UNIT |
|---------------------------------------|-------------------------------|-----|---------|-----|-----|---------|-----|------|
|                                       |                               | MIN | NOM     | MAX | MIN | NOM     | MAX | UNIT |
| Supply current, ICC                   |                               |     | 200     | 300 |     | 200     | 300 | mA   |
| High-level output voltage, VOH        |                               |     |         | 5.5 |     |         | 5.5 | V    |
|                                       | Any AOP, X, Y, ALUCOUT, DOP,  |     |         | 20  |     |         | 20  |      |
|                                       | or XWR MSB/LSB                |     |         | 20  |     |         | 20  | mA   |
| Low-level output current, IOL         | XWRLFT, XWRRT, WRRT, WRLFT,   |     |         | 10  |     |         | 10  | mA   |
|                                       | PCCOUT/BMSB, ENINCBY 2/AMSB   |     |         | 10  |     |         | 10  |      |
|                                       | High                          |     | 255     |     |     | 230     |     |      |
| Width of clock pulse, tw              | Low                           |     | 50      |     |     | 45      |     | ns   |
|                                       | OPERATION SELECT (0400A ONLY) |     | 78      |     |     | 70      |     |      |
|                                       | PCCIN                         |     | 28      |     |     | 25      |     | ]    |
| Setup time, t <sub>su</sub>           | $DIP \rightarrow RF, WR, XWR$ |     | 110     |     |     | 100     |     | ns   |
| (See Figure 30)                       | DIP THRU ALU                  | 1   | 200     |     |     | 180     |     | 1    |
|                                       | ALUCIN                        |     | 132     |     |     | 120     |     | 1    |
| Hold time, the (any input)            |                               |     | 0†      |     |     | 10      |     | ns   |
| Operating free-air temperature, $T_A$ |                               | -55 |         | 125 | 0   |         | 70  | °C   |

1 Rising edge of clock pulse is reference.

# 8.2 ELECTRICAL CHARACTERISTICS (OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE, UNLESS OTHERWISE NOTED)

| PARAMETER                   |                          | PARAMETER TEST CONDITIONS <sup>†</sup> |                            | SBP0400AM               |     |      | SI   |          |      |      |          |
|-----------------------------|--------------------------|--|----------------------------|-------------------------|-----|------|------|----------|------|------|----------|
|                             | FARAMETER                |  | IEST CON                   | HEST CONDITIONS'        |     | TYP‡ | MAX  | MIN      | TYP‡ | MAX  | UNIT     |
| ⊻ін                         | High-level inpu          | it voltage                             |                            |                         | 2   |      |      | 2        |      |      | V        |
| VIL Low-level input voltage |                          |  |                            |                         |     | 0.8  |      |          | 0.8  | V    |          |
| VIK                         | Input clamp voltage      |  | I <sub>CC</sub> = 200 mA,  | l∣ ≈ −12 mA             |     |      | -1.5 | 1        |      | -1.5 | V        |
| lau                         |                          |  | I <sub>CC</sub> ≈ 200 mA,  | VIH = 2 V               |     |      | 400  | <u> </u> |      |      | <u> </u> |
| юн                          | High-level outp          | High-level output current              |                            | V <sub>OH</sub> ≈ 5.5 V | 400 |      |      |          |      | 250  | μA       |
| Vai                         | Low-level output voltage |  | I <sub>CC</sub> = 200 mA,  | VIH = 2 V               |     |      |      |          |      |      |          |
| VOL                         |                          |  | V <sub>IL</sub> = 0.8 V,   | IOL = MAX               |     | 0.4  |      | 0.4      |      |      |          |
| 4                           | Input current            | Clock, PCCIN                           | la 200 A                   | N                       |     | 500  |      |          | 500  |      |          |
| ·'                          | All other inputs         |  | $I_{CC} = 200 \text{ mA},$ | c = 200 mA, VI = 2.5 V  |     | 250  |      |          | 250  |      | μA       |

<sup>†</sup>For conditions shown as MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at I<sub>CC</sub> = 200 mA, T<sub>A</sub> = 25°C.

| PARAMETER    | FROM          | то                               | TEST CONDITIONS          | TYP MAX | UNIT |
|--------------|---------------|----------------------------------|--------------------------|---------|------|
| tPLH or tPHL | DIP           | DOP                              | VIA A BUS, BYPASS ALU    | 85      | ns   |
| TPLH OF TPHL | DIP           | DOP                              | VIA A BUS, THRU ALU      | 155     | ns   |
| TPLH OF TPHL | DIP           | DOP                              | VIA B BUS, THRU ALU      | 155     | ns   |
| TPLH OF TPHL | PC PRIORITY   | AOP                              |                          | 70      | ns   |
| tPLH or tPHL | ALUCIN        | ALUCOUT                          |                          | 60      | ns   |
| tPLH or tPHL | DIP           | ENINCBY2/AMSB                    | POS0 = X, POS1 = H       | 80      | ns   |
| tPLH or tPHL | DIP           | PCCOUT/BMSB                      | POS0 = X, POS1 = H       | 80      | ns   |
| tPLH or tPHL | POS0, or POS1 | ENINCBY2/AMSB or<br>PCCOUT/BMSB  |                          | 95      | ns   |
| TPLH OF TPHL | PCCIN         | PCCOUT                           |                          | 35      | ns   |
| TPLH OF TPHL | ALUCIN        | DOP                              |                          | 105     | ns   |
| TPLH or TPHL | CLOCK         | PCCOUT/BMSB                      | POS0 = X, POS1 = H       | 140     | ns   |
| tPLH or tPHL | CLOCK         | DOP                              | VIA A BUS, BYPASS ALU    | 155     | ns   |
| tPLH or tPHL | CLOCK         | DOP                              | VIA A BUS, THRU ALU      | 240     | ns   |
| tPLH or tPHL | CLOCK         | ENINCBY2/AMSB                    | POS0 = X, POS1 = H       | 155     | ns   |
| TPLH OF TPHL | CLOCK         | DOP                              | VIA B BUS, THRU ALU      | 225     | ns   |
| tPLH or tPHL | CLOCK         | P.G, or ALUCOUT                  | VIA A OR B BUS, THRU ALU | 180     | ns   |
| TPLH OF TPHL | CLOCK         | AOP                              |                          | 105     | ns   |
| tPLH or tPHL | CLOCK         | WRLFT, WRRT, XWRLFT,<br>or XWRRT |                          | 240     | ns   |
| tPLH Or tPHL | CLOCK         | XWR MUX MSB                      | POS0 = H, POS1 = H       | 130     | ns   |
| TPLH OF TPHL | CLOCK         | XWR MUX LSB                      | POS0 = H, POS1 = L       | 130     | ns   |
| tPLH or tPHL | CLOCK         | ALU = 0                          |                          | 215     | ns   |

# 8.3 SBP0400A AND SBP0401A SWITCHING CHARACTERISTICS ( $I_{CC}$ = 200 mA, $T_A$ = 25°C) SEE FIGURES 30 THROUGH 34

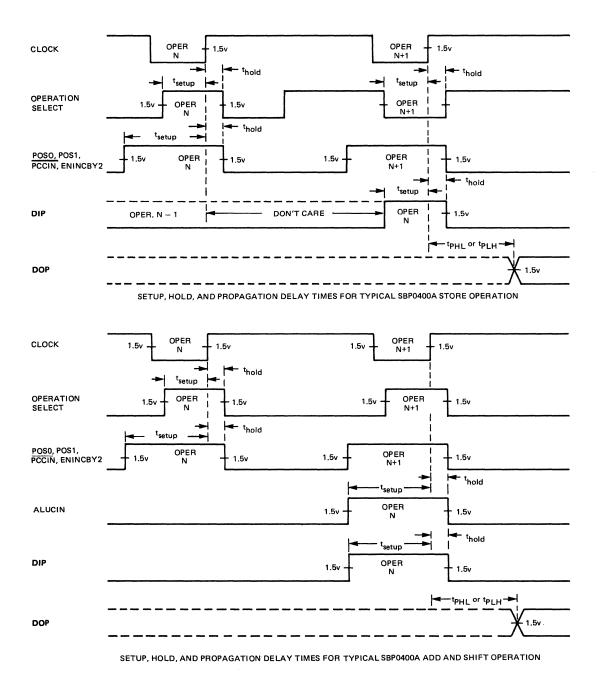
# 8.4 SBP0401A OPERATION SELECT SWITCHING CHARACTERISTICS ( $I_{CC}$ = 200 mA, $T_A$ = 25 °C) SEE FIGURES 31 THROUGH 34

.

| PARAMETER    | FROM   | то               | TEST CONDITIONS          | ΤΥΡ ΜΑΧ | UNIT |
|--------------|--------|------------------|--------------------------|---------|------|
| tPLH or tPHL | OP SEL | XWR MUX MSB      | POS0 = H, POS1 = H       | 175     | ns   |
| tPLH or tPHL | OP SEL | XWR MUX LSB      | POS0 = H, POS1 = L       | 175     | ns   |
| tPLH or tPHL | OP SEL | AOP              |                          | 130     | ns   |
| tPLH or tPHL | OP SEL | ALU = 0          |                          | 215     | ns   |
| tPLH or tPHL | OP SEL | P, G, or ALUCOUT | Via A or B bus, thru ALU | 180     | ns   |
| tPLH or tPHL | OP SEL | DOP              | Via A or B bus, thru ALU | 235     | ns   |
| tPLH or tPHL | OP SEL | AMSB             | POS0 = X, POS1 = H       | 140     | ns   |
| tPLH or tPHL | OP SEL | BMSB             | POS0 = X, POS1 = H       | 175     | ns   |

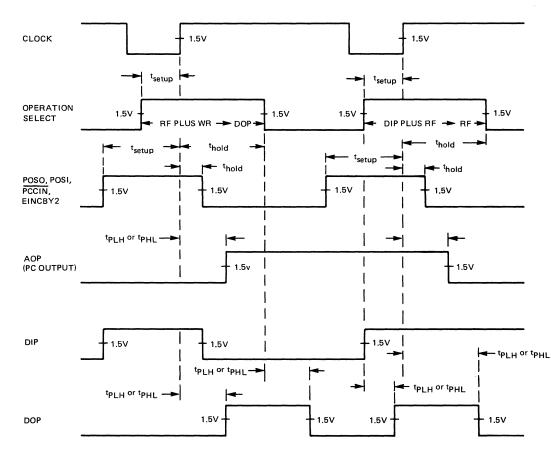
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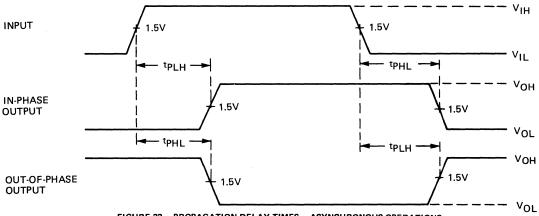
#### FIGURE 30 - PROPAGATION DELAY TIMES - SBP0400A SYNCHRONOUS OPERATIONS

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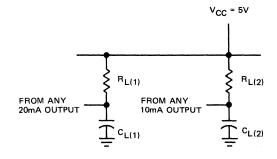


PC PRIORITY IS HIGH

FIGURE 31 - PROPAGATION DELAY TIMES - ASYNCHRONOUS OPERATIONS







| REF. | OUTPUTS   | MAXIMUM<br>CURRENT<br>RATING | R <sub>L</sub> VALUE | C <sub>L</sub> VALUE |
|------|---|------------------------------|----------------------|----------------------|
| 1    | ANY AOB, DOB, P, G, ALUCOUT OR XWR<br>MSB/LSB             | 20 mA                        | <b>280</b> Ω         | 50 PF                |
| 2    | XWRLFT, XWRRT, WRRT, WRLFT,<br>PCCOUT/BMSB, ENINCBY2/AMSB | 10 mA                        | 560 Ω                | 25 PF                |



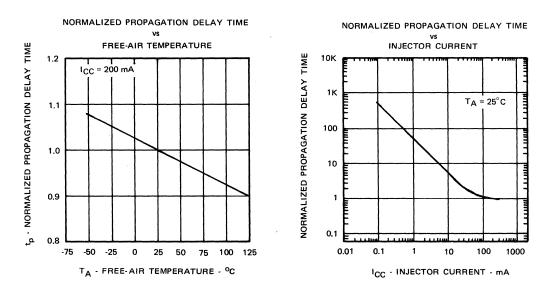
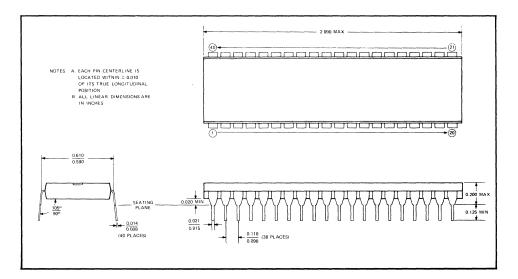
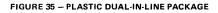


FIGURE 34 - TYPICAL SWITCHING CHARACTERISTICS





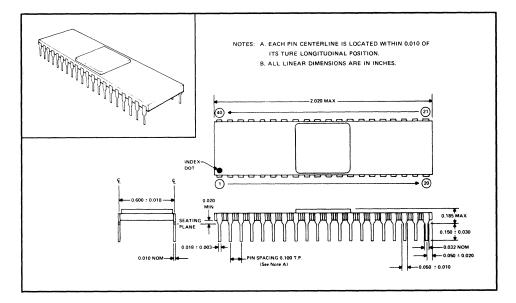


FIGURE 36 -- CERAMIC DUAL-IN-LINE PACKAGE

## 8.5 ORDERING INFORMATION

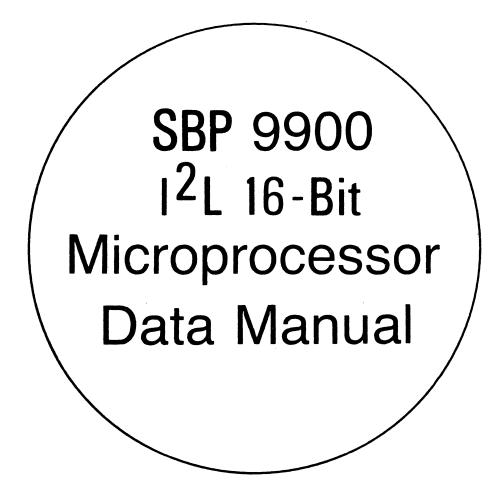
| PACKAGE     | OPERATING<br>TEMPERATURE | PART NUMBERS             |
|-------------|--------------------------|--------------------------|
| PLASTIC DIP | 0°C to 70°C              | SBP0400ACN or SBP0401ACN |
|             | 0°C to 70°C              | SBP0400ACJ or SBP0401ACJ |
| CERAMIC DIP | -55°C to 125°C           | SBP0400AMJ or SBP0401AMJ |

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The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group





OCTOBER 1976

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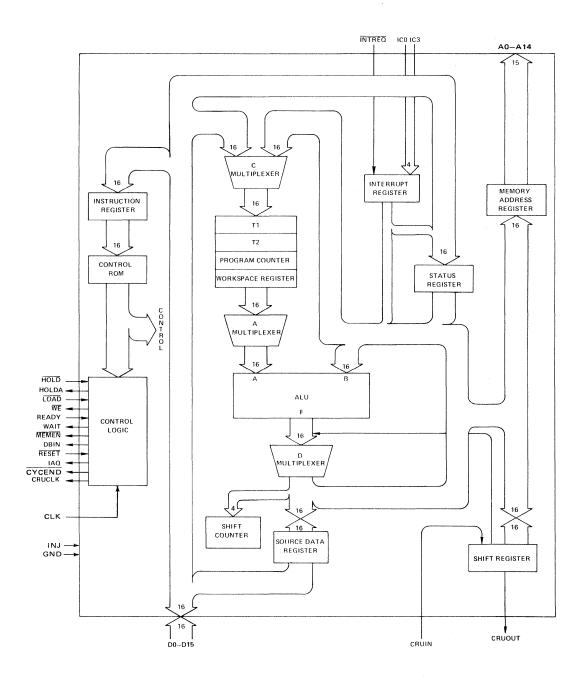


FIGURE 1 - SBP 9900 ARCHITECTURE

## TENTATIVE DATA SHEET

This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

# 1. INTRODUCTION

## 1.1 DESCRIPTION

The SBP 9900 microprocessor is a ruggedized monolithic parallel 16-bit Central Processing Unit (CPU) fabricated with Integrated Injection Logic (I<sup>2</sup>L) technology. The SBP 9900 combines the properties of I<sup>2</sup>L technology with a 16-bit word length, an advanced memory to memory architecture, and a full minicomputer instruction set to extend the end application reach of Texas Instruments 9900 microprocessor family into those applications requiring efficient, stable, reliable performance in severe operating environments. I<sup>2</sup>L technology enables the SBP9900 to operate over a very wide ambient temperature range from a d-c power source with user selectable speed/power performance. Static Logic is used throughout with directly TTL compatible I/O permitting use with standard logic and memory devices and thereby eliminating the need for special clock and interface functions. The SBP 9900 is software compatible with other 9900 microprocessor family members and shares a common body of hardware/software with Texas Instruments 990 minicomputer family.

## 1.2 KEY FEATURES

- Parallel 16-Bit Word Length
- Full Minicomputer Instruction Set Includes Multiply and Divide
- Directly Addresses Up to 65,536 Bytes/32,768 Words of Memory
- Advanced Memory-To-Memory Architecture
- Multiple 16-Word Register Files (Work Spaces) Reside in Memory
- Separate I/O, Memory and Interrupt Bus Structures
- 16 Prioritized Hardware Interrupts
- 16 Software Interrupts (XOPS)
- Programmed and DMA I/O Capability
- Serial I/O Via Communications-Register-Unit (CRU)
- 64-Pin Package
- Software Compatible with TI 9900 Microprocessor/990 Minicomputer Family
- I<sup>2</sup>L Technology:
  - User Selectable Speed/Power Operation
  - 2.6 MHz Nominal Clock at 500 mW
  - Single d-c Power Supply
  - Fully Static Operation
  - Single Phase Clock
  - Directly TTL Compatible I/O (Including Clock)
    - Operates Over Wide Temperature Range:
      - - -55°C to 125°C for SBP 9900M, SBP 9900N (883 B)
      - -40°C to 85°C for SBP 9900E

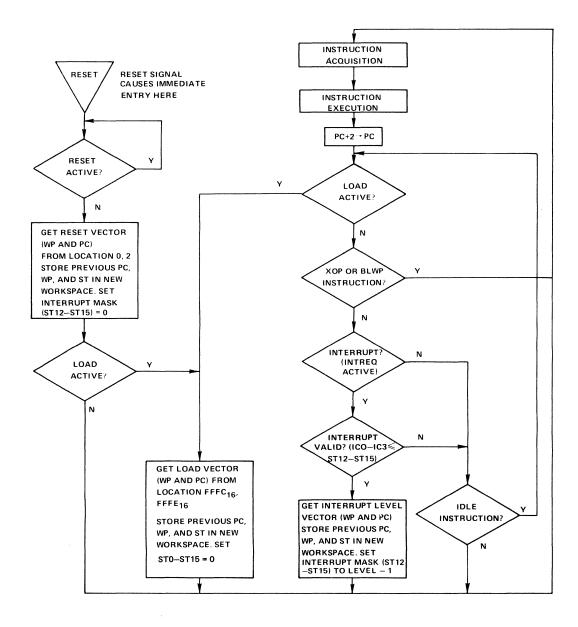
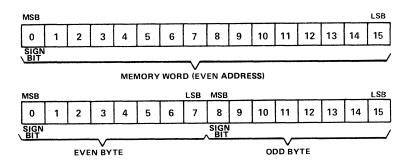
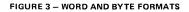


FIGURE 2 - 9900 CPU FLOW CHART

# 2. ARCHITECTURE

The memory word of the 9900 is 16 bits long. Each word is also defined as 2 bytes of 8 bits. The instruction set of the 9900 allows both word and byte operands. Thus, all memory locations are on even address boundaries and byte instructions can address either the even or odd byte. The memory space is 65,536 bytes or 32,768 words. The word and byte formats are shown in Figure 3.





#### 2.1 REGISTERS AND MEMORY

The 9900 employs an advanced memory-to-memory architecture. Blocks of memory designated as workspace replace internal-hardware registers with program-data registers. The 9900 memory map is shown in Figure 4. The first 32 words are used for interrupt trap vectors. The next contiguous block of 32 memory words is used by the extended operation (XOP) instruction for trap vectors. The last two memory words, FFFC16 and FFFE16, are used for the trap vector of the LOAD signal. The remaining memory is then available for programs, data, and workspace registers. If desired, any of the special areas may also be used as general memory.

Three internal registers are accessible to the user. The program counter (PC) contains the address of the instruction following the current instruction being executed. This address is referenced by the processor to fetch the next instruction from memory and is then automatically incremented. The status register (ST) contains the present state of the processor and will be further defined in Section 3.4. The workspace pointer (WP) contains the address of the first word in the currently active set of workspace registers.

A workspace-register file occupies 16 contiguous memory words in the general memory area (see Figure 4). Each workspace register may hold data or addresses and function as operand registers, accumulators, address registers, or index registers. During instruction execution, the processor addresses any register in the workspace by adding the register number to the contents of the workspace pointer and initiating a memory request for the word. The relationship between the workspace pointer and its corresponding workspace is shown in Figure 5.

The workspace concept is particularly valuable during operations that require a context switch which is a change from one program environment to another (as in the case of an interrupt) or to a subroutine. Such an operation, using a conventional multi-register arrangement, requires that at least part of the contents of the register file be stored and reloaded. A memory cycle is required to store or fetch each word. By exchanging the program counter, status register, and workspace pointer in the 9900 concept accomplishes a complete context switch withonly three store cycles and three fetch cycles. See Figure 5. After the switch the workspace pointer contains the starting address of a new 16-word workspace in memory for use in the new routine. A corresponding time saving occurs when the original context is restored. Instructions in the 9900 that result in a context switch include:

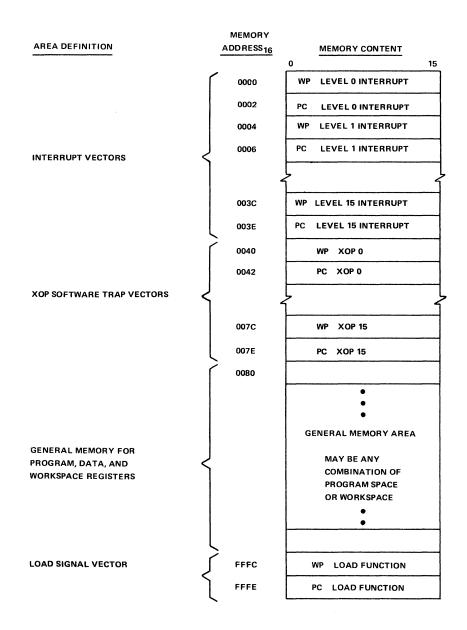
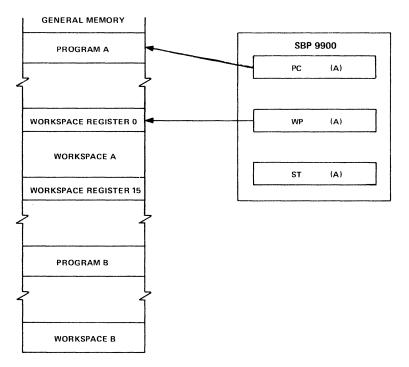


FIGURE 4 - MEMORY MAP



#### FIGURE 5 - MEMORY-TO-MEMORY WORKSPACE CONCEPT

- 1. Branch and Load Workspace Pointer (BLWP)
- 2. Return from Subroutine (RTWP)
- 3. Extended Operation (XOP).

Device interrupts, RESET, and LOAD also cause a context switch by forcing the processor to trap to a service subroutine.

# 2.2 INTERRUPTS

The 9900 employs 16 interrupt levels with the highest priority level 0 and lowest level 15. Level 0 is reserved for the RESET function and all other levels may be used for external devices. The external levels may also be shared by several device interrupts, depending upon system requirements.

The 9900 continuously compares the interrupt code (IC0 through IC3) with the interrupt mask contained in status-register bits 12 through 15. When the level of the pending interrupt is less than or equal to the enabling mask level (higher or equal priority interrupt), the processor recognizes the interrupt and initiates a context switch following completion of the currently executing instruction. The processor fetches the new context WP and PC from the interrupt vector locations. Then, the previous context WP, PC, and ST are stored in workspace registers 13, 14, and 15, respectively, of the new workspace. The 9900 then forces the interrupt mask to a value that is one less than

the level of the interrupt being serviced. This allows only interrupts of higher priority to interrupt a service routine. The processor also inhibits interrupts until the first instruction of the service routine has been executed. All interrupt requests should remain active until recognized by the processor in the device-service routine. The individual service routines must reset the interrupt requests before the routine is complete.

If a higher priority interrupt occurs, a second context switch occurs to service the higher priority interrupt. When that routine is complete, a return instruction (RTWP) restores the first service routine parameters to the processor to complete processing of the lower-priority interrupt. All interrupt subroutines should terminate with the return instruction to restore original program parameters. The interrupt-vector locations, device assignment, enabling-mask value, and the interrupt code are shown in Table 1.

|                      | Vector Location |                   | Interrupt Mask Values To     | Interrupt    |
|----------------------|-----------------|-------------------|------------------------------|--------------|
| Interrupt Level      | (Memory Address | Device Assignment | Enable Respective Interrupts | Codes        |
|                      | In Hex)         |                   | (ST12 thru ST15)             | IC0 thru IC3 |
| (Highest priority) 0 | 00              | Reset             | 0 through F*                 | 0000         |
| 1                    | 04              | External device   | 1 through F                  | 0001         |
| 2                    | 08              | r.                | 2 through F                  | 0010         |
| 3                    | 0C              |                   | 3 through F                  | 0011         |
| 4                    | 10              |                   | 4 through F                  | 0100         |
| 5                    | 14              |                   | 5 through F                  | 0101         |
| 6                    | 18              |                   | 6 through F                  | 0110         |
| 7                    | 1C              |                   | 7 through F                  | 0111         |
| 8                    | 20              |                   | 8 through F                  | 1000         |
| 9                    | 24              |                   | 9 through F                  | 1001         |
| 10                   | 28              |                   | A through F                  | 1010         |
| 11                   | 2C              |                   | B through F                  | 1011         |
| 12                   | 30              |                   | C through F                  | 1100         |
| 13                   | 34              |                   | D through F                  | 1101         |
| 14                   | 38              | ★                 | E and F                      | 1110         |
| (Lowest priority) 15 | 3C              | External device   | Fonly                        | 1111         |

TABLE 1 INTERRUPT LEVEL DATA

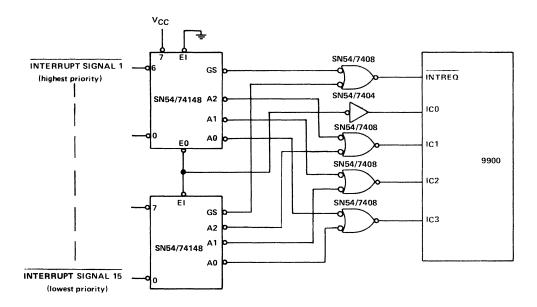
\* Level 0 can not be disabled.

The 9900 interrupt interface utilizes standard TTL components as shown in Figure 6. Note that for eight or less external interrupts a single SN54/74148 is required and for one external interrupt INTREQ is used as the interrupt signal with a hard-wired code IC0 through IC3.

#### 2.3 I/O INTERFACE COMMUNICATIONS-REGISTER-UNIT (CRU)

The SBP 9900 communications-register-unit (CRU) is a versatile, direct command-driven serial I/O interface. The CRU may directly address, in bit-fields of one to sixteen, up to 4096 peripheral input bits and up to 4096 peripheral output bits. The SBP 9900 executes three single-bit and two multiple-bit CRU instructions. The single-bit instructions include TEST BIT (TB), SET BIT TO ONE (SBO), and SET BIT TO ZERO (SBZ); the multiple-bit instructions include LOAD CRU (LDCR) and STORE CRU (STCR).

The SBP 9900 employs three dedicated I/O signals CRUIN, CRUOUT, CRUCLK, and the least significant twelve bits of the address bus to support the CRU interface. CRU interface timing is shown in Section 2.9.



#### FIGURE 6 - 9900 INTERRUPT INTERFACE

#### 2.4 SINGLE-BIT CRU OPERATIONS

The 9900 performs three single-bit CRU functions: test bit (TB), set bit to one (SBO), and set bit to zero (SBZ). To identify the bit to be operated upon, the 9900 develops a CRU-bit address and places it on the address bus, A3 to A14.

For the two output operations (SBO and SBZ), the processor also generates a CRUCLK pulse, indicating an output operation to the CRU device, and places bit 7 of the instruction word on the CRUOUT line to accomplish the specified operation (bit 7 is a one for SBO and a zero for SBZ). A test-bit instruction transfers the addressed CRU bit from the CRUIN input line to bit 2 of the status register (EQUAL).

The 9900 develops a CRU-bit address for the single-bit operations from the CRU-base address contained in workspace register 12 and the signed displacement count contained in bits 8 through 15 of the instruction. The displacement allows two's complement addressing from base minus 128 bits through base plus 127 bits. The base address from W12 is added to the signed displacement specified in the instruction and the result is loaded onto the address bus. Figure 7 illustrates the development of a single-bit CRU address.

#### 2.5 MULTIPLE-BIT CRU OPERATIONS

The 9900 performs two multiple-bit CRU operations: store communications register (STCR) and load communications register (LDCR). Both operations perform a data transfer from the CRU-to-memory or from memory-to-CRU as illustrated in Figure 8. Although the figure illustrates a full 16-bit transfer operation, any number of bits from 1 through 16 may be involved. The LDCR instruction fetches a word from memory and right-shifts it to serially transfer it to CRU output bits. If the LDCR involves eight or fewer bits, those bits come from the right-justified field within the addressed byte of the memory word. If the LDCR involves nine or more bits, those bits come from the right-justified field within the whole memory word. When transferred to the CRU interface, each successive bit receives an address that is sequentially greater than the address for the previous bit. This addressing mechanism results

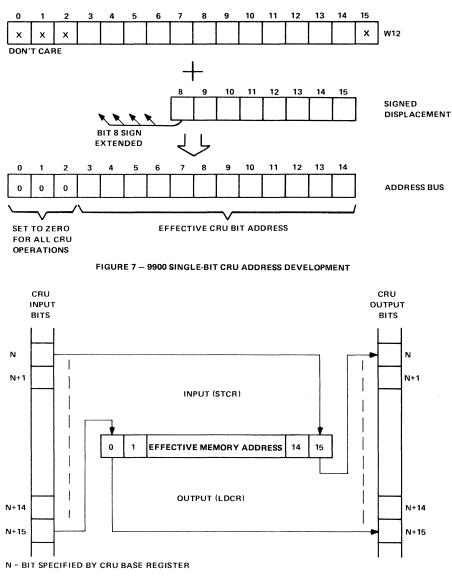


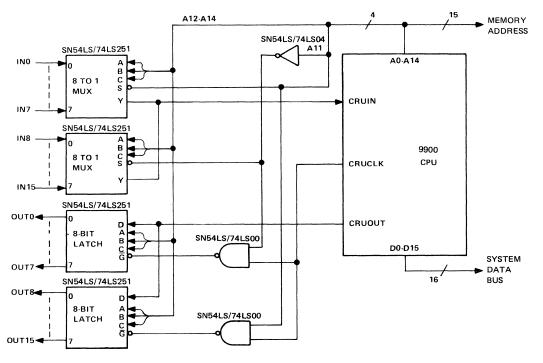
FIGURE 8 - 9900 LDCR/STCR DATA TRANSFERS

in an order reversal of the bits; that is, bit 15 of the memory word (or bit 7) becomes the lowest addressed bit in the CRU and bit 0 becomes the highest addressed bit in the CRU field.

An STCR instruction transfers data from the CRU to memory. If the operation involves a byte or less transfer, the transferred data will be stored right-justified in the memory byte with leading bits set to zero. If the operation involves from nine to 16 bits, the transferred data is stored right-justified in the memory word with leading bits set to

zero. When the input from the CRU device is complete, the first bit from the CRU is the least-significant-bit position in the memory word or byte.

Figure 9 illustrates how to implement a 16-bit input and a 16-bit output register in the CRU interface. CRU addresses are decoded as needed to implement up to 256 such 16-bit interface registers. In system application, however, only the exact number of interface bits needed to interface specific peripheral devices are implemented. It is not necessary to have a 16-bit interface register to interface an 8-bit device.





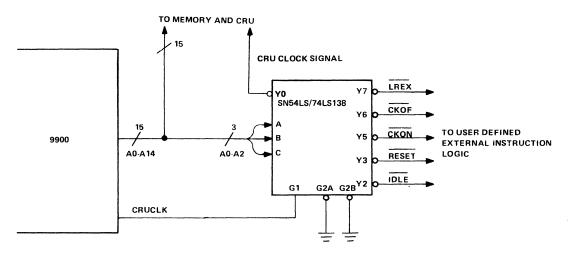
## 2.6 EXTERNAL INSTRUCTIONS

The 9900 has five external instructions that allow user-defined external functions to be initiated under program control. These instructions are CKON, CKOF, RSET, IDLE, and LREX. These mnemonics, except for IDLE, relate to functions implemented in the 990 minicomputer and do not restrict use of the instructions to initiate various user-defined functions. IDLE also causes the 9900 to enter the idle state and remain until an interrupt, RESET, or IOAD occurs. When any of these five instructions are executed by the 9900, a unique 3-bit code appears on the most-significant 3 bits of the address bus (A0 through A2) along with a CRUCLK pulse. When the 9900 is in an idle state, the 3-bit code and CRUCLK pulses occur repeatedly until the idle state is terminated. The codes are shown in Table 2.

Figure 10 illustrates typical external decode logic to implement these instructions. Note that a signal is generated to inhibit CRU decodes during external instructions.

TABLE 2 EXTERNAL INSTRUCTIONS

| EXTERNAL INSTRUCTION | A0 | A1 | A2 |
|----------------------|----|----|----|
| LREX                 | н  | н  | н  |
| СКОГ                 | н  | н  | L  |
| CKON                 | н  | L  | н  |
| RSET                 | L  | н  | н  |
| IDLE                 | L  | н  | L  |





# 2.7 LOAD FUNCTION

The LOAD signal allows cold-start ROM loaders and front panels to be implemented for the 9900. When active, LOAD causes the 9900 to initiate an interrupt sequence immediately following the instruction being executed. Memory location FFFC is used to obtain the vector (WP and PC). The old PC, WP and ST are loaded into the new workspace and the interrupt mask is set to 0000. Then, program execution resumes using the new PC and WP.

#### 2.8 **SBP 9900 PIN DESCRIPTION**

Table 3 describes the function of each SBP 9900 pin, and Figure 11 illustrates their assigned locations.

| SIGNATURE  | PIN | 1/0 | DESCRIPTION   | FIGURE 11 – SBP 99             | 900 PIN ASSIGNMENTS              |
|------------|-----|-----|---|--------------------------------|----------------------------------|
|            |     |     | ADDRESS BUS   |                                |                                  |
| A0 (MSB)   | 24  | OUT | A0 (MSB) through A14 (LSB) comprise the   |                                |                                  |
|            |     |     | address bus. This open-collector bus pro-   |                                | C 83 MEMEN                       |
|            |     |     | vides the memory-address vector to the  | WAIT 3 💭                       | 📥 62 READY                       |
|            |     |     | external-memory system when MEMEN is  |                                | 1 61 WE                          |
|            |     |     | active, and I/O-bit addresses to the I/O  |                                | G CRUCLK                         |
|            | 1   |     | system when MEMEN is inactive. When   | BESET 6                        |                                  |
|            |     | 1   | HOLDA is active, the address bus is pulled  |                                | T CICEND                         |
|            |     | 1   | to the logic level HIGH state by the individ-   |                                | 58 NC                            |
|            |     |     | ual pull-up resistors tied to each respective   |                                | [☐1]57 INJ                       |
| A14 (LSB)  | 10  | OUT | open-collector output.  | INJ 9 🛱                        | □ <b>□</b> <sup>1</sup> ,56 D15  |
|            |     |     |   | A14 10 🕅                       | □C \$\$ 55 D14                   |
| D0 (MSB)   | 41  | 1/0 | DATA BUS  | A13 11 💭                       | □C \$\$ 54 D13                   |
| DU (WISB)  | 41  | 10  | D0 (MSB) through D15 (LSB) comprise the bidirectional open-collector data bus. This     | A12 12 🔛                       | □ <b>53</b> D12                  |
|            |     |     | bus transfers memory data to (when writ-  | A11 13 📩                       | 52 D11                           |
|            | i   |     | ing) and from (when reading) the external-  | A10 14 5                       | <b>1</b> 51 D10                  |
|            |     |     | memory system when MEMEN is active.   | A9 15 5                        | 50 D9                            |
|            |     |     | When HOLDA is active, the data bus is   | A8 16                          |                                  |
|            |     |     | pulled to the logic level HIGH state by the   |                                | 149 D8                           |
|            | 1   |     | individual pull-up resistors tied to each   | A7 17 8                        | 148 D7                           |
| D15 (LSB)  | 56  | 1/0 | respective open-collector output.   | A6 18 🚰                        | <b>□</b> □ <sup>‡</sup> 47 D6    |
|            |     |     |   | A5 19 🖾                        | C <sup>1</sup> 46 D5             |
|            |     |     | POWER SUPPLY  | A4 20 💭                        | [ <b>□</b> ] 45 D4               |
| INJ        | 9   |     | Injector-Supply-Current   | A3 21 📩                        | <b>□</b> 44 D3                   |
| INJ        | 26  |     | Injector-Supply-Current   | A2 22 5                        | 43 D2                            |
| INJ<br>INJ | 40  |     | Injector-Supply-Current   | A1 23 5                        | C 42 D1                          |
| IINJ       | 5/  |     | Injector-Supply-Current   | A0 24 5                        |                                  |
| GND        | 1   | 1   | Ground Reference  |                                |                                  |
| GND        | 2   |     | Ground Reference  |                                | 140 INJ                          |
| GND        | 27  |     | Ground Reference  | INJ 26                         | 1 39 NC                          |
| GND        | 28  |     | Ground Reference  | GND 27 🛱                       | 138 NC                           |
|            |     |     |   | GND 28 💭                       | 137 NC                           |
|            |     |     | CLOCK   | DBIN 29                        | 1 36 ICO                         |
| CLOCK      | 8   | IN  | CLOCK   | CRUOUT 30 🖾                    | I 35 IC1                         |
|            |     |     |   | CRUIN 31                       | 34 IC2                           |
|            |     |     | BUS CONTROL   | INTREQ 32                      |                                  |
| DBIN       | 29  | OUT |   |                                | 33 103                           |
|            |     | 1   | level HIGH), DBIN indicates that the SBP  |                                |                                  |
|            |     |     | 9900 has disabled its output buffers to   |                                |                                  |
|            | 1   |     | allow the memory to place memory-read   | NC-No internal connection      |                                  |
|            | 1   |     | data on the data bus during MEMEN. DBIN   | NC-No internal connection      |                                  |
|            |     | ł   | remains at logic level LOW in all other cases<br>except when HOLDA is active (pulled to |                                |                                  |
|            |     |     | logic level HIGH).  |                                |                                  |
| MEMEN      | 63  | OUT | MEMORY ENABLE. When active (logic level   | LOW), MEMEN indicates that the | ne address bus contains a memory |
|            |     |     | address.  |                                |                                  |
|            | 1   | 1   |   |                                |                                  |

#### TABLE 3 9900 PIN ASSIGNMENTS AND FUNCTIONS

61 OUT WRITE ENABLE. When active (logic level LOW), WE indicates that the SBP 9900 data bus is outputting data to be written into memory. WE

# TABLE 3 (CONTINUED)

| SIGNATURE | PIN | 1/0 | DESCRIPTION   |
|-----------|-----|-----|---|
| CRUCLK    | 60  | Ουτ | COMMUNICATIONS-REGISTER-UNIT (CRU) CLOCK. When active (pulled to logic level HIGH),<br>CRUCLK indicates to the external interface logic the presence of output data on CRUOUT, or the<br>presence of an encoded external instruction on A0 through A2.  |
| CRUIN     | 31  | IN  | CRU DATA IN. CRUIN, normally driven by 3-state or open-collector devices, receives input data from the external interface logic. When the SBP 9900 executes a STCR or TB instruction, it samples CRUIN for the level of the CRU input bit specified by the address bus (A3 through A14).  |
| CRUOUT    | 30  | Ουτ | CRU DATA OUT. CRUOUT outputs serial data when the SBP 9900 executes a LDCR, SBZ, SBO instruction. The data on CRUOUT should be sampled by the external interface logic when CRUCLK goes active (pulled to logic level HIGH).  |
| INTREQ    | 32  | IN  | INTERRUPT CONTROL<br>INTERRUPT REQUEST. When active (logic level LOW), INTREQ indicates that an external interrupt is<br>requesting service. If INTREQ is active, the SBP 9900 loads the data on the interrupt-code input-lines IC0<br>through IC3 into the interrupt interrupt-code storage register. The code is then compared to the interrupt<br>mask bits of the status register. If equal or higher priority than the enabled interrupt level (interrupt code<br>equal or less than status register bits 12 through 15), the SBP 9900 initiates the interrupt sequence. If the<br>comparison fails, the SBP 9900 ignores the interrupt request. In that case, INTREQ should be held active.<br>The SBP 9900 will continue to sample IC0 through IC3 until the program enables a sufficiently low<br>interrupt-level to accept the requesting interrupt. |
| ICO (MSB) | 36  | IN  | INTERRUPT CODES. IC0 (MSB) through IC3 (LSB), receiving an interrupt identity code, are sampled by the SBP 9900 when INTREO is active (logic level LOW). When IC0 through IC3 are LLLH, the highest priority external interrupt is requesting service; when HHHH, the lowest priority external interrupt is   |
| IC3 (LSB) | 33  | IN  | requesting service.   |
| HOLD      | 64  | IN  | MEMORY CONTROL<br>When active (logic level LOW), HOLD indicates to the SBP 9900 that an external controller (e.g., DMA<br>device) desires to use both the address bus and data bus to transfer data to or from memory. In response,<br>the SBP 9900 enters the hold state after completion of its present memory cycle. The SBP 9900 then<br>allows its address bus, data bus, WE, MEMEN, DBIN, and HOLDA facilities to be pulled to the logic level<br>HIGH state. When HOLD is deactivated, the SBP 9900 returns to normal operation from the point at<br>which it was stopped.   |
| HOLDA     | 5   | Ουτ | HOLD ACKNOWLEDGE. When active (pulled to logic level HIGH), HOLDA indicates that the SBP 9900 is in the hold state and that its address bus, data bus, WE, MEMEN, and DBIN facilities are pulled to the logic level HIGH state.   |
| READY     | 62  | IN  | When active (logic level HIGH), READY indicates that the memory will be ready to read or write during the next clock cycle. When not-ready is indicated during a memory operation, the SBP 9900 enters a wait state and suspends internal operation until the memory systems activate READY.  |
| WAIT      | 3   | ουτ | When active (pulled to logic level HIGH), WAIT indicates that the SBP 9900 has entered a wait state in response to a not-ready condition from memory.   |
| ΙΑΟ       | 7   | ουτ | TIMING AND CONTROL<br>INSTRUCTION ACQUISITION. IAQ is active (pulled to logic level HIGH) during any SBP 9900 initiated<br>instruction acquisition memory cycle. Consequently, IAQ may be used to facilitate detection of illegal op<br>codes.  |
| CYCEND    | 59  | Ουτ | CYCLE END. When active (logic level LOW), CYCEND indicates that the SBP 9900 will initiate a new machine cycle on the low-to-high transition of the next CLOCK.   |
| LOAD      | 4   | IN  | When active (logic level LOW), LOAD causes the SBP 9900 to execute a nonmaskable interrupt with memory addresses FFFC16 and FFFE16 containing the associated trap vectors (WP and PC). The load sequence is initiated after the instruction being executed is completed. LOAD will also terminate an idle state. If LOAD is active during the time RESET is active, the LOAD trap will occur after the RESET function is completed. LOAD should remain active for one instruction execution period (IAQ may be  |

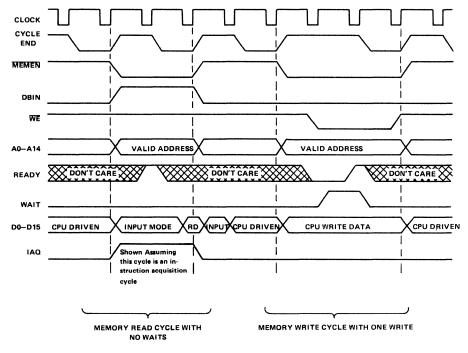
#### TABLE 3 (CONCLUDED)

| SIGNATURE    | PIN | 1/0 | DESCRIPTION  |
|--------------|-----|-----|--|
| LOAD (Cont.) |     |     | used to monitor instruction boundaries). LOAD may be used to implement cold-start ROM loaders.<br>Additionally, front-panel routines may be implemented using CRU bits as front-panel-interface signals, and software-control routines to direct the panel operations.   |
| RESET        | 6   | IN  | When active (logic level LOW), $\overrightarrow{\text{RESET}}$ causes the SBP 9900 to reset itself and inhibit $\overrightarrow{\text{WE}}$ and CRUCLK.<br>When $\overrightarrow{\text{RESET}}$ is released, the SBP 9900 initiates a level-zero interrupt sequence acquiring the WP and PC trap vectors from memory locations 0000 <sub>16</sub> and 0002 <sub>16</sub> , sets all status register bits to logic level LOW, and then fetches the first instruction of the reset program environment. $\overrightarrow{\text{RESET}}$ must be held active for a minimum of three CLOCK cycles. |

### 2.9 SBP 9900 TIMING

#### 2.9.1 SBP 9900 MEMORY

The SBP 9900 basic memory timing for a memory-read cycle with no wait states, and a memory-write cycle with one wait state, is as shown in Figure 12. During each memory-read or memory-write cycle, MEMEN becomes active (logic level LOW) along with valid memory-address data appearing on the address bus (A0 through A14).



RD = READ DATA

FIGURE 12 - SBP 9900 MEMORY BUS TIMING

In the case of a memory-read cycle, DBIN becomes active (pulled to logic level HIGH) at the same time memory-address data becomes valid; the memory write strobe WE remains inactive (pulled to logic level HIGH). If the memory-read cycle is initiated for acquisition of an instruction, IAQ becomes active (pulled to logic level HIGH) at the same time MEMEN becomes active. At the end of a memory-read cycle, MEMEN and DBIN together become inactive. At that time, though the address may change, the data bus remains in the input mode until terminated by the next high-to-low transition of the clock.

In the case of a memory-write cycle,  $\overline{WE}$  becomes active (logic level LOW) with the first high-to-low transition of the clock after  $\overline{MEMEN}$  becomes active; DBIN remains inactive. At the end of a memory-write cycle,  $\overline{WE}$  and  $\overline{MEMEN}$  together become inactive.

During either a memory-read or a memory-write operation, READY may be used to extend the duration of the associated memory cycle such that the speed of the memory system may be coordinated with the speed of the SBP 9900. If READY is inactive (logic level LOW) during the first low-to-high transition of the clock after MEMEN becomes active, the SBP 9900 will enter a wait state suspending further progress of the memory cycle. The first low-to-high transition of the clock after READY becomes active terminates the wait state and allows normal completion of the memory cycle.

#### 2.9.2 SBP 9900 HOLD

The SBP 9900 hold facilities allow both the '9900 and external devices to share a common memory. To gain memory-bus control, an external device requiring direct memory access (DMA) sends a hold request (HOLD) to the SBP 9900. When the next available non-memory cycle occurs, the SBP 9900 enters a hold state and signals its surrender of the memory-bus to the external device via a hold acknowledge (HOLDA). Receiving the hold acknowledgement, the external device proceeds to utilize the common memory. After its memory requirements have been satisfied, the external device returns memory-bus control to the SBP 9900 by releasing HOLD.

When HOLD becomes active (logic level LOW), the SBP 9900 enters a hold state at the beginning of the next available non-memory cycle as shown below. Upon entering a hold state, HOLDA becomes active (pulled to logic level HIGH) with the following signals pulled to a HIGH logic level by the individual pull-up resistors tied to each respective open-collector output: DBIN, MEMEN, WE, A0 through A14, and D0 through D15. When HOLD becomes inactive, the SBP 9900 exits the hold state and regains memory-bus control. If HOLD becomes active during a CRU operation, the SBP 9900 uses an extra clock cycle after the deactivation of HOLD to reassert the CRU address thereby providing the normal setup time for the CRU-bit transfer.

#### 2.9.3 SBP 9900 CRU

The transfer of two data-bits from memory to a peripheral CRU device, and the transfer of one data-bit from a peripheral CRU device to memory, is shown in Figure 14. To transfer a data-bit to a peripheral CRU device, the SBP 9900 outputs the corresponding CRU-bit-address on address bus bits A3 through A14 and the respective data-bit on CRUOUT. During the second clock cycle of the operation, the SBP 9900 outputs a pulse, on CRUCLK, indicating to the peripheral CRU device the presence of a data-bit. This process is repeated until transfer of the entire field of data-bits specified by the CRU instruction has been accomplished. To transfer a data-bit from a peripheral CRU device, the SBP 9900 outputs the corresponding CRU-bit-Address on address bus bits A3 through A14 and receives the respective data-bit on CRUCLK pulses occur during a CRU input operation.

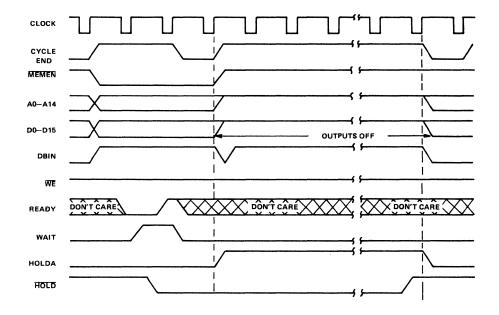
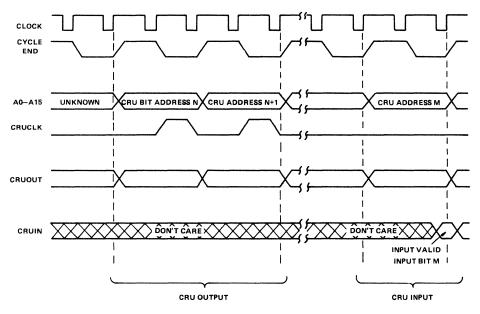


FIGURE 13 - SBP 9900 HOLD TIMING





# 3. 9900 INSTRUCTION SET

## 3.1 DEFINITION

Each 9900 instruction performs one of the following operations:

- Arithmetic, logical, comparison, or manipulation operations on data
- Loading or storage of internal registers (program counter, workspace pointer, or status)
- Data transfer between memory and external devices via the CRU
- Control functions.

### 3.2 ADDRESSING MODES

The 9900 instructions contain a variety of available modes for addressing random-memory data (e.g., program parameters and flags), or formatted memory data (character strings, data lists, etc.). The following figures graphically describe the derivation of the effective address for each addressing mode. The applicability of addressing modes to particular instructions is described in Section 3.5 along with the description of the operations performed by the instruction. The symbols following the names of the addressing modes [R, \*R, \*R+, @ LABEL, or @ TABLE (R)] are the general forms used by 9900 assemblers to select the addressing mode for register R.

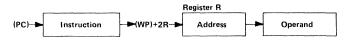
#### 3.2.1 WORKSPACE REGISTER ADDRESSING R

Workspace Register R contains the operand.



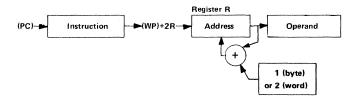
#### 3.2.2 WORKSPACE REGISTER INDIRECT ADDRESSING \*R

Workspace Register R contains the address of the operand.



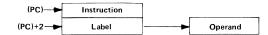
#### 3.2.3 WORKSPACE REGISTER INDIRECT AUTO INCREMENT ADDRESSING \*R+

Workspace Register R contains the address of the operand. After acquiring the operand, the contents of workspace register R are incremented.



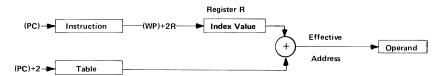
#### 3.2.4 SYMBOLIC (DIRECT) ADDRESSING @ LABEL

The word following the instruction contains the address of the operand.



#### 3.2.5 INDEXED ADDRESSING @ TABLE (R)

The word following the instruction contains the base address. Workspace register R contains the index value. The sum of the base address and the index value results in the effective address of the operand.



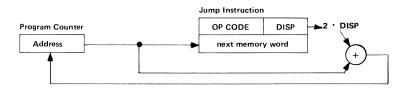
#### 3.2.6 IMMEDIATE ADDRESSING

The word following the instruction contains the operand.



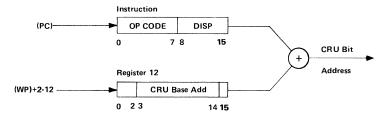
# 3.2.7 PROGRAM COUNTER RELATIVE ADDRESSING

The 8-bit signed displacement in the right byte (bits 8 through 15) of the instruction is multiplied by 2 and added to the updated contents of the program counter. The result is placed in the PC.



#### 3.2.8 CRU RELATIVE ADDRESSING

The 8-bit signed displacement in the right byte of the instruction is added to the CRU base address (bits 3 through 14 of the workspace register 12). The result is the CRU address of the selected CRU bit.



# 3.3 TERMS AND DEFINITIONS

The terms used in describing the instructions of the 9900 are defined in Table 4.

| TERM           | DEFINITION                                   |
|----------------|--|
| В              | Byte indicator (1=byte, 0 = word)            |
| с              | Bit count                                    |
| D              | Destination address register                 |
| DA             | Destination address                          |
| IOP            | Immediate operand                            |
| LSB(n)         | Least significant (right most) bit of (n)    |
| MSB(n)         | Most significant (left most) bit of (n)      |
| N              | Don't care                                   |
| PC             | Program counter                              |
| Result         | Result of operation performed by instruction |
| s              | Source address register                      |
| SA             | Source address                               |
| ST             | Status register                              |
| STn            | Bit n of status register                     |
| т <sub>D</sub> | Destination address modifier                 |
| Τ <sub>S</sub> | Source address modifier                      |
| W              | Workspace register                           |
| WRn            | Workspace register n                         |
| (n)            | Contents of n                                |
| a→b            | a is transferred to b                        |
| Ini            | Absolute value of n                          |
| +              | Arithmetic addition                          |
| -              | Arithmetic subtraction                       |
| AND            | Logical AND                                  |
| OR             | Logical OR                                   |
| Ð              | Logical exclusive OR                         |
| n              | Logical complement of n                      |

TABLE 4 TERM DEFINITIONS

# 3.4 STATUS REGISTER

The status register contains the interrupt mask level and information pertaining to the instruction operation. Table 5 explains the bit indications.

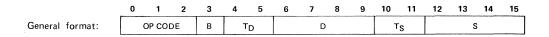
|   | 0  | 1          | 2   | 3   | 4   | 5   | 6   | 7 | 8   | 9    | 10   | 11 | 12    | 13      | 14      | 15    |
|---|----|------------|-----|-----|-----|-----|-----|---|-----|------|------|----|-------|---------|---------|-------|
| s | то | ST1        | ST2 | ST3 | ST4 | ST5 | ST6 |   | not | used | (=0) |    | ST 12 | ST 13   | ST14    | ST 15 |
|   | L> | <b>A</b> > | =   | С   | 0   | Р   | x   |   |     |      |      |    | I     | nterrup | ot Mask | c l   |

| BIT       | NAME       | INSTRUCTION          | CONDITION TO SET BIT TO 1                                  |
|-----------|------------|----------------------|--|
| ST0       | LOGICAL    | C,CB                 | If MSB(SA) = 1 and MSB(DA) = 0, or if MSB(SA) = MSB(DA)    |
|           | GREATER    |                      | and MSB of $[(DA)-(SA)] = 1$                               |
|           | THAN       | CI                   | If MSB(W) = 1 and MSB of IOP = 0, or if MSB(W) = MSB of    |
|           |            |                      | IOP and MSB of $[IOP-(W)] = 1$                             |
|           |            | ABS                  | If (SA) ≠ 0  |
|           |            | All Others           | If result ≠ 0  |
| ST1       | ARITHMETIC | С,СВ                 | If MSB(SA) = 0 and MSB(DA) = 1, or if MSB(SA) = MSB(DA)    |
|           | GREATER    |                      | and MSB of $[(DA)-(SA)] = 1$                               |
|           | THAN       | СІ                   | If MSB(W) = 0 and MSB of IOP = 1, or if MSB(W) = MSB of    |
|           |            |                      | IOP and MSB of $[IOP-(W)] = 1$                             |
|           |            | ABS                  | If MSB(SA) = 0 and (SA) $\neq$ 0                           |
|           |            | All Others           | If MSB of result = 0 and result $\neq$ 0                   |
| ST2       | EQUAL      | C, CB                | If (SA) = (DA)   |
|           |            | C1                   | If (W) = IOP   |
|           |            | coc                  | If (SA) and $(\overline{DA}) = 0$                          |
|           |            | czc                  | If $(SA)$ and $(DA) = 0$                                   |
|           |            | тв                   | If CRUIN = 1   |
|           |            | ABS                  | If (SA) = 0  |
|           |            | All Others           | If result = 0  |
| ST3       | CARRY      | A, AB, ABS, AI, DEC, |  |
|           |            | DECT, INC, INCT,     | If CARRY OUT = 1   |
|           |            | NEG, S, SB           |  |
|           |            | SLA, SRA, SRC, SRL   | If last bit shifted out = 1                                |
| ST4       | OVERFLOW   | A, AB                | If MSB(SA) = MSB(DA) and MSB of result $\neq$ MSB(DA)      |
|           |            | AI                   | If MSB(W) = MSB of IOP and MSB of result $\neq$ MSB(W)     |
|           |            | S, SB                | If MSB(SA) $\neq$ MSB(DA) and MSB of result $\neq$ MSB(DA) |
|           |            | DEC, DECT            | If MSB(SA) = 1 and MSB of result = 0                       |
|           |            | INC, INCT            | If $MSB(SA) = 0$ and $MSB$ of result = 1                   |
|           |            | SLA                  | If MSB changes during shift                                |
|           |            | DIV                  | If MSB(SA) = 0 and MSB(DA) = 1, or if MSB(SA) = MSB(DA)    |
|           |            |                      | and MSB of $[(DA)-(SA)] = 0$                               |
|           |            | ABS, NEG             | If (SA) = 800016   |
| ST5       | PARITY     | CB, MOVB             | If (SA) has odd number of 1's                              |
| -         |            | LDCR, STCR           | If $1 \leq C \leq 8$ and (SA) has odd number of 1's        |
|           |            | AB, SB, SOCB, SZCB   | If result has odd number of 1's                            |
| ST6       | XOP        | XOP                  | If XOP instruction is executed                             |
| ST12-ST15 | INTERRUPT  | LIMI                 | If corresponding bit of IOP is 1                           |
|           | MASK       | RTWP                 | If corresponding bit of WR15 is 1                          |

TABLE 5 STATUS REGISTER BIT DEFINITIONS

# 3.5 INSTRUCTIONS

# 3.5.1 Dual Operand Instructions with Multiple Addressing Modes for Source and Destination Operand



If B = 1 the operands are bytes and the operand addresses are byte addresses. If B = 0 the operands are words and the operand addresses are word addresses.

| T <sub>S</sub> OR T <sub>D</sub> | S OR D   | ADDRESSING MODE                            | NOTES |
|----------------------------------|----------|--|-------|
| 00                               | 0, 1, 15 | Workspace register                         | 1     |
| 01                               | 0, 1, 15 | Workspace register indirect                |       |
| 10                               | 0        | Symbolic                                   | 4     |
| 10                               | 1, 2, 15 | Indexed                                    | 2,4   |
| 11                               | 0, 1, 15 | Workspace register indirect auto-increment | 3     |

The addressing mode for each operand is determined by the T field of that operand.

NOTES: 1. When a workspace register is the operand of a byte instruction (bit 3 = 1), the left byte (bits 0 through 7) is the operand and the right byte (bits 8 through 15) is unchanged.

2. Workspace register 0 may not be used for indexing.

3. The workspace register is incremented by 1 for byte instructions (bit 3 = 1) and is incremented by 2 for word instructions (bit 3 = 0). 4. When  $T_S = T_D = 10$ , two words are required in addition to the instruction word. The first word is the source operand base address and the second word is the destination operand base address.

| MIELONIO | OP | сс | DE | в | MEANING                        | RESULT           | STATUS |  |
|----------|----|----|----|---|--------------------------------|------------------|--------|--|
| MNEMONIC | 0  | 1  | 2  | 3 | MEANING                        | COMPARED<br>TO 0 | BITS   | DESCRIPTION  |
| A        | 1  | 0  | 1  | 0 | Add                            | Yes              | 0-4    | $(SA)+(DA) \rightarrow (DA)$                         |
| AB       | 1  | 0  | 1  | 1 | Add bytes                      | Yes              | 0-5    | (SA)+(DA) → (DA)                                     |
| С        | 1  | 0  | 0  | 0 | Compare                        | No               | 0-2    | Compare (SA) to (DA) and set appropriate status bits |
| СВ       | 1  | 0  | 0  | 1 | Compare bytes                  | No               | 0-2,5  | Compare (SA) to (DA) and set appropriate status bits |
| S        | 0  | 1  | 1  | 0 | Subtract                       | Yes              | 0-4    | (DA) (SA) -> (DA)                                    |
| SB       | 0  | 1  | 1  | 1 | Subtract bytes                 | Yes              | 0-5    | (DA) – (SA) → (DA)                                   |
| SOC      | 1  | 1  | 1  | 0 | Set ones corresponding         | Yes              | 0-2    | (DA) OR (SA) → (DA)                                  |
| SOCB     | 1  | 1  | 1  | 1 | Set ones corresponding bytes   | Yes              | 0-2,5  | (DA) OR (SA) → (DA)                                  |
| SZC      | 0  | 1  | 0  | 0 | Set zeroes corresponding       | Yes              | 0-2    | (DA) AND (SA) → (DA)                                 |
| SZCB     | 0  | 1  | 0  | 1 | Set zeroes corresponding bytes | Yes              | 0-2,5  | (DA) AND (SA) → (DA)                                 |
| MOV      | 1  | 1  | 0  | 0 | Move                           | Yes              | 0-2    | $(SA) \rightarrow (DA)$                              |
| MOVB     | 1  | 1  | 0  | 1 | Move bytes                     | Yes              | 0-2,5  | $(SA) \rightarrow (DA)$                              |

### 3.5.2 Dual Operand Instructions with Multiple Addressing Modes for the Source Operand and Workspace Register Addressing for the Destination

|                 | 0 | 1 | 2     | 3  | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|-------|----|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   | ор со | DE |   |   |   | D |   |   | т  | s  |    | s  | 5  |    |

The addressing mode for the source operand is determined by the  $\mathsf{T}_{\mathsf{S}}$  field.

| т <sub>s</sub> | S        | ADDRESSING MODE                            | NOTES |
|----------------|----------|--|-------|
| 00             | 0, 1, 15 | Workspace register                         |       |
| 01             | 0, 1, 15 | Workspace register indirect                |       |
| 10             | 0        | Symbolic                                   |       |
| 10             | 1, 2, 15 | Indexed                                    | • 1   |
| 11             | 0, 1, 15 | Workspace register indirect auto increment | 2     |

NOTES: 1, Workspace register 0 may not be used for indexing.

2. The workspace register is incremented by 2.

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 | MEANING   | RESULT<br>COMPARED<br>TO 0 | STATUS<br>BITS<br>AFFECTED | DESCRIPTION   |
|----------|------------------------|---|----------------------------|----------------------------|---|
| COC      | 001000                 | Compare ones                                    | No                         | 2                          | Test (D) to determine if 1's are in each bit  |
| czc      | 001001                 | corresponding<br>Compare zeros<br>corresponding | No                         | 2                          | position where 1's are in (SA). If so, set ST2.<br>Test (D) to determine if 0's are in each bit<br>position where 1's are in (SA). If so, set ST2.  |
| XOR      | 001010                 | Exclusive OR                                    | Yes                        | 0-2                        | $(D) \bigoplus (SA) \to (D)$  |
| MPY .    | 001110                 | Multiply  | No                         |                            | Multiply unsigned (D) by unsigned (SA) and<br>place unsigned 32-bit product in D (most<br>significant) and D+1 (least significant). If WR15<br>is D, the next word in memory after WR15 will<br>be used for the least significant half of the<br>product.   |
| DIV      | 001111                 | Divide  | No                         | 4                          | If unsigned (SA) is less than or equal to unsigned<br>(D), perform no operation and set ST4. Otherwise,<br>divide unsigned (D) and (D+1) by unsigned<br>(SA). Quotient $\rightarrow$ (D), remainder $\rightarrow$ (D+1). If<br>D = 15, the next word in memory after WR 15<br>will be used for the remainder. |

# 3.5.3 Extended Operation (XOP) Instruction

|                 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: | 0 | 0 | 1 | 0 | 1 | 1 |   | D |   |   | т  | s  |    | S  | 3  |    |

The T<sub>S</sub> and S fields provide multiple mode addressing capability for the source operand. When the XOP is executed, ST6 is set and the following transfers occur:  $(40_{16} + 4D) \rightarrow (WP)$ 

| $(4016 \pm 40) \rightarrow (WP)$  |
|-----------------------------------|
| $(42_{16} + 4D) \rightarrow (PC)$ |
| SA $\rightarrow$ (new WR11)       |
| (old WP) → (new WR13)             |
| (old PC) → (new WR14)             |
| (old ST) $\rightarrow$ (new WR15) |
|                                   |

The 9900 does not test interrupt requests (INTREQ) upon completion of the XOP instruction.

# 3.5.4 Single Operand Instructions

|                 | 0 | 1 | 2 | 3 | 4    | 5   | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|------|-----|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   | OP C | ODE |   |   |   |   | т  | s  |    | 5  | 5  |    |

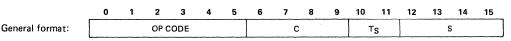
The  $\mathsf{T}_S$  and S fields provide multiple mode addressing capability for the source operand.

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 6 7 8 9 | MEANING           | RESULT<br>COMPARED<br>TO 0 | STATUS<br>BITS<br>AFFECTED | DESCRIPTION                                       |
|----------|--------------------------------|-------------------|----------------------------|----------------------------|---|
| В        | 0000010001                     | Branch            | No                         | -                          | $SA \rightarrow (PC)$                             |
| BL       | 0000011010                     | Branch and link   | No                         |                            | $(PC) \rightarrow (WR11); SA \rightarrow (PC)$    |
| BLWP     | 0 0 0 0 0 1 0 0 0 0            | Branch and load   | No                         | -                          | $(SA) \rightarrow (WP); (SA+2) \rightarrow (PC);$ |
|          |                                | workspace pointer |                            |                            | (old WP) $\rightarrow$ (new WR 13);               |
|          |                                |                   |                            |                            | (old PC) $\rightarrow$ (new WR14);                |
|          |                                |                   |                            |                            | (old ST) $\rightarrow$ (new WR15);                |
| ]        |                                |                   |                            |                            | the interrupt input (INTREQ) is not               |
|          |                                |                   |                            |                            | tested upon completion of the                     |
|          |                                |                   |                            |                            | BLWP instruction.                                 |
| CLR      | 0000010011                     | Clear operand     | No                         | _                          | 0→(SA)  |
| SETO     | 0000011100                     | Set to ones       | No                         | -                          | FFFF16→(SA)                                       |
| INV      | 0000010101                     | Invert            | Yes                        | 0-2                        | $(\overline{SA}) \rightarrow (SA)$                |
| NEG      | 0000010100                     | Negate            | Yes                        | 0-4                        | –(SA) → (SA)                                      |
| ABS      | 0000011101                     | Absolute value*   | No                         | 0-4                        | (SA)  → (SA)                                      |
| SWPB     | 0000011011                     | Swap bytes        | No                         | -                          | (SA), bits 0 thru 7 → (SA), bits                  |
|          |                                |                   |                            |                            | 8 thru 15; (SA), bits 8 thru 15 $\rightarrow$     |
|          |                                |                   |                            |                            | (SA), bits 0 thru 7.                              |
| INC      | 0000010110                     | Increment         | Yes                        | 0-4                        | $(SA) + 1 \rightarrow (SA)$                       |
| INCT     | 0000010111                     | Increment by two  | Yes                        | 0-4                        | (SA) + 2→(SA)                                     |
| DEC      | 0000011000                     | Decrement         | Yes                        | 0-4                        | $(SA) - 1 \rightarrow (SA)$                       |
| DECT     | 0000011001                     | Decrement by two  | Yes                        | 0-4                        | (SA) - 2→(SA)                                     |
| X†       | 0000010010                     | Execute           | No                         | -                          | Execute the instruction at SA.                    |

\* Operand is compared to zero for status bit.

<sup>†</sup> If additional memory words for the execute instruction are required to define the operands of the instruction located at SA, these words will be accessed from PC and the PC will be updated accordingly. The instruction acquisition signal (IAQ) will not be true when the 9900 accesses the instruction at SA. Status bits are affected in the normal manner for the instruction executed.

#### 3.5.5 CRU Multiple-Bit Instructions



The C field specifies the number of bits to be transferred. If C = 0, 16 bits will be transferred. The CRU base register (WR12, bits 3 through 14) defines the starting CRU bit address. The bits are transferred serially and the CRU address is incremented with each bit transfer, although the contents of WR12 is not affected. T<sub>S</sub> and S provide multiple mode addressing capability for the source operand. If 8 or fewer bits are transferred (C = 1 through 8), the source address is a byte address. If 9 or more bits are transferred (C = 0, 9 through 15), the source address is a word address. If the source is addressed in the workspace register indirect auto increment mode, the workspace register is incremented by 1 if C = 1 through 8, and is incremented by 2 otherwise.

| MNEMONIC  | OP CODE | MEANING                     | RESULT<br>COMPARED | STATUS             | DESODIPTION   |
|-----------|---------|-----------------------------|--------------------|--------------------|---|
| MINEMONIC | 012345  | MEANING                     | TO 0               | BITS               | DESCRIPTION   |
| LDCR      | 001100  | Load communcation register  | Yes                | 0-2,5 <sup>†</sup> | Beginning with LSB of (SA), transfer the<br>specified number of bits from (SA) to<br>the CRU.                                     |
| STCR      | 001101  | Store communcation register | Yes                | 0-2,5 <sup>†</sup> | Beginning with LSB of (SA), transfer the<br>specified number of bits from the CRU to<br>(SA). Load unfilled bit positions with 0. |

 $^{\dagger}\text{ST5}$  is affected only if 1  $\leq$  C  $\leq$  8.

#### 3.5.6 CRU Single-Bit Instructions

|                 | 0 | 1 | 2 | 3     | 4   | 5 | 6 | 7 | 8 | 9 | 10    | 11   | 12    | 13   | 14 | 15 |
|-----------------|---|---|---|-------|-----|---|---|---|---|---|-------|------|-------|------|----|----|
| General format: |   |   |   | OP CC | DDE |   |   |   |   |   | SIGNE | DDIS | PLACE | MENT |    |    |

CRU relative addressing is used to address the selected CRU bit.

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 6 7 | MEANING         | STATUS<br>BITS<br>AFFECTED | DESCRIPTION                                 |
|----------|----------------------------|-----------------|----------------------------|---|
| SBO      | 00011101                   | Set bit to one  |                            | Set the selected CRU output bit to 1.       |
| SBZ      | 00011110                   | Set bit to zero | -                          | Set the selected CRU output bit to 0.       |
| ТВ       | 00011111                   | Test bit        | 2                          | If the selected CRU input bit = 1, set ST2. |

#### 3.5.7 Jump Instructions

|                 | 0 | 1 | 2 | 3     | 4  | 5 | 6 | 7 | 8 | 9 | 10 | 11   | 12    | 13 | 14 | 15 |
|-----------------|---|---|---|-------|----|---|---|---|---|---|----|------|-------|----|----|----|
| General format: |   |   |   | OP CC | DE |   |   |   |   |   | D  | SPLA | CEMEN | т  |    |    |

Jump instructions cause the PC to be loaded with the value selected by PC relative addressing if the bits of ST are at specified values. Otherwise, no operation occurs and the next instruction is executed since PC points to the next instruction. The displacement field is a word count to be added to PC. Thus, the jump instruction has a range of -128 to 127 words from memory-word address following the jump instruction. No ST bits are affected by jump instruction.

| MNEMONIC  | OP CODE         | MEANING            | ST CONDITION TO LOAD PC |
|-----------|-----------------|--------------------|-------------------------|
| MINEMONIC | 0 1 2 3 4 5 6 7 | MEANING            | ST CONDITION TO LOAD FC |
| JEQ       | 0 0 0 1 0 0 1 1 | Jump equat         | ST2 = 1                 |
| JGT       | 0 0 0 1 0 1 0 1 | Jump greater than  | ST1 = 1                 |
| JH        | 0 0 0 1 1 0 1 1 | Jump high          | ST0 = 1 and ST2 = 0     |
| JHE       | 0 0 0 1 0 1 0 0 | Jump high or equal | ST0 = 1 or ST2 = 1      |
| JL        | 0 0 0 1 1 0 1 0 | Jump low           | ST0 = 0 and $ST2 = 0$   |
| JLE       | 0 0 0 1 0 0 1 0 | Jump low or equal  | ST0 = 0 or ST2 = 1      |
| JLT       | 0 0 0 1 0 0 0 1 | Jump less than     | ST1 = 0 and $ST2 = 0$   |
| JMP       | 0 0 0 1 0 0 0 0 | Jump unconditional | unconditional           |
| JNC       | 0 0 0 1 0 1 1 1 | Jump no carry      | ST3 = 0                 |
| JNE       | 0 0 0 1 0 1 1 0 | Jump not equal     | ST2 = 0                 |
| JNO       | 0 0 0 1 1 0 0 1 | Jump no overflow   | ST4 = 0                 |
| JOC       | 0 0 0 1 1 0 0 0 | Jump on carry      | ST3 = 1                 |
| JOP       | 0 0 0 1 1 1 0 0 | Jump odd parity    | ST5 = 1                 |

# 3.5.8 Shift Instructions

|                 | 0 | 1 | 2 | 3     | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|-------|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   | OP CC |   |   |   |   |   | C | ;  |    |    | v  | v  |    |

If C = 0, bits 12 through 15 of WR0 contain the shift count. If C = 0 and bits 12 through 15 of WR0 = 0, the shift count is 16.

|          |   |   | 0 | PC | :00 | DE |   |   |                        | RESULT<br>COMPARED | STATUS<br>BITS | DESCRIPTION   |
|----------|---|---|---|----|-----|----|---|---|------------------------|--------------------|----------------|---|
| MNEMONIC | 0 | 1 | 2 | 3  | 4   | 5  | 6 | 7 | MEANING                | TO 0               | AFFECTED       | DESCRIPTION   |
| SLA      | 0 | 0 | 0 | 0  | 1   | 0  | 1 | 0 | Shift left arithmetic  | Yes                | 0-4            | Shift (W) left. Fill vacated bit positions with 0.                    |
| SRA      | 0 | 0 | 0 | 0  | 1   | 0  | 0 | 0 | Shift right arithmetic | Yes                | 0-3            | Shift (W) right. Fill vacated bit positions with original MSB of (W). |
| SRC      | 0 | 0 | 0 | 0  | 1   | 0  | 1 | 1 | Shift right circular   | Yes                | 0-3            | Shift (W) right. Shift previous LSB into MSB.                         |
| SRL      | 0 | 0 | 0 | 0  | 1   | 0  | 0 | 1 | Shift right logical    | Yes                | 0-3            | Shift (W) right. Fill vacated bit positions with O's.                 |

# 3.5.9 Immediate Register Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6 | 7 | 8   | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|---|---|-----|---|----|----|----|----|----|----|
| General format: |   |   |   |   | о | P COD | E |   |     |   |    | N  |    | ١  | v  |    |
|                 |   |   |   |   |   |       |   |   | IOP |   |    |    |    |    |    |    |

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 6 7 8 9 10 | MEANING        | RESULT<br>COMPARED<br>TO 0 | STATUS<br>BITS<br>AFFECTED | DESCRIPTION                 |
|----------|-----------------------------------|----------------|----------------------------|----------------------------|-----------------------------|
| AI       | 00000010001                       | Add immediate  | Yes                        | 0-4                        | $(W) + IOP \rightarrow (W)$ |
| ANDI     | 00000010010                       | AND immediate  | Yes                        | 0-2                        | (W) AND IOP → (W)           |
| CI       | 00000010100                       | Compare        | Yes                        | 0-2                        | Compare (W) to IOP and set  |
|          |                                   | immediate      |                            |                            | appropriate status bits     |
| LI       | 00000010000                       | Load immediate | Yes                        | 0-2                        | $IOP \rightarrow (W)$       |
| ORI      | 00000010011                       | OR immediate   | Yes                        | 0-2                        | (W) OR IOP → (W)            |

# 3.5.10 Internal Register Load Immediate Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7   | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|-----|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   |   | OP CC | DDE |     |   |   |    |    |    | N  |    |    |
|                 |   |   |   |   |   |       |     | IOP |   |   |    |    |    |    |    |    |

|          |   |   |   | ( | OP ( | 200 | DE |   |   |   |    | MEANING                          | DESOBUTION                                  |
|----------|---|---|---|---|------|-----|----|---|---|---|----|----------------------------------|---|
| MNEMONIC | 0 | 1 | 2 | 3 | 4    | 5   | 6  | 7 | 8 | 9 | 10 | MEANING                          | DESCRIPTION                                 |
| LWPI     | 0 | 0 | 0 | 0 | 0    | 0   | 1  | 0 | 1 | 1 | 1  | Load workspace pointer immediate | IOP $\rightarrow$ (WP), no ST bits affected |
| LIMI     | 0 | 0 | 0 | 0 | 0    | 0   | 1  | 1 | 0 | 0 | 0  | Load interrupt mask              | IOP, bits 12 thru 15 → ST12                 |
|          |   |   |   |   |      |     |    |   |   |   |    |                                  | thru ST15                                   |

#### 3.5.11 Internal Register Store Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   |   | OP CO | DDE |   |   |   |    | N  |    | V  | v  |    |

No ST bits are affected.

| MNEMONIC  |   |   |   | C | )P C | 00 | θE |   |   |   |    | MEANING                 | DESCRIPTION            |
|-----------|---|---|---|---|------|----|----|---|---|---|----|-------------------------|------------------------|
| MINEWONIC | 0 | 1 | 2 | 3 | 4    | 5  | 6  | 7 | 8 | 9 | 10 | MEANING                 | DESCRIPTION            |
| STST      | 0 | 0 | 0 | 0 | 0    | 0  | 1  | 0 | 1 | 1 | 0  | Store status register   | $(ST) \rightarrow (W)$ |
| STWP      | 0 | 0 | 0 | 0 | 0    | 0  | 1  | 0 | 1 | 0 | 1  | Store workspace pointer | $(WP) \rightarrow (W)$ |

# 3.5.12 Return Workspace Pointer (RTWP) Instruction

|                 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0  |    |    | N  |    |    |

The RTWP instruction causes the following transfers to occur:

 $(WR15) \rightarrow (ST)$  $(WR14) \rightarrow (PC)$  $(WR13) \rightarrow (WP)$ 

# 3.5.13 External Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   |   | OP CC | DDE |   |   |   |    |    |    | N  |    |    |

External instructions cause the three most-significant address lines (A0 through A2) to be set to the below-described levels and the CRUCLK line to be pulsed, allowing external control functions to be initiated.

|          | OP CODE                |              | STATUS   |                                |    | DRE | SS |
|----------|------------------------|--------------|----------|--------------------------------|----|-----|----|
| MNEMONIC | 0 1 2 3 4 5 6 7 8 9 10 | MEANING      | BITS     | DESCRIPTION                    |    | BUS |    |
|          | 0123430,0310           |              | AFFECTED |                                | A0 | A1  | A2 |
| IDLE     | 0 0 0 0 0 0 1 1 0 1 0  | Idle         | -        | Suspend TMS 9900               | L  | н   | L  |
|          |                        |              |          | instruction execution until    |    |     |    |
|          |                        |              |          | an interrupt, LOAD, or         |    |     |    |
|          |                        |              |          | RESET occurs                   |    |     |    |
| RSET     | 0000001101 1           | Reset        | 12-15    | $0 \rightarrow ST12$ thru ST15 | L  | н   | н  |
| CKOF     | 00000011110            | User defined |          |                                | н  | н   | L  |
| CKON     | 00000011101            | User defined |          |                                | н  | L   | н  |
| LREX     | 0000011111             | User defined |          |                                | н  | н   | н  |

#### 3.6 MICROINSTRUCTION CYCLE

The SBP 9900 includes circuitry which will indicate the completion of a microinstruction cycle. Designated as the CYCEND function, it provides CPU status that can simplify system design. The CYCEND output will go to a low logic level as a result of the low-to-high transition of each clock pulse which initiates the last clock of a microinstruction.

#### 3.7 SBP 9900 INSTRUCTION EXECUTION TIMES

Instruction execution times for the SBP 9900 are a function of:

- 1) Clock cycle time, t<sub>c</sub>
- 2) Addressing mode used where operands have multiple addressing mode capability
- 3) Number of wait states required per memory access.

The following Table 6 lists the number of clock cycles and memory accesses required to execute each SBP 9900 instruction. For instructions with multiple addressing modes for either or both operands, the table lists the number of clock cycles and memory accesses with all operands addressed in the workspace-register mode. To determine the additional number of clock cycles and memory accesses required for modified addressing, add the appropriate values from the referenced tables. The total instruction-execution time for an instruction is:

#### $T = t_c (C + W \cdot M)$

where:

T = total instruction execution time;

- t<sub>c</sub> = clock cycle time;
- C = number of clock cycles for instruction execution plus address modification;
- W = number of required wait states per memory access for instruction execution plus address modification;
- M = number of memory accesses.

| Т           | ABLE 6          |
|-------------|-----------------|
| INSTRUCTION | EXECUTION TIMES |

| INSTRUCTION       | CLOCK<br>CYCLES | MEMORY | ADDRI<br>MODIFIC |   | INS | TRUCTION          | CLOCK<br>CYCLES | MEMORY |        |     |
|-------------------|-----------------|--------|------------------|---|-----|-------------------|-----------------|--------|--------|-----|
|                   | С               | м      | SOURCE           |   |     |                   | С               | м      | SOURCE |     |
| A                 | 14              | 4      | А                | A | LW  | PI                | 10              | 2      | -      |     |
| AB                | 14              | 4      | в                | в | MO  | v                 | 14              | 4      | A      | A   |
| ABS (MSB = 0)     | 12              | 2      | A                | - | МО  | VB                | 14              | 4      | в      | в   |
| (MSB ≕ 1)         | 14              | 3      | A                | - | MP  | Y                 | 52              | 5      | A      | -   |
| AI                | 14              | 4      | -                | - | NE  | G                 | 12              | 3      | A      | - 1 |
| ANDI              | 14              | 4      |                  | - | OR  | 1                 | 14              | 4      | -      | -   |
| в                 | 8               | 2      | A                |   | RS  | ΞT                | 12              | 1      |        | -   |
| BL                | 12              | 3      | A                | - | RT  | WP                | 14              | 4      | - 1    |     |
| BLWP              | 26              | 6      | A                | - | s   |                   | 14              | 4      | A      | A   |
| с                 | 14              | 3      | A                | A | SB  |                   | 14              | 4      | в      | в   |
| СВ                | 14              | 3      | в                | в | SBO | )                 | 12              | 2      | _      | 12  |
| CI                | 14              | 3      | _                |   | SB2 | 2                 | 12              | 2      | -      | -   |
| СКОЕ              | 12              | 1      | -                | - | SE  | ю                 | 10              | 3      | A      | - 1 |
| CKON              | 12              | 1      | _                | _ | Shi | ft (C≠0)          | 12+2C           | . 3    | -      | -   |
| CLR               | 10              | 3      | A                | _ |     | 0, Bits 12-15     |                 | -      |        |     |
| COC               | 14              | 3      | A                | _ |     | of WRO=0)         | 52              | 4      | -      | -   |
| czc               | 14              | 3      | A                | _ |     | 0, Bits 12-15     | 02              |        | ļ      | 1   |
| DEC               | 10              | 3      | A                | - |     | of WRP=N≠0)       | 20+2N           | 4      | _      | -   |
| DECT              | 10              | 3      | A                | _ | so  |                   | 14              | 4      | А      | A   |
| DIV (ST4 is set)  | 16              | 3      | A                | _ | so  |                   | 14              | 4      | в      | в   |
| VV (ST4 is reset) | 92-124          | 6      | A                |   |     | CR (C=0)          | 60              | 4      | A      |     |
| DLE               | 12              | 1      | _                | _ |     | (1≤C≤7)           | 42              | 4      | В      |     |
| INC               | 10              | 3      | А                | - |     | (C=8)             | 44              | 4      | В      | -   |
| INCT              | 10              | 3      | A                | - | 1   | (9≤C≤15)          | 58              | 4      | A      | -   |
| INV               | 10              | 3      | A                | - | STS |                   | 8               | 2      | 1 2    | -   |
| Jump (PC is       |                 | -      |                  |   | STV |                   | 8               | 2      | -      |     |
| changed)          | 10              | 1      | _                |   | sw  |                   | 10              | 3      | A      | _   |
| PC is not         |                 |        |                  |   | SZC |                   | 14              | 4      | A      | A   |
| changed)          | 8               | 1      |                  | _ | SZC |                   | 14              | 4      | в      | В   |
| LDCR (C = 0)      | 52              | 3      | A                |   | ТВ  | -                 | 12              | 2      | _      | -   |
| (1≤C≤8)           | 20+2C           | 3      | В                | - | x.  | •                 | 8               | 2      | A      | -   |
| (9 ≤ C ≤ 15)      | 20+2C           | 3      | A                |   | xo  |                   | 36              | 8      | A      |     |
| LI                | 12              | 3      | _                | - | xo  |                   | 14              | 4      | A      | -   |
| LIMI              | 14              | 2      |                  |   |     |                   |                 |        | 1      | 1   |
| LREX              | 12              | 1      | -                | - |     |                   |                 |        |        |     |
| RESET function    | 26              | 5      |                  | - | Unc | lefined op codes: |                 |        |        |     |
| OAD function      | 22              | 5      |                  | - | 00  | 00-01 F F ,0320-  | 6               | 1      | 1      |     |
| Interrupt context |                 |        |                  |   | 0   | 33F,0C00-0FFF,    | 0               | '      | -      | -   |
| switch            | 22              | 5      |                  | - | 0   | 780-07FF          |                 |        |        | Į – |

\*Execution time is dependent upon the partial quotient after each clock cycle during execution.

\*\* Execution time is added to the execution time of the instruction located at the source address minus 4 clock cycles and 1 memory access time. <sup>†</sup>The letters A and B refer to the respective tables that follow.

#### ADDRESS MODIFICATION - TABLE A

| ADDRESSING MODE                                     | CLOCK<br>CYCLES | MEMORY<br>ACCESSES |
|---|-----------------|--------------------|
|   | <u> </u>        | М                  |
| WR (T <sub>S</sub> or T <sub>D</sub> = 00)          | 0               | 0                  |
| WR indirect (T <sub>S</sub> or T <sub>D</sub> = 01) | 4               | 1                  |
| WR indirect auto-                                   |                 |                    |
| increment (T <sub>S</sub> or T <sub>D</sub> = 11)   | 8               | 2                  |
| Symbolic (T <sub>S</sub> or T <sub>D</sub> = 10,    |                 |                    |
| S or D = 0)   | 8               | 1                  |
| Indexed (T <sub>S</sub> or T <sub>D</sub> = 10,     |                 |                    |
| S or D ≠ 0)   | 8               | 2                  |

#### ADDRESS MODIFICATION - TABLE B

| ADDRESSING MODE  | CLOCK<br>CYCLES<br>C | MEMORY<br>ACCESSES<br>M |
|--|----------------------|-------------------------|
| WR (T <sub>S</sub> or T <sub>D</sub> = 00)                             | 0                    | 0                       |
| WR indirect (T <sub>S</sub> or T <sub>D</sub> = 01)                    | 4                    | 1                       |
| WR indirect auto-<br>increment (T <sub>S</sub> or T <sub>D</sub> = 11) | 6                    | 2                       |
| Symbolic ( $T_S \text{ or } T_D = 10$ ,                                |                      |                         |
| S or D = 0)  | 8                    | 1                       |
| Indexed (T <sub>S</sub> or T <sub>D</sub> = 10,<br>S or D ≠ 0)         | 8                    | 2                       |

As an example, the instruction MOVB is used in a system with  $t_c = 0.5 \ \mu s$  and no wait states are required to access memory. Both operands are addressed in the workspace register mode:

 $T = t_c (C + W \cdot M) = 0.5 (14 + 0 \cdot 4) \mu s = 7 \mu s.$ 

If two wait states per memory access were required, the execution time is:

T = 0.5 (14 + 2.4)  $\mu$ s = 11  $\mu$ s.

If the source operand was addressed in the symbolic mode and two wait states were required:

 $T = t_{C} (C + W \cdot M)$ C = 14 + 8 = 22M = 4 + 1 = 5 $T = 0.5 (22 + 2 \cdot 5) <math>\mu$ s = 16  $\mu$ s.

# 4. INTERFACING

The input/output (I/O) accommodations have been designed for TTL compatibility. Direct interfacing, supportable by the entire families of catalog devices, is shown in Figure 15.

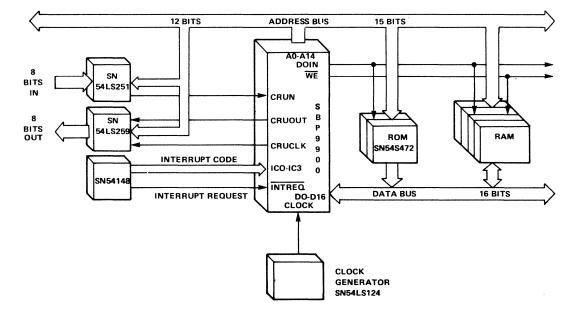
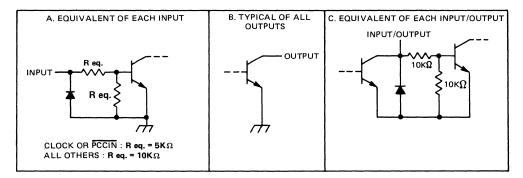


FIGURE 15 - MINIMUM SBP 9900 SYSTEM

#### 4.1 INPUT CIRCUIT

The input circuit used on the SBP 9900 is basically an RTL configuration which has been modified for TTL compatibility as shown in Figure 16A. An input-clamping diode is incorporated to limit negative excursions (ringing) when the SBP 9900 is on the receiving end of a transmission line; an input switching threshold of nominally +1.5 volts has been specified for improved noise immunity. This threshold is achieved via two resistors which function as a voltage divider to increase the one VBE threshold of the  $I^2L$  input transistor to +1.5 volts. Since this input circuit is independent of injector current, input threshold compatibility is maintained over the entire speed/power performance range.





The input circuit characteristics for input current versus input voltage are shown in Figure 17. The 10K and 20K ohm load lines and threshold knee at +1.5 volts provide a high-impedance characteristic to reduce input loading and improve the low-logic level input noise immunity over some standard TTL inputs. Full compatibility is maintained with virtually all 5 volt logic families even when the SBP 9900 is powered down (injector current reduced).

#### 4.1.1 Sourcing Inputs

The inputs may be sourced directly by most 5 volt logic families. Five volt functions which feature internal pull-up resistors at their outputs require no external interface components; five volt functions which feature open-collector outputs generally require external pull-up resistors.

#### 4.1.2 Terminating Unused Inputs

Inputs which are selected to be hardwired to a logic-level low may be connected directly to

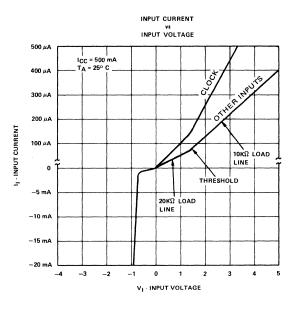


FIGURE 17 - TYPICAL INPUT CHARACTERISTICS

ground. Inputs which are selected to be hardwired to a logic-level high must be tied, via a current limiting (pull-up) resistor, to a logic-level-high low-impedance voltage source such as V<sub>CC</sub>. A single transient protecting resistor may be utilized common to (N) inputs.

#### 4.2 OUTPUT CIRCUIT

The output circuit selected for the SBP 9900 is an injected open-collector transistor shown in Figure 16B. Since this transistor is injected, output sourcing capability is directly related to injector current. In other words, the number of loads which may be sourced by an SBP 9900 output is directly reduced as injector current is reduced.

The output circuit characteristic for logic-level low output voltage (VOL) versus logic-level low output current (IOL) is shown in Figure 18. At rated injector current, the SBP 9900 output circuit offers a low-level output voltage of typically 220 mV.

The output circuit characteristics for 1) logic-level high output voltage (VOH) and current (IOH), 2) rise times, and 3) next stage input noise immunity, are a function of the load circuit being sourced. The load circuit may be either:

 A) the direct input, if no source current is required, of a five-volt logic family function,

or, for greater noise immunity and improved rise times,

B) the direct input of a five-volt logic family function in conjunction with a discrete pull-up resistor.

When a discrete pull-up resistor ( $R_L$ ) is utilized, the fanout requirements placed on a particular SBP 9900 output restrict both the maximum and minimum value

OUTPUT CURRENT 400 ICC = 500 mA TA = 25°C 350 ٤ 300 VO - OUTPUT VOLTAGE 250 200 150 100 50 0 5 10 15 20 25 IO - OUTPUT CURRENT - mA

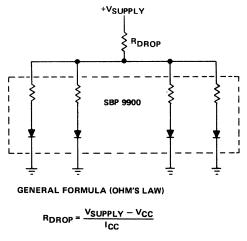
OUTPUT VOLTAGE

FIGURE 18 - TYPICAL OUTPUT CHARACTERISTICS

of R<sub>L</sub>. Techniques for calculating  $R_{L(max)}$  and  $R_{L(min)}$  respectively are explained in the SBP 0400A, SBP 0401A data manual in Chapter 2 of this data book.

#### 5. POWER SOURCE

1<sup>2</sup>L is a current-injected logic. When placed across a curve tracer, the processor will resemble a silicon switching diode. Any voltage or current source capable of supplying the desired current at the injector node voltage required will suffice. A dry-cell battery, a 5-volt TTL power supply, a programmable current supply (for power-up/power-down operation) – literally whatever power source is convenient can be used for most cases. For example, if a 5-volt TTL power supply is to be used, a series dropping resistor would be connected between the 5-volt supply and the injector pins of the l<sup>2</sup>L device, as illustrated in Figure 19, to select the desired operating current.



EXAMPLE FOR VSUPPLY = 5V, AND ICC = 500 mA:

$$R_{DROP} = \frac{5 - 1.05}{0.5} = \frac{3.95}{0.5} = 7.9 \text{ OHMS}$$

### FIGURE 19 - INJECTOR CURRENT CALCULATIONS

Operating from a constant current power source, the SBP 9900 may be powered-up/powered-down with complete maintenance of data integrity to execute instructions over a speed/power range spanning several orders of user-selectable injector-supplycurrent range as illustrated in Figure 21.

Figures 22 and 23 show the typical injector node voltages which occur across the temperature and injector current ranges.

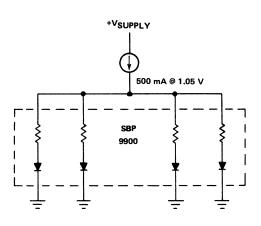


FIGURE 20 - INJECTOR CURRENT SOURCE

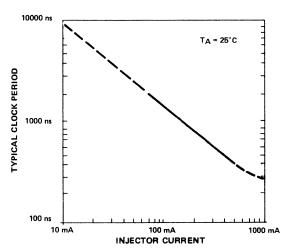
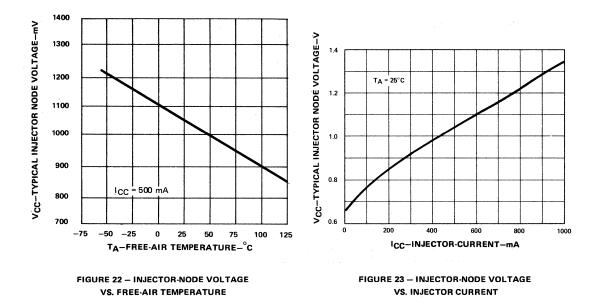


FIGURE 21 - SBP 9900 CLOCK PERIOD VS. INJECTOR CURRENT

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# 6. ELECTRICAL AND MECHANICAL SPECIFICATIONS

# 6.1 SBP 9900 RECOMMENDED OPERATING CONDITIONS, UNLESS OTHERWISE NOTED ICC = 500 mA

|   |  | MIN  | NOM | MAX | UNIT |
|---|--|------|-----|-----|------|
| Supply current, ICC                         |  | 450  | 500 | 550 | mA   |
| High-level output voltage, VOH              |  |      |     | 5.5 | V    |
| Low-level output current, IOL               |  |      |     | 20  | mA   |
| Clock frequency, fclock                     |  | 0    |     | 2   | MHz  |
| Width of electronics t                      | High (67%) (V <sub>IH</sub> = 2.5 V max) | 330  |     |     |      |
| Width of clock pulse, t <sub>W</sub>        | Low (33%)                                | 170  |     |     | ns   |
| Clock rise time, t <sub>r</sub>             |  |      | 10  |     | ns   |
| Clock fall time, t <sub>f</sub>             |  | 1    | 10  |     | ns   |
|   | HOLD                                     | 2101 |     |     |      |
|   | READY                                    | 1401 |     |     | 1    |
|   | D0 D15                                   | 851  |     |     |      |
| Setup time, t <sub>su</sub> (see Figure 24) | CRUIN                                    | 651  | •   |     | ns   |
|   | INTREQ                                   | 25↑  |     |     |      |
|   | IC0 – IC3                                | 25↑  |     |     | 1    |
|   | HOLD                                     | 25↑  |     |     |      |
|   | READY                                    | 651  |     |     |      |
| Hold time to (see Figure 24)                | D0 – D15                                 | 65↑  |     |     |      |
| Hold time, t <sub>h</sub> (see Figure 24)   | CRUIN                                    | 55↑  |     |     | ns   |
|   | INTREQ                                   | 901  |     |     |      |
|   | IC0 – IC3                                | 106  |     |     |      |
| Operating free-air temperature, TA          | SBP 9900 M/N                             | 55   |     | 125 | °c   |
| operating free on compositions, r A         | SBP 9900E                                | -40  |     | 85  |      |

Thising edge of clock pulse is reference.

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#### TENTATIVE DATA SHEET

This document provides tentative information on a new product. Texas instruments reserves the right to change specifications for this product in any manner without notice.

# 6.2 SBP 9900 ELECTRICAL CHARACTERISTICS (OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE, UNLESS OTHERWISE NOTED)

|      | PARAMETER              |                  | TEST CON  | DITIONS  | MIN | TYP‡ | MAX  | UNIT |
|------|------------------------|------------------|---|--|-----|------|------|------|
| VIH  | High-level input volta | ge               |   |  | 2   |      |      | V    |
| VIL  | Low-level input volta  | ge               |   |  |     |      | 0.8  | V    |
| VIK  | Input clamp voltage    |                  | ICC = MIN,  | lj = -12 mA                                      |     |      | -1.5 | V    |
| юн   | High-level output cur  | rent             | I <sub>CC</sub> = 500 mA,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V<br>V <sub>OH</sub> = 5.5 V |     |      | 400  | μA   |
| VOL  | Low-level output volt  | age              | I <sub>CC</sub> = 500 mA,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V<br>I <sub>OL</sub> = 20 mA |     |      | 0.4  | v    |
| 1.   | Input current          | Clock            | I <sub>CC</sub> = 500 mA,                             | Vi = 2.4 V                                       |     | 480  | 600  |      |
| li – | mput current           | All other inputs | 100 mA,   | v] - 2.4 v                                       |     | 240  | 300  | μA   |

<sup>†</sup>For conditions shown as MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $I_{CC}$  = 500 mA,  $T_A$  = 25°C.

# 6.3 SBP 9900 SWITCHING CHARACTERISTICS, I<sub>CC</sub> = 500 mA, (OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE UNLESS OTHERWISE NOTED) SEE FIGURES 24 AND 25.

| PARAMETER        | FROM    | то                            | TEST CONDITIONS                                 | MIN | түр‡ | MAX         | UNIT |
|------------------|---------|-------------------------------|---|-----|------|-------------|------|
| f <sub>max</sub> | MAXIMUM | CLOCK FREQUENCY               |   | 2   |      |             | MHz  |
| tPLH or tPHL     | CLOCK   | ADDRESS BUS (A0 – A14)        |   |     | 170  | 225 ·       | ns   |
| tPLH or tPHL     | CLOCK   | DATA BUS (D0 - D15)           |   |     | 170  | <b>26</b> 5 | ns   |
| tPLH or tPHL     | CLOCK   | WRITE ENABLE (WE)             |   |     | 220  | 295         | ns   |
| tPLH or tPHL     | CLOCK   | CYCLE END (CYCEND)            |   |     | 170  | 225         | ns   |
| tPLH or tPHL     | CLOCK   | DATA BUS IN (DBIN)            |   |     | 190  | 250         | ns   |
| tPLH or tPHL     | CLOCK   | MEMORY ENABLE (MEMEN)         | C <sub>L</sub> = 150 pF, R <sub>L</sub> = 280 Ω |     | 155  | 205.        | ns   |
| tPLH or tPHL     | CLOCK   | CRU CLOCK (CRUCK)             |   |     | 187  | 280         | ns   |
| tPLH or tPHL     | CLOCK   | CRU DATA OUT (CRUOUT)         |   |     | 210  | 265         | ns   |
| tPLH or tPHL     | CLOCK   | HOLD ACKNOWLEDGE (HLDA)       |   |     | 320  | 410         | ns   |
| tPLH or tPHL     | CLOCK   | WAIT                          |   |     | 155  | 210         | ns   |
| tPLH or tPHL     | CLOCK   | INSTRUCTION ACQUISITION (1AQ) |   |     | 155  | 210         | ns   |

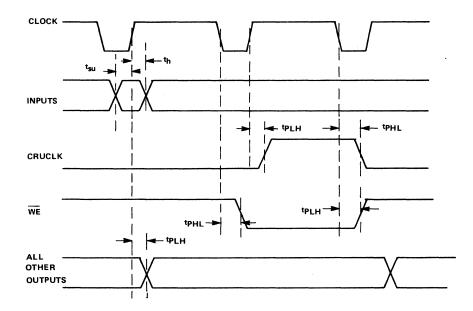
 $\ddagger$ All typical values are at  $25^{\circ}$ C.

#### TENTATIVE DATA SHEET

This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

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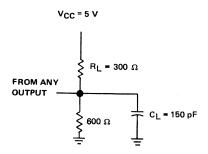
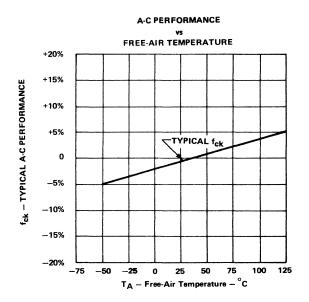


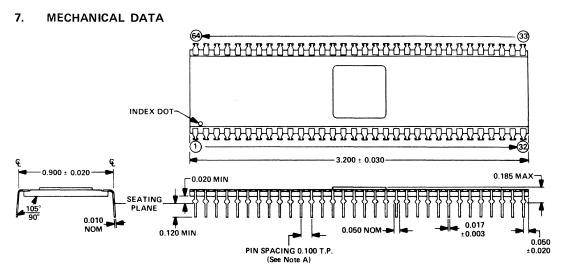
FIGURE 25 - SWITCHING TIMES LOAD CIRCUITS

# 6.4 CLOCK FREQUENCY VS. TEMPERATURE

Stability of the operational frequency over the full temperature range of -55°C to 125°C is illustrated in Figure 26.







NOTE A. Each pin centerline is located within 0.010 of its true longitudinal position.

# 8. SBP 9900 PROTOTYPING SYSTEM

### 8.1 HARDWARE

The TMS 9900 prototyping system enables the user to generate and debug software and to debug I/O controller interfaces. The prototyping system consists of:

- 990/4 computer with TMS 9900 microprocessor
- 1024 bytes of ROM containing the bootstrap loader for loading prototyping system software, the front-panel and maintenance utility, and the CPU self-testing feature
- 16,896 bytes of RAM with provisions for expansion up to 57,334 bytes of RAM
- Programmable-write-protect feature for RAM
- Interface for Texas Instruments Model 733 ASR\* Electronic Data Terminal with provisions for up to five additional interface moculdes

\* Requires remote device control and 1200 baud EIA interface option on 733 ASR.

- Available with Texas Instruments Model 733 ASR Electronic Data Terminal
- 7-inch-high table-top chassis
- Programmer's front panel with controls for run, halt, single-instruction execute, and entering and displaying memory or register contents
- Power supply with the following voltages:
  - 5 V dc @ 20 A
  - 12 V dc @ 2 A
  - —12 V dc @ 1 A
  - –5 V dc @ 0.1 A
- Complete hardware and software documentation.

#### 8.2 SYSTEM CONSOLE

The system console for the prototyping system is the 733 ASR, which provides keyboard entry, 30-character-per-second thermal printer, and dual cassette drives for program loading and storage.

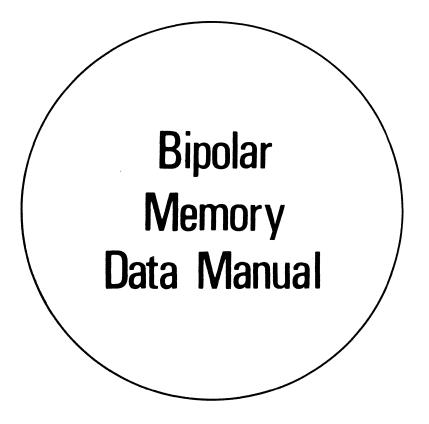
# 8.3 SOFTWARE

The following software is provided on cassette for loading into the prototyping system:

- Debug Monitor Provides full control of the prototyping system during program development and includes single instruction, multiple breakpoints, and entry and display capability for register and memory contents for debugging user software under 733 ASR console control.
- One-Pass Assembler Converts source code stored on cassette to relocatable object on cassette and generates program listing. (Object is upward compatible with other 990 series assemblers).
- Linking Loader Allows loading of absolute and relocatable object modules and links object modules as they are loaded.
- Source Editor Enables user modification of both source and object from cassette with resultant storage on cassette.
- Trace Routine Allows user to monitor status of computer at completion of each instruction.
- PROM Programming/Documentation Facility Provides documentation for ROM mask generation, or communicates directly with the optional PROM Programmer Unit.

The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group





SEPTEMBER 1977

TEXAS INSTRUMENTS

# **INDEX FOR SCHOTTKY TTL BIPOLAR MEMORIES**

# FIELD PROGRAMMABLE READ-ONLY MEMORY (PROM) LINE SUMMARY (SEE PAGES 1 AND 6)

# MASK-PROGRAMMED READ-ONLY MEMORY (ROM) LINE SUMMARY

|              | TYPE OF             | BIT SIZE                   | TYPICAL PE | RFORMANCE            |             |
|--------------|---------------------|----------------------------|------------|----------------------|-------------|
| TYPE NUMBER  | OUTPUT(S)           |                            |            | POWER<br>DISSIPATION | SEE<br>PAGE |
| SN54/7488A   | Open-Collector      | 256 Bits<br>(32 W x 8 B)   | 26 ns      | 320 mW               | 9           |
| SN54/74187   | Open-Collector      | 1024 Bits<br>(256 W x 4 B) | 40 ns      | 460 mW               | 9           |
| SN54S/74S270 | Open-Collector      | 2048 Bits                  | 45         | FOF 14               |             |
| SN54S/74S370 | 3-State             | (512 W × 4 B)              | - 45 ns    | 525 mW               | 9           |
| SN54S/74S271 | Open-Collector      | 2048 Bits                  | 45         | F05                  |             |
| SN54S/74S371 | 3-State             | (256 W x 8 B)              | - 45 ns    | 525 mW               | 9           |
| SBP 8316M/C  | 0-C or 10 kΩ pullup | 16.384                     | ≥350 ns    | ≤500 mW              | 16          |
| SBP 9818M/C  | Open-Collector      | (2048W x 8 B)              | ≥150 ns    | ≤500 mW              | 10          |

# **READ/WRITE MEMORY (RAM) LINE SUMMARY**

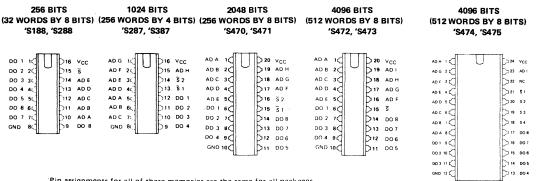
|  | BIT SIZE               | ΟυΤΡυΤ                        | TYPICAL PE             | FORMANCE             | SEE  |
|--|------------------------|-------------------------------|------------------------|----------------------|------|
| TYPE NUMBER                            | (ORGANIZATION)         | CONFIGURATION                 | ADDRESS<br>ACCESS TIME | POWER<br>DISSIPATION | PAGE |
| SN54S/74S189(J,N)<br>SN54S/74S289(J,N) | 64 bits<br>(16 W x 4B) | Three-state<br>Open-Collector | 25 ns                  | 375 mW               | 20   |
| SN74S201(J,N)                          | 256 bits               | Three-State                   | 42 ns                  | 500 mW               | 24   |
| SN74S301(J,N)                          | (256 W x 1B)           | Open-Collector                | 42 ns                  | 500 mW               | 24   |
| SN74S214(J,N)                          |                        |                               | 40 ns                  | 550 mW               |      |
| SN74LS214(J,N)                         |                        | Three-State                   | 65 ns                  | 200 mW               |      |
| SN74LS215(J,N)                         | 1024 bits              |                               | 75 ns                  | 200/100*mW           | 27   |
| SN74S314(J,N)                          | (1024 W × 1B)          |                               | 40 ns                  | 550 mW               | 21   |
| SN74LS314(J,N)                         |                        | Open-Collector                | 75 ns                  | 200 mW               |      |
| SN74S314(J,N)                          |                        |                               | 75 ns                  | 200/100*mW           |      |
| SN74S207(J,N)                          |                        |                               | 40 ns                  | 600 mW               |      |
| SN74LS207(J,N)                         | 1024 bits              | 4 bits Three-State            |                        | 200 mW               | . 33 |
| SN74S208(J,N)                          | (256 W × 4B)           | i mee-State                   | 40 ns                  | 600 mW               | 33   |
| SN74LS208(J,N)                         | Ľ                      |                               | 75 ns                  | 200 mW               |      |

# FIRST-IN/FIRST-OUT (FIFO) MEMORY

| TYPE NUMBER | 017 0175                   |               | TYPICAL PER   | FORMANCE |             | SEE  |
|-------------|----------------------------|---------------|---------------|----------|-------------|------|
|             | BIT SIZE<br>(ORGANIZATION) | DATA          | RATES         | FALL     | POWER       | PAGE |
|             | (URGANIZATION)             | INPUT         | OUTPUT        | THROUGH  | DISSIPATION | FAGE |
| SN74S225    | 80 bits<br>(16 W x 5B)     | d-c to 10 MHz | d-c to 10 MHz | 190 ns   | 400 mW      | 39   |

- Titanium-Tungsten (Ti-W) Fuse Links for Fast, Low-Voltage, Reliable Programming
- All Schottky-Clamped PROM's Offer: . Fast Chip Select to Simplify System Decode Choice of Three-State or Open-Collector Outputs P-N-P Inputs for Reduced Loading on System Buffers/Drivers
- Full Decoding and Chip Select Simplify System Design
- **Applications Include:** Microprogramming/Firmware Loaders Code Converters/Character Generators Translators/Emulators Address Mapping/Look-Up Tables

|                | R (PACKAGES)   | BIT SIZE       | OUTPUT         | TYPICAL PE             | RFORMANCE            |
|----------------|----------------|----------------|----------------|------------------------|----------------------|
| -55°C to 125°C | 0°C to 70°C    | (ORGANIZATION) | CONFIGURATION  | ADDRESS<br>ACCESS TIME | POWER<br>DISSIPATION |
| SN54S188(J, W) | SN74S188(J, N) | 256 bits       | open-collector | 05                     |                      |
| SN54S288(J, W) | SN74S288(J, N) | (32 W × 8 B)   | three-state    | 25 ns                  | 400 mW               |
| SN54S287(J, W) | SN74S287(J, N) | 1024 bits      | three-state    | 40                     | 500                  |
| SN54S387(J, W) | SN74S387(J, N) | (256 W × 4 B)  | open-collector | 42 ns                  | 500 mW               |
| SN54S470(J)    | SN74S470(J, N) | 2048 bits      | open-collector | 50                     |                      |
| SN54S471(J)    | SN74S471(J, N) | (256 W × 8 B)  | three-state    | 50 ns                  | 550 mW               |
| SN54S472(J)    | SN74S472(J, N) | 4096 bits      | three-state    |                        |                      |
| SN54S473(J)    | SN74S473(J, N) | (512 W x 8 B)  | open-collector | 55 ns                  | 600 mW               |
| SN54S474(J, W) | SN74S474(J, N) | 4096 bits      | three-state    |                        | 000 14               |
| SN54S475(J, W) | SN74S475(J, N) | (512 W × 8 B)  | open-collector | 55 ns                  | 600 mW               |



Pin assignments for all of these memories are the same for all packages.

# description

977

These monolithic TTL programmable read-only memories (PROM's) feature titanium-tungsten (Ti-W) fuse links with each link designed to program with a 100 microsecond pulse. These PROM's offer considerable flexibility for upgrading existing designs or improving new designs as they feature full Schottky clamping for improved performance, low-current MOS-compatible p-n-p inputs, choice of bus-driving three state or open-collector outputs, and improved chip-select access times.

The high-complexity 2048- and 4096-bit 20-pin PROM's can be used to significantly improve system density for fixed memories as all are offered in dual-in-line packages having pin-row spacings of 0.300 inch.

PRELIMINARY DATA SHEET: Supplementary data may be published at a later date. TEXAS INSTRUMENTS POST OFFICE BOX 5012 . DALLAS, TEXAS 75222

<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

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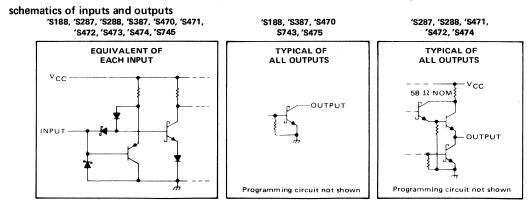
# SERIES 54S/74S PROGRAMMABLE READ-ONLY MEMORIES

#### description (continued)

Data can be electronically programmed, as desired, at any bit location in accordance with the programming procedure specified. All PROM's, except the 'S287 and 'S387 are supplied with a low-logic-level output condition stored at each bit location. The programming procedure open-circuits Ti-W metal links, which reverses the stored logic level at selected locations. The procedure is irreversible; once altered, the output for that bit location is permanently programmed. Outputs never having been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content.

Active level(s) at the chip-select input(s) enables all of the outputs. An inactive level at any chip-select input causes all outputs to be off.

The three-state output offers the convenience of an open-collector output with the speed of a totem-pole output; it can be bus-connected to other similar outputs yet it retains the fast rise time characteristic of the TTL totem-pole output. The open-collector output offers the capability of direct interface with a data line having a passive pull-up.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage (see Note 1)           |                 | <br> | 7V             |
|---------------------------------------|-----------------|------|----------------|
| Input voltage                         |                 | <br> | 5.5 V          |
| Off-state output voltage              |                 | <br> | 5.5 V          |
| Operating free-air temperature range: | SN54S' Circuits | <br> | –55°C to 125°C |
|                                       |                 |      |                |
| Storage temperature range             |                 | <br> | –65°C to 150°C |

# recommended conditions for programming the 'S188, 'S287, 'S288, 'S387, 'S470 through 'S475

|   |                 | SN5  | 4S', SN | 74S'           |      |
|---|-----------------|------|---------|----------------|------|
|   |                 | MIN  | NOM     | MAX            | UNIT |
| Supply voltage, V <sub>CC</sub> (see Note 1)                              | Steady state    | 4.75 | 5       | 5.25           | v    |
| Supply voltage, VCC (see 100te 1)   | Program pulse   | 10   | 10.5    | 11†            | V    |
| Input voltage   | High level, VIH | 2.4  |         | <sup>.</sup> 5 | v    |
| input voltage   | Low level, VIL  | 0    |         | 0.5            |      |
| Termination of all outputs except the one to be programmed                |                 | See  |         |                |      |
|   |                 | (    | Figure  | 1)             |      |
| Voltage applied to output to be programmed, $V_{Q(pr)}$ (see Note 2)      |                 | 0    | 0.25    | 0.3            | V    |
| Duration of V <sub>CC</sub> programming pulse Y (see Figure 2 and Note 3) |                 | 98   | 100     | 103            | μs   |
| Programming duty cycle  |                 | 1    | 25      | 35             | %    |
| Free-air temperature  |                 | 0    |         | 55             | °C   |

<sup>†</sup>Absolute maximum ratings.

NOTES: 1. Voltage values are with respect to network ground terminal. The supply-voltage rating does not apply during programming.
 2. The 'S188, 'S288, 'S470, 'S471, 'S472, 'S473, 'S474, and 'S475 are supplied with all bit locations containing a low logic level, and programming a bit changes the output of the bit to high logic level. The 'S287 and 'S387 are supplied with all bit outputs at a high

logic level, and programming a bit changes it to a low logic level. The S287 a

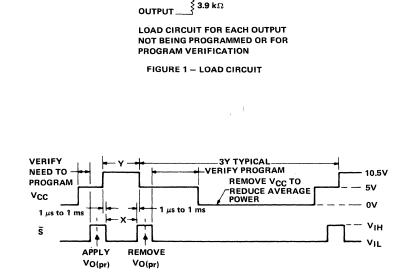
3. Programming is guaranteed if the pulse applied is 98 µs in duration.

# step-by-step programming procedure for the 'S188, 'S287, 'S288, 'S387, 'S470 through 'S475

- 1. Apply steady-state supply voltage (V<sub>CC</sub> = 5 V) and address the word to be programmed.
- 2. Verify that the bit location needs to be programmed. If not, proceed to the next bit.
- 3. If the bit requires programming, disable the outputs by applying a high-logic-level voltage to the chip-select input(s).
- 4. Only one bit location is programmed at a time. Connect each output not being programmed to 5 V through  $3.9k\Omega$  and apply the voltage specified in the table to the output to be programmed. Maximum current out of the programming output is 150 mA. This current flows from the programmer into the PROM output.
- 5. Step V<sub>CC</sub> to 10.5 V nominal. Maximum supply current required during programming is 750 mA.
- 6. Apply a low-logic-level voltage to the chip-select input(s). This should occur between 1 μs and 1 ms after V<sub>CC</sub> has reached its 10.5-V level. See programming sequence of Figure 2.
- 7. After the X pulse time is reached, a high logic level is applied to the chip-select inputs to disable the outputs.
- 8. Within 1  $\mu$ s to 1 ms after the chip-select input(s) reach a high logic level, V<sub>CC</sub> should be stepped down to 5 V at which level verification can be accomplished.
- 9. The chip-select input(s) may be taken to a low logic level (to permit program verification)  $1 \mu s$  or more after V<sub>CC</sub> reaches its steady-state value of 5 V.
- 10. At a Y pulse duty cycle of 35% or less, repeat steps 1 through 8 for each output where it is desired to program a bit.

5V

NOTE: Only one programming attempt per bit is recommended.







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# **SERIES 54S/74S PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS**

# recommended operating conditions

| PARAMETER                        | PARAMETER  |      | 'S287, 'S471 |      | <b>'S288</b> |     |      | 'S472, 'S474 |     |      |      |
|----------------------------------|------------|------|--------------|------|--------------|-----|------|--------------|-----|------|------|
|                                  |            | MIN  | NOM          | MAX  | MIN          | NOM | MAX  | MIN          | NOM | MAX  | UNIT |
| Sumphraphane Mar                 | Series 54S | 4.5  | 5            | 5.5  | 4.5          | 5   | 5.5  | 4.5          | 5   | 5.5  |      |
| Supply voltage, VCC              | Series 74S | 4.75 | 5            | 5.25 | 4.75         | 5   | 5.25 | 4.75         | 5   | 5,25 |      |
| High lovel entered entered in    | Series 54S |      |              | -2   |              |     | -2   |              |     | -2   |      |
| High-level output current, IOH   | Series 74S |      |              | -6.5 |              |     | 6.5  |              |     | -6.5 | mΑ   |
| Low-level output current, IOL    |            |      |              | 16   |              |     | 20   |              |     | 12   | mA   |
| Operation from air temperature T | Series 54S | -55  |              | 125♦ | -55          |     | 125  | -55          |     | 125  | 0.0  |
| erating free-air temperature, TA | Series 74S | 0    |              | 70   | 0            |     | 70   | 0            |     | 70   | °c   |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|       | <b>D</b>  |  |   |     | SN54S' |      | SN74S' |      |      |      |
|-------|---|--|---|-----|--------|------|--------|------|------|------|
|       | PARAMETER   | TEST CONDIT  | IONS  | MIN | TYP‡   | MAX  | MIN    | TYP‡ | MAX  | UNIT |
| VIH · | High-level input voltage                                |  |   | 2   |        |      | 2      |      |      | v    |
| VIL   | Low-level input voltage                                 |  |   |     |        | 0.8  |        |      | 0.8  | V    |
| VIK   | Input clamp voltage                                     | V <sub>CC</sub> = MIN,                             | lı =18 mA                                       |     |        | -1.2 |        |      | -1.2 | V    |
| ∨он   | High-level output voltage                               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX | 2.4 | 3.4    |      | 2.4    | 3.2  |      | v    |
| VOL   | Low-level output voltage                                | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX |     |        | 0.5  |        |      | 0.5  | v    |
| IOZH  | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 2.4 V   | V <sub>IH</sub> = 2 V,                          |     |        | 50   |        |      | 50   | μΑ   |
| IOZL  | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.5 V   | V <sub>IH</sub> = 2 V,                          |     |        | -50  |        |      | 50   | μΑ   |
| lj    | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V                          |     |        | 1    |        |      | 1    | mA   |
| Чн    | High-level input current                                | V <sub>CC</sub> = MAX,                             | V1 = 2.7 V                                      |     |        | 25   |        |      | 25   | μA   |
| 41    | Low-level input current                                 | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 0.5 V                          |     |        | -250 |        |      | -250 | μA   |
| los   | Short-circuit output current §                          | V <sub>CC</sub> = MAX                              |   | -30 |        | -100 | -30    |      | -100 | mA   |
|       |   | V <sub>CC</sub> = MAX,                             | 'S287   |     | 100    | 135  |        | 100  | 135  |      |
|       |   | Chip select(s) at 0 V,                             | 'S288   |     | 80     | 110  |        | 80   | 110  |      |
| ICC   | Supply current  | Outputs open,                                      | 'S471   |     | 110    | 155  |        | 110  | 155  | mA   |
|       |   | See Note 4   | 'S472, 'S474                                    |     | 120    | 155  |        | 120  | 155  | 1    |

# switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ               | TEST CONDITIONS                           | t <sub>a(ad)</sub> (ns)<br>Access time from<br>address |      |     | t <sub>a</sub> (͡S) (ns)<br>Access time from<br>chip select (enable time) |      |     | tp <sub>XZ</sub> (ns)<br>Disable time from<br>high or low level |      |     | UNIT |
|--------------------|---|--|------|-----|---|------|-----|---|------|-----|------|
|                    |   | MIN  | TYP‡ | MAX | MIN   | TYP‡ | MAX | MIN   | TYP‡ | MAX |      |
| SN54S287           |   |  | 42   | 75  |   | 15   | 40  |   | 12   | 40  | ns   |
| SN74S287           | CL= 30 pF for                             |  | 42   | 65  |   | 15   | 35  |   | 12   | 35  | ns   |
| SN54S288           | t <sub>a(ad)</sub> and t <sub>a</sub> (S) |  | 25   | 50  |   | 12   | 30  |   | 8    | 30  | ns   |
| SN74S288           | 5 pF for tpxz;                            |  | 25   | 40  |   | 12   | 25  |   | 8    | 20  | ns   |
| SN54S471           | R <sub>L</sub> = 300 Ω;                   |  | 50   | 80  |   | 20   | 40  |   | 15   | 35  | ns   |
| SN74S471           | See Figure 2,                             |  | 50   | 70  |   | 20   | 35  |   | 15   | 30  | ns   |
| SN54S472, SN54S474 | Page 13                                   |  | 55   | 85  |   | 20   | 45  |   | 15   | 40  | ns   |
| SN74S472, SN74S474 |   |  | 55   | 75  |   | 20   | 40  |   | 15   | 35  | ns   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. §Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

An SNS4287 in the W package operating at free-air temperatures above 108°C requires a heat sink that provides a thermal resistance from case-to-free-air,  $R_{\phi CA}$ , of not more than  $42^{\circ}$ C/W. NOTE 4: The typical values of I<sub>CC</sub> shown are with all outputs low.



# recommended operating conditions

| PARAMETER                             |                         |      | 'S188 |      | 's   | 387, 'S | 470  | 'S   | UNIT |      |     |  |
|---------------------------------------|-------------------------|------|-------|------|------|---------|------|------|------|------|-----|--|
|                                       |                         | MIN  | NOM   | MAX  | MIN  | NOM     | MAX  | MIN  | NOM  | MAX  |     |  |
| Supply voltage, V <sub>CC</sub>       | Series 54S              | 4.5  | 5     | 5.5  | 4.5  | 5       | 5.5  | 4.5  | 5    | 5.5  |     |  |
|                                       | Series 74S              | 4.75 | 5     | 5.25 | 4.75 | 5       | 5.25 | 4.75 | 5    | 5.25 | l v |  |
| High-level output voltage, VOH        |                         |      |       | 5.5  |      |         | 5.5  |      |      | 5.5  | 5 V |  |
| Low-level output current, IOL         | vel output current, IOL |      |       | 20   |      |         | 16   |      |      | 12   | mA  |  |
| Operating free-air temperature, $T_A$ | Series 54S              | 55   |       | 125  | -55  |         | 125♦ | -55  |      | 125  | °c  |  |
|                                       | Series 74S              | 0    |       | 70   | 0    |         | 70   | 0    |      | 70   |     |  |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | PARAMETER                              | TEST CONDI                                       | TIONST                  | MIN | гүр‡ | МАХ  | UNIT |
|-----|--|--|-------------------------|-----|------|------|------|
| VIH | High-level input voltage               |  |                         | 2   |      |      | V    |
| VIL | Low-level input voltage                |  |                         |     |      | 0.8  | V    |
| VIK | Input clamp voltage                    | V <sub>CC</sub> = MIN,                           | lj =18 mA               |     |      | -1.2 | V    |
| юн  | High-level output current              | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V, | V <sub>OH</sub> = 2.4 V |     |      | 50   | μA   |
| ЮН  |  | V <sub>IL</sub> = 0.8 V                          | V <sub>OH</sub> = 5.5 V |     |      | 100  | μΑ   |
| VOL | Low-level output voltage               | V <sub>CC</sub> = MIN,                           | V <sub>IH</sub> = 2 V,  |     |      | 0.5  | v    |
| VOL |  | V <sub>IL</sub> = 0.8 V,                         | I <sub>OL</sub> = MAX   |     |      | 0.5  | v    |
| 4   | Input current at maximum input voltage | V <sub>CC</sub> = MAX,                           | VI = 5.5 V              |     |      | 1    | mA   |
| Чн  | High-level input current               | V <sub>CC</sub> = MAX,                           | V <sub>I</sub> = 2.7 V  |     |      | 25   | μA   |
| ЧL  | Low-level input current                | V <sub>CC</sub> = MAX,                           | V <sub>1</sub> = 0.5 V  |     |      | -250 | μA   |
|     |  | V <sub>CC</sub> = MAX,                           | ʻS188                   |     | 80   | 110  |      |
| 1   | Current and                            | Chip select(s) at 0 V,                           | ʻS387                   |     | 100  | 135  |      |
| 1cc | Supply current                         | Outputs open,                                    | 'S470                   |     | 110  | 155  | mA   |
|     |  | See Note 4                                       | 'S473; 'S475            |     | 120  | 155  | ]    |

# switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ               | TEST CONDITIONS                                     | Acce | <sup>t</sup> a(ad)<br>ess time<br>address |     | c   | <sup>t</sup> a(S)<br>ess time<br>hip sele<br>nable tir | ct  | put fr | <sup>t</sup> PLH<br>ition del<br>-high-lev<br>om chip<br>sable tir | el out-<br>select | UNIT |
|--------------------|---|------|---|-----|-----|--|-----|--------|--|-------------------|------|
|                    |   | MIN  | TYP‡                                      | MAX | MIN | TYP‡   | MAX | MIN    | TYP‡   | MAX               |      |
| SN54S188           |   |      | 25  | 50  |     | 12   | 30  |        | 12   | 30                | ns   |
| SN74S188           |   |      | 25  | 40  |     | 12   | 25  |        | 12   | 25                | ns   |
| SN54S387           | $C_L = 30 \text{ pF},$                              |      | 42  | 75  |     | 15   | 40  |        | 15   | 40                | ns   |
| SN74S387           | $R_{L1} = 300 \Omega,$                              |      | 42  | 65  |     | 15   | 35  |        | 15   | 35                | ns   |
| SN54S470           | $R_{L2} = 600 \Omega$ ,<br>See Figure 1,<br>Page 13 |      | 50  | 80  |     | 20   | 40  |        | 15   | 35                | ns   |
| SN74S470           |   |      | 50  | 70  |     | 20   | 35  |        | 15   | 30                | ns   |
| SN54S473, SN54S475 |   |      | 55  | 85  |     | 20   | 45  |        | 15   | 40                | ns   |
| SN74S743, SN74S475 |   |      | 55  | 75  |     | 20   | 40  |        | 15   | 35                | ns   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C.

A SN54S387 in the W package operating at free-air temperatures above  $108^{\circ}$ C requires a heat sink that provides a thermal resistance from case-to-free-air, R<sub> $\theta$ </sub> C<sub>A</sub>, of not more than  $42^{\circ}$ C/W.

NOTE 4: The typical values of ICC shown are with all outputs low.



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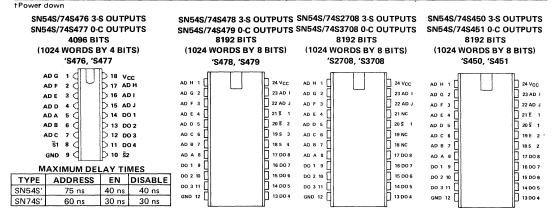
4

# SCHOTTKY† PROMS

# SERIES 54S/74S PROGRAMMABLE READ-ONLY MEMORIES

- Titanium-Tungsten (Ti-W) Fuse Links for Fast Low-Voltage Reliable Programming
- Full Decoding and Chip Select Simplify System Design
- Power-Down Versions ('S450, 'S451) Can Reduce System Power Requirements
- Fast Chip Select to Simplify System Decode
- Choice of Three-State or Open Collector Outputs
- PNP Inputs for Reduced Loading on System Buffers/Drivers
- Applications Include: Microprogramming/Firmware Loaders Code Converters/Character Generators Translators/Emulators Address Mapping/Look-Up Tables

| TYPE NUMBE     | R (PACKAGES)   | BIT SIZE       | OUTPUT         | TYPICAL PERFORMANCE |        |                         |  |  |  |  |  |
|----------------|----------------|----------------|----------------|---------------------|--------|-------------------------|--|--|--|--|--|
| -55°C to 125°C | 0°C to 70°C    | (ORGANIZATION) | CONFIGURATION  | ACCESS              | TIMES  | POWER                   |  |  |  |  |  |
| -55 C 10 125 C | 000000         | (UNGANIZATION) | CONFIGURATION  | ADDRESS             | SELECT | DISSIPATION             |  |  |  |  |  |
| SN54S450(J)    | SN74S450(J,N)  | 8192 bits      | three-state    | 45 ns               | 20 ns  | 600/100 <sup>†</sup> mW |  |  |  |  |  |
| SN54S451(J)    | SN74S451(J,N)  | 1024 W x 8 B   | open-collector | 45 ns               | 20 hs  | 600/100° mw             |  |  |  |  |  |
| SN54S478(J)    | SN74S478(J,N)  | 8192 bits      | three-state    | 45                  |        | 000                     |  |  |  |  |  |
| SN54S479(J)    | SN74S479(J,N)  | 1024 W x 8 B   | open-collector | 45 ns               | 20 ns  | 600 mW                  |  |  |  |  |  |
| SN54S2708(J)   | SN74S2708(J,N) | 8192 bits      | three-state    | 45                  |        | 000 111                 |  |  |  |  |  |
| SN54S3708(J)   | SN74S3708(J,N) | 1024 W x 8 B · | open-collector | 45 ns               | 20 ns  | 600 mW                  |  |  |  |  |  |
| SN54S476(J)    | SN74S476(J,N)  | 4096 bits      | three-state    | 05                  | 45     | 175                     |  |  |  |  |  |
| SN54S477(J)    | SN74S477(J,N)  | 1024 W × 4 B   | open-collector | 35 ns               | 15 ns  | 475 mW                  |  |  |  |  |  |



#### description

These monolithic TTL programmable read-only memories (PROM's) features titanium-tungsten (Ti-W) fuse links with each link designed to program with a 100 microsecond pulse. They offer considerable flexibility for upgrading existing designs or improving new designs as they feature full Schottky clamping for improved performance, low-current MOS-compatible p-n-p inputs, and choice of bus-driving three-state or open-collector outputs. Additionally, the 'S450, 'S451 features dual enable/disable inputs which power-down or power-up the PROM providing additional cost effectiveness in power-sensitive applications. The power-down and power-up functions are sequenced to occur with the outputs at a high impedance.

Data can be electrically programmed, as desired, at any bit location in accordance with the programming procedure specified. These new PROM's are supplied with a high logic-level output condition stored at each bit location. The programming procedure open-circuits Ti-W metal links, which reverses the stored logic level at selected locations. The

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DESIGN GOAL This document provides tentative information on a product in the developmental stage. Texas Instruments reserves the right to change or discontinue this product without notice.

TEXAS INSTRUMENTS

<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas 977 Instruments. U.S. Patent Number 3,463,975.

# SERIES 54S/74S PROGRAMMABLE READ-ONLY MEMORIES

procedure is irreversible. Once altered, the output for that bit location is permanently programmed. Outputs never having been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content. Active level(s) at the chip-select(s) or memory enable (E) input(s) activates all of the outputs, and the 'S450, 'S451 memory enable will initiate a power-up sequence. An inactive level at any chip-select or memory enable input causes all outputs to be off, and the memory enable will initiate a power-down sequence. The three-state output offers the convenience of an open-collector output with the speed of a totem-pole output; it can be bus-connected to other similar outputs yet it retains the fast rise time characteristic of the TTL totem-pole output. The open-collector output offers the capability of direct interface with a data line having a passive pull-up.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage                |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  |    |     |    | 7    | v  |
|-------------------------------|-----|-----|-----|----|-----|------|------|-----|---|--|--|--|--|--|--|--|----|-----|----|------|----|
| Input voltage                 |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  |    |     |    |      |    |
| Off-state output voltage      |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  |    |     |    |      |    |
| Operating free-air temperatur | e r | ang | ge: | SN | 154 | S' ( | Circ | uit | s |  |  |  |  |  |  |  | -5 | 5°C | to | 125  | °c |
|                               |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  |    |     |    | o 70 |    |
| Storage temperature range     |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  | 6  | 5°C | to | 150  | °C |
|                               |     |     |     |    |     |      |      |     |   |  |  |  |  |  |  |  |    |     |    |      |    |

### recommended conditions for programming

| PARAMETER  | <b>'</b> \$4              | 50, 'S | 451 |                 | HER<br>S | UNIT                |        |    |  |  |  |
|--|---------------------------|--------|-----|-----------------|----------|---------------------|--------|----|--|--|--|
|  |                           | MIN    | NOM | ΜΑΧ             |          |                     | MAX    |    |  |  |  |
|  | Steady state              | 5.8    | 6   | 6.25            | 4.75     | 5                   | 5.25   | v  |  |  |  |
| Supply voltage, V <sub>CC</sub> (See Note 1)                         | During programming        | 6.8    | 7   | 7.25            | 5.75     | 6                   | 6.25   |    |  |  |  |
|  | High level, VIH           | 2.4    |     | 5               | 2.4      |                     | 5      |    |  |  |  |
| Address input voltage  | Low level, VIL            | 0.0    |     | 0.5             | 0.0      |                     | 0.5    | v  |  |  |  |
|  | to disable                | 9.75   | 10  | 10.25†          | 9.75     | 10                  | 10.25† |    |  |  |  |
| Select input voltage, VS   | to enable                 | 0.0    |     | 0.5             | 0.0      |                     | 0.5    | V  |  |  |  |
| Termination of all outputs except the one to be programmed           |                           | 0.0    |     | 0.5             | 0.0      |                     | 0.5    | V  |  |  |  |
| Voltage applied to output to be programmed, $V_{O(pr)}$ (See Note 2) |                           | 16.75  | 17  | 17.25†          | 16.7     | 5 17                | 17.25† | V  |  |  |  |
| Programming ramp (10% to 90% times                                   | Rise time, t <sub>r</sub> | 10‡    |     | 50              | 10‡      |                     | 50     |    |  |  |  |
| for VCC, VS, and VO(pr)  | Fall time, t <sub>f</sub> | 10     |     |                 | 10       |                     |        | μs |  |  |  |
| Duration of VO(pr) programming pulse (See Figure 3)                  |                           | 98     | 100 | 10 <sup>3</sup> | 98       | 100 10 <sup>3</sup> |        |    |  |  |  |
| Programming duty cycle   | 25 35 25 35               |        |     |                 |          |                     |        | %  |  |  |  |
| Free air temperature   |                           | 0      |     | 55              | 0        |                     | 55     | °C |  |  |  |

<sup>†</sup>Absolute maximum ratings.

 $\ddagger This minimum rise time applies only for the <math display="inline">V_{O(pr)}$  ramp.

NOTES: 1. Voltage values are with respect to network ground terminal.

All bit locations contain a high logic level and programming a bit changes the output of the bit to low logic level.
 Programming is guaranteed if the pulse applied is 98 μs in duration.

#### step-by-step programming procedure

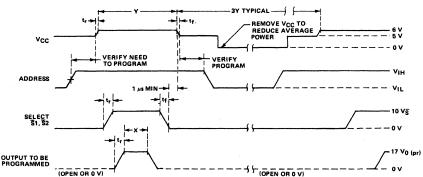
- 1. Apply steady-state supply voltage and address the word to be programmed.
- 2. Enable the PROM and verify that the bit location needs to be programmed. If not, proceed to the next bit.
- If the bit requires programming, increase V<sub>CC</sub> by 1 volt (minimum current capability should be 200 mA) and disable the outputs by applying 10 volts to chip-select inputs. Minimum chip-select input current capabilities should be 5 mA.
- 4. Only one bit location is programmed at a time. Connect each output not being programmed to a 0 to 0.5 volt source. Apply the VO(pr) voltage pulse specified in the table to the output to be programmed. Minimum current capability of the programming output supply (during programming) should be 200 mA. See programming sequence of Figure 1.
- 5. After the X pulse is completed, disconnect the output that was programmed. Then, remove the 0 to 0.5 volt source from the remaining outputs.

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## SERIES 54S/74S PROGRAMMABLE READ-ONLY MEMORIES

- 6. The chip-select inputs may be taken to a low logic level (to permit program verification).
- One microsecond after the chip select input(s) reach low logic level V<sub>CC</sub> should be decreased 1 V at which verification can be accomplished by measuring V<sub>OL</sub> at the programmed output.
- 8. At a Y pulse duty cycle of 35% or less, repeat steps 1 through 7 for each output where it is desired to program a bit.

NOTE: Only one programming attempt per bit is recommended.



### recommended operating conditions

| PARAMETE           |       |     | 'S450 |      |     | 'S451 |      | 'S4  | 78, 'S2 | 708  | <b>'</b> S4 | 79, 'S3 | 708  |      | 'S476 |      |      | 'S477 |      |      |
|--------------------|-------|-----|-------|------|-----|-------|------|------|---------|------|-------------|---------|------|------|-------|------|------|-------|------|------|
| PARAMETE           | R     | MIN | NOM   | MAX  | MIN | NOM   | MAX  | MIN  | NOM     | MAX  | MIN         | NOM     | MAX  | MIN  | NOM   | MAX  | MIN  | NOM   | MAX  | UNIT |
| Supply voltage,    | SN54S | 5.8 | 6     | 6.5  | 5.8 | 6     | 6.5  | 4.5  | 5       | 5.5  | 4.5         | 5       | 5,5  | 4.5  | 5     | 5.5  | 4.5  | 5     | 5.5  | v    |
| Vcc                | SN74S | 5.8 | 6     | 6.25 | 5.8 | 6     | 6.25 | 4.75 | 5       | 5.25 | 4.75        | 5       | 5.25 | 4.75 | 5     | 5.25 | 4.75 | 5     | 5.25 | v    |
| High-level output  | SN54S |     |       | -2   |     |       |      |      |         | -2   |             |         |      |      |       | -2   |      |       |      |      |
| current, IOH       | SN74S |     |       | -3.2 |     |       |      |      |         | -3.2 |             |         |      |      |       | -3.2 |      |       |      | mA   |
| Low-level output   |       |     |       | 12   |     |       | 12   |      |         | 12   |             |         | 12   |      |       | 16   |      |       | 16   |      |
| current, IOL       |       |     |       | 12   |     |       | 12   |      |         | 12   |             |         | 12   |      |       | 10   |      |       | 10   | mA   |
| Operating free-air | SN54S | -55 |       | 125  | -55 |       | 125  | -55  |         | 125  | -55         |         | 125  | -55  |       | 125  | -55  |       | 125  | °c   |
| temperature, TA    | SN74S | 0   |       | 70   | 0   |       | 70   | 0    |         | 70   | 0           |         | 70   | 0    |       | 70   | 0    |       | 70   |      |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER  | TEST COM   |   | 1     | ), 'S476,<br>3, 'S2708 | 'S451, 'S4<br>'S479, 'S3 |      | UNIT |
|-----------------|--|--|---|-------|------------------------|--------------------------|------|------|
|                 |  |  |   | MIN T | YP‡ MAX                | MIN TYP‡                 | MAX  | ]    |
| VIH             | High-level input voltage                               |  |   | 2     |                        | 2                        |      | V    |
| VIL             | Low-level input voltage                                |  |   |       | 0.8                    |                          | 0.8  | V    |
| VIK             | Input clamp voltage                                    | V <sub>CC</sub> = MIN,                             | 1 <sub>1</sub> = -18 mA                         |       | -1.2                   |                          | -1.2 | V    |
| v <sub>он</sub> | High-level output voltage                              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX | 2.4   | 3.4                    |                          |      | v    |
| VOL             | Low-level output voltage                               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX |       | 0.5                    |                          | 0.5  | v    |
| IOZH,           | Off-state output current,                              | VCC = MAX,   | V <sub>0</sub> = 2.4 V                          |       | 50                     |                          | 50   |      |
| юн              | high-level voltage applied                             | V <sub>IH</sub> = 2 V,                             | V <sub>O</sub> = 5.5 V                          |       |                        |                          | 100  | μA   |
| loz∟            | Off-state output current,<br>low-level voltage applied | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.5 V   | V <sub>IH</sub> = 2 V,                          |       | 50                     |                          |      | μA   |
| 4               | Input current at maximum<br>input voltage              | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.5 V                          |       | 1                      |                          | 1    | mA   |
| ήн              | High-level input current                               | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 2.7 V                          |       | 25                     |                          | 25   | μA   |
| կլ              | Low-level input current                                | VCC = MAX,   | V1 = 0.5 V                                      |       | -250                   |                          | -250 | μA   |
| 1.0.0           | Short-circuit output current §                         | VMAX   | SN54S'  | -20   | -100                   |                          |      | -    |
| los             | Short-circuit output currents                          | V <sub>CC</sub> = MAX                              | SN74S'  | -15   | -100                   | ]                        |      | mA   |
| 1               | Suealu aureat  |  | 4096-BIT PROM                                   |       | 95 140                 | 95                       | 140  |      |
| 'cc             | Supply current   | V <sub>CC</sub> = MAX                              | 8192-BIT PROM                                   |       | 120                    | 120                      |      | 1 mA |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

§Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

### DESIGN GOAL

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## TTL MEMORIES

## SERIES 54/74, 54S/74S READ-ONLY MEMORIES

BULLETIN NO. DL-S 7512259, MAY 1975

DO 1 1(

DO 2 2(

DO 3 30

DO 4 41

DO 5 50

DO 6 61

007 70

GND 8C

256 BITS (32 WORDS BY 8 BITS) '884

⊃16 Vcc

〕14 AD E

AD C

AD B

AD A

DO 8

)15 s

ີ 112

<u>ን</u>11

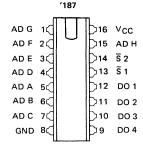
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- Mask-Programmed Memories That Can Replace PROMs
- Full On-Chip Decoding and Fast Chip Select(s) Simplify System Decoding
- All Schottky-Clamped ROMs Offer
  - -Choice of 3-State or Open-Collector Outputs
  - -P-N-P Inputs for Reduced Loading on System Buffers/Drivers
- Applications Include:
  - -Microprogramming Firmware/Firmware Loaders
  - -Code Converters/Character Generators
  - -Translators/Emulators
  - -Address Mapping/Look-Up Tables

| TYPE NUMBER    | R (PACKAGES)                    | TYPE OF        | BIT SIZE       | TYPICAL ACCE | SS TIMES |
|----------------|---------------------------------|----------------|----------------|--------------|----------|
| –55°C to 125°C | 0°C to 70°C                     | OUTPUT(S)      | (ORGANIZATION) | CHIP-SELECT  | ADDRESS  |
| SN5488A(J, W)  | SN7488A(J, N)                   | Open-Collector | 256 Bits       | 22 ns        | 26 ns    |
| 3113466A(J, W) | 5486A(J, W) 3N7486A(J, N) Open- |                | (32 W × 8 B)   | 22 115       | 20 /15   |
| SN54187(J, W)  | SN74187(J, N)                   | Open-Collector | 1024 Bits      | 20 ns        | 40 ns    |
| 51054167(3, W) | 5N/410/(J, N)                   | Open-Conector  | (256 W × 4 B)  | 20 ms        | 40 ns    |
| SN54S270(J)    | SN74S270(J, N)                  | Open-Collector | 2048 Bits      | 15 ns        | 45 ns    |
| SN54S370(J)    | SN74S370(J, N)                  | 3-State        | (512 W × 4 B)  | 15 ns        | 45 ns    |
| SN54S271(J)    | SN74S271(J, N)                  | Open-Collector | 2048 Bits      | 15           | 45       |
| SN54S371(J)    | SN74S371(J, N)                  | 3-State        | (256 W × 8 B)  | 15 ns        | 45 ns    |





### description

These monolithic TTL custom-programmed read-only memories (ROMs) are particularly attractive for applications requiring medium to large quantities of the same bit pattern. Plug-in replacements can be obtained for most of the popular TTL PROMs.

The high-complexity 2048-bit ROMs can be used to significantly improve system bit density for fixed memory as all are offered in compact 16- or 20-pin dual-in-line packages having pin-row spacings of 0.300-inch.

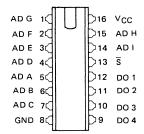
The Schottky-clamped versions offer considerable flexibility for upgrading existing designs or improving new designs as they feature improved performance; plus, they offer low-current MOS-compatible p-n-p inputs, choice of bus-driving three-state or open-collector outputs, and improved chip-select access times.

Data from a sequenced deck of data cards punched according to the specified format are permanently programmed by the factory into the monolithic structure for all bit locations. Upon receipt of the order, Texas Instruments, will assign a special identifying number for each pattern programmed according to the order. The completed devices will be marked with the appropriate TI special device number. It is important that the customer specify not only the output levels desired at all bit locations, but also the other information requested under ordering instructions.

The three-state outputs offer the convenience of an open-collector output with the speed of a totem-pole output: they can be bus-connected to other similar outputs yet they retain the fast rise time characteristic of the TTL totem-pole output. The open-collector outputs offer the capability of direct interface with a data line having a passive pull-up.

Word-addressing is accomplished in straight positive-logic binary and the memory may be read when all  $\bar{S}$  inputs are low. A high at any  $\bar{S}$  input causes the outputs to be off.

2048 BITS (512 WORDS BY 4 BITS) 'S270, 'S370



2048 BITS (256 WORDS BY 8 BITS) 'S271, 'S371

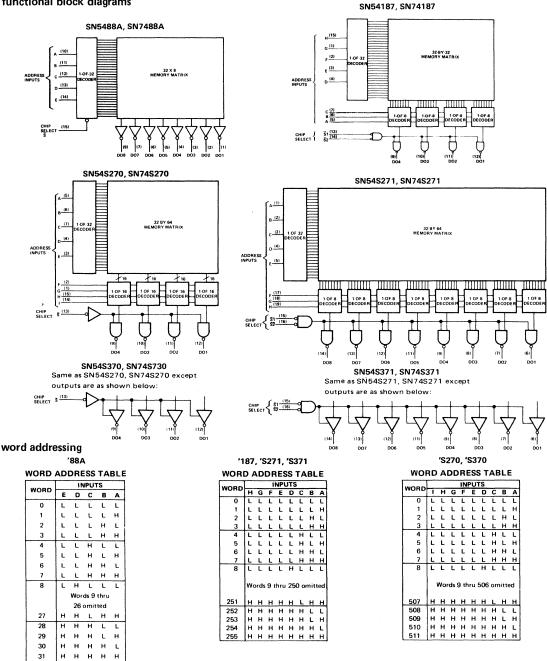
| AD A | ਾਪੀ |   | ₿20   | Vcc        |
|------|-----|---|-------|------------|
| AD B | 2   |   | j⊃ 19 | AD H       |
| AD C | 3⊄  |   | Þ 18  | AD G       |
| AD D | 4   |   | Þ17   | AD F       |
| AD E | 5   |   | Þ 16  | <b>Š</b> 2 |
| DO 1 | 6   |   | 2 15  | <u>s</u> 1 |
| DO 2 | 70  |   | 14    | DO 8       |
| DO 3 | 8   |   | ⊅13   | DO 7       |
| DO 4 | ₽₫  |   | D 12  | DO 6       |
| GND  | 10  |   | Þ11   | DO 5       |
|      | L   | L | L     |            |

TEXAS INSTRUMENTS

Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

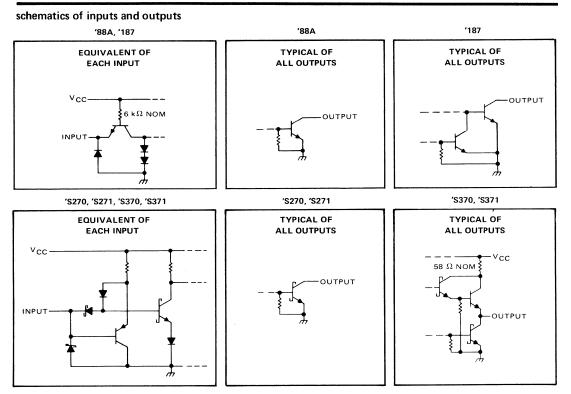
## SERIES 54/74, 54S/74S **READ-ONLY MEMORIES**

### functional block diagrams



Word selection is accomplished in a conventional positive-logic binary code with the A address input being the least-significant bit progressing alphabetically through the address inputs to the most-significant bit.

## SERIES 54/74, 54S/74S READ-ONLY MEMORIES



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |              |               |         | <br> | <sup>-</sup> 7V                  |
|--|--------------|---------------|---------|------|----------------------------------|
| Input voltage                                |              |               |         | <br> | 5.5 V                            |
| Off-state output voltage                     |              |               |         |      |                                  |
| Operating free-air temperature range:        | SN54', SN54S | Circuits (see | Note 2) | <br> | –55°C to 125°C                   |
|  | SN74', SN74S | Circuits .    |         | <br> | $0^{\circ}$ C to $70^{\circ}$ C  |
| Storage temperature range                    |              |               |         | <br> | $-65^{\circ}C$ to $150^{\circ}C$ |

### recommended operating conditions

|                                 |       |      | '88A |      | <b>′187</b> , | 'S270, | 'S271 | 'S   | 370, 'S3 | 371  | UNIT |
|---------------------------------|-------|------|------|------|---------------|--------|-------|------|----------|------|------|
|                                 |       | MIN  | NOM  | MAX  | MIN           | NOM    | MAX   | MIN  | NOM      | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub> | SN54' | 4.5  | 5    | 5.5  | 4.5           | 5      | 5.5   | 4.5  | 5        | 5.5  |      |
| (See Note 1)                    | SN74' | 4.75 | 5    | 5.25 | 4.75          | 5      | 5.25  | 4.75 | 5        | 5.25 | l v  |
| High-level output voltage, VOH  |       |      |      | 5.5  |               |        | 5.5   |      |          | 5.5  | V    |
| High-level output               | SN54' |      |      |      |               |        |       |      |          | -2   |      |
| current, IGH                    | SN74' |      |      |      |               |        |       |      |          | 6.5  | mA   |
| Low-level output current, IOL   |       |      |      | 12   |               |        | 16    |      |          | 16   | mA   |
| Operating free-air temperature, | SN54' | -55  |      | 125  | -55           |        | 125   | -55  |          | 125  | 00   |
| T <sub>A</sub> (See Note 2)     | SN74' | 0    |      | 70   | 0             |        | 70    | 0    |          | 70   | °C   |

NOTES: 1. Voltage values are with respect to network ground terminal.

 An SN54187 in the W package operating at free-air temperatures above 111°C requires a heat sink that provides a thermal resistance from case-to-free-air, R<sub>∂CA</sub>, of not more than 46°C/W.

## SERIES 54S/74S READ-ONLY MEMORIES

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER   | TEST CO  | NDITIONS                | ′S  | 270, 'S27 | 1     |     | \$370, <b>'</b> \$3 | 371   |    |
|-----------------|---|--|-------------------------|-----|-----------|-------|-----|---------------------|-------|----|
|                 |   |  |                         | MIN | TYP‡      | MAX   | MIN | түр‡                | MAX   | 1  |
| VIH             | High-level input voltage                                |  |                         | 2   |           |       | 2   |                     |       | V  |
| VIL             | Low-level input voltage                                 |  |                         |     |           | 0.8   |     |                     | 0.8   | V  |
| VIK             | Input clamp voltage                                     | V <sub>CC</sub> = MIN,                             | l <sub>l</sub> = -18 mA |     |           | -1.2  |     |                     | -1.2  | V  |
| v <sub>он</sub> | High-level output voltage                               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |                         |     |           |       | 2.4 |                     |       | v  |
| юн              | High-level output current                               | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V,   | V <sub>OH</sub> = 2.4 V |     |           | 50    |     |                     |       | μA |
| 0               | - · · · · · · · · · · · · · · · · · · ·                 | VIL = 0.8 V  | V <sub>OH</sub> = 5.5 V |     |           | 100   |     |                     |       | μA |
| V <sub>OL</sub> | Low-level output voltage                                | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |                         |     |           | 0.5   |     |                     | 0.5   | v  |
| IOZH            | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 2.4 V   |                         |     |           |       |     |                     | 50    | μA |
| IOZL            | Off-state output current<br>low-level voltage applied   | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.5 V   | V <sub>IH</sub> = 2 V,  |     |           |       |     |                     | -50   | μA |
| 4               | Input current at maximum input voltage                  | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V  |     |           | 1     |     |                     | 1     | mA |
| Чн              | High-level input current                                | $V_{CC} = MAX,$                                    | V <sub>I</sub> = 2.7 V  |     |           | 25    |     |                     | 25    | μA |
| μL              | Low-level input current                                 | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.5 V  |     |           | -0.25 |     |                     | -0.25 | mA |
| los             | Short-circuit output current §                          | V <sub>CC</sub> = MAX                              |                         |     |           |       | -30 |                     | -100  | mA |
| lcc             | Supply current  | V <sub>CC</sub> = MAX,                             | See Note 4              |     | 105       | 155   |     | 105                 | 155   | mA |
| Co              | Off-state output capacitance                            | V <sub>CC</sub> = 5 V,<br>f = 1 MHz                | V <sub>O</sub> = 5 V,   |     | 6.5       |       |     | 6.5                 |       | pF |

 $^{\dagger}_{\mu}$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

<sup>§</sup>Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

NOTE 4: With outputs open and  $\overrightarrow{Cs}$  input(s) grounded, I<sub>CC</sub> is measured first by selecting a word that contains the maximum number of programmed high-level outputs; then by selecting a word that contains the maximum number of programmed low-level outputs.

### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

|                  | PARAMETER                                  | TEST                       | SN54<br>SN54 |     | SN74<br>SN74 |     | SN54S370<br>SN54S371 |     | SN74S370<br>SN74S371 |      | UNIT |
|------------------|--|----------------------------|--------------|-----|--------------|-----|----------------------|-----|----------------------|------|------|
|                  |  | CONDITIONS                 | TYP‡         | MAX | TYP‡         | MAX | TYP‡                 | MAX | TYP‡                 | MAX  |      |
| ta(ad)           | Access time from address                   |                            | 45           | 95  | 45           | 70  |                      |     |                      |      | ns   |
| ta(S)            | Access time from chip select (enable time) | $R_{L1} = 300\Omega$ ,     | 15           | 45  | 15           | 30  |                      |     |                      |      | ns   |
|                  | Propagation delay time,                    | See Figure 1               |              |     |              |     |                      |     |                      |      |      |
| tPLH             | low-to-high-level output                   | See ligure i               | 15           | 40  | 15           | 25  |                      |     |                      |      | ns   |
|                  | from chip select (disable time)            |                            |              |     |              |     |                      |     |                      |      |      |
| ta(ad)           | Access time from address                   | C <sub>L</sub> = 30 pF,    |              |     |              |     | 45                   | 95  | 45                   | 70   | ns   |
| ta(S)            | Access time from chip select (enable time) | See Figure 2               |              |     |              |     | 15                   | 45  | 15                   | 30   | ns   |
| <sup>t</sup> PXZ | Disable time from high or low level        | CL = 5 pF,<br>See Figure 2 |              |     |              |     | 10                   | 40  | 10                   | - 25 | ns   |

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

|                | PARAMETER                              | TEST CO  |   | '88A |       |      |     | UNIT |      |    |
|----------------|--|--|---|------|-------|------|-----|------|------|----|
|                |  |  |   | MIN  | TYP‡  | MAX  | MIN | ТҮР‡ | MAX  |    |
| VIH            | High-level input voltage               |  |   | 2    |       |      | 2   |      |      | V  |
| VIL            | Low-level input voltage                |  |   |      |       | 0.8  |     |      | 0.8  | V  |
| VIK            | Input clamp voltage                    | V <sub>CC</sub> = MIN,                             | l <sub>l</sub> = –12 mA                           |      |       | -1.5 |     |      | -1.5 | V  |
| юн             | High-level output current              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>V <sub>OH</sub> = 5.5 V |      |       | 40   |     |      | 40   | μA |
| VOL            | Low-level output voltage               | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V,   | I <sub>OL</sub> = 12 mA                           |      | 0.2   | 0.4  |     |      | 0.4  | v  |
|                |  | V <sub>IL</sub> = 0.8 V                            | I <sub>OL</sub> = 16 mA                           |      |       |      |     |      | 0.45 |    |
| 4              | Input current at maximum input voltage | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V                            |      |       | 1    |     |      | 1    | mA |
| Чн             | High-level input current               | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 2.4 V                            |      | ····· | 25   |     |      | 40   | μA |
| 11L            | Low-level input current                | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 0.4 V                            |      |       | -1   |     |      | -1   | mA |
| 1cc            | Supply current                         | V <sub>CC</sub> = MAX,                             | See Note 3  |      | 64    | 80   |     | 92   | 130  | mA |
| с <sub>о</sub> | Off-state output capacitance           | V <sub>CC</sub> = 5 V ,<br>f = 1 MHz               | V <sub>O</sub> = 5 V,                             |      | 6.5   |      |     | 6.5  |      | pF |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

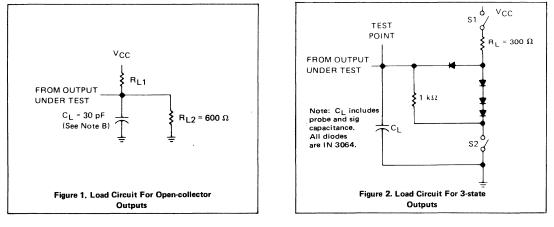
<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

NOTE 3: With outputs open and CS input(s) grounded, I<sub>CC</sub> is measured first by selecting a word that contains the maximum number of programmed high-level outputs, then by selecting a word that contains the maximumnumber of programmed low-level outputs.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

|             | PARAMETER                                  | TEST CONDITIONS                | ''  | 38A | 1   | UNIT |    |
|-------------|--|--------------------------------|-----|-----|-----|------|----|
| 2           |  |                                | ТҮР | MAX | ТҮР | MAX  | 1  |
| ta(ad)      | Access time from address                   | C <sub>L</sub> = 30 pF,        | 26  | 45  | 40  | 60   | ns |
| ta(S)       | Access time from chip select (enable time) | R <sub>L1</sub> = 400 Ω ('88A) | 22  | 35  | 20  | 30   | ns |
|             | Propagation delay time,                    | <b>300</b> Ω ('187)            |     |     |     |      |    |
| <b>tPLH</b> | low-to-high-level output                   | R <sub>L2</sub> = 600 Ω,       | 22  | 35  | 20  | 30   | ns |
|             | from chip select (disable time)            | See Figure 1                   |     |     |     |      |    |
|             |  |                                |     |     |     |      |    |

### parameter measurement information



## SERIES 54/74, 54S/74S TTL READ-ONLY MEMORIES

### **ORDERING INSTRUCTIONS**

Programming instructions for these read-only memories are solicited in the form of a sequenced deck of standard 80-column data cards providing the information requested under "data card format," accompanied by a properly sequenced listing of these cards, and the supplementary ordering data. Upon receipt of these items, a computer run will be made from the deck of cards which will produce a complete function table for the requested part. This function table, showing output conditions for each of the words, will be forwarded to the purchaser as verification of the input data as interpreted by the computerautomated design (CAD) program. This single run also generates mask and test program data; therefore, verification of the function table should be completed promptly.

Each card in the data deck prepared by the purchaser identifies the words specified and describes the levels at the outputs for each of those words. All addresses must have all outputs defined and columns designated as "blank" must not be punched. Cards should be punched according to the data card format shown.

### SUPPLEMENTARY ORDERING DATA

Submit the following information with the data cards:

- a) Customer's name and address
- b) Customer's purchase order number
- c) Customer's drawing number.

The following information will be furnished to the customer by Texas Instruments:

- a) TI part number
- b) TI sales order number
- c) Date received.

### '88A DATA CARD FORMAT (32 CARDS)

Column

1-2 Punch a right-justified integer representing the positive-logic binary input address (00-31) for the word described on the card.

3-4 Blank

- 5 Punch "H" or "L" for output Y8. H = highvoltage-level output, L = low-voltage-level output
- 6-9 Blank
- 10 Punch "H" or "L" for output DO 7.
- 11-14 Blank

- 15 Punch "H" or "L" for output DO 6.
- 16-19 Blank
  - 20 Punch "H" or "L" for output DO 5.
- 21-24 Blank
  - 25 Punch "H" or "L" for output DO 4.
- 26-29 Blank
  - 30 Punch "H" or "L" for output DO 3.
- 31-34 Blank
  - 35 Punch "H" or "L" for output DO 2.
- 36-39 Blank
  - 40 Punch "H" or "L" for output DO 1.
- 41-49 Blank
- 50-51 Punch a right-justified integer representing the current calendar day of the month.
- 52 Blank
- 53-55 Punch an alphabetic abbreviation representing the current month.
- 56 Blank
- 57-58 Punch the last two digits of the current year.
  - 59 Blank
- 60-61 Punch "SN"
- 62-66 Punch a left-justified integer representing the Texas Instruments part number. This is supplied by the factory through a TI sales representative.
- 67-68 Blank
- 69-80 Preferably these columns should be punched to reflect the customer's part or specification-control number. This information is not essential.

### '187 DATA CARD FORMAT (32 CARDS)

Column

- 1- 3 Punch a right-justified integer representing the binary input address (000-248) for the first set of outputs described on the card.
  - 4 Punch a "-" (Minus sign)
- 5-7 Punch a right-justified integer representing the binary input address (007-255) for the last set of outputs described on the card.
- 8-9 Blank

### ORDERING INSTRUCTIONS

10-13 Punch "H", "L", or "X" for bits four, three, two, and one (outputs DO 4, DO 3, DO 2 and DO 1 in that order) for the first set of outputs specified on the card. H = high-voltage-level output, L = low-voltage-level output, X = output level irrelevant.

| ••    | Diani   |
|-------|---|
| 15-18 | Punch "H", "L", or "X" for the second set of outputs. |
|       |   |

19 Blank

Blank

14

- 20-23 Punch "H", "L", or "X" for the third set of outputs.
  - 24 Blank
- 25-28 Punch "H" "L", or "X" for the fourth set of outputs.
  - 29 Blank
- 30-33 Punch "H", "L", or "X" for the fifth set of outputs.
  - 34 Blank
- 35-38 Punch "H", "L", or "X" for the sixth set of outputs.
  - 39 Blank
- 40-43 Punch "H", "L", or "X" for the seventh set of outputs.
  - 44 Blank
- 45-48 Punch "H", "L", or "X" for the eighth set of outputs.
  - 49 Blank
- 50-51 Punch a right-justified integer representing the current calendar day of the month.
  - 52 Blank
- 53-55 Punch an alphabetic abbreviation representing the current month.
  - 56 Blank
- 57-58 Punch the last two digits of the current year.
- 59 Blank
- 60-61 Punch "SN"
- 62-66 Punch a left-justified integer representing the Texas Instruments part number. This is supplied by the factory through a TI sales representative.
- 67-68 Blank
- PRINTED IN U.S.A.

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### 'S270, 'S370 DATA CARD FORMAT (64 CARDS)

Column

- 1-3 Punch a right-justified integer representing the binary input address (000-504) for the first set of outputs described on the card.
- 4 Punch a "-" (Minus sign)
- 5-7 Punch a right-justified integer representing the binary input address (007-511) for the last set of outputs described on the card.
- 8-80 Same as the '187 data card format.

### 'S271, 'S371 DATA CARD FORMAT (64 CARDS)

### Column

- Punch a right-justified integer representing the binary input address (000-252) for the first set of outputs described on the card.
  - 4 Punch a "-" (Minus sign)
- 5- 7 Punch a right-justified integer representing the binary input address (003-255) for the last set of outputs described on the card.
- 8-9 Blank
- 10.17 Punch "H", "L", or "X" for bits eight, seven, six, five, four, three, two, and one (outputs DO 8, DO 7, DO 6, DO 5, DO 4, DO 3, DO 2, and DO 1 in that order) for the first set of outputs specified on the card. H = high-voltage-level output, L = low-voltage-level output, X = output level irrelevant.
  - 18 Blank
- 19-26 Punch "H", "L", or "X" for the second set of outputs.
  - 27 Blank
- 28-35 Punch "H", "L", or "X" for the third set of outputs.
  - 36 Blank
- 37-44 Punch "H", "L", or "X" for the fourth set of outputs.
- 45-49 Blank
- 50-80 Same as the '187 data card format.

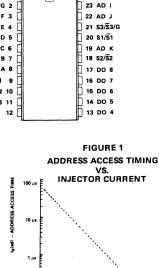
## TEXAS INSTRUMENTS

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## BIPOLAR MEMORIES

## TYPES SBP 8316, SBP 9818 16,384-BIT I<sup>2</sup>L READ-ONLY MEMORIES

- **JOR N PACKAGE**  Mask Programmable I<sup>2</sup>L ROM (TOP VIEW) Fully TTL Compatible Inputs/Outputs AD H 1 24 VCC/INJ AD G 2 [ h **Programmable Options Include:** AD F 3 User Selectable Speed/Power Operation: AD E 4 - Wide Range for Injector Current Supply AD D 5 AD C 6 **Operation (SBP 9818)** AD B 7 - Resistor Options for 5-Volt Supply AD A 8 Operation (SBP 8316) DO 1 9 Choice of Outputs: DO 2 10 Γ DO 3 11 - Open-Collector for VCC or INJ Operation GND 12 - Internal 10K Ω Pull-Up Resistors to VCC (SBP 8316) Choose Any Combination of Up to 3 Boolean Variables for Chip Select or 2 Boolean Variables with Latched Outputs TIME 1**00** µ • Industry Standard Pin Assignments in 24-Pin ADDRESS ACCESS Plastic or C-DIP Packages 10 µ • Choice of Temperature Ranges: □ SBP 8316CN, SBP 9818CN for 0 to 70°C Applications
  - □ SBP 8316MJ, SBP 9818MJ for -55°C to 125°C Applications



10 m 4

1 m 4 ICC - INJECTOR CURRENT 100 mA

### description

These integrated injection logic (I<sup>2</sup>L) 16,384-bit mask programmable read-only memories are organized as 2048-words of 8-bit length. They offer a system designer the highest degree of selectivity with respect to speed/power/performance and a wide choice of programmable options in a single monolithic ROM function. These flexible, high density, bipolar ROM's can provide the basis for cost-effective solutions to a wide range of applications especially large, fixed macroand microprogram memory having a capacity which may include code converters, constants, character generators, and look-up tables.

These ROM's feature a unique capability of being dedicated at programming to become either:

- Pure I<sup>2</sup>L, SBP 9818, for operation from an injector (INJ) current source with user selectable speed/power performance and open-collector outputs. This option is injector-source compatible with other user selectable speed/power I<sup>2</sup>L products such as the SBP 9900, SBP 0400A, and SBP 0401A. See Figure 1 and schematic of outputs.
- Or, the SBP 8316, with a fixed voltage source (V<sub>CC</sub>) in the range of 1.5 to 5 volts, has on-chip supply current resistor supplied and output pull-up resistors available. See Figure 1 and schematic of outputs. This option is VCC compatible with Schottky TTL or low-threshold MOS and can eliminate the need for external resistors.

In addition to the data bits, other programmable selections available are:

To include or eliminate latches for the outputs which are controllable from the strobe input (G). If latches are selected, the strobe being high will make the latches transparent, and when low the addressed data is latched.

### DESIGN GOAL

This document provides tentative information on a product in the developmental stage. Texas Instruments reserves the right to change or discontinue this product without notice.

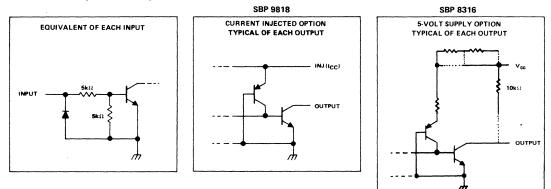
16

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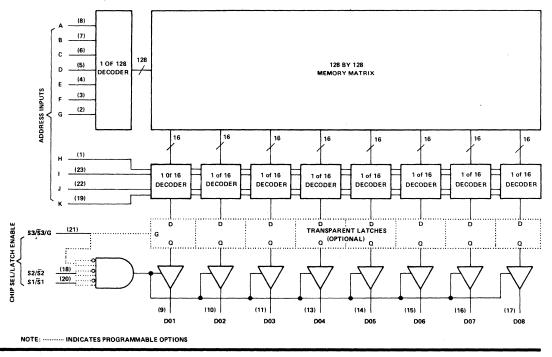
Active high or active low chip selects (S). Two inputs are dedicated as chip selects and if output latches are
not used, a third chip-select input is available. Each can be specified active high or low providing the
flexibility of selecting the ROM with any Boolean combination of up to three inputs.

The SBP 8316M and SBP 9818M are characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C and the SBP 8316C and SBP 9818C are characterized for operation from 0°C to 70°C.

### schematics of inputs and outputs



### functional block diagram



## **TYPES SBP 8316, SBP 9818** 16,384-BIT I<sup>2</sup>L READ-ONLY MEMORIES

### recommended operating conditions

|                                    | Τ   | SBP 8316 |     |      |         |      |     |         | SBP | 9818      |     |     |      |
|------------------------------------|-----|----------|-----|------|---------|------|-----|---------|-----|-----------|-----|-----|------|
|                                    | S   | BP 8316  | SM  | S    | BP 8316 | 6C   | S   | BP 9818 | M   | SBP 9818C |     |     | UNIT |
|                                    | MIN | NOM      | MAX | MIN  | NOM     | MAX  | MIN | NOM     | MAX | MIN       | NOM | MAX |      |
| Supply current, ICC                |     |          |     |      |         |      | 300 |         | 500 | 300       |     | 500 | mA   |
| Supply voltage, VCC                | 4.5 | 5        | 5.5 | 4.75 | 5       | 5.25 |     |         |     |           |     |     | V    |
| Operating free-air temperature, TA | -55 |          | 125 | 0    |         | 70   | -55 |         | 125 | 0         |     | 70  | °C   |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | <b>BAD 414</b>    |                | TEST CONDIT  | IONS                     |     | SBP 831 | 6    | 5   | SBP 981 | 8    | UNIT |
|-----|-------------------|----------------|--|--------------------------|-----|---------|------|-----|---------|------|------|
|     | PARAME            | IER            | TEST CONDIT  | IUNS                     | MIN | түр     | MAX  | MIN | түр     | MAX  | UNIT |
| νін | High-level i      | nput voltage   |  |                          | 2   |         |      | 2   |         |      | V    |
| VIL | Low-level i       | nput voltage   |  |                          |     |         | 0.8  |     |         | 0.8  | V    |
| vik | Input clam        | p voltage      | I <sub>CC</sub> = 3 mA or V <sub>CC</sub> = 5 V<br>II =12 mA |                          |     |         | -1.5 |     |         | -1.5 | ~    |
|     | High-level        | Open-collector | ICC = 300 to 500 mA or                                       | V <sub>O</sub> = 2.4 V   |     |         | 200  |     |         | 200  |      |
| 1   |                   | outputs        | V <sub>CC</sub> = 5 V  | Vo = 5.5 V               |     |         | 400  |     |         | 400  |      |
| юн  | output<br>current | 10-kΩ Pull-    | V <sub>CC</sub> = 5 V,                                       | R <sub>VCC</sub> = 40 Ω  |     | -310    |      |     |         |      | μA   |
|     | current           | up Resistors   | V <sub>O</sub> = 2.4 V                                       | HVCC = 40 32             |     | -310    |      |     |         |      |      |
|     |                   |                | V <sub>CC</sub> = MIN,                                       |                          |     |         |      |     |         |      |      |
|     | Low-level c       | utout          | V <sub>IH</sub> ≈ 2 V,                                       | l <sub>OL</sub> = 5.6 mA |     | 0.4     |      |     | 0.      |      |      |
| VOL | voltage           | diput          | V <sub>IL</sub> = 0.8 V                                      |                          |     |         |      |     |         |      |      |
|     | Voltage           |                | I <sub>CC</sub> = 300 mA                                     | IOL = 16 mA              |     |         | 0.4  |     |         | 0.4  |      |
|     |                   |                | I <sub>CC</sub> = 500 mA                                     | IOL = 20 mA              |     |         | 0.5  |     |         | 0.5  |      |
| 1.  |                   |                | V <sub>I</sub> = 2.4 V                                       |                          |     | 340     |      |     | 340     | 1    | μA   |
| 11  | Input curre       | ant.           | V <sub>1</sub> = 0.4 V                                       |                          |     | 25      |      |     | 25      |      | μΑ   |
| 1cc |                   |                | V <sub>CC</sub> = 5 V  | R <sub>VCC</sub> = 40 Ω  |     | 100     |      |     |         |      | mA   |

### typical switching characteristics, $T_A = 25^{\circ}C$ , $C_L = 50 \text{ pF}$

| PARAMETER         |                              | SBP 8316                | SBP 9818                 |                          |  |  |  |
|-------------------|------------------------------|-------------------------|--------------------------|--------------------------|--|--|--|
|                   |                              | R <sub>VCC</sub> = 40 Ω | I <sub>CC</sub> = 300 mA | I <sub>CC</sub> = 500 mA |  |  |  |
| ta(ad)            | Access time from address     | 350 ns                  | 200 ns                   | 150 ns                   |  |  |  |
| <sup>t</sup> a(S) | Access time from chip select | 175 ns                  | 75 ns                    | 60 ns                    |  |  |  |

### DESIGN GOAL

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### **ORDERING INSTRUCTIONS**

| TO BE COMPLETED BY REQUESTOR   | BIT PROGRAMMING INSTRUCTIONS   |
|--|--|
| COMPANY:<br>ADDRESS:<br>POSTAL ZIP CODE:   | Programming instructions for each bit location of these read-only<br>memories are solicited in the form of a sequenced deck of standard<br>80-column data cards providing the information requested below,<br>and accompanied by a properly sequenced listing of these cards.<br>Upon receipt of these items, a computer run will be made from the<br>deck of cards which will produce a complete function table for the |
| CONTACT(NAME):   | requested part. This function table, showing output conditions for   |
| PHONE: (Area Code)(NO.)  | each of the words, will be forwarded to the purchaser as verification<br>of the input data as interpreted by the computer-automated design   |
|  | (CAD) program. This single run also generates mask and test  |
| CUSTOMER PRINT OR I.D. NO:<br>CUSTOMER PART NO:  | program data; therefore, verification of the function table should be  |
| SYMBOLIZE AS PART NO:  | completed promptly.  |
| ROM POWER-SUPPLY OPTIONS (Choose A or B):<br>A. INJECTOR-SUPPLY VERSION<br>(outputs are open-collector)<br>B. 5V-SUPPLY VERSION<br>(choose one | Each card in the data deck prepared by the purchaser identifies the<br>words specified and describes the levels at the outputs for each of<br>those words. All addresses must have all outputs defined and<br>columns designated as "blank" must not be punched. The 512 cards<br>should be punched according to the following data card format:<br>Column   |
| pullup resistor option):   | 1-3 Punch a right-justified integer representing the binary  |
| B1. OUTPUT COLLECTOR $\int \Box$ 10k $\Omega$  | input address (000-2044) for the first set of outputs described on the card.   |
| PULLUPS (check one) 🛛 🗌 NONE (open)  | 4 Punch a "-" (Minus sign)   |
|  | 5-7 Punch a right-justified integer representing the binary<br>input address (003-2047) for the last set of outputs<br>described on the card.  |
| ROM MEMORY-ENABLE OPTIONS  | 8-9 Blank  |
| (Choose one option for each pin):  | 8-9 Blank  |
| <ul> <li>A. PIN 18 □ H = true enable<br/>(Check one) □ L = true enable</li> <li>B. PIN 20 □ H = true enable</li> </ul>                         | 10-17 Punch "H", "L", or "X" for bits eight, seven, six, five,<br>four, three, two, and one (outputs DO 8, DO 7, DO 6, DO<br>5, DO 4, DO 3, DO 2, and DO 1 in that order) for the<br>first set of outputs specified on the card. (See note 1.)   |
| (Choose one) 🗌 L = true enable   | 18 Blank   |
| NOTES: 1. L = True enable pins will be logically true if left open.  |  |
| 2. All memory enable pins must be true to enable the outputs.  | 19-26 Punch "H", "L", or "X" for the second set of outputs.  |
| ROM LATCH/ENABLE OPTIONS<br>(Choose one option):   | 27 Blank   |
| A. D TRANSPARENT LATCH FOR EACH OUTPUT   | 28-35 Punch "H", "L", or "X" for the third set of outputs.   |
| (Pin 21 = H for transparency, L for storing)   | 36 Blank   |
| B. □ NO LATCHES (Choose memory-enable option for pin 21):<br>□ H = true enable<br>B1. PIN 21 (Choose one) □ H = true enable                    | 37-44 Punch "H", "L", or "X" for the fourth set of outputs.  |
| L = true enable  | 45-49 Blank  |
|  | 50-80 Same as the '187 data card format, page 15.  |
|  |  |
| SALES ORDER NO:  |  |
| CONTACT (NAME):  | PHONE EXT:   |
|  |  |

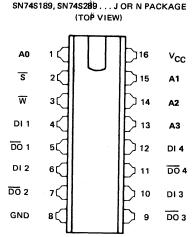
## SCHOTTKY† TTL MEMORIES

## 64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

- Static Fully Decoded Ram's Organized as 16 Words of Four Bits Each
- Schottky-Clamped for High Speed: Read Cycle Time . . . 25 ns Typical Write Cycle Time . . . 25 ns Typical
- Choice of Three-State or Open-Collector Outputs
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Chip-Select Input Simplifies External
   Decoding

### description

These 64-bit active-element memories are monolithic Schottky-clamped transistor-transistor logic (TTL) arrays organized as 16 words of four bits each. They are fully decoded and feature a chip-select input to simplify decoding required to achieve expanded



SN54S189, SN54S289 . . . J OR W PACKAGE

Pin assignments are same for all packages.

system organization. The memories feature p-n-p input transistors that reduce the low-level input current requirement to a maximum of -0.25 milliamperes, only one-eighth that of a Series 54S/74S standard load factor. The chip-select circuitry is implemented with minimal delay times to compensate for added system decoding.

#### write cycle

The information applied at the data input is written into the selected location when the chip-select input and the write-enable input are low. While the write-enable input is low, the 'S189 output is in the high-impedance state and the 'S289 output is off. When a number of outputs are bus-connected, this high-impedance or off state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up.

### read cycle

The stored information (complement of information applied at the data input during the write cycle) is available at the output when the write-enable input is high and the chip-select input is low. When the chip-select input is high, the 'S189 output will be in the high-impedance state and the 'S289 output will be off.

#### FUNCTION TABLE

| FUNCTION | IN                       | PUTS | 'S189                      | ʻS289                      |  |  |
|----------|--------------------------|------|----------------------------|----------------------------|--|--|
| FONCTION | CHIP SELECT WRITE ENABLE |      | OUTPUT                     | OUTPUT                     |  |  |
| Write    | L L                      |      | High Impedance             | Off                        |  |  |
| Read     | L                        | н    | Complement of Data Entered | Complement of Data Entered |  |  |
| Inhibit  | н                        | Х    | High Impedance             | Off                        |  |  |

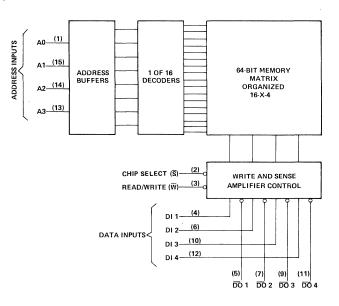
 $H \equiv high \ level, \ L \equiv low \ level, \ X \equiv irrelevant$ 

PRELIMINARY DATA SHEET: Supplementary data may be published at a later date.

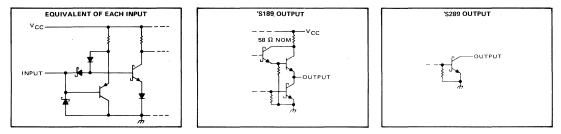
TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 5012 • DALLAS, TEXAS 75222 <sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

## **64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES**

### functional block diagram



### schematics of inputs and outputs



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |                 | <br> | 7V                  |
|--|-----------------|------|---------------------|
| Input voltage                                |                 |      |                     |
| Off-State output voltage                     | · · · · · · ·   | <br> | 5.5 V               |
| Operating free-air temperature range:        |                 |      |                     |
|  | SN74S' Circuits | <br> | $\cdot$ 0°C to 70°C |
| Storage temperature range                    |                 | <br> | –65°C`to 150°C      |

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## **64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES**

### recommended operating conditions

|               |   | s   | N54S18 | 39  | s   | SN54S289 |     | SN74S189   |     | SN74S289 |      |     |      |    |
|---------------|---|-----|--------|-----|-----|----------|-----|------------|-----|----------|------|-----|------|----|
|               |   | MIN | NOM    | MAX | MIN | NOM      | MAX | MIN        | NOM | MAX      | MIN  | NOM | MAX  |    |
| Suppl         | y Voltage, V <sub>CC</sub>                                    | 4.5 | 5      | 5.5 | 4.5 | 5        | 5.5 | 4.75       | 5   | 5.25     | 4.75 | 5   | 5.25 | V  |
| High-I        | evel output voltage, VOH                                      |     |        |     |     |          | 5.5 |            |     |          |      |     | 5.5  | V  |
| High-I        | evel output current, IOH                                      |     |        | -2  |     |          |     |            |     | -6.5     |      |     |      | mA |
| Low-le        | evel output current, IOL                                      |     |        | 16  |     |          | 16  |            |     | 16       |      |     | 16   | mA |
|               | of write pulse (write enable<br><sup>t</sup> w(wr)            | 25  |        |     | 25  |          |     | 25         |     |          | 25   |     |      | ns |
|               | Address before write<br>pulse, t <sub>su(da)</sub>            | 01  |        |     | 01  |          |     | 0↓         |     |          | O↓   |     |      |    |
| Setup<br>time | Data before end of write<br>pulse, t <sub>su</sub> (da)       | 25↑ |        |     | 25↑ |          |     | 25↑        |     |          | 25↑  |     |      | ns |
|               | Chip-select before end of write<br>pulse, t <sub>su</sub> (S) | 25↑ |        |     | 25↑ |          |     | 25↑        |     |          | 25↑  |     |      | 1  |
|               | Address after write pulse, th(ad)                             | 01  |        |     | 10  |          |     | 0↑         |     |          | 01   |     |      |    |
| Hold          | Data after write pulse, th(da)                                | 01  |        |     | 10  |          |     | <b>0</b> ↑ |     |          | 10   |     |      | 1  |
| time          | Chip-select after write<br>pulse, t <sub>h</sub> (S)          | 0†  |        |     | 01  |          |     | 0†         |     |          | 10   |     |      | ns |
| Opera         | ting free-air temperature, T <sub>A</sub>                     | -55 |        | 125 | -55 |          | 125 | 0          |     | 70       | 0    |     | 70   | °C |

†↓The arrow indicates the transition of the write-enable input used for reference: ↑ for the low-to-high transition, ↓ for the high-to-low transition.

### electrical characteristics over recommended operating free-air temperature range (otherwise noted)

|      | PARAMETER                              | теет                     | CONDITIONS              | •+                    |     | ʻS189 |      |     | 'S289 |      |    |
|------|--|--------------------------|-------------------------|-----------------------|-----|-------|------|-----|-------|------|----|
|      | FARAMETER                              | 1531                     | CONDITIONS              | , ·                   | MIN | TYP‡  | MAX  | MIN | TYP‡  | MAX  |    |
| VIH  | High-level input voltage               |                          |                         |                       | 2   |       |      | 2   |       |      | V  |
| VIL  | Low-level input voltage                |                          |                         |                       |     |       | 0.8  |     |       | 0.8  | v  |
| VIK  | Input clamp voltage                    | $V_{CC} = MIN$ ,         | I <sub>I</sub> =18mA    |                       |     |       | -1.2 |     |       | -1.2 | v  |
| ∨он  | High-level output voltage              | $V_{CC} = MIN,$          | VIH = 2 V,              | SN54S'                | 2.4 | 3.4   |      |     |       |      | v  |
| VOH  |  | V <sub>IL</sub> = 0.8 V, | IOH = MAX               | SN74S'                | 2.4 | 3.2   |      |     |       |      | v  |
| юн   | High-level output current              | $V_{CC} = MIN$ ,         | VIH = 2 V,              | V <sub>O</sub> =2.4 V |     |       |      |     |       | 40   | μA |
| ·0n  | High-level output current              | V <sub>IL</sub> = 0.8 V  |                         | V <sub>O</sub> =5.5 V |     |       |      |     |       | 100  | μA |
| Vai  | Low-level output voltage               | $V_{CC} = MIN,$          | V <sub>IH</sub> = 2 V,  | SN54S'                |     | 0.35  | 0.5  |     | 0.35  | 0.5  |    |
| VOL  | Low-level output voltage               | V <sub>IL</sub> = 0.8 V, | I <sub>OL</sub> = 16 mA | SN74S'                |     | 0.35  | 0:45 |     | 0.35  | 0.45 | v  |
| 1    | Off-state output current,              | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V,  |                       |     |       | 50   |     |       |      |    |
| юzн  | high-level voltage applied             | V <sub>IL</sub> = 0.8 V, | V <sub>OH</sub> = 2.4 V |                       |     |       | 50   |     |       |      | μA |
| 1    | Off-state output current,              | V <sub>CC</sub> ≈ MAX,   | V <sub>IH</sub> = 2 V,  |                       |     |       | 50   | 1   |       |      |    |
| IOZL | low-level voltage applied              | V <sub>IL</sub> = 0.8 V, | V <sub>OL</sub> = 0.4 V |                       |     |       | -50  |     |       |      | μΑ |
| II.  | Input current at maximum input voltage | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 5.5 V  |                       |     |       | 1    |     |       | 1    | mA |
| цн   | High-level input current               | V <sub>CC</sub> = MAX,   | VI = 2.7 V              |                       |     |       | 25   |     |       | 25   | μA |
| ΊL   | Low-level input current                | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.5 V  |                       |     |       | -250 |     |       | -250 | μA |
| los  | Short-circuit output current §         | V <sub>CC</sub> = MAX    |                         |                       | -30 |       | -100 |     |       |      | mA |
| Icc  | Supply current                         | V <sub>CC</sub> = MAX,   | See Note 2              |                       |     | 75    | 110  |     | 75    | 105  | mA |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. ‡All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . §Duration of the short circuit should not exceed one second.

NOTES: 1. Voltage values are with respect to network ground terminal. 2. I CC is measured with the read/write and chip-select inputs grounded. All other inputs at 4.5V, and the outputs open. 'S189 switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

|                    | PARAMETER                                  |        | TEST CONDITIONS                       | SN54 | SN74S189 |      |     |      |
|--------------------|--|--------|---------------------------------------|------|----------|------|-----|------|
| ]                  | I ANAME I EN                               |        | TEST CONDITIONS                       | TYP‡ | MAX      | TYP‡ | MAX | UNIT |
| ta(ad)             | Access time from address                   |        | C <sub>L</sub> = 30 pF,               | 25   | 50       | 25   | 35  | ns   |
| t <sub>a</sub> (S) | Access time from chip select (enable time) |        | R <sub>L</sub> = 300 Ω<br>See Note 3  | 12   | 25       | 12   | 17  | ns   |
| tSR                | R Sense recovery time                      |        |                                       | 22   | 40       | 22   | 35  | ns   |
| tova               | Disable time from high or low level        | from S | $C_L = 5  pF$ ,<br>$B_L = 300  p$     | 12   | 25       | 12   | 17  |      |
| <sup>t</sup> PXZ   | Disable time from high of low level        | from W | R <sub>L</sub> = 300 Ω,<br>See Note 3 | 12   | 30       | 12   | 25  | ns   |

### 'S289 switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

|                  | PABAMETER  |        | TEST CONDITIONS          | SN54 | S289 | SN74 | IS289 |      |
|------------------|--|--------|--------------------------|------|------|------|-------|------|
|                  | d) Access time from address<br>;) Access time from chip select (enable time) |        | TEST CONDITIONS          | TYP‡ | MAX  | ТҮР‡ | MAX   | UNIT |
| ta(ad)           | Access time from address   |        | $C_{L} = 30  pF$ ,       | 25   | 50   | 25   | 35    | ns   |
| ta(S)            | Access time from chip select (enable time)                                   |        | RL1 = 300 Ω,             | 12   | 25   | 12   | 17    | ns   |
| tSR              | Sense recovery time  |        | R <sub>L2</sub> = 600 Ω, | 22   | 40   | 22   | 35    | ns   |
| to               | Propagation delay time, low-to-high-level                                    | from S | See Note 3               | 12   | 25   | 12   | 17    |      |
| <sup>t</sup> PLH | output (disable time)  | from W |                          | 12   | 30   | 12   | 25    | ns   |

 $^{\ddagger}$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

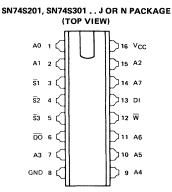
NOTES: 3. Load circuit and voltage wave forms are shown in Appendix A, page 44.

## SCHOTTKY† TTL MEMORIES

### 256-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

SEPTEMBER 1977

- Static Fully Decoded RAM's Organized as 256 Words of One Bit Each
- Schottky-Clamped for High Performance
- Choice of Three-State or Open-Collector Outputs
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Chip-Select Inputs Simplify External Decoding



Pin assignments are same for all packages.

### description

These 256-bit active-element memories are monolithic transistor-transistor logic (TTL) arrays organized as 256 words of one bit. They are fully decoded and have three chip-select inputs to simplify decoding required to achieve expanded system organizations.

### write cycle

The information applied at the data input is written into the selected location when the three chip-select inputs and the write-enable input are low. While the write-enable input is low, the 'S201 outputs are in the high-impedance state and the 'S301 outputs are off. When a number of outputs are bus-connected, this high-impedance or off state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up.

### read cycle

The stored information (complement of information applied at the data input during the write cycle) is available at the output when the write-enable input is high and the three chip-select inputs are low. When any one of the chip-select inputs are high, the 'S201 outputs will be in the high-impedance state and the 'S301 outputs will be off.

#### FUNCTION TABLE

|          | INP                                | JTS          |                               |                               |
|----------|------------------------------------|--------------|-------------------------------|-------------------------------|
| FUNCTION | CHIP ENABLE (Ei)<br>OR SELECT (Si) | WRITE ENABLE | 'S201<br>OUTPUT (DO)          | 'S301<br>OUTPUT (DO)          |
| Write    | L                                  | L            | High Impedance                | Off                           |
| Read     | L                                  | Н            | Complement of<br>Data Entered | Complement of<br>Data Entered |
| Inhibit  | Н                                  | x            | High Impedance                | Off                           |

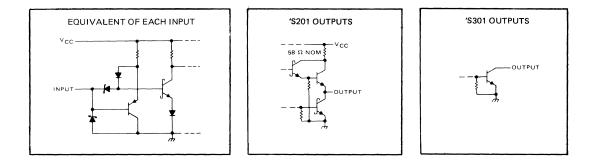
 $H \equiv high \ level, \ L \equiv low \ level, \ X \equiv irrelevant$ 

<sup>‡</sup>For chip-select: L  $\equiv$  all Si inputs low, H  $\equiv$  one or more Si inputs high

TEXAS INSTRUMENTS

<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

### schematics of inputs and outputs



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> 9see Note 1) |   |
|--|---|
| Input voltage                                | 5.5 V                                       |
| Off-State output voltage                     |   |
| Operating free-air temperature range         | $\dots \dots 0^{\circ}$ C to $70^{\circ}$ C |
| Storage temperature range                    | $\dots -65^{\circ}C$ to $150^{\circ}C$      |

### recommended operating conditions

|         |   | 8    | SN74S20 | )1    | SN74301    |         |      |    |
|---------|---|------|---------|-------|------------|---------|------|----|
|         |   | MIN  | NOM     | MAX   | MIN        | NOM     | MAX  |    |
| Supply  | Voltage, V <sub>CC</sub> (see Note 1)                     | 4.75 | 5       | 5.25  | 4.75       | 5       | 5.25 | V  |
| High-le | evel output voltage, V <sub>OH</sub>                      |      |         |       |            |         | 5.5  | V  |
| High-le | evel output current, IOH                                  |      |         | -10.3 |            |         |      | mA |
| Low-le  | vel output current, IOL                                   |      |         | 16    |            |         | 16   | mA |
| Width   | of write pulse (write enable low), t <sub>w(wr)</sub>     | 65   | ******  |       | 65         | ******* |      | ns |
| Setup   | Address before write pulse, t <sub>su(ad)</sub>           | o↓   | _       |       | 04         |         |      |    |
| time    | Data before end of write pulse, t <sub>su</sub> (da)      | 651  |         |       | 65↑        |         |      | ns |
| time    | Chip-select before end of write pulse, t <sub>su(S)</sub> | 65↑  |         |       | 651        |         |      |    |
| Hold    | Address after write pulse, th(ad)                         | 01   |         |       | 01         |         |      |    |
|         | Data after write pulse, th(da)                            | 01   |         |       | <b>0</b> ↑ |         |      | ns |
| time    | Chip-select after write pulse, th(S)                      | 01   |         |       | 0†         |         |      |    |
| Operat  | ing free-air temperature, TA                              | 0    |         | 70    | 0          |         | 70   | °C |

↑↓ The arrow indicates the transition of the write input used for references: ↑ for the low-to-high transition, ↓ for the high-to-low transition.

NOTES: 1. Voltage values are with respect to network ground terminal.

## 256-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

|                 | DADAMETED                     |                          | T CONDITIONS <sup>†</sup>                    |     | 'S201 |      |     | <b>′S301</b> |      |      |
|-----------------|-------------------------------|--------------------------|--|-----|-------|------|-----|--------------|------|------|
|                 | PARAMETER                     | IES                      | CONDITIONS                                   | MIN | TYP   | MAX  | MIN | түр          | MAX  | UNIT |
| VIH             | High-level input voltage      |                          |  | 2   |       |      | 2   |              |      | V    |
| VIL             | Low-level input voltage       |                          |  |     |       | 0.8  |     |              | 0.8  | V    |
| VIK             | Input clamp voltage           | V <sub>CC</sub> = MIN,   | lı =18mA                                     |     |       | -1.2 |     |              | -1.2 | V    |
| VOH             | High-level                    | V <sub>CC</sub> = MIN,   |  | 2.4 |       |      |     |              |      | v    |
| · UH            | output voltage                | V <sub>IL</sub> = 08 V,  | I <sub>OH</sub> = MAX                        |     |       |      |     |              |      |      |
| VOL             | Low-level                     | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,                       |     |       | 0.45 |     |              | 0.45 | v    |
| VOL             | output voltage                |                          |  |     |       | 0.45 |     |              | 0.45 | v    |
| 1               | High-level                    | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, V <sub>O</sub> =2.4 V |     |       |      |     |              | 40   | μA   |
| юн              | output current                | V <sub>IL</sub> = 0.8 V  | V <sub>O</sub> =5.5 V                        |     |       |      |     |              | 100  | μΑ   |
| 1               | Off-state output current,     | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V,                       |     |       | 40   |     |              |      |      |
| IOZH            | high-level voltage applied    | $V_{1L} = 0.8 V$ ,       | V <sub>OH</sub> ≈ 2.4 V                      |     |       | 40   |     |              |      | μA   |
| 1               | Off-state output current,     | $V_{CC} = MAX,$          | V <sub>IH</sub> = 2 V,                       |     |       | 40   |     |              |      |      |
| IOZL            | low-level voltage applied     | V <sub>IL</sub> = 0.8 V, | V <sub>OL</sub> = 0.5 V                      |     |       | 40   |     |              |      | μA   |
| 1.              | Input current at maximum      | VMAX                     |  |     |       | 1    |     |              | 1    |      |
| 4               | input voltage                 | V <sub>CC</sub> = MAX,   | V = 5.5 V                                    |     |       |      |     |              | 1    | mA   |
| Чн              | High-level input current      | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V                       |     |       | 25   |     |              | 25   | μA   |
| կլ              | Low-level input current       | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 0.5 V                       |     |       | -250 |     |              | -250 | μA   |
| los             | Short-circuit output current§ | V <sub>CC</sub> = MAX    |  | -30 |       | -100 |     |              |      | mA   |
| <sup>I</sup> CC | Supply current                | $V_{CC} = MAX,$          | See Note 2                                   |     | 100   | 140  |     | 100          | 140  | mA   |

### electrical characteristics over recommended operating free-air temperature range (otherwise noted)

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operation conditions.

<sup>‡</sup>These typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§Duration of the short circuit should not exceed one second.

NOTE: 2. I CC is measured with all chip-select inputs grounded, all other inputs at 4.5 V, and the output open

## 'S201 switching characteristics over recommended operating ranges of ${\sf T}_A$ and ${\sf V}_{CC}$ (unless otherwise noted)

|                    | PARAMETER                              |                      | 1 | <b>TEST CONDITIONS</b>  | MIN | TYP‡ | MAX | UNIT |
|--------------------|--|----------------------|---|---|-----|------|-----|------|
| <sup>t</sup> a(ad) | Access time from add                   | ess                  |   | CL = 30 pF,   |     | 42   | 65  | ns   |
| t <sub>a</sub> (S) | Access time from chip                  | select (select time) |   | RL=300 Ω,   |     | 13   | 30  | ns   |
| <sup>t</sup> SR    | Sense recovery time                    |                      |   | See Note 3  |     | 20   | 40  | ns   |
| <sup>t</sup> PXZ   | Disable time from<br>high or low level | From S<br>From W     |   | C <sub>L</sub> = 5 pF,<br>R <sub>L</sub> = 300 Ω,<br>See Note 3 |     | 9    | 20  | ns   |

# 'S301 switching characteristics over recommended operating ranges of ${\sf T}_{\sf A}$ and ${\sf V}_{\sf CC}$ (unless otherwise noted)

|                    | PARAMETER   |                  | TEST CONDITIONS          | MIN | TYP‡    | MAX      | UNIT |
|--------------------|---|------------------|--------------------------|-----|---------|----------|------|
| <sup>t</sup> a(ad) | Access time from address  |                  | C <sub>L</sub> = 30 pF,  |     | 42      | 65       | ns   |
| ta(S)              | Access time from chip enable  | e (enable time)  | R <sub>L1</sub> = 300 Ω, |     | 13      | 30       | ns   |
| <sup>t</sup> SR    | Sense recovery time   |                  | R <sub>L2</sub> = 600 Ω, |     | 20      | 40       | ns   |
| <sup>t</sup> PLH   | Propagation delay time,<br>low-to-high-level output<br>(disable time) | From S<br>From W | See Note 3               |     | 8<br>15 | 20<br>35 | ns   |

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTE: 3, Load circuit and voltage waveforms are shown in Appendix A, page 44.

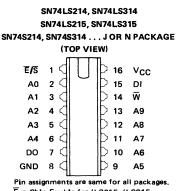
### SCHOTTKY† TTL MEMORIES

### 1024-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

SEPTEMBER 1977

- Static Fully Decoded RAM's Organized 1024 Words of One Bit Each
- Schottky-Clamped for High Performance
- Choice of Three-State or Open-Collector Outputs
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Chip-Enable/Select Inputs Simplify External Decoding
- Typical Performance

| TYPES         | READ<br>ACCESS TIMES | POWER    |
|---------------|----------------------|----------|
| 'S214/'S314   | 40 ns                | 550 mW   |
| 'LS214/'LS314 | 75 ns                | 200 mW   |
| 'LS215/'LS315 | 75 ns                | 200 mW   |
| 'LS215/'LS315 | 75 ns                | 125 mW   |
| POWER DOWN    | (to power-up)        | 125 1110 |



E = Chip-Enable for 'LS215, 'LS315

S = Chip-Select for 'LS214, 'LS314, 'S214, 'S314

### description

These 1024-bit active-element memories are monolithic transistor-transistor logic (TTL) arrays organized as 1024 words of one bit. They are fully decoded and have a chip-enable or chip-select input to simplify decoding required to achieve expanded system organizations. When the 'LS215/'LS315 is disabled, all read and write functions are in a power-down mode, that is, turned off.

### write cycle

The information applied at the data input is written into the selected location when the chip-enable/select input and the write-enable input are low. While the write-enable input is low, the 'S214, 'LS214, and 'LS215 outputs are in the high-impedance state and the 'S314, 'LS314, and 'LS315 outputs are off. When a number of outputs are bus-connected, this high-impedance or off state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up.

### read cycle

The stored information is available at the output when the write-enable input is high and the chip-enable/select input is low. When the chip-enable/select input is high, the 'S214, 'LS214, or 'LS215 output will be in the high-impedance state, the 'S314, 'LS314, or 'LS315 output will be off, and 'LS215 or 'LS315 will be in a power-down mode.

#### TENTATIVE DATA SHEET

This document provides tentative information on new products. Texas Instruments reserves the right to change specifications for these products in any manner without notice.

TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 5012 • DALLAS, TEXAS 75222 <sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by 27 Texas Instruments, U. S. Patent Number 3,463,975.

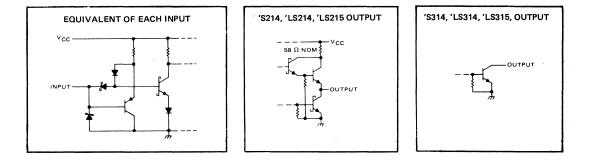
## **1024-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES**

| FUNCTION | TABLE |
|----------|-------|
|          |       |

|          | INPL                             | JTS                 | <b>'</b> S214                   | <b>'</b> S314                   |
|----------|----------------------------------|---------------------|---------------------------------|---------------------------------|
| FUNCTION | CHIP ENABLE (Ë)<br>OR SELECT (S) | WRITE ENABLE<br>(W) | 'LS214<br>'LS215<br>OUTPUT (DO) | 'LS314<br>'LS315<br>OUTPUT (DO) |
| Write    | L                                | L                   | High Impedance                  | Off                             |
| Read     | L                                | н                   | Stored Data                     | Stored Data                     |
| Inhibit  | н                                | х                   | High Impedance                  | Off                             |

 $\mathsf{H} \equiv \mathsf{high} \; \mathsf{level}, \; \mathsf{L} \equiv \mathsf{low} \; \mathsf{level}, \; \mathsf{X} \equiv \mathsf{irrelevant}$ 

### schematics of inputs and outputs



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |   |  |   |  |  |   |   |   |   |   |   |   |   |  |   |       | . 7V     |
|--|---|--|---|--|--|---|---|---|---|---|---|---|---|--|---|-------|----------|
| Input voltage                                |   |  |   |  |  |   |   |   |   |   |   |   |   |  |   |       | . 5.5 V  |
| Off-State output voltage                     |   |  | • |  |  |   | • | • |   |   | • |   |   |  | • |       | . 5.5 V  |
| Operating free-air temperature rang          |   |  |   |  |  |   |   |   |   |   |   |   |   |  |   |       |          |
| Storage temperature range .                  | • |  | • |  |  | • |   | • | • | • | • | • | • |  |   | -65°C | to 150°C |

NOTE: 1. Voltage values are with respect to network ground terminal.

### 'S214 recommended operating conditions

|        |   | s           | N74S21 | 14    | UNIT |
|--------|---|-------------|--------|-------|------|
|        |   | MIN         | NOM    | MAX   |      |
| Supply | voltage, V <sub>CC</sub> (see Note 1)                         | 4.75        | 5      | 5.25  | V    |
| High-I | evel output current, IOH                                      |             |        | -10.3 | mA   |
| Low-le | evel output current, IOL                                      |             |        | 16    | mA   |
| Width  | of write pulse (write enable low), t <sub>W(wr)</sub>         | 50          |        |       | ns   |
| Setup  | Address before write pulse, t <sub>su(ad)</sub>               | 15↓         |        |       |      |
| time   | Data before end of write pulse, t <sub>su(da)</sub>           | <b>55</b> ↑ |        |       | ns   |
| ume    | Chip select before end of write pulse, $t_{su}(\overline{s})$ | 551         |        |       |      |
| Hold   | Address after write pulse, th(ad)                             | 201         |        |       |      |
| time   | Data after write pulse, t <sub>h(da)</sub>                    | 51          |        |       | ns   |
| ume    | Chip select after write pulse, $t_{h}(\overline{S})$          | 51          |        |       |      |
| Opera  | ting free-air temperature, T <sub>A</sub>                     | 0           |        | 70    | °C   |

### 'S314 recommended operating conditions

|        |  | s    | N74S31 | 14   | UNIT |
|--------|--|------|--------|------|------|
|        |  | MIN  | NOM    | MAX  |      |
| Supply | y voltage, V <sub>CC</sub> (see Note 1)                    | 4.75 | 5      | 5.25 | V    |
| High-I | evel output voltage, V <sub>OH</sub>                       |      |        | 5.5  | V    |
| Low-I  | evel output current, IOL                                   |      |        | 16   | mA   |
| Width  | of write pulse (write enable low), t <sub>w(wr)</sub>      | 50   |        |      | ns   |
| Setup  | Address before write pulse, t <sub>su(ad)</sub>            | 15↓  |        |      |      |
| time   | Data before end of write pulse, t <sub>su(da)</sub>        | 55↑  |        |      | ns   |
| ume    | Chip select before end of write pulse, t <sub>su</sub> (S) | 55↑  |        |      |      |
| Hold   | Address after write pulse, th(ad)                          | 201  |        |      |      |
| time   | Data after write pulse, t <sub>h(da)</sub>                 | 5↑   |        |      | ns   |
| ume    | Chip select after write pulse, th(S)                       | 51   |        |      |      |
| Opera  | ting free-air temperature, T <sub>A</sub>                  | 0    |        | 70   | °C   |

 $\uparrow\downarrow$ The arrow indicates the transition from the read/write input used for reference:  $\uparrow$  for the low-to-high transition,  $\downarrow$  for the high-to-low transition.

NOTE: 1. Voltage values are with respect to network ground terminal.

## **1024-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES**

|         |  |            |      | SN74LS<br>SN74LS |      | -    | N74LS2<br>N74LS3 |      | UNIT |
|---------|--|------------|------|------------------|------|------|------------------|------|------|
|         |  |            | MI   | NOM              | MAX  | MIN  | NOM              | MAX  |      |
| Supply  | / Voltage, V <sub>CC</sub> (see Note )               | )          | 4.75 | i 5              | 5.25 | 4.75 | 5                | 5.25 | v    |
| High-le | evel output voltage, V <sub>OH</sub>                 | LS314,     |      |                  | 5.5  |      |                  |      |      |
| ingirit | ever output voltage, vOH                             | LS315      |      |                  | 5.5  |      |                  | 5.5  |      |
|         | evel output current, IOH                             | LS214,     |      |                  |      |      |                  |      |      |
| righ-it | ever output current, IOH                             | LS215      |      |                  | -5.2 |      |                  | 5.2  | mA   |
| Low-le  | evel output current, IOL                             |            |      |                  | 16   |      |                  | 16   | mA   |
| Width   | of write pulse (write enab                           | e low),    | 60   |                  |      | 60   |                  |      |      |
| tw(wr)  |  |            | 0    |                  |      | 60   |                  |      | ns   |
|         | Address before write puls                            | ),         | 20   |                  |      | 20↓  |                  |      |      |
|         | <sup>t</sup> su(ad)                                  |            | 20   | 14               |      | 201  |                  |      |      |
| Setup   | Data before end of write                             | oulse,     | 75   | •                |      | 75↑  |                  |      |      |
| time    | <sup>t</sup> su(da)                                  |            | /8   | ι <b>τ</b>       |      | 751  |                  |      | ns   |
|         | Chip-select/enable before                            | end        | 75   | •                |      |      |                  |      |      |
|         | of write pulse, t <sub>su</sub> (E), t <sub>su</sub> | <u>s</u> ) |      | 1                |      | 1101 |                  |      |      |
|         | Address after write pulse,                           | th(ad)     | 15   | it .             |      | 15↑  |                  |      |      |
| Hold    | Data after write pulse, th                           | da)        | 1!   | 5†               |      | 15t  |                  |      |      |
| time    | Chip-select/enable after w                           | rite pulse |      |                  |      | 454  |                  |      | ns   |
|         | $t_{h}(\overline{E}), t_{h}(\overline{S})$           |            | 18   | θŦ               |      | 15↑  |                  |      |      |
| Operat  | ting free-air temperature, T                         | Α          |      | )                | 70   | 0    |                  | 70   | °C   |

### 'LS214, 'LS314, 'LS215, 'LS315 recommended operating conditions

### 'S214, 'S314 electrical characteristics over recommended operating free-air temperature range (otherwise noted)

|            | PARAMETER                      | TEST CONDITIO                                    | Net                   |     | 'S214 |      |     | 'S314 |      |      |
|------------|--------------------------------|--|-----------------------|-----|-------|------|-----|-------|------|------|
|            | FARAMETER                      | TEST CONDITIO                                    | N2.                   | MIN | TYP‡  | MAX  | MIN | TYP‡  | MAX  | UNIT |
| VIH        | High-level input voltage       |  |                       | 2   |       |      | 2   |       |      | V    |
| VIL        | Low-level input voltage        |  |                       |     |       | 0.8  |     |       | 0.8  | V    |
| VIK        | Input clamp voltage            | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA   |                       |     |       | -1.2 |     |       | -1.2 | V    |
| Vali       | High-level                     | $V_{CC} = MIN, V_{IH} = 2 V,$                    |                       | 2.4 | 2.9   |      |     |       |      | v    |
| ∨он        | output voltage                 | V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MAX   |                       | 2.4 | 2.9   |      |     |       |      | v    |
| VOL        | Low-level                      | $V_{CC} = MIN, V_{IH} = 2 V,$                    |                       |     |       | 0.45 |     |       | 0.45 | v    |
| VOL        | output voltage                 | V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX   |                       |     |       | 0.45 |     |       | 0,45 | v    |
| 1          | High-level                     | $V_{CC} = MIN, V_{IH} = 2 V,$                    | V <sub>O</sub> =2.4 V |     |       |      |     |       | 50   | μA   |
| юн         | output current                 | V <sub>IL</sub> = 0.8 V                          | V <sub>O</sub> =5.5 V |     |       |      |     |       | 100  | μΑ   |
| 1          | Off-state output current,      | $V_{CC} = MAX, V_{IH} = 2 V,$                    | •                     |     |       | 50   |     |       |      | μA   |
| юzн        | high-level voltage applied     | V <sub>IL</sub> = 0.8 V, V <sub>OH</sub> = 2.4 V | ,                     |     |       | 50   |     |       |      | μΑ   |
| 1          | Off-state output current,      | $V_{CC} = MAX, V_{IH} = 2 V,$                    |                       |     |       | -50  |     |       |      | μA   |
| <b>OZL</b> | low-level voltage applied      | V <sub>IL</sub> = 0.8 V, V <sub>OL</sub> = 0.5 V |                       |     |       | -50  |     |       |      | μΑ   |
| 1.         | Input current at maximum       | Vcc = MAX, VI = 5.5 V                            |                       |     |       | 1    |     |       | 1    | mA   |
| 4          | input voltage                  | VCC = WAX, V1 = 3.5 V                            |                       |     |       |      |     |       | •    |      |
| Чн         | High-level input current       | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V    |                       |     |       | 25   |     |       | 25   | μA   |
| ΗL         | Low-level input current        | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V    |                       |     |       | -250 |     |       | -250 | μA   |
| los        | Short-circuit output current § | V <sub>CC</sub> = MAX                            |                       | -30 |       | -100 |     |       |      | mA   |
| Icc        | Supply current                 | VCC = MAX, See Note 2                            | T <sub>A</sub> =0°C   |     |       | 155  |     |       | 155  | mA   |
|            |                                |  | T <sub>A</sub> = 70°C |     |       | 130  |     |       | 130  |      |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. <sup>‡</sup>These typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25 C$ . § Duration of the short circuit should not exceed one second. NOTES: 1. Voltage values are with respect to network ground terminal. 2.  $I_{CC}$  is measured with all inputs grounded and the output open.

### 'LS214, 'LS314, 'LS215, 'LS315 electrical characteristics over recommended operating free-air temperature range (otherwise noted)

|      | PARAMETER                      |                       | TEST CONDITIONS <sup>†</sup>  |     | SN74' |       | UNIT            |
|------|--------------------------------|-----------------------|---|-----|-------|-------|-----------------|
|      |                                |                       |   | MIN | TYP‡  | MAX   | 1               |
| VIН  | High-level input voltage       |                       |   | 2   |       |       | V               |
| VIL  | Low-level input voltage        |                       |   |     |       | 0.8   | V               |
| VIK  | Input clamp voltage            |                       | $V_{CC} = MIN, I_I = -18 \text{ mA}$                                |     |       | -1.2  | V               |
|      | High-level                     | 'LS214,               | $V_{CC} = MIN, V_{IH} = 2 V,$                                       | 2.4 | 3.3   |       | V               |
| ۷он  | output voltage                 | 'LS215                | VIL = 0.8 V, I <sub>OH</sub> = MAX                                  | 2.4 | 3.3   |       | ľ               |
|      | Low-level                      |                       | $V_{CC} = MIN, V_{IH} = 2 V,$                                       |     |       | 0.5   | V               |
| VOL  | output voltage                 |                       | V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX                      |     |       | 0.5   | ľ               |
|      | High-level                     | 'LS314,               | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>O</sub> =2.4 V |     |       | 50    | μA              |
| юн   | output current                 | 'LS315                | V <sub>IL</sub> = 0.8 V V <sub>O</sub> =5.5 V                       |     |       | 100   | 1 <sup>#A</sup> |
|      | Off-state output current,      | 'LS214,               | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V,                       |     |       | 50    | μA              |
| IOZH | high-level voltage applied     | 'LS215                | V <sub>IL</sub> = 0.8 V, V <sub>OH</sub> = 2.4 V                    |     |       | 50    |                 |
|      | Off-state output current,      | 'LS214,               | $V_{CC} = MAX, V_{IH} = 2 V,$                                       |     |       | -50   | μA              |
| IOZL | low-level voltage applied      | 'LS215                | V <sub>IL</sub> = 0.8 V, V <sub>OL</sub> = 0.5 V                    |     |       | -50   | μ.Α.            |
|      | Input current at maximum       |                       |   |     |       |       | -               |
| 4    | input voltage                  |                       | $V_{CC} = MAX, V_I = 5.5 V$   |     |       |       | mA              |
| Чн   | High-level input current       |                       | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V                       |     |       | 25    | μA              |
| ΗL   | Low-level input current        |                       | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V                       |     | -     | - 250 | μA              |
| IOS  | Short-circuit output current § | 'LS214,<br>'LS215     | V <sub>CC</sub> = MAX   | -20 |       | -100  | mA              |
| ICC  | Supply current                 | •                     | V <sub>CC</sub> = MAX, See Note 2                                   |     | 40    | 58    | mA              |
| ICC  | Supply current - Power dow     | (LS215<br>n<br>(LS315 | V <sub>CC</sub> = MAX, Ē = 2.4 V                                    |     | 25    | 30    | mA              |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. <sup>‡</sup>These typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Duration of the short circuit should not exceed one second. NOTE: 2.  $I_{CC}$  is measured with all inputs grounded and the output open.

### 'S214, 'LS214 switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

|                    | PARAMETER                            |                     | TEST  | s   | N74S2 | 14  | S   | 14       |    |      |
|--------------------|--------------------------------------|---------------------|---|-----|-------|-----|-----|----------|----|------|
|                    | PARAMETER                            |                     | CONDITIONS  | MIN | түр‡  | MAX | MIN | N TYP‡ N |    | UNIT |
| ta(ad)             | Access time from ad                  | dress               |   |     | 40    | 70  |     | 75       | 95 | ns   |
| <sup>t</sup> a(͡S) | Access time from ch<br>(select time) | ip select           | C <sub>L</sub> = 30 pF, R <sub>L</sub> = 400 Ω,<br>See Note 3 |     | 15    | 40  |     | 30       | 50 | ns   |
| <sup>t</sup> SR    | Sense recovery time                  |                     |   |     | 25    | 50  |     | 35       | 65 | ns   |
|                    | Disable time from                    | from S              | $C_{L} = 5  pF, R_{L} = 400  \Omega,$                         |     | 20    | 40  |     | 30       | 40 |      |
| tPXZ               | high or low level                    | from $\overline{W}$ | See Note 3  |     | 20    | 40  |     | 35       | 50 | ns   |

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. NOTE: 3. Load circuit and voltage waveforms are shown in Appendix A, page 44.

## **1024-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES**

## 'S314 and 'LS315 switching characteristics over recommended operating ranges of T<sub>A</sub> and V<sub>CC</sub> (unless otherwise noted)

|  |  |     | TEST  | 5        | N74S3 | 14       | S        | 14   |     |    |
|--|--|-----|---|----------|-------|----------|----------|------|-----|----|
|  | PARAMETER                                  |     | CONDITIONS                                    | MIN      | түр‡  | MAX      | MIN      | TYP‡ | мах |    |
| t <sub>a(ad)</sub>   | Access time from address                   |     |   |          | 40    | 70       |          | 75   | 95  | ns |
| ta(S)  | Access time from chip sel<br>(select time) | ect |   |          | 15    | 40       |          | 35   | 50  | ns |
| tSR  | Sense recovery time                        |     | $C_{L} = 30 \text{ pF}, R_{L1} = 300 \Omega,$ |          | 25    | 50       |          | 35   | 50  | ns |
| Propagation delay time,<br>tPLH low-to-high-level output<br>(disable time) | $R_{L2} = 600 \Omega$ , See Note 3         |     | 20<br>25                                      | 40<br>40 |       | 45<br>35 | 60<br>50 | ns   |     |    |
|  | (disable time)                             |     |   |          | 20    | 40       |          | 35   | 50  |    |

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

## 'LS215 switching characteristics over recommended operating ranges of T<sub>A</sub> and V<sub>CC</sub> (unless otherwise noted)

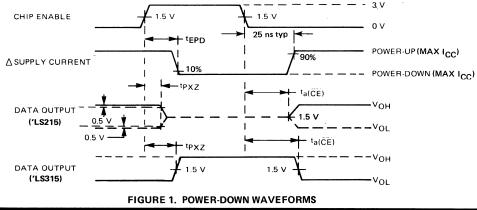
| (u                 | nless otherwise noted)              |         |  | SN74LS215 |      |     |      |
|--------------------|-------------------------------------|---------|--|-----------|------|-----|------|
|                    | PARAMETER                           |         | TEST CONDITIONS                                    | MIN       | TYP‡ | MAX | UNIT |
| ta(ad)             | Access time from address            |         | C <sub>L</sub> = 15 pF,                            |           | 75   | 95  | ns   |
| t <sub>a</sub> (Ē) | Access time from chip enable (enabl | e time) | RL = 400 Ω,  |           | 75   | 95  | ns   |
| tSR                | Sense recovery time                 |         | See Note 5   |           | 35   | 65  | ns   |
| tpxz               | Disable time from high or low level | from E  | C <sub>L</sub> = 5 pF,<br>R <sub>L1</sub> = 400 Ω, |           | 30   | 40  | ns   |
|                    |                                     | from W  | See Note 3   |           | 35   | 50  |      |
| <sup>t</sup> EPD   | Chip power-down time                |         | See Figure 1                                       |           | 40   | 65  | ns   |

## 'LS315 switching characteristics over recommended operating ranges of T<sub>A</sub> and V<sub>CC</sub> (unless otherwise noted)

| (u                 | mess otherwise noted)                   |        |                          | 5   | SN74LS | 315 |      |
|--------------------|---|--------|--------------------------|-----|--------|-----|------|
|                    | PARAMETER                               |        | TEST CONDITIONS          | MIN | TYP‡   | MAX | UNIT |
| ta(ad)             | Access time from address                |        | C <sub>1</sub> = 15 pF,  |     | 75     | 95  | ns   |
| t <sub>a</sub> (Ē) | Access time from chip enable (enable ti | me)    | R <sub>L1</sub> = 400 Ω, |     | 75     | 95  | ns   |
| tSR                | Sense recovery time                     |        | $R_{L2} = 600 \Omega,$   |     | 35     | 50  | ns   |
|                    | Propagation delay time,                 | from E | See Note 3               |     | 30     | 60  |      |
| <sup>t</sup> PLH   | low-to-high level output (disable time) | from W | See Note 3               |     | 35     | 50  | ns   |
| tepd               | Chip power-down time                    |        | See Figure 1             |     | 40     | 65  | ns   |

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

NOTE: 3. Load circuit and voltage waveforms are shown in Appendix A, page 44.



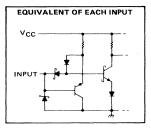
- Static Fully Decoded RAM's Organized as 256 Words of Four Bits Each
- Schottky-Clamped for High Performance
- Edge-Triggered Write Control
- 'S207 Data and Address are Same Pins as 1K PROM's ('S287, 'S387)
- High-Density Dual-in-Line Packages have Pin-Row Spacing of 0.300-Inch
- Three-State Output for Driving Bus-Organized Systems and/or Highly Capacitive Loads
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Typical Performance:

| TYPEO        | ACCESS | TIMES | POWER  |
|--------------|--------|-------|--------|
| TYPES        | WRITE  | READ  | DISS.  |
| 'S207/'S208  | 35 ns  | 40 ns | 600 mW |
| 'LS207/'S208 | 65 ns  | 75 ns | 200 mW |

### description

These 1024-bit active-element memories are monolithic transistor-transistor logic (TTL) arrays organized as 256 words of four bits each. They are fully decoded with output enable inputs to simplify decoding required to achieve the desired system organization. Read and write times are virtually equal, which simplifies control implementation.

### schematics of inputs and outputs



### write cycle

While the output-enable input,  $\overline{OE}$ , of the 'LS207, 'S207 is high, data applied to the input/output (I/O) is written into the selected location on a positive transition at the write input. Information at the data input of the 'LS208, 'S208 memory is written into the selected location on a positive transition at the write input regardless of the state of the output-enable input. While the output-enable input of either is high, the output is in the high-impedance state. When a number of outputs are bus-connected, this high-impedance output state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up if desired.

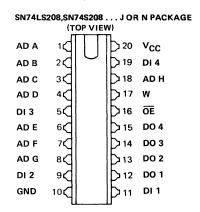
### read cycle

The stored information is available at the output when the output-enable input is low.

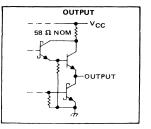
DESIGN GOAL This document provides tentative information on a product in the developmental stage. Texas Instruments reserves the right to change or discontinue this product without notice.

TEXAS INSTRUMENTS

SN74LS207,SN74S207 ... J OR N PACKAGE (TOP VIEW) AD G 1( 〕16 Vcc AD H AD F 20 े15 w AD E 3ť ≥14 ÕE **4**¢ े 13 AD D 712 1/0 1 AD A 5ť AD B **6**( <u>)</u>11 1/0 2 1/0 3 AD C 7٢ 〉10 1/0 4 GND 81 g



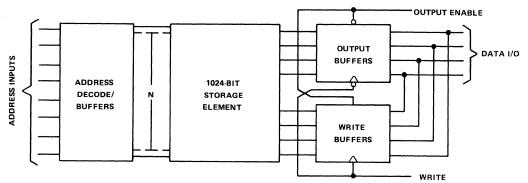
Pin assignments are same for all packages.



<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

## **1024-BIT EDGE-TRIGGERED RANDOM-ACCESS MEMORIES**



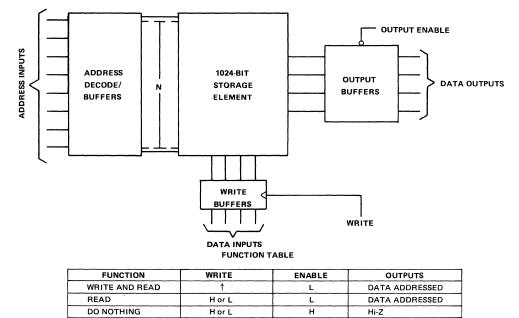


#### FUNCTION TABLE

| FUNCTION   | WRITE  | ENABLE | OUTPUTS                   |
|------------|--------|--------|---------------------------|
| WRITE      | 1      | н      | Hi-Z (USE AS DATA INPUTS) |
| READ       | H or L | L      | DATA ADDRESSED            |
| DO NOTHING | H or L | н      | Hi-Z                      |

 $H = HIGH, L = LOW, \uparrow = LOW-TO-HIGH TRANSITION$ 

'LS208, 'S208 functional block diagram



 WRITE ONLY
 ↑
 H

 H = HIGH, L = LOW, ↑= LOW-TO-HIGH TRANSITION
 H
 H

Hi-Z

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1)                 |      |      |     |     |       |     |     |  |  |  |  |  |  |  |   |        | 7 V     | ' |
|--|------|------|-----|-----|-------|-----|-----|--|--|--|--|--|--|--|---|--------|---------|---|
| Input voltage                                    |      |      |     |     |       |     |     |  |  |  |  |  |  |  |   |        |         |   |
| Off-state output voltage                         |      |      |     |     |       |     |     |  |  |  |  |  |  |  |   |        | 5.5 V   | ' |
| Operating free-air temperature range:            |      |      |     |     |       |     |     |  |  |  |  |  |  |  | 0 | )°C to | 5 70° C | ; |
| Storage temperature range                        |      |      |     |     |       |     |     |  |  |  |  |  |  |  |   |        |         |   |
| NOTE 1: All voltage values are with respect to r | netv | vork | gro | unc | d ter | min | al. |  |  |  |  |  |  |  |   |        |         |   |

### 'S207, 'S208 recommended operating conditions

|                                 |  |                    | SN74S' |      |      |
|---------------------------------|--|--------------------|--------|------|------|
|                                 |  | MIN                | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub> |  | 4.75               | 5      | 5.25 | V    |
| High-level output curre         | ent, IOH   |                    | 1.000  | -6.5 | mA   |
| Low-level output curre          | int, I <sub>OL</sub>   |                    |        | 16   | mA   |
| Width of write pulse (h         |  | 151                |        | ns   |      |
| Setup time                      | Address before write, t <sub>su(ad)</sub>                              |                    | o†     |      | ns   |
| (see Figures 3 and 4)           | Data before write, t <sub>su(da)</sub>                                 |                    | 01     |      | 1 "  |
|                                 | Output enable after write, $t_{h}(\overline{OE})$ (see Figure 3) 'S207 | <sup>t</sup> h(da) | t      |      |      |
| Hold time                       | Address after write, $t_{h(ad)}$ (see Figures 3 and 4)                 |                    | 351    |      | ns   |
|                                 | Data after write, t <sub>h(da)</sub> (see Figures 3 and 4)             |                    | 351    |      | 1    |
| Operating free-air temp         | rating free-air temperature, T <sub>A</sub>                            |                    |        |      |      |

The arrow indicates that the rising transition of the write input is used for reference.

# 'S207,'S208 electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER                    | Т <b>т</b>   | TEAT OON   |   |     | SN74S' |      | UNIT     |
|-----------------|------------------------------|--------------|--|---|-----|--------|------|----------|
|                 | PARAMETER                    |              | TEST CON   | DITIONS   | MIN | TYP‡   | MAX  | UNIT     |
| VIH             | High-level input voltage     |              |  |   | 2   |        |      | V        |
| VIL             | Low-level input voltage      |              |  |   |     |        | 0.8  | V        |
| VIK             | Input Clamp voltage          |              | V <sub>CC</sub> = MIN,                             | I <sub>I</sub> =18 mA                             |     |        | -1.2 | V        |
| v <sub>он</sub> | High-level output voltage    |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX   | 2.4 | 3.2    |      | v        |
| VOL             | Low-level output voltage     |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = 16 mA |     |        | 0.5  | v        |
| 1               | Off-state output current     | 'S207        | V <sub>CC</sub> = MAX,                             | V <sub>1H</sub> = 2 V,                            |     |        | 100  | μA       |
| lozh            | high-level voltage applied   | ʻS208        | V <sub>0</sub> = 2.4 V                             |   |     |        | 50   | 1 **~    |
| 1               | Off-state output current     | 'S207        | V <sub>CC</sub> = MAX,                             | V <sub>IH</sub> = 2 V,                            |     |        | -250 | μA       |
| IOZL            | low-level voltage applied    | 'S208        | V <sub>O</sub> = 0.5 V                             |   |     |        | 50   | <u> </u> |
| 4               | Input current at maximum i   | nput voltage | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.5 V                            |     |        | 1    | mA       |
| 1               | Link lovel instance and and  | 'S207        | 1/ MAA.V   | N/ - 2 4 M  |     |        | 100  | μA       |
| Чн              | High-level input current     | 'S208        | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 2.4 V                            |     |        | 25   | μ.Α.     |
| ΙL              | Low-level input current      |              | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.5 V                            |     |        | -250 | μA       |
| los             | Short-circuit output current | §            | V <sub>CC</sub> = MAX                              |   | -30 |        | -100 | mA       |
|                 | C. and L.                    | 'S207        | N MAX  | San Nata 2  |     | 120    |      |          |
| ICC             | Supply current               | 'S208        | V <sub>CC</sub> = MAX,                             | See Note 2  |     | 120    |      | mA       |

## **1024-BIT EDGE-TRIGGERED RANDOM-ACCESS MEMORIES**

### 'LS207, 'LS208 recommended operating conditions

|                                 |   |                                 | SN74LS | 5    | UNIT  |
|---------------------------------|---|---------------------------------|--------|------|-------|
|                                 |   | <br>MIN                         | NOM    | MAX  |       |
| Supply voltage, V <sub>CC</sub> |   | 4.75                            | 5      | 5.25 | v     |
| High-level output curre         | ent, IOH  |                                 |        | -6.5 | mA    |
| Low-level output curre          | ent, IOL  |                                 |        | 16   | mA    |
| Width of write pulse (H         | nigh), t <sub>w(wr)</sub>                                     |                                 | 251    |      | ns    |
| Setup time                      | Address before write, t <sub>su(ad)</sub>                     |                                 | 01     |      | ns    |
| (see Figures 3 and 4)           | Data before write, t <sub>su(da)</sub>                        |                                 | 01     |      | 1 115 |
|                                 | Output enable after write, th(OE) (see Figure 3) 'S207        | <sup>t</sup> h(da) <sup>↑</sup> |        |      |       |
| Hold time                       | Address after write, t <sub>h(ad)</sub> (see Figures 3 and 4) |                                 | 651    |      | ns    |
|                                 | Data after write, t <sub>h(da)</sub> (see Figures 3 and 4)    |                                 | 65 1   |      | 1     |
| Operating free-air tem          | perature, T <sub>A</sub>                                      | 0                               |        | 70   | °C    |

<sup>†</sup>The arrow indicates that the rising transition of the write input is used for reference.

## 'LS207, 'LS208 electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER                    |                  | TEST CON   | DITIONET  |     | SN74LS   | i         | UNIT       |
|-----------------|------------------------------|------------------|--|---|-----|----------|-----------|------------|
|                 | FARAMETER                    |                  | TEST CON   | DITIONS.  | MIN | TYP‡     | MAX       |            |
| ⊻ін             | High-level input voltage     |                  |  |   | 2   |          |           | V          |
| VIL             | Low-level input voltage      |                  |  |   |     |          | 0.8       | V          |
| Viк             | Input Clamp voltage          |                  | V <sub>CC</sub> = MIN,                             | lj =18 mA   |     |          | -1.2      | V          |
| V <sub>OH</sub> | High-level output voltage    |                  | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |   | 2.4 | 3.2      |           | v          |
| VOL             | Low-level output voltage     |                  | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = 16 mA |     |          | 0.5       | v          |
| 1               | Off-state output current     | 'LS207           | V <sub>CC</sub> = MAX,                             | V <sub>IH</sub> = 2 V,                            |     |          | 100       | μA         |
| IOZH            | high-level voltage applied   | 'LS208           | V <sub>O</sub> = 2.4 V                             |   |     |          | 50        | <i>µ</i> A |
| 1               | Off-state output current     | 'LS207           | V <sub>CC</sub> = MAX,                             | V <sub>IH</sub> = 2 V,                            |     |          | -250      | μA         |
| IOZL            | low-level voltage applied    | 'LS208           | V <sub>O</sub> = 0.5 V                             |   |     |          | -50       | 1          |
| 4               | Input current at maximum i   | nput voltage     | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V                            |     |          | 1         | mA         |
| Чн              | High-level input current     | 'LS207<br>'LS208 | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 2.4 V                            |     |          | 100<br>25 | μA         |
| 46              | Low-level input current      |                  | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.5 V                            |     |          | -250      | μA         |
| los             | Short-circuit output current | §                | V <sub>CC</sub> = MAX                              |   | -20 |          | -100      | mA         |
| lcc             | Supply current               | 'LS207<br>'LS208 | V <sub>CC</sub> = MAX,                             | See Note 2  |     | 40<br>40 |           | mA         |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25° C.

§Duration of the short-circuit should not exceed one second.

NOTES: 1. All voltage values are with respect to network ground terminal.

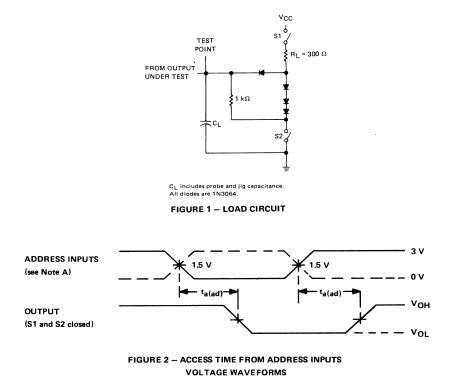
2. ICC is measured with the write input high, output enable input grounded, all other inputs at 4.5 V, and all outputs open.

## switching characteristics at V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

|                  | PARAMETER                        |                      | TEST CONDITIONS                            | 'S207 | , 'S208 | 'LS207 | ,'LS208 | UNIT |
|------------------|----------------------------------|----------------------|--|-------|---------|--------|---------|------|
|                  | PARAMETER                        | TEST CONDITIONS      | түр  | MAX   | TYP     | MAX    |         |      |
| ta(ad)           | Access time from address         |                      | $C_{L} = 30  pF, R_{L} = 300  \Omega,$     | 40    |         | 75     |         | ns   |
| ta(OE)           | Access time from output enable ( | See Figures 1 thru 5 | 15   |       | 20      |        | ns      |      |
| ta(wr)           | Access time from write           | 'LS208, 'S208        |  | 25    |         | 50     |         | ns   |
|                  | Disable time from high or low    | from OE §            | $C_{L} = 5  pF$ , $R_{L1} = 300  \Omega$ , | 15    |         | 20     |         | ns   |
| <sup>t</sup> PXZ | level (see Note 4)               | See Figures 3 and 5  | 15   |       | 20      |        | , ''s   |      |

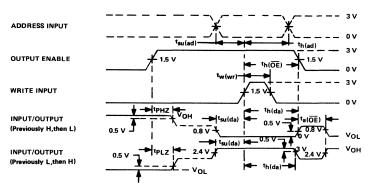
 $\ensuremath{\S{\text{This}}}$  parameter defines the delay for the I/O port to enter the input mode.

### PARAMETER MEASUREMENT INFORMATION



NOTE A. When measuring delay times from address inputs, the output-enable and write inputs are low.

### **1024-BIT EDGE-TRIGGERED RANDOM-ACCESS MEMORIES**



### FIGURE 3 - 'LS207, 'S207 WRITE AND READ VOLTAGE WAVEFORMS

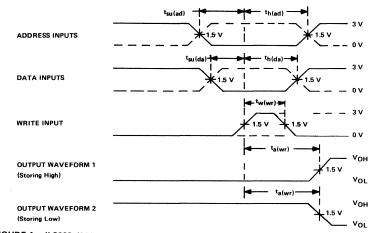
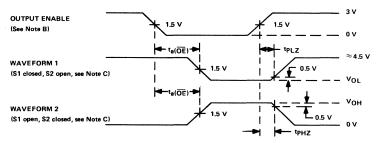


FIGURE 4 - 'LS208, 'S208 WRITE WHILE READ VOLTAGE WAVEFORMS (OUTPUT ENABLE IS LOW)



### FIGURE 5 – ACCESS (ENABLE) TIME AND DISABLE TIME FROM OUTPUT ENABLE VOLTAGE WAVEFORMS

- NOTES: B. When measuring delay times from the output-enable input, the address inputs are steady-state and the write/read input is low. C. Waveform 1 is for the output with internal conditions such that the output is low except when disabled, Waveform 2 is for the
  - output with internal conditions such that the output is high except when disabled.
  - D. Input waveforms are supplied by the pulse generators having the following characteristics:  $t_r \le 2.5$  ns,  $t_f \le 2.5$  ns, PRR  $\le 1$  MHz, and  $Z_{out} \approx 50 \ \Omega$ .

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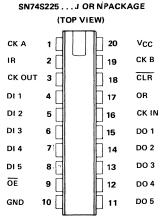
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SEPTEMBER 1976

- Independent Synchronous Inputs and Outputs
- Organized as 16-Words of 5 Bits •
- DC to 10 MHz Data Rate
- 3-State Data Outputs
- 20-Pin, 300-mil, High Density Package



Pin assignments are same for all packages

description

This 80-bit active-element memory is a monolithic, Schottky-clamped transistor-transistor logic (STTL) array organized as 16 words of five-bits each. The 'S225 can easily be expanded to 16N-words of 5N-bits in length and features a single enable control for all 3-state data outputs.

### operation

A FIFO is a memory storage device which allows data to be written into and/or read from its array at independent data rates. The 'S225 is a FIFO which will process data at any desired clock rate from DC to 10 MHz. The data is processed in a parallel format, word by word.

Reading or writing is done independently utilizing separate synchronous data clocks. Data may be written into the array on the low-to-high transition of either load clock input. Data may be read out of the array on the low-to-high transition of the unload clock input (normally high). When writing data into the FIFO one of the load clock inputs must be held high while the other strobes in the data. This arrangement allows either load clock to function as an inhibit for the other

Status of the 'S225 is provided by three outputs. Input ready monitors the status of the last word location and signifies when the memory is full. This output is high whenever the memory is available to accept any data. The unload clock output also monitors the last word location. This output generates a low-logic-level pulse (synchronized to the internal clock pulse) when the location is vacant. The third status output, output ready, is high when the first word location contains valid data and unload clock input is high. When unload clock input is low, output ready will be low. The first word location is defined as the location from which data is provided to the outputs.

The data outputs are noninverted with respect to the data inputs and are three-state with a common control input, output enable. When output enable is low, the data outputs are enabled to function as totem-pole outputs. A high-logic-level forces each data output to a high-impedance state while all other inputs and outputs remain active.

The clear input invalidates all data stored in the memory array by clearing the control logic and setting output ready to a low-logic-level on the high-to-low transition of a low-active pulse. The data outputs do not change as a result of the clear input; however, the output ready at a low-logic-level signifies invalid data.

TENTATIVE DATA SHEET This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments, U. S. Patent Number 3,463,975.

### **FUNCTION TABLES**

| Table | 1 | Input | Functions |
|-------|---|-------|-----------|
|-------|---|-------|-----------|

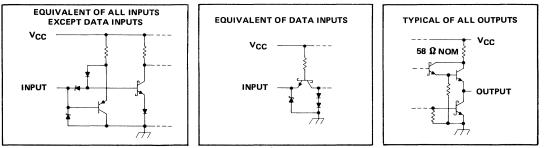
| Input       | Pin | Description        |
|-------------|-----|--------------------|
| CK A        | 1   | Load Clock A       |
| DI 1 - DI 5 | 4-8 | Data Inputs        |
| ŌĒ          | 9   | Output Enable      |
| CK IN       | 16  | Unload Clock Input |
| ĈĽŔ         | 18  | Clear              |
| СК В        | 19  | Load Clock B       |
| GND         | 10  | Ground pin         |
| Vcc         | 20  | Supply Voltage     |

### Table 2 - Output Functions

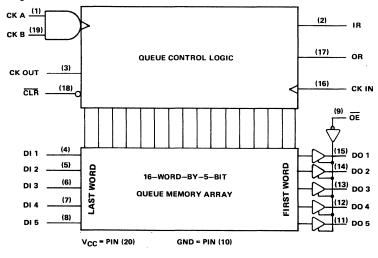
| Output      | Pin     | Description         |
|-------------|---------|---------------------|
| IR          | 2       | Input Ready         |
| CK OUT      | 3       | Unload Clock Output |
| DO 5 - DO 1 | 11 - 15 | Data Outputs        |
| OR          | 17      | Output Ready        |

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### sohematics of inputs and outputs



functional block diagram



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply Voltage, V <sub>CC</sub> (see Note 1) . |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |             | 7V  |
|--|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|-------------|-----|
| Input Voltage                                  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   | 5.          | .5V |
| Off-State Output Voltage                       |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   | 5.          | .5V |
| Operating Free-Air Temperature Range           |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   | 0°C to 70   | с°С |
| Storage Temperature Range                      |   |   |   |   | • |   |   |   |   |   |   |   |   |   |   |   |   |   | - | 65°C to 150 | °С  |
| Storage Temperature Range                      | • | • | · | • | · | • | · | • | · | • | · | · | · | · | • | · | · | · |   | 65°C to 150 | )°С |

NOTE 1: All voltage values are with respect to network ground terminal.

### recommended operating conditions

|  |  | MIN  | NOM | MAX  | UNIT |
|--|--|------|-----|------|------|
| Supply Voltage, V <sub>CC</sub>          |  | 4.75 | 5   | 5.25 | V    |
|  | All Outputs Except Data                              |      |     | -3.2 | mA   |
| High-level output current, IOH           | Data Outputs   |      |     | -6.5 |      |
|  | All Outputs Except Data                              |      |     | 8    | mA   |
| Low-level output current, IOL            | Data Outputs   |      |     | 16   | mA   |
|  | Load Clock A or B, t <sub>w</sub> (high)             | 25   |     |      |      |
| Pulse Width                              | Unload Clock Input, tw (low)                         | 7    |     |      | ns.  |
|  | Clear, t <sub>w</sub> (low)                          | 40   |     |      |      |
| Setup Time                               | Data to Load Clock, t <sub>su</sub> (DIi) See Note 2 | -201 |     |      | ns   |
|  | Clear Release to Load Clock, t <sub>su</sub>         | 25†  |     |      | 1    |
| Hold Time, Data from Load Clock, th(Dli) |  | 70†  |     |      | ns   |
| Operating free-air temperature, TA       |  | 0    |     | 70   | °C   |

NOTE 2: Data must be setup within 15 ns after the load clock positive transition.

 $\dagger$  = The arrow indicates that the low-to-high transition of the load clock is used for reference.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                | PARAMETER  | TEST CON                  | DITIONST   | MIN  | TYP‡ | MAX  | UNIT |    |
|----------------|--|---------------------------|--|--|------|------|------|----|
| VIH            | High-level input voltage                             |                           |  | 2  |      |      | v    |    |
| VIL            | Low-level input voltage                              |                           |  |  |      | 0.8  | V    |    |
| VIK            | Input clamp voltage                                  |                           | V <sub>CC</sub> = MIN,                             | l₁ = −18 mA                                      |      |      | -1.2 | V  |
| ∨он            | High-level output voltage                            |                           | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX  | 2.4  | 2.9  |      | v  |
| VOL            | Low-level output voltage                             |                           | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX  |      | 0.35 | 0.50 | v  |
| lоzн           | Off-state output current, high-level voltage applied |                           | V <sub>CC</sub> = MAX,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>V <sub>O</sub> = 2.4 V |      |      | 50   | μA |
| IOZL           | Off-state output current, low-level voltage applied  |                           | V <sub>CC</sub> = MAX,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>V <sub>O</sub> = 0.5 V |      |      | -50  | μΑ |
| Ι <sub>Ι</sub> | Input current at maximum input voltage               |                           | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V                           |      |      | 1    | mA |
| 1              |  | Data In                   |  | V = 0.7.V  |      |      | 40   |    |
| Чн             | High-level input current                             | All Inputs Except Data In | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 2.7 V                           |      |      | 25   | μA |
|                |  | Data In                   | V MAX  | Vi = 0.5 V                                       |      |      | -1   | mA |
| 4L             | Low-level input current                              | All Inputs Except Data In | V <sub>CC</sub> = MAX,                             | VI - 0.5 V                                       |      |      | -250 | μA |
| los            | Short-circuit output current §                       |                           | V <sub>CC</sub> = MAX                              |  | -30  |      | -100 | mA |
| Icc            | Supply Current                                       |                           | V <sub>CC</sub> = MAX,                             | See Note 3                                       |      | 80   | 120  | mA |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. ‡All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^\circ C$ . §Duration of the short circuit should not exceed one second. NOTE 3: I<sub>CC</sub> is measured with all inputs grounded and the output open.

| PARAMETERS¶      | FROM               | то     | TEST<br>CONDITIONS         | MIN | түр‡ | мах | UNIT |
|------------------|--------------------|--------|----------------------------|-----|------|-----|------|
| f <sub>max</sub> | CK A               |        | CL = 30 pF,                | 10  | 20   |     | MHz  |
| f <sub>max</sub> | СК В               |        | RL = 300 Ω,                | 10  | 20   |     | MHz  |
| f <sub>max</sub> | CK IN              |        | See Note 4                 | 10  | 20   |     | MHz  |
| tw               | CK OUT             |        | 566 NOIE 4                 | 7   | 14   |     | ns   |
| <sup>t</sup> PXZ | ŌĒ                 | DOi    | Cլ = 5 pF                  |     | 10   | 25  |      |
| <sup>t</sup> PZX | 02                 |        |                            |     | 10   | 25  | ns   |
| <sup>t</sup> PLH | CK IN              | DOi    |                            |     | 50   | 75  |      |
| <sup>t</sup> PHL |                    | 001    |                            |     | 50   | 75  | ns   |
| tРLН             | CK A<br>or<br>CK B | OR     |                            |     | 190  | 300 | ns   |
| tPLH .           | 014 111            | 0.5    | CL = 30 pF,<br>RL = 300 Ω, |     | 40   | 60  |      |
| <sup>t</sup> PHL | CK IN              | OR     |                            |     | 30   | 45  | ns   |
| <sup>t</sup> PHL | CLR                | OR     |                            |     | 35   | 60  | ns   |
| <sup>t</sup> PHL | CK A<br>or<br>CK B | ск оит |                            |     | 25   | 50  | ns   |
| <sup>t</sup> PHL | CK IN              | CK OUT | See Note 4                 |     | 270  | 400 | ns   |
| <sup>t</sup> PHL | CK A<br>or<br>CK B | IR     |                            |     | 55   | 75  | ns   |
| <sup>t</sup> PLH | CK IN              | IR     |                            |     | 255  | 400 | ns   |
| <sup>t</sup> PLH | CLR                | IR     |                            |     | 16   | 35  | ns   |
| <sup>t</sup> PLH | OR↑                |        |                            |     | 10   | 20  |      |
| <sup>t</sup> PHL | OR↓                | DOi    |                            |     | 10   | 20  | ns   |

## switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

¶ fmax ≡ maximum clock frequency.

 $t_W \equiv pulse width (output)$ 

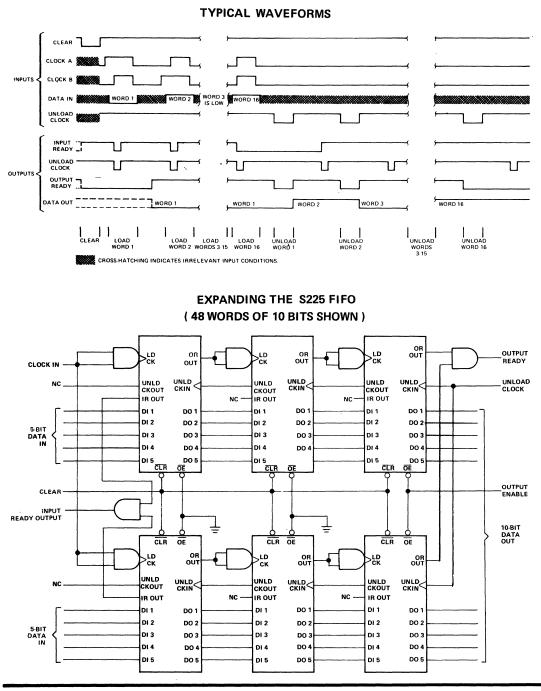
t↓ = The arrow indicates that the low-to-high (1) or high-to-low (↓) transition of the output ready (OR) output is used for reference.

 $t_{PLH} \equiv propagation delay time, low-to-high level output.$ 

tPHL ≡ propagation delay time, high-to-low-level output.

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTE 4: Load circuit and voltage waveforms are shown in Appendix A.



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TI cannot assume any responsibility for any circuits shown

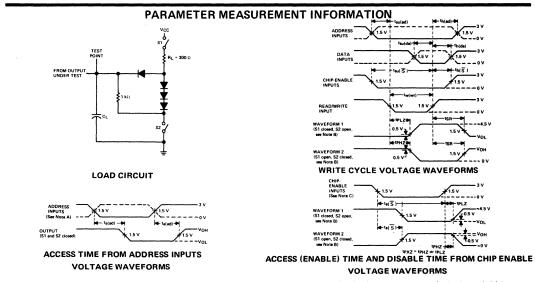
or represent that they are free from patent infringement. 43

TEXAS INSTRUMENTS RESERVES THE RIGHT TO MAKE CHANGES AT ANY TIME IN ORDER TO IMPROVE DESIGN AND TO SUPPLY THE BEST PRODUCT POSSIBLE.

377

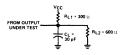
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### **APPENDIX A**

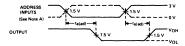


- NOTES: A. When measuring access times from address inputs, the enable/select input (s) is (are) low and the read/write input is high.
  - B. Waveform shown is for the output with internal conditions such that the output is low except when disabled.
     C. When measureing access and disable times from enable/select input (s), the address inputs are steady-state and the read/write input is high.
  - D. Input waveforms are supplied by pulse generators having the following characteristics and  $Z_{\text{Out}}\approx$  50  $\Omega.$

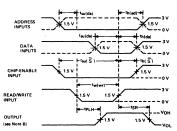
#### **TESTING RAM's WITH 3-STATE OUTPUTS**



LOAD CIRCUIT



#### ACCESS TIME FROM ADDRESS INPUTS VOLTAGE WAVEFORMS



WRITE CYCLE VOLTAGE WAVEFORMS



#### ACCESS (ENABLE) TIME AND DISABLE TIME FROM CHIP ENABLE VOLTAGE WAVEFORMS

NOTES: A. When measuring access times from address inputs, the enable/select input (s) is (are) low and the read/write input is high.

- B. Waveform shown is for the output with internal conditions such that the output is low except when disabled.
- C. When measureing access and disable times from enable/select input (s), the address inputs are steady-state and the read/write input is high.
- D. Input waveforms are supplied by pulse generators having the following characteristics

TESTING RAM'S WITH OPEN COLLECTOR OUTPUTS

PRINTED IN U.S.A.

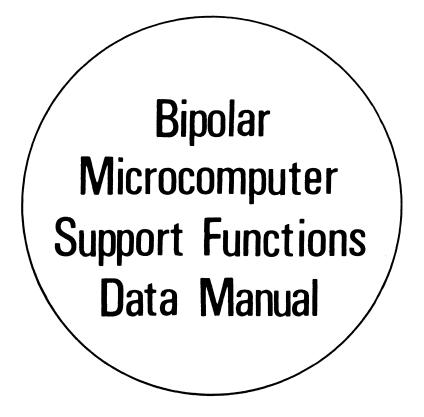
44 TI cannot assume any responsibility for any circuits shown or represent that they are free from patent infringement.

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The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group





DECEMBER 1976 REVISED DECEMBER 1977

TEXAS INSTRUMENTS

### INDEX TO BIPOLAR MICROCOMPUTER SUPPORT FUNCTIONS

| TYPE NUMBER      | (PACKAGES)           | FUNCTION                                     | SEE                                     |
|------------------|----------------------|--|---|
| –55° C to 125° C | to 125°C 0°C to 70°C |  | PAG                                     |
| SN54S226(J)      | SN74S226(J,N)        | 4-BIT PARALLEL LATCHED BUS TRANSCEIVERS      | 1                                       |
| SN54S240(J)      | SN74S240(J,N)        | OCTAL INVERTING BUS BUFFER DRIVERS/RECEIVERS | -                                       |
| SN54S241(J)      | SN74S241(J,N)        | OCTAL BUS BUFFER DRIVER/RECEIVERS            | 5                                       |
| SN54S299(J)      | SN74S299(J,N)        | OCTAL UNIVERSAL SHIFT/STORAGE REGISTERS      | 9                                       |
| SN54S330(J)      | SN74S330(J,N)        | 12-INPUT, 50-TERM, 6-OUTPUT FIELD-           | 10                                      |
| SN54S331(J)      | SN74S331(J,N)        | PROGRAMMABLE LOGIC ARRAYS (FPLA)             | 13                                      |
| SN54S373(J)      | SN74S373(J,N)        | OCTAL D-TYPE TRANSPARENT LATCHES             | 26                                      |
| SN54S374(J)      | SN74S374(J,N)        | OCTAL D-TYPE FLIP-FLOPS                      | ~ |
| SN54S412(J)      | SN74S412(J,N)        | OCTAL MULTIMODE BUFFERED LATCHES             | 30                                      |
|                  | SN74S428(N)          | CONTROLLERS AND BUS DRIVERS                  | 35                                      |
|                  | SN74S438(N)          | FOR 8080A SYSTEMS                            | 35                                      |
| SN54S482(J)      | SN74S482(J,N)        | 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS      | 41                                      |



BULLETIN NO. DL-S 7712477, OCTOBER 1976-REVISED AUGUST 1977

- Universal Transceivers for Implementing System Bus Controllers
- Dual-Rank 4-Bit Transparent Latches Provide
  - Exchange of Data Between 2 Buses In One Clock Pulse
  - Bus-to-Bus Isolation
  - Rapid Data Transfer
  - Full Storage Capability
- Hysteresis at Data Inputs Enhances Noise Rejection
- Separate Output Control Inputs Provide Independent Enable/Disable for Either Bus Output
- 3-State Outputs Drive Bus Lines Directly

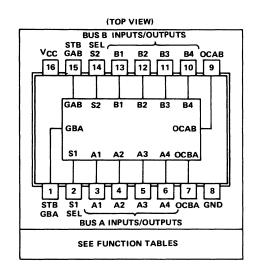
#### description

These high-performance Schottky TTL quadruple bus transceivers employ dual-rank bidirectional four-bit transparent latches and feature three-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The bus-management functions implemented and the high-impedance controls offered provide the designer with a controller/ transceiver that interfaces and drives system busorganized lines directly. They are particularly attractive for implementing:

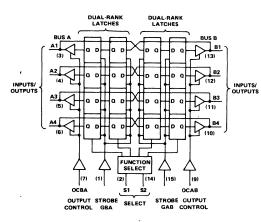
> Bidirectional bus transceivers Data-bus controllers

The bus-management functions, under control of the function-select (S1, S2) inputs, provide complete data integrity for each of the four modes described in the function table. Directional transparency provides for routing data from or to either bus, and the dual store and dual readout capabilities can be used to perform the exchange of data between the two bus lines in the equivalent of a single clock pulse. Storage of data is accomplished by selecting the latch function, setting up the data, and taking the appropriate strobe input low. As long as the strobe is held low, the data is latched for the selected function. Further control is offered through the availability of independent output controls that can be used to enable or

#### SN54S226 ... J PACKAGE SN74S226 ... J OR N PACKAGE



#### functional block diagram



REVISED AUGUST 1977

#### **BUS-MANAGEMENT FUNCTION TABLE**

| OPERATION   | S2 | S1 | LATCH FUNCTIONS            |
|-------------|----|----|----------------------------|
| DRIVE BUS A | L  | L  | Pass Bus B Data to Bus A   |
| DRIVE BUS B | н  | L  | Pass Bus A Data to Bus B   |
| EXCHANGE    | н  | н  | Store Bus A and Bus B Data |
| BUS A AND B | L  | н  | Readout Stored Data        |

### OUTPUT-CONTROL FUNCTION TABLE

| OCAB | ОСВА | OUTPUT FUNCTION              |
|------|------|------------------------------|
| L    | ×    | Disable Bus B Outputs (Hi-Z) |
| н    | ×    | Enable Bus B Outputs         |
| x    | L    | Disable Bus A Outputs (Hi-Z) |
| х    | н    | Enable Bus A Outputs         |

disable the outputs as shown in the output-control function table, regardless of the latch function in process. Store operations can be performed with the outputs disabled to a high impedance (Hi-Z). In the Hi-Z state the inputs/outputs neither load nor drive the bus lines significantly. The p-n-p inputs feature typically 400 millivolts of hysteresis to enhance noise rejection.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |                    |    | <br>7V             |
|--|--------------------|----|--------------------|
| Input voltage                                |                    |    | <br>5.5 V          |
| Off-state output voltage                     |                    |    |                    |
| Operating free-air temperature range:        | SN54S226 (see Note | 2) | <br>–55°C to 125°C |
|  | SN74S226           |    |                    |
| Storage temperature range                    |                    |    | <br>–65°C to 150°C |

NOTES: 1. Voltage values are with respect to network ground terminal.

2. An SN54S226 in the J package operating at temperatures above 113°C requires a heat-sink that provides a thermal resistance from case to free air, R<sub>#CA</sub>, of not more than 48°C/W.

REVISED AUGUST 1977

### recommended operating conditions

|   |               | s   | N54S22 | 26   | Ś           | N74S22 | 26    | UNIT |
|---|---------------|-----|--------|------|-------------|--------|-------|------|
|   |               | MIN | NOM    | MAX  | MIN         | NOM    | MAX   | UNIT |
| Supply voltage, V <sub>CC</sub>                 |               | 4.5 | 5      | 5.5  | 4.75        | 5      | 5.25  | V    |
| High-level output voltage, VOH                  |               |     |        | 5.5  |             |        | 5,5   | V    |
| High-level output current, IOH                  |               |     |        | -6.5 |             |        | -10.3 | mA   |
| Pata antun tima t                               | Data (A or B) | 01  |        |      | 01          |        |       |      |
| Data setup time, t <sub>su</sub>                | Select        | 01  |        |      | 01          |        |       | ns   |
| Pata hald time to                               | Data (A or B) | 30↓ |        |      | 30↓         |        |       |      |
| Data hold time, t <sub>h</sub>                  | Select        | 30↓ |        |      | <b>30</b> ↓ |        |       | ns   |
| Operating free-air temperature, TA (see Note 2) | -55           |     | 125    | 0    |             | 70     | °C    |      |

↓The arrow indicates that the high-to-low transition of the enable input is used for reference.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|       | PARAMETER                              |          | TEST                     | CONDITION               | st       | MIN | TYP‡ | MAX  | UNIT       |
|-------|--|----------|--------------------------|-------------------------|----------|-----|------|------|------------|
| VIH   | High-level input voltage               |          |                          |                         |          | 2   |      |      | V          |
| VIL   | Low-level input voltage                |          |                          |                         |          |     | 0.8  | V    |            |
| VIK   | Input clamp voltage                    |          | V <sub>CC</sub> = MIN,   | lj =18 mA               |          |     |      | -1.2 | V          |
| V     | High-level output voltage              | SN54S226 | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | SN54S226 | 2.4 | 3.3  |      |            |
| ∨он   |  | SN74S226 | V <sub>IL</sub> = 0.8 V, | IOH = MAX               | SN74S226 | 2.4 | 2.9  |      | ľ          |
| Vai   | Low-level output voltage               |          | V <sub>CC</sub> = MIN,   | V <sub>1H</sub> = 2 V,  |          |     |      | 0.5  | v          |
| VOL   |  |          | V <sub>IL</sub> = 0.8 V, | I <sub>OL</sub> = 20 mA | <b>N</b> |     |      | 0.5  |            |
| 1     | Off-state output current,              |          | V <sub>CC</sub> = MAX,   | VIH = 2 V,              |          |     |      | 100  | μA         |
| IOZH  | high-level voltage applied             |          | V <sub>O</sub> = 2.4 V   |                         |          |     |      | 100  | <b>"</b> " |
| 10.71 | Off-state output current,              |          | V <sub>CC</sub> = MAX,   | VIH = 2 V,              |          |     |      | -100 | μA         |
| OZL   | low-level voltage applied              |          | V <sub>O</sub> = 0.5 V   |                         |          |     |      | -100 | <u> </u>   |
| ų –   | Input current at maximum input voltage |          | V <sub>CC</sub> = MAX,   | V1 = 5.5 V              |          |     |      | 1    | mA         |
| Чн    | High-level input current               |          | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V  |          |     |      | 100  | μA         |
| ΊL    | Low-level input current                |          | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 0.5 V  |          |     |      | -380 | μA         |
| los   | Short-circuit output current §         |          | V <sub>CC</sub> = MAX    |                         |          | 50  |      | -180 | mA         |
| ICC   | Supply current                         |          | V <sub>CC</sub> = MAX,   | See Note 3              |          |     | 125  | 185  | mA         |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

NOTES: 2. An SN54S226 in the J package operating at temperatures above 113°C requires a heat-sink that provides a thermal resistance from case to free air,  $R_{\theta CA}$ , of not more than 48°C/W.

3. ICC is measured with all inputs (and outputs) grounded.

REVISED AUGUST 1977

### switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CO     | MIN         | түр | MAX | UNIT |    |
|------------------|-----------------|----------------|-------------|-------------|-----|-----|------|----|
| <sup>t</sup> PLH | A or B          | B or A         |             |             |     | 20  | 30   |    |
| <sup>t</sup> PHL | AUB             | BORA           |             |             |     | 15  | 30   | ns |
| <sup>t</sup> PLH | Select          | A              | 1           |             |     | 25  | 37   |    |
| <sup>t</sup> PHL | Select          | Any            | CL = 50 pF, | RL = 280 Ω, |     | 19  | 30   | ns |
| <sup>t</sup> PLH | Strobe GBA      | A or B         | 1           |             |     | 25  | 37   |    |
| <sup>t</sup> PHL | or GAB          | A or B         |             |             |     | 19  | 30   | ns |
| <sup>t</sup> PZH | Output Control  | A              | 1           |             |     | 12  | 20   |    |
| <sup>t</sup> PZL | OCBA or OCAB    | A or B         |             |             |     | 12  | 20   | ns |
| <sup>t</sup> PHZ | Output Control  |                | CL = 5 pF,  | RL = 280 Ω, | 1   | 10  | 15   |    |
| <sup>t</sup> PLZ | OCBA or OCAB    | A or B         |             |             |     | 10  | 15   | ns |

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

tpHL ≡ propagation delay time, low-to-high-level output

 $t_{ZH} \equiv$  output enable time to high level

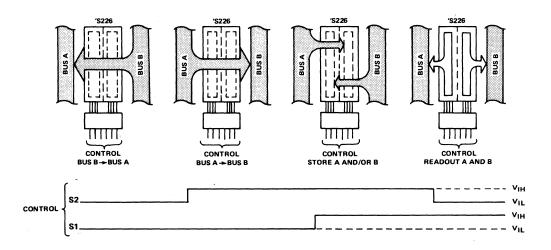
 $t_{ZL} \equiv output enable time to low level$ 

 $t_{HZ} \equiv$  output disable time from high level

 $t_{LZ} \equiv$  output disable time from low level

### applications

The following examples demonstrate four fundamental bus-management functions that can be performed with the 'S226. Exchange of data on the two bus lines can be accomplished with a single high-to-low transition at S2 when S1 is high.



### TYPES SN54S240. SN54S241, SN74S240, SN74S241 OCTAL BUFFERS/LINE DRIVERS/LINE RECEIVERS WITH 3-STATE OUTPUTS

BULLETIN NO. DL-S 7512346, DECEMBER 1975

SN54S240 . . . J PACKAGE

### features:

- High-Performance Schottky TTL Line Drivers and/or Receivers in a **High-Density 20-Pin Package**
- **3-State Outputs Drive Bus Lines Directly**
- P-N-P Inputs Reduce D-C Loading on **Bus Lines**
- Hysteresis at Inputs Improve Noise Margins
- 'S241 Can Be Interconnected With No External Components to Perform as **Bi-directional Bus Transceiver**

typical characteristics:

- Fan-Out: SN74S' SN54S' IOI (Sink Current) 64 mA 48 mA IOH (Source Current) -15 mA -12 mA
- **Typical Propagation Delay Times:** Data-to-Output: 'S240 (Inverting) . . . 4.5 ns 'S241 (Noninverting) . . . 6 ns
- Enable-to-Output . . . 9 ns

### description

These buffers/line drivers are designed specifically to improve both the performance and p-c board density of 3-state buffers/drivers employed as memory-address drivers. clock drivers, and bus-oriented transmitters/receivers. Featuring 400 millivolts of hysteresis at each low-current p-n-p data-line input, they provide improved noise rejection and high-fan-out outputs to restore Schottky TTL levels completely, or the SN74S' versions can be used to drive terminated lines down to 133  $\Omega$ .

Typically, the 'S240 can replace the equivalent of six SN54S04, SN74S04 inverters or four SN54S130, SN74S140 line drivers at their rated drive capabilities with the added benefits of input hysteresis and 3-state outputs. The 'S241 offers the same complexity and drive capability but is designed for use in non-inverting applications.

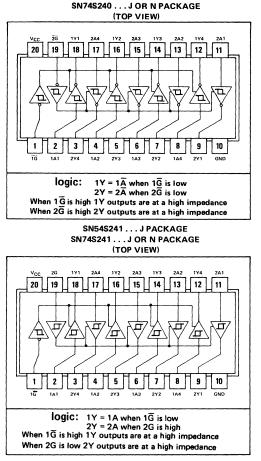
In bus-organized systems, the 'S241 can be connected with no external components to perform as a non-inverting input/output bus transceiver. With complementing enable inputs, the control function can be connected directly to both enable inputs while the two 4-line data paths can be connected (at adjacent pins) input-to-output on both sides to form the asynchronous transceiver/buffer.

Unused inputs must not be left open, or used inputs must not experience driving impedances of  $\geq$ 40 k $\Omega$ .

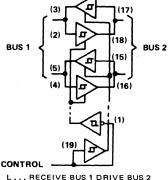
#### TENTATIVE DATA SHEET

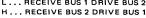
This document provides tentative information TEXAS INSTRUMENTS the right to change specifications for this POST OFFICE BOX 5012 . DALLAS, TEXAS 75222 product in any manner without notice.

977



S241 BUS TRANSCEIVER





<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U.S. Patent Number 3,463,975.

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## TYPES SN54S240, SN54S241, SN74S240, SN74S241 OCTAL BUFFERS/LINE DRIVERS/LINE RECEIVERS WITH 3-STATE OUTPUTS

### recommended operating conditions

| PARAMETER   | SN54S' |     |     |      |     |      |      |
|---|--------|-----|-----|------|-----|------|------|
| FARAMETER   | MIN    | NOM | MAX | MIN  | NOM | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub> (see Note 1)                | 4.5    | 5   | 5.5 | 4.75 | 5   | 5.25 | V    |
| High-level output current, IOH                              |        |     | -12 |      |     | 15   | mA   |
| Low-level output current, IOL                               |        |     | 48  |      |     | 64   | mA   |
| Operating free-air temperature, T <sub>A</sub> (see Note 2) | 55     |     | 125 | 0    |     | 70   | °C   |

NOTES: 1. These voltage values are with respect to network ground terminal.

2. An SN54S241J operating at free-air temperature above 116°C requires a heat sink that provides a thermal resistance from case to free-air, R<sub>ØCA</sub>, of not more than 40°C/W.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | DADAMETED   |                | 7507 0010   | uzioniat                 | L        | 'S240 |      |     | 'S241 |          |          |
|------|---|----------------|---|--------------------------|----------|-------|------|-----|-------|----------|----------|
|      | PARAMETER   |                | TEST COND   | DITIONS                  | MIN      | TYP‡  | MAX  | MIN | TYP‡  | MAX      | UNIT     |
| VIH  | High-level input voltage                                |                |   |                          | 2        |       |      | 2   |       |          | V        |
| VIL  | Low-level input voltage                                 |                |   |                          |          |       | 0.8  |     |       | 0.8      | V        |
| VIK  | Input clamp voltage                                     |                | V <sub>CC</sub> = MIN,                            | lj =18 mA                |          |       | 1.2  |     |       | -1.2     | V        |
|      | Hysteresis ( $V_{T+} - V_{T-}$ )                        |                | V <sub>CC</sub> = MIN                             |                          | 0.2      | 0.4   |      | 0.2 | 0.4   | •        | V        |
| ∨он  | High-level output voltage                               |                | V <sub>CC</sub> = MIN,<br>I <sub>OH</sub> ≈3 mA   | V <sub>IL</sub> = 0.8 V, | 2.4      | 3.4   |      | 2.4 | 3.4   |          | v        |
| VOH  | ingniever output vortage                                |                | V <sub>CC</sub> = MIN,<br>I <sub>OH</sub> = MAX   | V <sub>IL</sub> = 0.5 V, | 2        |       |      | 2   |       |          | v        |
| VOL  | Low-level output voltage                                |                | V <sub>CC</sub> = MIN,                            | IOL = MAX                | 1        |       | 0.55 |     |       | 0.55     | V        |
| lozн | Off-state output current,<br>high-level voltage applied |                | V <sub>CC</sub> = MAX,                            | V <sub>O</sub> = 2.4 V   |          |       | 50   |     |       | 50       |          |
| IOZL | Off-state output current,<br>low-level voltage applied  |                | V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V | V <sub>O</sub> = 0.5 V   |          |       | 50   |     |       | 50       | μΑ       |
| 4    | Input current at maximur<br>input voltage               | n              | V <sub>CC</sub> = MAX,                            | V <sub>I</sub> = 5.5 V   |          |       | 1    |     |       | 1        | mA       |
| Чн   | High-level input current, a                             | iny input      | V <sub>CC</sub> = MAX,                            | VIH = 2.7 V              |          |       | 50   |     |       | 50       | μA       |
| 41   | Low-level input current                                 | Any A<br>Any G | V <sub>CC</sub> = MAX,                            | V <sub>IL</sub> = 0.5 V  |          |       | 400  |     |       | 400<br>2 | μA<br>mA |
| los  | Short-circuit output curre                              |                | V <sub>CC</sub> = MAX                             |                          | -50      |       | -225 | -50 |       | -225     | mA       |
| -03  |   | Total.         |   | SN54S'                   | +        | 80    | 123  |     | 95    | 147      |          |
|      |   | outputs high   |   | SN74S'                   | <u> </u> | 80    | 135  |     | 95    | 160      |          |
|      | 0   | Total,         | VCC = MAX,  | SN54S'                   | 1        | 100   | 145  |     | 120   | 170      |          |
| 1cc  | Supply current  | outputs low    | Outputs open                                      | SN74S'                   |          | 100   | 150  |     | 120   | 180      | mA       |
|      |   | Outputs at     |   | SN54S'                   |          | 100   | 145  |     | 120   | 170      |          |
|      |   | Hi-Z           |   | SN74S'                   |          | 100   | 150  |     | 120   | 180      |          |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

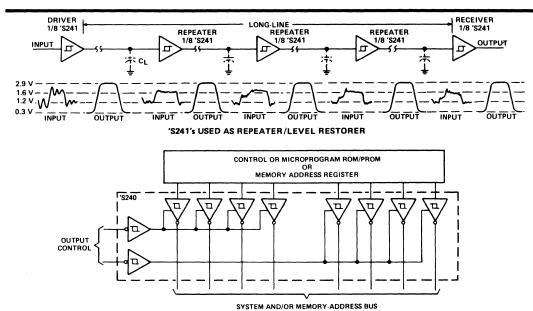
<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

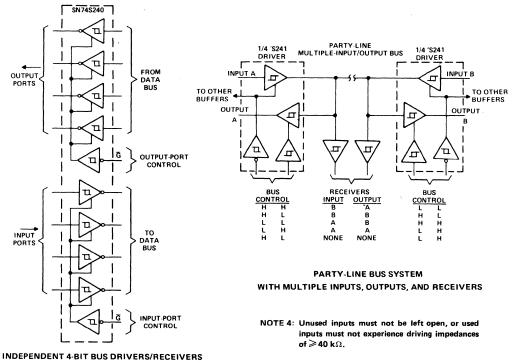
### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

|                 | PARAMETER   | TEST OC                   | TEST CONDITIONS        |  |     | <b>*</b> \$240 |     |     | <b>*</b> \$241 |      |  |
|-----------------|---|---------------------------|------------------------|--|-----|----------------|-----|-----|----------------|------|--|
|                 | FARAMETER   | TEST CC                   |                        |  |     | MAX            | MIN | TYP | MAX            | UNIT |  |
| ₽LH             | Propagation delay time,<br>low-to-high-level output |                           |                        |  | 4.5 | 7              |     | 6   | 9              | ns   |  |
| ΦHL             | Propagation delay time,<br>high-to-low-level output | CL = 50 pF,<br>See Note 3 | R <sub>L</sub> = 90 Ω, |  | 4.5 | 7              |     | 6   | 9              | ns   |  |
| <sup>t</sup> ZL | Output enable time to low level                     | -                         |                        |  | 10  | 15             |     | 10  | 15             | ns   |  |
| <sup>t</sup> ZH | Output enable time to high level                    | 7                         |                        |  | 6.5 | 10             |     | 8   | 12             | ns   |  |
| <sup>t</sup> LZ | Output disable time from low level                  | C <sub>L</sub> = 5 pF,    | RL = 90 Ω              |  | 10  | 15             |     | 10  | 15             | ns   |  |
| tHZ             | Output disable time from high level                 |                           | -                      |  | 6   | 9              |     | 6   | 9              | ns   |  |

## TYPES SN54S240, SN54S241, SN74S240, SN74S241 OCTAL BUFFERS/LINE DRIVERS/LINE RECEIVERS WITH 3-STATE OUTPUTS



'\$240 USED AS SYSTEM AND/OR MEMORY BUS DRIVER-4-BIT ORGANIZATION CAN BE APPLIED TO HANDLE BINARY OR BCD



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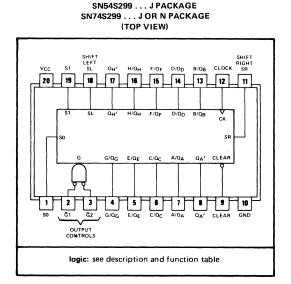
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## SCHOTTKY† TTL

## TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

DECEMBER 1976

- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operation: Hold (Store) Shift Left Shift Right Load Data
- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can be cascaded for N-Bit Word Lengths
- Applications: Stacked or Push-Down Registers, Buffer Storage, and Accumulator Registers



#### description

These Schottky TTL eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table.

Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. A direct overriding input is provided to clear the register whether the outputs are enabled or off.

|             |   |    |            | INPU' | rs   |      |                  |      | INPUTS/OUTPUTS  |                 |                  |                 |                 |                 |                 |                 |                 | OUTPUTS |  |
|-------------|---|----|------------|-------|------|------|------------------|------|-----------------|-----------------|------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|---------|--|
| MODE        | FUNCTION OUTPUT<br>CLEAR SELECT CONTROL CLOCK |    | SERIAL     |       | A/0∆ | B/QB | c/Q <sub>C</sub> | D/QD | E/QF            | F/QF            | G/Q <sub>G</sub> | H/QH            | ۵۵٬             | QH,             |                 |                 |                 |         |  |
|             |   | S1 | <b>S</b> 0 | Ğ1†   | Ğ2†  |      | SL               | SR   |                 | 5               | Ŭ                | 5               | -               |                 |                 |                 |                 | ••      |  |
| Class       | L   | x  | L          | L     | L    | х    | х                | х    | L               | L               | L                | L               | L               | L               | L               | L               | L               | L       |  |
| Clear       | L   | L  | н          | L     | L    | х    | х                | х    | L               | L               | L                | L               | L               | L               | L               | L               | L               | L       |  |
| Hold        | н   | L  | L          | L     | L    | х    | х                | х    | Q <sub>A0</sub> | QB0             | Q <sub>C0</sub>  | Q <sub>D0</sub> | QE0             | QFO             | Q <sub>G0</sub> | Q <sub>H0</sub> | Q <sub>A0</sub> | QH0     |  |
| HOID        | н   | x  | X          | L     | L    | L    | х                | х    | Q <sub>A0</sub> | Q <sub>B0</sub> | OC0              | Q <sub>D0</sub> | QE0             | QF0             | Q <sub>G0</sub> | QH0             | QA0             | QH0     |  |
| Shift Right | н   | L  | н          | L     | L    | 1    | х                | н    | н               | Q <sub>An</sub> | Q <sub>Bn</sub>  | QCn             | 0 <sub>Dn</sub> | QEn             | Q <sub>Fn</sub> | QGn             | н               | QGn     |  |
| Shirt Hight | н   | L  | н          | L     | L    | † ↑  | х                | L    | L               | QAN             | Q <sub>Bn</sub>  | QCn             | ۵ <sub>Dn</sub> | QEn             | Q <sub>Fn</sub> | Q <sub>Gn</sub> | L               | QGn     |  |
| Shift Left  | н   | н  | L          | L     | L    | †    | н                | х    | Q <sub>Bn</sub> | QCn             | Q <sub>Dn</sub>  | QEn             | Q <sub>Fn</sub> | QGn             | Q <sub>Hn</sub> | н               | QBn             | н       |  |
| Shirt Leit  | н   | н  | L          | L     | Ľ    | 1    | L                | х    | QBn             | QCn             | Q <sub>Dn</sub>  | QEn             | Q <sub>Fn</sub> | Q <sub>Gn</sub> | Q <sub>Hn</sub> | L               | 0 <sub>Bn</sub> | L       |  |
| Load        | н   | н  | н          | X     | Х    | 1    | X                | Х    | а               | b               | с                | d               | е               | f               | g               | h               | a               | h       |  |

operation or clearing of the register is not affected.

a... h = level of the steady-state input at inputs A through H, respectively. These data are loaded into the flipflops while the flip-flop outputs are isolated from the input/output terminals.

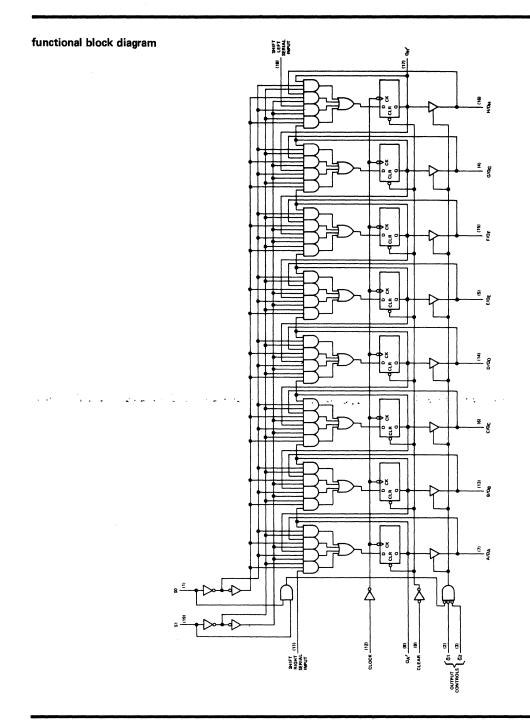
<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

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## TEXAS INSTRUMENTS

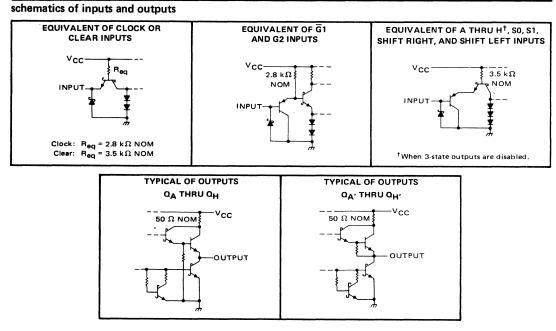
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## TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS



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### TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |          | <br> | 7V                              |
|--|----------|------|---------------------------------|
| Input Voltage                                |          | <br> | 5.5 V                           |
| Off-state output voltage                     |          | <br> | 5.5 V                           |
| Operating free-air temperature range:        |          |      |                                 |
| ·  | SN74S299 | <br> | $. 0^{\circ}C$ to $70^{\circ}C$ |
| Storage temperature                          |          | <br> | –65°C to 150°C                  |

NOTES 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

|   |                                      | S   | SN54S29 | 39   | S    | N74S29 | 99   |      |
|---|--------------------------------------|-----|---------|------|------|--------|------|------|
|   |                                      | MIN | NOM     | MAX  | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>             |                                      | 4.5 | 5       | 5,5  | 4.75 | 5      | 5.25 | V    |
| High-level output current, IOH              | Q <sub>A</sub> thru Q <sub>H</sub>   |     |         | -2   |      |        | -6.5 |      |
| riginever output current, IOH               | Q <sub>A</sub> , or Q <sub>H</sub> , |     |         | -0.5 |      |        | -0.5 | mA   |
| Low-level output current, IOL               | Q <sub>A</sub> thru Q <sub>H</sub>   |     |         | 20   |      |        | 20   |      |
| Low-level output current, IOL               | Q <sub>A</sub> , or Q <sub>H</sub> , |     |         | 6    |      |        | 6    | mA   |
| Clock frequency, fclock                     |                                      | 0   |         | 50   | 0    |        | 50   | MHz  |
| Width of clock pulse to the state           | Clock high                           | 10  |         |      | 10   |        |      |      |
| Width of clock pulse, t <sub>w(clock)</sub> | Clock low                            | 10  |         |      | 10   |        |      | ns   |
| Width of clear pulse, tw(clear)             | Clear low                            | 10  |         |      | 10   |        |      | ns   |
|   | Select                               | 15↑ |         |      | 15↑  |        |      |      |
| Catura time t                               | High-level data <sup>♦</sup>         | 7↑  |         |      | 7↑   |        |      |      |
| Setup time, t <sub>su</sub>                 | Low-level data <sup>♦</sup>          | 5↑  |         |      | 5↑   |        |      | ns   |
|   | Clear inactive-state                 | 10↑ |         |      | 10↑  |        |      |      |
|   | Select                               | 5↑  |         |      | 5↑   |        |      |      |
| Hold time, t <sub>h</sub>                   | Data <sup>♦</sup>                    | 5↑  |         |      | 5↑   |        |      | ns   |
| Operating free-air temperature, TA          |                                      | -55 |         | 125  | 0    |        | 70   | °c   |

 $\diamond$ Data includes the two serial inputs and the eight input/output data lines.

### TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

|      | PARAMETER                              |                                      | TEST CON                 | IDITIONS <sup>†</sup>  | MIN | ТҮР‡ | MAX  | UNIT |
|------|--|--------------------------------------|--------------------------|------------------------|-----|------|------|------|
| VIH  | High-level input voltage               |                                      |                          |                        | 2   |      |      | V    |
| VIL  | Low-level input voltage                |                                      | 1                        |                        |     |      | 0.8  | V    |
| VIK  | Input clamp voltage                    |                                      | V <sub>CC</sub> = MIN,   | lı =18 mA              | 1   |      | -1.2 | V    |
| ∨он  | High-level output voltage              | Q <sub>A</sub> thru Q <sub>H</sub>   | V <sub>CC</sub> = MIN,   | VIH = 2 V,             | 2.4 | 3.2  |      |      |
| ∙он  | inginever output vortage               | Q <sub>A</sub> , or Q <sub>H</sub> , | V <sub>IL</sub> = 0.8 V, | I <sub>OH</sub> = MAX  | 2.7 | 3.4  |      | V V  |
| VOL  | Low-level output voltage               |                                      | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, |     |      | 0.5  | v    |
|      |  |                                      | V <sub>IL</sub> = 0.8 V, | I <sub>OL</sub> = MAX  |     |      |      |      |
| lоzн | Off-state output current,              | Q <sub>A</sub> thru Q <sub>H</sub>   | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V, |     |      | 100  |      |
| '02H | high-level voltage applied             | QA IIIU QH                           | V <sub>O</sub> = 2.4 V   |                        | 1   |      | 100  | μA   |
| 1    | Off-state output current               | 0                                    | V <sub>CC</sub> = MAX,   | VIH = 2 V,             | 1   |      | 05.0 |      |
| IOZL | low-level voltage applied              | Q <sub>A</sub> thru Q <sub>H</sub>   | V <sub>O</sub> = 0.5 V   |                        |     |      | 250  | μA   |
| 1    | Input current at maximum input voltage |                                      | V <sub>CC</sub> = MAX,   | VI = 5.5 V             | 1   |      | 1    | mA   |
| 1    | High lovel input everent               | A thru H, S0, S1                     | N                        |                        | 1   |      | 100  |      |
| ЧН   | High-level input current               | Any other                            | $V_{CC} = MAX,$          | VI = 2.7 V             |     |      | 50   | μA   |
| 1    | Low-level input current                | Clock or clear                       | N. MANY                  | N - 05 M               | 1   |      | -2   | mA   |
| Կட   | Low-level input current                | Any other                            | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.5 V |     |      | -250 | μA   |
| 1    | Short-circuit output current §         | Q <sub>A</sub> thru A <sub>H</sub>   | N                        |                        | -40 |      | -100 |      |
| los  | Short-circuit output currents          | Q <sub>A</sub> , or Q <sub>H</sub>   | V <sub>CC</sub> = MAX    |                        | -20 |      | -100 | mA   |
| 1CC  | Supply current                         |                                      | V <sub>CC</sub> = MAX    |                        | 1   | 140  | 225  | mA   |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>AII typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>o</sup>C.

§Not more than one output should be shorted at a time and duration of the short-circuit test should not exceed one second.

| PARAMETER¶       | FROM<br>(INPUT)        | TO<br>(OUTPUT)                       | TEST CONDITIONS                        | MIN | түр | МАХ         | UNIT |
|------------------|------------------------|--------------------------------------|--|-----|-----|-------------|------|
| <sup>f</sup> max |                        |                                      | See Note 2                             | 50  | 70  |             | MHz  |
| <sup>t</sup> PLH | Clock                  | Q <sub>A'</sub> or Q <sub>H'</sub>   | $C_L = 15  pF$ , $R_L = 1  K\Omega$ ,  |     | 12  | 20          |      |
| <sup>t</sup> PHL |                        |                                      | See Note 2                             |     | 13  | 20          | ns   |
| <sup>t</sup> PHL | Clear                  | Q <sub>A</sub> , or Q <sub>H</sub> , | See Note 2                             |     | 14  | 21          | ns   |
| <sup>t</sup> PLH | Clock                  | O to three Out                       |  |     | 15  | 21          |      |
| tPHL             | CIOCK                  | Q <sub>A</sub> thru Q <sub>H</sub>   | 0 - 15 - 5 - 0 - 000 o                 |     | 15  | 21          | nis  |
| <sup>t</sup> PHL | Clear                  | Q <sub>A</sub> thru Q <sub>H</sub>   | CL = 45 pF, RL = 280 Ω,<br>See Note 2  |     | 16  | <b>.</b> 24 | ns   |
| <sup>t</sup> PZH | Ğ1, Ğ2                 | O . the O .                          |  |     | 10  | 18          |      |
| <sup>t</sup> PZL | 61, 62                 | Q <sub>A</sub> thru Q <sub>H</sub>   |  |     | 12  | 18          | ns   |
| <sup>t</sup> PHZ | <u></u> G1, <u>G</u> 2 | O thru Ou                            | $C_{L} = 5  pF,  R_{L} = 280  \Omega,$ |     | 7   | 12          |      |
| <sup>t</sup> PLZ | 01, 02                 | Q <sub>A</sub> thru Q <sub>H</sub>   | See Note 2                             |     | 7   | 12          | ns   |

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

 $f_{max} \equiv maximum$  clock frequency

 $t_{PLH} \equiv$  propagation delay time, low-to-high-level output

 $t_{PHL} \equiv propagation delay time, high-to-low-level output$ 

 $t_{PZH} \equiv output enable time to high level$ 

t  $PZL \equiv$  output enable time to low level

 $t_{PHZ} \equiv output disable time from high level$ 

 $t_{PLZ} \equiv$  output disable time from low level

NOTE 2: For testing fmax, all outputs are loaded simultaneously, each with CL and RL as specified for the propagation times.

### SCHOTTKY† TTL

- Field-Programmable Logic Array Organized 12-Inputs/50-Product Terms/6-Outputs
- Programmable Options Include:
  - Active High or Low Inputs/Outputs
  - Choice of Dedicated Enable Input or Automatic Enable by True Product Terms
- Number of Inputs, Outputs, and Product Terms are Expandable
- High Density 20-Pin Package
- Full Schottky Clamping for High-Performance:
  - 30 ns Typical Data Delay Time
  - 20 ns Typical Enable Time
- Reliable TI-W Fuse Links for Fast, Low-Voltage Programming

### • Choice of 3-State ('S330) or 2.5 kΩ Passive-Pull-up ('S331) Outputs

### description

These high-performance, Schottky-clamped 12-input, 6-output logic arrays can be field programmed to provide 50 product terms derived from the 12 inputs and sum the 50 products onto 6-output lines. They feature a programmable option which permits the FPLA outputs to be automatically enabled by a true product term or, to dedicate during programming, input  $(L/\overline{OE})$  to serve as an output enable  $(\overline{OE})$ . Either option makes the FPLA expandable with respect to product terms. Other options permit use of both dedicated or automatic enable or no disable.

For every product term, 12 input variables can be programmed as high or low. Logic flexibility is further enhanced by the feature that the six outputs can be programmed individually to be active high or low.

The 'S330 is implemented with bus-driving 3-state outputs and can be connected directly to similar outputs in a busorganized system. The 'S331 is implemented with a 2.5 k $\Omega$  passive pull-up resistor on each output meaning that:

- a. The output can be combined with other similar or open-collector outputs to perform the logical wire-AND or a simple enable/disable function.
- b. The 'S331 outputs are also rated at VOH = 3.7 minimum for direct interface with MOS input thresholds.

The TI-W fuse links, used in the 'S330/'S331, feature the same low-voltage programming characteristics and proven reliability which Texas Instruments PROM's have demonstrated over a number of years.

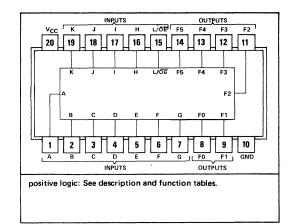


TENTATIVE DATA SHEET This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

TEXAS INSTRUMENTS

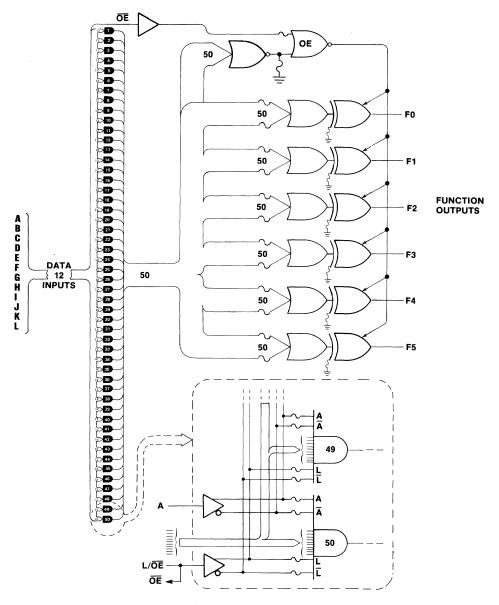
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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by 13 Texas Instruments, U. S. Patent Number 3,463,975.



SN74S330, SN74S331 . . J OR N PACKAGE

5



#### WHERE:

 $F_i = F_0$ ,  $F_1$ ,  $F_2$ ,  $F_3$ ,  $F_4$ , or  $F_5$ (ABC . . . . . L)<sub>i</sub> = 12 PROGRAMMABLE INPUTS (H = TRUE OR L = TRUE) FOR EACH OF 50 PRODUCT TERMS

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, $V_{CC}$ (see Note 1) . | • |   |            |   |   |  |   |   |   |   |   |   |   |   |   |    |     |            |      | . 7               | v  |
|---|---|---|------------|---|---|--|---|---|---|---|---|---|---|---|---|----|-----|------------|------|-------------------|----|
| Input voltage                           |   |   |            |   |   |  |   |   |   |   | - |   |   |   |   |    |     |            |      | 5.5               | V  |
| Off-state output voltage                |   |   |            |   |   |  |   |   |   |   |   |   |   |   |   |    |     |            |      | 5.5               | V  |
| Operating free-air temperature range    |   | - | <b>.</b> ' | - | - |  |   |   |   |   |   |   |   |   |   |    |     | <b>0</b> ° | C to | о 70 <sup>°</sup> | °C |
| Storage temperature range               | · | • | •          | • |   |  | • | • | • | • |   | • | • | • | • | •- | -65 | ΰ°C        | to   | 150°              | C  |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|                                    |                       | 5 | SN74S3 | 330, SN | 74S331 | UNIT |
|------------------------------------|-----------------------|---|--------|---------|--------|------|
|                                    |                       |   | MIN    | NOM     | MAX    |      |
| Supply voltage, V <sub>CC</sub>    |                       |   | 4.75   | 5       | 5.25   | V    |
|                                    | 'S330 (T-S)           |   |        |         | -6.5   |      |
| High-level output current, IOH     | 'S331 (2.5 kΩ Pullup) |   |        |         | -0.25  | mA   |
| Operating free-air temperature, TA |                       |   | 0      |         | 70     | °C   |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER                  |                | TEST CON   | DITIONS  | SN74S | 330, SN |       | UNIT       |
|------|----------------------------|----------------|--|--|-------|---------|-------|------------|
|      | TANAMETER                  |                | TESTCON  | DITIONS  | MIN   | TYPŦ    | MAX   |            |
| ∨ін  | High-level input voltage   |                |  |  | 2     |         |       | V          |
| VIL  | Low-level input voltage    |                |  |  |       |         | 0.8   | V          |
| VIK  | Input clamp voltage        |                | $V_{CC} = MIN,$                                    | lj =18 mA  |       |         | -1.2  | V          |
| ∨он  | High-level output voltage  | ʻS330          | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V    | IOH = MAX  | 2.4   | 3.1     |       | v          |
| *UH  |                            | ʻS331          | V <sub>IL</sub> ≈ 0.8 V                            | IOH = MAX  | 3.7   | 4.4     |       | Ň          |
| VOL  | Low-level output voltage   |                | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> ≈ 0.8 V, | V <sub>IH</sub> = 2V,<br>I <sub>OL</sub> = 12 mA |       |         | 0.5   | v          |
| 10ZH | Off-state output current,  | <b>'</b> \$330 | V <sub>CC</sub> = MAX                              | $V_0 = 2.4V$                                     |       |         | 50    |            |
| loff | high-level voltage applied | ʻS331          |  | Vo = Vcc   |       |         | 150   | μA         |
| IOZL | Off-state output current,  | 'S330          | V <sub>CC</sub> = MAX,                             |  |       |         | 50    | μA         |
|      | low-level voltage applied  | 0000           | VCC 111/2/2,                                       | *0 0.5 *   |       |         | -50   | # <b>^</b> |
| 4    | Input current at maximum   |                | V <sub>CC</sub> = MAX,                             | Vi = 5.5 V                                       | 1     |         | 1     | mA         |
|      | input voltage              |                | 00   | ·  |       |         |       |            |
| Чн   | High-level input current   |                | V <sub>CC</sub> = MAX,                             |  |       |         | 50    | μA         |
| ΠL   | Low-level input current    |                | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.5 V                           |       |         | -0.25 | mA         |
| 100  | Short-circuit output       | 'S330          | V <sub>CC</sub> = MAX                              |  | -30   |         | -100  | ~ ^        |
| los  | current§                   | 'S331          |  |  | -1.4  |         | -4.4  | mA         |
| 100  | Supply current             | 'S330          | V <sub>CC</sub> = MAX,                             | See Note 2                                       |       | 110     | 155   | mA         |
| lcc  |                            | <b>'</b> \$331 |  |  |       | 122     | 165   |            |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>§</sup>Not more than one output of the 'S330 should be shorted at a time.

a Not more than one output of the 5330 should be shorted at a time.

NOTE 2: I  $_{\mbox{CC}}$  is measured with all outputs open and all inputs grounded.

### switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

| PARAN            | NETER            | FROM       | то         | TEST CO              | NDITIONS                |     | 'S330 |     |     | ʻS331 |     | UNIT |
|------------------|------------------|------------|------------|----------------------|-------------------------|-----|-------|-----|-----|-------|-----|------|
| <b>'</b> \$330   | ʻS331            | FROM       | 10         | <b>'</b> \$330       | ʻS331                   | MIN | түр   | MAX | MIN | TYP   | MAX | UNIT |
| <sup>t</sup> PLH | <sup>t</sup> PLH | Any data   | Any output | $C_{1} = 30  pF_{2}$ | R <sub>L1</sub> = 300Ω, |     | 35    | 60  |     | 35    | 60  |      |
| <sup>t</sup> PHL | <b>tPHL</b>      | input      | Any output | See Figure 2,        | С <sub>L</sub> = 30 рF, |     | 35    | 60  |     | 35    | 60  | ns   |
| <sup>t</sup> ZL  | <sup>t</sup> PHL | ŌĒ         | Any output | Section 4, page 13   | See Figure 1,           |     | 20    | 35  |     | 20    | 35  | ns   |
| <sup>t</sup> ZH  |                  | 02         | Any output | Section 4, page 15   | Section 4, page 13      |     | 20    | 35  |     |       |     |      |
| tHZ              |                  | AE or OE   | Any output | CL = 5 pF,           | R <sub>L1</sub> = 300Ω, |     | 15    | 30  |     |       |     | ns   |
| <sup>t</sup> LZ  | <sup>t</sup> PLH | AE OF UE   | Any output | See Figure 2,        | CL = 30 pF,             |     | 15    | 30  |     | 15    | 30  |      |
| <sup>t</sup> ZL  | <b>tPHL</b>      | Any data   | Any output | Section 4, page 13   | See Figure 1,           |     | 40    | 70  |     |       |     | ns   |
| tZH              |                  | input (AE) | Any output | Section 4, page 15   | Section 4, page 13      |     | 40    | 70  |     | 40    | 70  |      |

### programming the FPLA

The 'S330 and 'S331 are fabricated to include reliable low-voltage programmable Ti-W fuse links which have identical fusing characteristics with those used for most of TI's PROM's; however, the AND-OR combinational logic performed by an FPLA requires that sequential programming be employed which establishes the AND term including the data/enable  $L/\overline{OE}$  input before the OR term. Programming the automatic enable feature active and the data/enable input  $(L/\overline{OE})$  can be accomplished before or after the AND and OR matrices are established. Programming the true low level of the outputs should be performed last.

### recommended conditions for programming

|  |   | м   | N NO  | M MAX              | UNIT |
|--|---|-----|-------|--------------------|------|
| Supply voltage, V <sub>CC</sub> (see Note 1) |   | 4.7 | '5    | 5 5.75             | V    |
| Program pulse voltage, V(pr) (see Not        | 9 1)  |     | 0 10  | .5 11†             | v    |
| Program pulse rise time                      |   |     | 10    | 00                 | ns   |
| Input voltage (see Note 1)                   | High level, VIH                             | 2   | .4    | 5                  | V    |
| Input voltage (see Note 1)                   | Low level, VIL                              |     | 0     | 0.5                | 1 °  |
| Voltage applied to output for OR prop        | gramming, V <sub>O(pr)</sub> (see Figure 4) |     | 0 0.2 | 25 0.3             | V    |
| Duration of programming pulse Y (see         | Figures 1, 3, 4, and Note 2)                |     | 98 10 | 00 10 <sup>3</sup> | μs   |
| Programming duty cycle                       |   |     | 2     | 25 35              | %    |
| Free-air temperature                         |   |     | 0     | 55                 | °C   |

<sup>†</sup>Absolute maximum ratings.

NOTES: 1. Voltage values are with respect to the GND terminal.

2. Programming is guaranteed if the pulse applied is 98 µs in duration.

#### TABLE I - ADDRESSES FOR PROGRAMMING ENABLES AND OUTPUT LEVELS

| ADD | DRESS | APPL | ED TO | OUT | PUTS | PRODUCT TERM    |                                |             |
|-----|-------|------|-------|-----|------|-----------------|--------------------------------|-------------|
| F5  | F4    | F3   | F2    | F1  | FO   | ADDRESSED       | PROGRAM                        | 15          |
| н   | н     | L    | L     | н   | L    | 50 <sub>2</sub> | Output F5 true low )           |             |
| н   | н     | L    | L     | н   | н    | 51 <sub>2</sub> | Output F <sub>4</sub> true low |             |
| н   | н     | L    | н     | L   | L    | 52 <sub>2</sub> | Output F <sub>3</sub> true low | PROGRAM     |
| н   | н     | L    | н     | L   | н    | 53 <sub>2</sub> | Output F <sub>2</sub> true low | LAST        |
| н   | н     | L    | н     | н   | L    | 54 <sub>2</sub> | Output F <sub>1</sub> true low |             |
| ) н | н     | L    | н     | н   | н    | 55 <sub>2</sub> | Output F <sub>0</sub> true low |             |
| н   | н     | н    | L     | L   | L    | 56 <sub>2</sub> | $L/\overline{OE} = L$ input    |             |
| н   | н     | н    | L     | L   | н    | 57 <sub>2</sub> | Automatic output ena           | able active |

#### TABLE II - OUTPUT ENABLE OPTIONS

| TERM FUSED                     | PROGRAMS   |
|--------------------------------|--|
| Neither 562 nor 572            | "L/OE" as "OE" (L Must be Programmed "don't care")   |
| 56 <sub>2</sub> (See Note 3)   | Outputs to be Continously Enabled (L/OE as L input)  |
| 57 <sub>2</sub>                | $L/\overline{OE}$ as $\overline{OE}$ and Automatic Enable (AE) Active (F <sub>i</sub> = $\overline{OE} \bullet AE$ ,<br>Where: AE = True Product Term Addressed) |
| $56_2$ and $57_2$ (See Note 3) | Automatic Enable (AE) Active (F <sub>i</sub> = AE)   |

NOTE 3: If the  $L/\overline{OE}$  input is not used as an enable input, programming the fuse at address 56<sub>2</sub> will cause the outputs to be continously enabled. This function can be used to simplify verification during programming even if address 57<sub>2</sub> is fused subsequently to activate the automatic enable.

#### programming the automatic enable (AE) to be active

The 'S330 and 'S331 are supplied with a fuse link disabling the automatic enable circuit. When a true product term is not present at the inputs this circuit is designed to automatically disable the six outputs [high-impedance (Z) for 'S330, high (H) for 'S331]. Fusing one link (See Table I) activates the automatic enabling circuit resulting in the six outputs being enabled for any true input term.

The fuse is programmed by addressing term 572 and fusing in accordance with the step-by-step procedure. See Table II above for options available.

### programming the L/OE input

The L/OE input must be programmed either to function as a dedicated enable or to function as the 12th data input.

If it is to become the 12th data input a single fuse, at term 562 (see Table 1), should be programmed in accordance with steps 1 through 5 below; then, input L is programmed logically into each AND/AND product term.

If input  $L/\overline{OE}$  is to function as an output enable, term 562 is not fused: however, both AND/AND fuse links at each of the 50 product term addresses must be fused as outlined in the step-by-step procedures for the AND matrix creating a "don't care" for input L. This causes the input to become an overriding output disable for the package. See Table II for other output enable options.

#### step-by-step programming procedure for enable options and output polarity

- 1. Apply steady-state supply voltage (V<sub>CC</sub> = 5 V) and disable the outputs by applying 10.5 volts to the 12 data inputs. See Figure 1.
- 2. For output polarity, verify that the fuse link needs to be programmed. If not, proceed to the next term.
- Only one fuse link is programmed at a time. Address the term to be programmed by applying VIH and VIL to the outputs in accordance with Table 1 and recommended conditions for programming.
- 4. Step VCC to 10.5 V nominal. Maximum supply current required during programming is 750 mA.
- 5. After the Y pulse time is reached, V<sub>CC</sub> should be stepped down to 5 V.
- The data inputs may be taken to logic levels (to permit output polarity verification) 1 μs or more after V<sub>CC</sub> reaches its steady-state value of 5 V.
- 7. At a Y pulse duty cycle of 35% or less, repeat steps 1 through 6 for each function to be programmed.

NOTE 4: VCC should be removed between program-pulses to reduce dissipation and chip temperatures. See Figure 1.

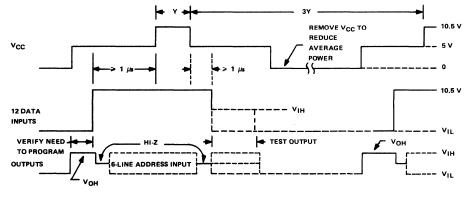


FIGURE 1 - OUTPUTS AND ENABLES PROGRAMMING SEQUENCE

### programming the true/false logic level of the outputs

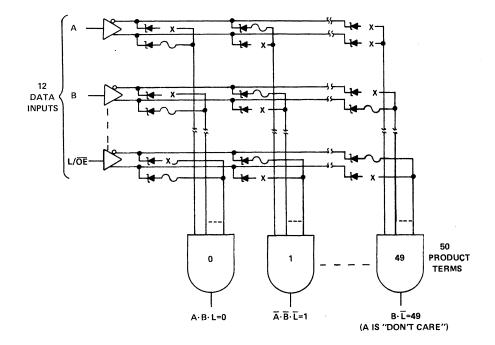
The FPLA is supplied with internal conditions established such that when a programmed AND or  $\overline{\text{AND}}$  input term is true the associated function output (F<sub>i</sub>) will be at a high logic level voltage, VOH.

After programming the enables, product terms, and OR matrix, the outputs can be programmed to provide a low logic level voltage (VOL) output. This is accomplished by using AND/ $\overline{\text{AND}}$  terms 50 through 55 shown in Table I and fusing the desired outputs using the step-by-step procedure.

Programming can be verified by applying V<sub>CC</sub> = 5 V and the input conditions which correspond to each term programmed to result in an active low-level output, measuring V<sub>OL</sub>  $\leq 0.5$  V at the programmed outputs.

### programming the AND/AND product terms

Each of the 50 product terms are capable of being programmed to decode a 12-wide term consisting of any combination of active (true) high, active (true) low, or don't care (H or L) input conditions at each of the 12 lines. This capability is implemented by providing AND/AND decode input gates each having a pair of associated fusible links which can be programmed to inactivate the unused decode level. Both decode levels can be removed resulting in a "don't care" input. The equivalent logic diagram showing the fusible links is shown in Figure 2.





A particular pattern is assumed to have been programmed into the AND/ $\overline{AND}$  fuse matrix with fused links opened at the locations marked with an "X". The resultant product terms are enumerated for the outputs of each product-term AND gate.

Product terms programmed into the AND/AND matrix will be used to select the term for programming the OR (summing) matrix. Redundant product terms will select two sum terms in the OR matrix, and overlapping product terms may select two or more sum terms. Reliable programming can be accomplished if redundant product terms are avoided and overlapping product terms are made unique within the FPLA for programming.

Redundant product terms are defined as being absolutely equal; i.e., ABCDEFG≡ABCDEFG. Use of apparently redundant terms is possible if the term does not use all inputs as the remaining inputs can be utilized to create FPLA unique terms for programming purposes by expansion:

Example:

ABCDEFGH#ABCDEFGH

After programming the entire OR matrix, the product terms can be readdressed and expanded inputs can be programmed "don't care".

Overlapping terms are defined as two or more product terms in which the lesser product term can be addressed as a result of the application of a larger product term.

Examples:

ABCDEFG - This large product term

AB DE G

The small terms can be made FPLA unique for programming by simply expanding to non-redundant inputs.

ABCDEFG - Large term

AB DEFG

After programming the entire OR matrix, the product terms can be shortened by readdressing the expanded terms and programming the added inputs to a "don't care". The AND/AND matrix is programmed one fuse at a time by addressing the term in accordance with Table III and fusing the input while applying the logic level desired to be active. See Figure 3.

| ADD | RESS | APPLI | ED TO | OUTP | UTS | PRODUCT   |
|-----|------|-------|-------|------|-----|-----------|
| F5  | F4   | F3    | F2    | F1   | Fo  | ADDRESSED |
| L   | L    | L     | L     | L    | L   | 0         |
| L   | L    | L     | L     | L    | н   | 1         |
| L   | L    | L     | L     | н    | L   | 2         |
| L   | L    | L     | L.    | н    | н   | 3         |
|     |      |       |       |      |     |           |
|     |      |       |       |      |     |           |
| н   | н    | L     | L     | L    | L   | 48        |
| н   | н    | Ł     | L     | L    | н   | 49        |

TABLE III - ADDRESSES FOR PROGRAMMING PRODUCT TERMS

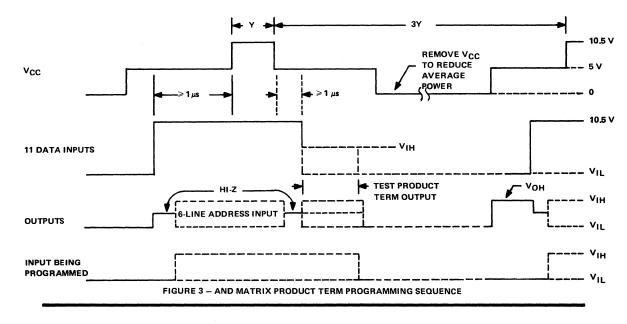
#### step-by-step programming procedure for AND matrix

Programming efficiency may be enhanced by programming the OR matrix upon completion of the 12-wide AND/AND term associated with it; or, the entire AND/AND term matrix can be programmed for all 50 product terms before programming the summing matrix.

- 1. Apply steady-state supply ( $V_{CC} = 5$  V) and disable the outputs by applying 10.5 volts to the 11 data inputs not being programmed. See Figure 3.
- 2. Only one fuse link is programmed at a time. Address the term to be programmed by applying VIH and VIL to the outputs in accordance with Table II.
- 3. Apply the logic level to be true at the input to be programmed.
- 4. Step V<sub>CC</sub> to 10.5 V nominal. Maximum supply current required during programming is 750 mA.
- 5. After the Y pulse time is reached, V<sub>CC</sub> should be stepped down to 5 V. See notes 6 and 7.
- 6. The data inputs may be taken to logic levels (to permit product term verification) 1  $\mu$ s or more after V<sub>CC</sub> reaches its steady-state value of 5 V.
- 7. At a Y pulse duty cycle of 35% or less, repeat steps 1 through 6 for each input to be programmed.

NOTES: 5. V<sub>CC</sub> should be removed between program pulses to reduce dissipation and chip temperatures. See Figure 3.

- 6. If the input just programmed is to be a "don't care" and is not being used to expand the product term repeat steps 3 and 4 with the opposite logic level applied to the input. Before changing the product term address, program all inputs (A through L/OE for this product term including all "don't cares".
- If input L/OE is to be used as a dedicated package enable it must be programmed as a "don't care" by fusing both links at each of the 50 product term locations.



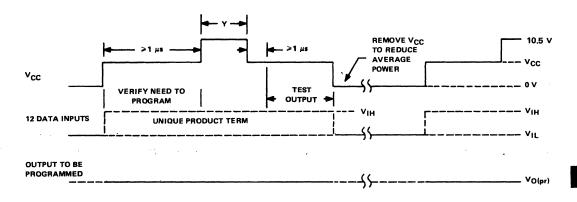
### step-by-step programming procedure for OR matrix

Programming the OR matrix consists of fusing (one at a time) those outputs ( $F_0$  through  $F_5$ ) which are desired to be false in the addressed product term. The procedure is:

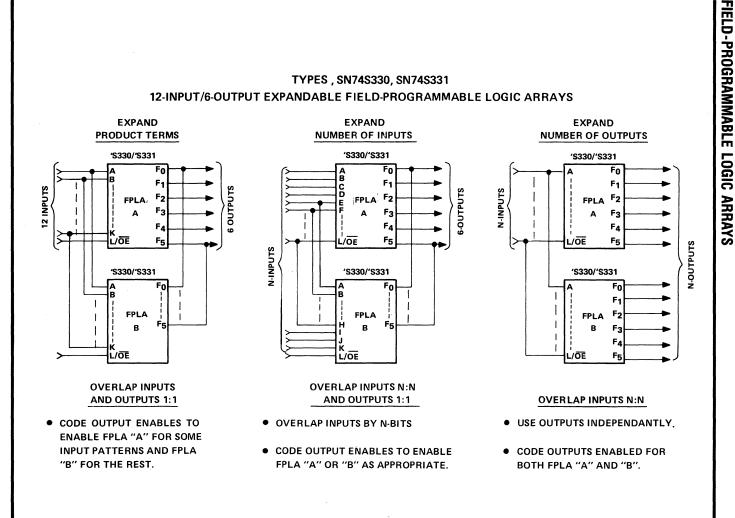
- 1. Apply steady-state supply voltage (V<sub>CC</sub> = 5 V) and apply the unique product term. See Figure 4.
- 2. Verify that the fuse link needs to be programmed. If not, proceed to the next fuse link.
- Only one fuse link is programmed at a time. Enable the output to be programmed by applying VO(pr) to the first output to be false in the product term.
- 4. Step V<sub>CC</sub> to 10.5 V nominal. Maximum supply current required during programming is 750 mA.
- 5. After the Y pulse time is reached, V<sub>CC</sub> should be stepped down to 5 V.
- 6. Verification can occur 1 µs or more after V<sub>CC</sub> reaches its steady-state value of 5 V.
- 7. At a Y pulse duty cycle of 35% or less repeat steps 1 through 6 for each output to be programmed false for the active product term. Repeat for all product terms. Then program active-low outputs.

NOTES: 8. V<sub>CC</sub> should be removed between program pulses to reduce dissipation and chip temperatures. See Figure 1.

 If product terms were expanded to make them unique for programming purposes the product terms can be addressed and the added inputs can be removed by programming them to a "don't care" (fuse the remaining links).



#### FIGURE 4 - OR TERM PROGRAMMING SEQUENCE



**EXPANDABLE 12-INPUT, 50-TERM** 

TYPES

SN74S330, SN74S331

FIGURE 5 - EXPANDING THE 'S330, 'S331 FPLA

TEXAS INSTRUMENTS

1277

### APPLICATIONS

The FPLA is efficiently suited for generating the sum of product terms which are normally required to implement:

- Memory mapping/supplemental functions
- Random logic or function generators
- Sequential controllers
- Status decoders or result interpreters
- Priority encoders

In addition, the FPLA introduces an alternative approach to the implementation of some code converters, pattern generators, and look-up tables which have commonly utilized PROMs and/or ROMs.

### MEMORY CONTROL/SUPPLEMENTAL FUNCTIONS

The FPLA is ideally suited for implementing a wide variety of functions with respect to the control and/or supplementing of system memory capabilities. Some are:

- Memory mapping
- Microprogram control
- Memory patch
- PROM extension

The wide input capability of the 'S330/'S331 FPLA makes it ideal for decoding either a current memory address or a variety of status lines and generate a unique system control function.

### MEMORY MAPPING/MICROPROGRAM CONTROL (See Figure 6)

These similar control functions utilize FPLAs which decode the assigned (mapped) addresses to accomplish system memory management; and/or, the FPLAs decode the current system address/status and implement the hardwired jump, branch-to-subroutine, or starting address in the microprogram control memory.

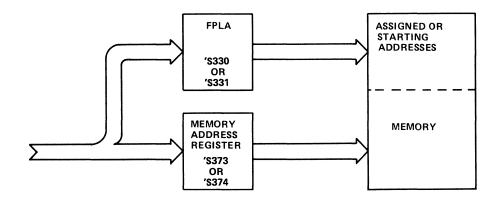


FIGURE 6 - MEMORY MAPPING/MICROPROGRAM CONTROL

## SCHOTTKY TTL

### TYPES SN74S330, SN74S3 EXPANDABLE 12-INPUT, 50-TER FIELD-PROGRAMMABLE LOGIC ARRA'

### **ORDERING INSTRUCTIONS (SHEET 1 OF 2)**

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| COMPANY   |            |                 |       |               |          |                  |               |                  |        | SPE      | CIAL        | DEVIC               | ΕN         | o:            |                            |                  |                   |                 |                 |
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| CUSTOMER  |            |                 |       |               |          |                  |               |                  |        | LO       | CATIO       | N:                  |            |               |                            |                  |                   |                 |                 |
| CUSTOMER  |            |                 |       |               |          |                  |               |                  |        |          |             | VT.                 |            |               |                            |                  |                   |                 |                 |
| CUSTOMEI<br>SYMBOLIZ  |            |                 |       |               |          |                  |               |                  |        |          |             | хт:                 |            |               |                            |                  |                   |                 |                 |
|   |            | ISABL           |       |               | C        | AUT              | ΟΜΑΤΙ         |                  | BLE (  | 4/E)     |             |                     | CE         |               |                            | SN74S<br>SN74S   |                   |                 |                 |
|   | (0         | heck o          | ne)   |               | Ľ        |                  |               | D L/OE           | E (OE) |          |             |                     |            |               |                            |                  |                   |                 |                 |
|   |            |                 |       |               |          | Pin (Pin )       |               |                  |        |          |             |                     | PL/<br>DIF | ASTIC         |                            | SN74S<br>SN74S   |                   |                 |                 |
|   |            |                 |       |               | L.       |                  | c<br>outs ena | abled)           |        |          |             |                     | 0          |               |                            | 011740           | 00111             |                 |                 |
|   |            |                 |       |               | C        |                  | 4E • 0        | -                |        |          |             |                     | οι         |               |                            | VE LE<br>oreach  |                   |                 |                 |
|   |            |                 |       |               |          |                  |               |                  |        |          | OL          | JTPUT               |            | F0            | F1                         | F2               | F3                | F4              | F5              |
|   |            |                 |       |               |          |                  |               |                  |        |          |             | <b>≥2.4</b> V       |            |               |                            |                  |                   |                 |                 |
| PRODU   | СТ ТЕ      | RM IN           | IPUT. | FILL          |          | TER              |               | BERS             | FOR    |          | L           | <b>≼0.5</b> V       |            |               |                            |                  |                   |                 |                 |
| ALL IN  |            |                 |       |               |          |                  |               |                  |        |          |             |                     | su         | MMIN          | IG DA                      | TA: Fil          | l in usi          | ng:             |                 |
|   |            |                 |       |               |          |                  |               |                  |        |          |             |                     |            |               |                            |                  |                   | -               |                 |
| H = Ac<br>product   |            |                 | = Act | ive lov       | v, X =   | Irrele           | vant. L       | eave u           | nused  |          |             |                     |            |               |                            | output           |                   |                 |                 |
| H = Ac  |            |                 | = Act | ive lov       | v, X =   | Irrele           | vant. L       | .eave u          | nused  |          |             |                     |            |               |                            | output<br>active |                   |                 |                 |
| H = Ac  |            | blank.          |       |               |          |                  | JT V          |                  |        | EVE      | LS          |                     |            |               | B = In                     |                  | or not            | summø           |                 |
| H = Ac<br>product<br>PROD.  | terms<br>A | PRC<br>B        | DDU(  |               | ERM      | INPL             | JT VC<br>G    | DLTA             | AGE I  | J        | к           | prov                | duct       | t term.<br>F0 | B = In<br>SUN<br>F1        | IMIN<br>F2       | G DA              | TA<br>F4        | d.<br>F5        |
| H = Ac<br>product   | terms      | blank.<br>PR(   | DDU   | ст ті         | ERM      | INPL             | υτ να         | DLTA             | GE I   |          | <del></del> | pro                 | duct       | t term.       | B = In<br>SUN              | active           | or not            | summe<br>ATA    | d.              |
| H = Ac<br>product<br>PROD.<br>TERM  | terms<br>A | PR(<br>B<br>PIN | DDU(  |               | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ad<br>product<br>PROD.<br>TERM<br>NO.   | terms<br>A | PR(<br>B<br>PIN | DDU(  |               | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0  | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1   | terms<br>A | PR(<br>B<br>PIN | DDU(  |               | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4  | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3   | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6  | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5   | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8                              | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8<br>9                         | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8<br>9<br>9<br>10              | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8<br>9<br>10<br>11             | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8<br>9<br>10<br>11<br>11<br>12 | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |
| H = Ac<br>product<br>PROD.<br>TERM<br>NO.<br>0<br>1<br>2<br>3<br>4<br>5<br>6<br>7<br>8<br>9<br>10<br>11             | terms<br>A | PR(<br>B<br>PIN | DDU(  | D<br>PIN<br>4 | ERM<br>E | INPL<br>F<br>PIN | JT VC<br>G    | DLTA<br>H<br>PIN | GE L   | J<br>PIN | K<br>PIN    | prov<br>L/OE<br>PIN | duct       | F0<br>FIN     | B = In<br>SUN<br>F1<br>PIN | MIN<br>F2<br>PIN | G DA<br>F3<br>PIN | TA<br>F4<br>PIN | d.<br>F5<br>PIN |

| TERM         PI           15         16           17         18           19         20           21         22 | A B<br>IN PIN<br>1 2 | C<br>PIN<br>3 | D<br>PIN<br>4 | E<br>PIN<br>5 | F<br>PIN<br>6 | G<br>PIN<br>7 | H<br>PIN<br>16 | I<br>PIN<br>17 | J<br>PIN<br>18 | K<br>PIN<br>19 | L/OE<br>PIN<br>15 | F        | FO<br>PIN<br>8 | F1<br>PIN<br>9 | F2<br>PIN<br>11 | F3<br>PIN<br>12 | F4<br>PIN<br>13 | FI<br>PI<br>14 |
|---|----------------------|---------------|---------------|---------------|---------------|---------------|----------------|----------------|----------------|----------------|-------------------|----------|----------------|----------------|-----------------|-----------------|-----------------|----------------|
| 15       16       17       18       19       20       21       22   |                      | 3             | 4             | 5             | 6             | 7             | 16             | 17             | 18             | 19             | 15                |          | 8              | 9              | 11              | 12              | 13              | 1.4            |
| 16       17       18       19       20       21       22  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | <u>+ "</u>     |
| 17       18       19       20       21       22   |                      |               |               |               |               |               |                |                |                |                |                   | -        |                |                |                 | ļ               | ļ               | <u> </u>       |
| 18       19       20       21       22  |                      |               |               |               |               |               |                |                |                |                |                   | -        |                |                |                 |                 |                 | -              |
| 19       20       21       22   |                      |               |               |               |               |               |                |                |                |                |                   | F        |                |                |                 |                 |                 | ļ              |
| 20<br>21<br>22  |                      |               |               | · .           |               |               |                |                |                |                |                   |          |                |                |                 |                 | ļ               | -              |
| 21<br>22  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 22  |                      |               |               |               |               |               |                |                |                |                |                   | L        |                |                |                 |                 |                 |                |
|   | Ì                    |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 22  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 23  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 24  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 25  |                      |               | 1             |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 26  |                      |               |               |               |               |               |                |                |                |                |                   | T        |                |                |                 |                 |                 |                |
| 27  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 28  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 29  |                      |               |               |               |               |               |                |                |                |                |                   | F        |                |                |                 |                 |                 |                |
| 30  |                      |               |               |               |               |               |                |                |                |                |                   | -        |                |                |                 |                 |                 | $\vdash$       |
| 31  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 32  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 33  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 34  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 35  |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 36  |                      | 1             |               |               |               |               |                |                |                |                |                   | +        |                |                |                 |                 |                 | -              |
| 37  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | <u> </u>       |
| 38  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | ┢─             |
| 39  |                      | 1             |               |               |               |               |                |                |                |                |                   | $\vdash$ |                |                |                 |                 |                 | $\vdash$       |
| 40  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 41  |                      | +             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |
| 42  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | $\vdash$       |
| 43  |                      | +             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | -              |
| 44  |                      | +             |               |               |               |               |                |                |                |                |                   | +        |                |                |                 |                 |                 | $\vdash$       |
| 45  |                      | +             |               |               |               |               |                |                |                |                |                   | -        |                |                |                 |                 |                 | -              |
| 46  |                      | +             |               |               |               |               |                |                |                |                |                   |          | -              |                |                 |                 |                 |                |
| 40  |                      | +             |               |               |               |               |                |                |                |                |                   | -        |                |                |                 |                 |                 | ┝              |
|   |                      |               |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 | ┝              |
| 48<br>49  |                      | 1             |               |               |               |               |                |                |                |                |                   |          |                |                |                 |                 |                 |                |

### ORDERING INSTRUCTIONS (SHEET 2 OF 2)

## SCHOTTKY † TTL MSI

### TYPES SN54S373, SN54S374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

BULLETIN NO. DL-S 7512350, OCTOBER 1975

- Choice of 8 Latches or 8 D-Type Flip-Flops In a Single Package
- 3-State Bus-Driving Outputs
- Full Parallel-Access for Loading and Reloading
- Buffered Control Inputs
- Clock/Enable Input has Hysteresis to Improve Noise Rejection
- P-N-P Inputs Reduce D-C Loading on Data Lines
- Operates with outputs Enabled or at High Z

SN74S373

|   | ENABLE<br>G | D | ουτρυτ         |
|---|-------------|---|----------------|
| L | н           | н | н              |
| L | н           | L | L              |
| L | L           | х | 0 <sub>0</sub> |
| н | x           | х | Hi-Z           |

#### SN74S374

| OUTPUT<br>CONTROL | CLOCK | D | ουτρυτ |
|-------------------|-------|---|--------|
| L ·               | ↑ (   | н | н      |
| L                 | 1     | L | L      |
| L                 | L     | х | Q0     |
| н                 | х     | х | Hi-Z   |

 $\mathbf{Q}_{0} \equiv$  the level of Q before the indicated stead-state input conditions were established.

H ≡ high level

L ≡ low level

- $Hi-Z \equiv high impedance$
- X ≡ irrelevant
- $\uparrow$  = transition from low to high level

### description

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These 8-bit registers feature totem-pole 3-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The high-impedance third state and increased high-logic-level drive provide these registers with the capability of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pull-up components. They are particularly attractive for implementing:

Buffer Registers

I/O Ports

**Bidirectional Bus Drivers** 

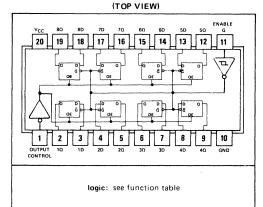
Working Registers.

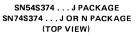
The SN54S373 and SN74S373 are transparent D-type latches meaning that while the enable (G) is high the Q output will follow the data (D) input. When the enable is taken low the output will be latched at the data that was setup.

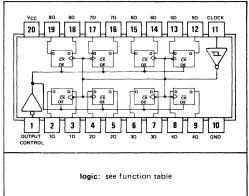
#### TENTATIVE DATA SHEET

#### <sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments, U. S. Patent Number 3,463,975.

SN54S373 . . . J PACKAGE SN74S373 . . . J OR N PACKAGE







### description (continued)

The SN54S374 and SN74S374 are edge-triggered D-type flip-flops. On the positive transition of the clock the Q output will be set to the logic state that was setup at the D input.

Schmitt-trigger buffered inputs at the enable ('S373) and clock ('S374) lines simplifies system design as a-c and d-c noise rejection is improved by typically 400 mV due to the input hysteresis. A buffered output control input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state (Hi-Z). In the Hi-Z state the outputs neither load nor drive the bus line significantly.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1)             |  |  |  |    |  |  | 7V                                 |
|--|--|--|--|----|--|--|------------------------------------|
| Input voltage  |  |  |  |    |  |  |                                    |
| Off-state output voltage                                 |  |  |  |    |  |  |                                    |
| Operating free-air temperature range: SN54S373, SN54S374 |  |  |  | ۰. |  |  | $-55^{\circ}$ C to $125^{\circ}$ C |
| SN74S373, SN74S374                                       |  |  |  |    |  |  | . 0°C to 70°C                      |
| Storage temperature range                                |  |  |  |    |  |  | $-65^{\circ}$ C to $150^{\circ}$ C |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|  |                | SN54 | S373, SN5 | 54S374 | SN74 | S373, SN7             | 4S374 |    |
|--|----------------|------|-----------|--------|------|-----------------------|-------|----|
|  |                | MIN  | NOM       | MAX    | MIN  | NOM                   | MAX   |    |
| Supply voltage, V <sub>CC</sub>            |                | 4.5  | 5         | 5.5    | 4.75 | 5                     | 5.25  | V  |
| High-level output voltage, V <sub>OH</sub> |                |      |           | 5.5    |      |                       | 5.5   | V  |
| High-level output current, IOH             |                |      |           | 2      |      |                       | 6.5   | mA |
| Width of clock/enable pulse, tw            | High           | 6    |           |        | 6    |                       |       |    |
| whath of clock/enable pulse, tw            | Low            | 7.3  |           |        | 7.3  |                       |       | ns |
| Data setup time, t <sub>su</sub>           | <b>'</b> \$373 | 01   |           |        | 01   | Vand Bolde of the off |       |    |
| Data setup time, t <sub>su</sub>           | <b>'</b> \$374 | 5†   |           |        | 5↑   |                       |       | ns |
| Data hold time, th                         | <b>'S</b> 373  | 10↓  |           |        | 10↓  |                       |       |    |
| 'S374                                      |                | 2↑   |           |        | 2↑   |                       |       | ns |
| Operating free-air temperature, TA         |                | -55  |           | 125    | 0    |                       | 70    | °C |

↑↓ The arrow indicates the transition of the clock/enable input used for reference: ↑ for the low-to-high transition, ↓ for the high-to-low transition.

### TYPES SN54S373, SN54S374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER   |              | TEST C   | ONDITIONS <sup>†</sup> | MIN | TYPŦ | MAX  | UNIT |
|------|---|--------------|--|------------------------|-----|------|------|------|
| ViH  | High-level input voltage                                |              |  |                        | 2   |      |      | V    |
| VIL  | Low-level input voltage                                 |              |  |                        |     |      | 0.8  | V    |
| VIК  | Input clamp voltage                                     |              | $V_{CC} = MIN,$                                    | l <sub>l</sub> =18 mA  |     |      | -1.2 | V    |
| .,   | 11 <sup>2</sup> k 1 1                                   | SN54S'       | V <sub>CC</sub> = MIN,                             | V <sub>IH</sub> = 2 V, | 2.4 | 3.4  |      |      |
| ∨он  | High-level output voltage                               | SN74S'       | V <sub>IL</sub> = 0.8 V,                           | IOH = MAX              | 2.4 | 3.1  |      | - v  |
| VOL  | Low-level output voltage                                |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |                        |     |      | 0.5  | v    |
| lozh | Off-state output current,<br>high-level voltage applied |              | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 2.4 V   | V <sub>IH</sub> = 2 V, |     |      | 50   | μA   |
| IOZL | Off-state output current,<br>low-level voltage applied  |              | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.5 V   | V <sub>IH</sub> = 2 V, |     |      | 50   | μA   |
| 4    | Input current at maximum i                              | nput voltage | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V |     |      | 1    | mA   |
| Чн   | High-level input current                                |              | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 2.7 V |     |      | 50   | μA   |
| μL   | Low-level input current                                 |              | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.5 V |     |      | -250 | μA   |
| los  | Short-circuit output current                            | ş            | V <sub>CC</sub> = MAX                              |                        | 40  |      | -100 | mA   |
|      | C   |              |  | <b>'</b> \$373         |     | 105  | 160  |      |
| 'cc  | Supply current  |              | V <sub>CC</sub> = MAX                              | <b>'</b> \$374         |     | 90   | 140  | - mA |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

<sup>†</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C.

Not more than one output should be shorted at a time and duration of the short-circuit test should not exceed one second,

| PARAMETER        | FROM     | то       | TERT COMPLETIONS                          | S373   |       |     |     |     |     | UNIT |
|------------------|----------|----------|---|--|-------|-----|-----|-----|-----|------|
| FARAMETER        | (INPUT)  | (OUTPUT) | TEST CONDITIONS                           | MIN  | түр   | MAX | MIN | ТҮР | MAX | UNIT |
| f <sub>max</sub> |          |          |   |  |       |     | 75  | 100 |     | MHz  |
| <sup>t</sup> PLH | Data     | Any Q    |   |  | 5     | 9   |     |     |     |      |
| <sup>t</sup> PHL | Data     | Any U    | C = 15  pc $D = 280.0$                    |  | 9     | 13  |     |     |     | ns   |
| <sup>t</sup> ₽LH | Clock or | A === 0  |   | $C_{L} = 15 \text{ pF}, R_{L} = 280 \Omega,$<br>See Note 10 18 | 18    |     | 8   | 15  |     |      |
| <sup>t</sup> PHL | enable   | Any Q    | See Note                                  |  | 12 18 | 18  |     | 11  | 17  | ns   |
| <sup>t</sup> ZH  | Output   | A        |   |  | 8     | 15  |     | 8   | 15  |      |
| <sup>t</sup> ZL  | Control  | Any Q    |   |  | 11    | 18  |     | 11  | 18  | ns   |
| tHZ              | Output   | 1        | $C_{L} = 5  pF$ , $R_{L} = 280  \Omega$ , |  | 6     | 9   |     | 5   | 9   |      |
| tLZ              | Control  | Any Q    | See Note                                  |  | 8     | 12  |     | 7   | 12  | ns   |

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

NOTE: f<sub>max</sub> is tested with all outputs loaded. See load circuits and waveforms on page 3-10 of The TTL Data Book for Design Engineers, second edition, LCC4112.

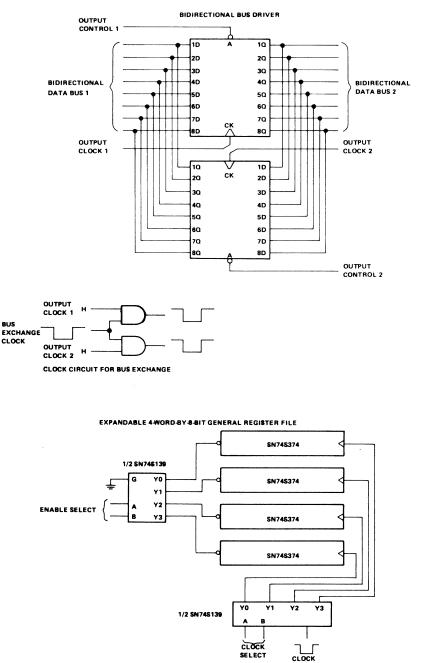
 $t_{\text{PL}} \equiv \text{propagation delay time, high-to-low level}$  $t_{\text{PL}} \equiv \text{propagation delay time, high-to-low level}$  $t_{\text{ZH}} \equiv \text{output enable time to high level}$ 

 $t_{ZL} \equiv$  output enable time to low level

 $t_{HZ} \equiv$  output disable time from high level  $t_{LZ} \equiv$  output disable time from low level

### TYPES SN54S373, SN54S374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

APPLICATIONS



TEXAS INSTRUMENTS

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BULLETIN NO. DL-S 7512351, OCTOBER 1975

- P-N-P Inputs and 3-State Outputs Maximize I/O and Data Bus Capabilities
- Data Latch Transparency Permits Asynchronous or Latched Receiver Modes
- Mode and Select Inputs Permit Storing
   With Outputs Enabled or Disabled
- Strobe-Controlled Flag Flip-Flop Indicates Status or Interrupt
- Asynchronous Clear Sets All Eight Data Lines Low and Initializes Status Flag
- High-Level Output Voltage, Typically 4 V, Drives Most MOS Functions Directly
- Direct Replacement for Intel 3212 or 8212

### description

This high-performance eight-bit parallel expandable buffer register incorporates package and mode selection inputs and an edge-triggered status flip-flop designed specifically for implementing bus-organized input/output ports. The three-state data outputs can be connected to a common data bus and controlled from the appropriate select inputs to receive or transmit data. An integral status flip-flop provides package busy or request interrupt commands. The outputs, with a 4-volt typical high-level voltage, are compatible for driving low-threshold MOS directly.

#### DATA LATCHES

The eight data latches are fully transparent when the internal gate enable, G, input is high and the outputs are enabled (OE = H). Latch transparency is selected by the mode control (M), select ( $\overline{S}1$  and S2), and the strobe (STB) inputs and during transparency each data output (DO<sub>i</sub>) follows its respective data input (DI<sub>i</sub>). This mode of operation can be terminated by clearing, de-selecting, or holding the data latches. See data latches function table.

#### MODE SELECTION

An input mode or an output mode is selectable from this single input line. In the input mode, MD = L, the eight data latch inputs are enabled when the strobe is high regardless of device selection. If selected during an input mode, the outputs will follow the data inputs. When the strobe input is taken low, the latches will store the most-recently setup data.

In the output mode, M = H, the output buffers are enabled regardless of any other control input. During the output mode the content of the register is under control of the select (S1 and S2) inputs. See data latches function table.

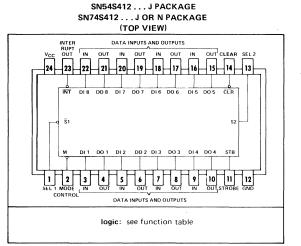
#### STATUS FLIP-FLOP

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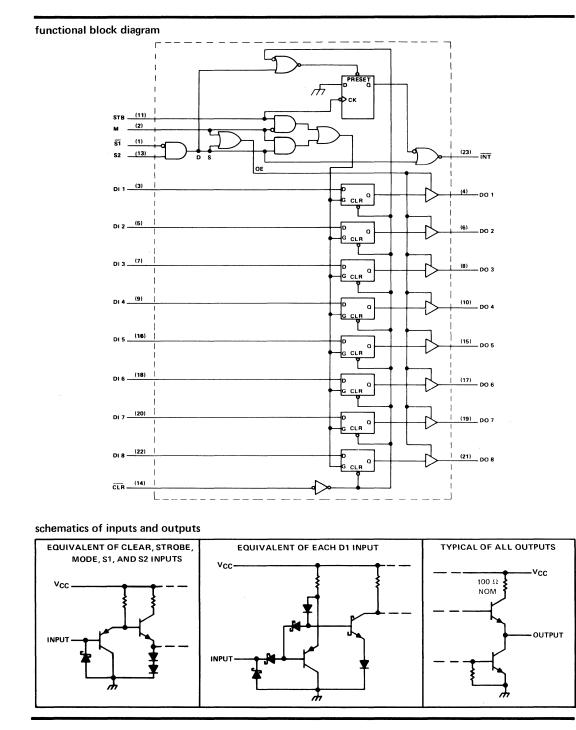
The status flip-flop provides a low-level output signal when:

- a. the package is selected
- b. a strobe input is received.

This status signal can be used to indicate that the register is busy or to initiate an interrupt type command.



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| FUNCTION  | CLEAR | м | sī1 | S2 | STB | DATA IN | DATA OUT       |
|-----------|-------|---|-----|----|-----|---------|----------------|
| 0         | L     | н | н   | X  | X   | ×       | L              |
| Clear     | L     | L | L   | н  | L   | х       | L.             |
| De-select | X     | L | X   | L  | ×   | x       | Z              |
| De-select | x     | L | н   | X  | ×   | x       | z              |
| Hold      | н     | н | н   | L  | X   | x       | 00<br>00       |
| HOIG      | н     | L | L   | н  | L   | x       | 0 <sub>0</sub> |
| Data Bus  | н     | н | L   | н  | х   | L       | L              |
| Data Dus  | н     | н | L   | н  | x   | н       | н              |
| Data Bus  | н     | L | L   | н  | н   | L       | L              |
| Data Dus  | н     | L | L   | н  | н   | н       | н              |

### DATA LATCHES FUNCTION TABLE

#### STATUS FLIP-FLOP FUNCTION TABLE

|   | CLEAR | sī1 | S2 | STB | ĪNT |
|---|-------|-----|----|-----|-----|
| ſ | L     | н   | х  | х   | н   |
|   | L     | х   | L  | х   | н   |
|   | н     | х   | х  | ↓   | L   |
|   | н     | L   | н  | х   | L   |

 $H \equiv high \ level \ (steady \ state)$ 

L ≡ low level (steady state)

 $X \equiv irrelevant$  (any input, including transitions)

 $Z \equiv$  high impedance (off)

 $\downarrow \equiv \text{transition from low to high level}$ 

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) . |          | • |     |  |   |   |   |  | • | 7V   |
|--|----------|---|-----|--|---|---|---|--|---|--|
| Input voltage                                  |          |   |     |  |   |   |   |  |   |  |
| Operating free-air temperature range:          | SN54S412 |   |     |  |   |   |   |  |   | . –55°C to 125°C                             |
|  | SN74S412 |   |     |  |   |   |   |  |   | $\cdot \cdot 0^{\circ}$ C to 70 $^{\circ}$ C |
| Storage temperature range                      |          | • | • • |  | • | • | • |  |   | . –65°C to 150°C                             |

NOTE 1: Voltage values are with respect to network ground terminal,

#### recommended operating conditions

| · ·  |                 | SN54S412   | SN74S412     |        |
|--|-----------------|------------|--------------|--------|
|  |                 | MIN NOM MA | MIN NOM MA   | X UNIT |
| Supply voltage, V <sub>CC</sub>            |                 | 4.5 5 5.   | 5 4.75 5 5.2 | 25 V   |
| Pulse width, tw                            | STB or \$1 • S2 | 25         | 25           |        |
| (see Figures 1, 2, and 4)                  | Clear low       | 25         | 25           | ns     |
| Setup time, t <sub>su</sub> (see Figure 3) |                 | 15↓        | 15↓          | ns     |
| Hold time, th (see Figures 1 and           | 13)             | 20↓        | 20↓          | ns     |
| Operating free-air temperature,            | TA              | 55 12      | 5 0          | °C °C  |

 $\downarrow$  The arrow indicates that the falling edge of the clock pulse is used for reference.

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|                 | DADAMETER                    |             | TEST OO  |   | S             | N54S41 | 2     | S    | N74S41 | 2     |      |
|-----------------|------------------------------|-------------|--|---|---------------|--------|-------|------|--------|-------|------|
|                 | PARAMETER                    |             | TEST CO  | NDITIONS  | MIN           | TYPŦ   | MAX   | MIN  | түр‡   | MAX   | UNIT |
| VIH             | High-level input voltage     |             |  |   | 2             |        |       | 2    |        |       | V    |
| VIL             | Low-level input voltage      |             |  |   |               |        | 0.85  |      |        | 0.85  | V    |
| ٧ıĸ             | Input clamp voltage          |             | V <sub>CC</sub> = MIN,                             | l <sub>l</sub> = –18 mA                           |               |        | -1.2  |      |        | -1.2  | V    |
| v <sub>он</sub> | High-level output voltage    |             | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = -1 mA | 3. <b>6</b> 5 | 4      |       | 3.65 | 4      |       | v    |
| VOL             | Low-level output voltage     |             | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V,   | $I_{OL} = 15 \text{ mA}$                          |               |        | 0.45  |      |        | 0.45  | v    |
|                 |                              |             | V <sub>IL</sub> = 0.8 V                            | IOL = 20 mA                                       |               |        | 0.5   |      |        | 0.5   |      |
| 1               | Off-state output current,    | DO 1 thru   | Vcc = MAX,   | $\lambda = 24\lambda$                             |               |        | 50    |      |        | 50    | μΑ   |
| lozh            | high-level voltage applied   | DO 8        | VCC - MAA,   | VO = 2.4 V  |               |        | 50    |      |        | 50    | μΑ   |
| 10-             | Off-state output current,    | DO 1 thru   | Vcc = MAX,   |   |               |        | -50   |      |        | 50    | μA   |
| IOZL            | low-level voltage applied    | DO 8        | VCC - MAA,   | VO = 0.5 V  |               |        | -50   |      |        | 50    | μΑ   |
| li -            | Input current at             |             | V <sub>CC</sub> = MAX,                             | V. = 5 5 V  |               |        | 1     |      |        | 1     | mA   |
| "               | maximum input voltage        |             | VCC MAA,   | v] = 5.5 v  |               |        |       |      |        |       |      |
| Чн              | High-level input current     |             | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.25 V                           |               |        | 20    |      |        | 10    | μA   |
|                 |                              | <u></u> \$1 |  |   |               |        | 1     |      |        | -1    |      |
| hι              | Low-level input current      | м           | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 0.4 V                            | 1             |        | -0.75 |      |        | -0.75 | mA   |
|                 |                              | All others  |  |   |               |        | -0.25 |      |        | -0.25 | mA   |
| los             | Short-circuit output current | ŝ           | V <sub>CC</sub> = MAX                              |   | -20           |        | -65   | 20   |        | 65    | mA   |
| lcc             | Supply current               |             | V <sub>CC</sub> = MAX,                             | see Note 2  |               | 82     |       |      | 82     | 130   | mA   |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\S$ Not more than one output should be shorted at a time.

NOTE 2: I  $_{\mbox{CC}}$  is measured with all outputs open, clear input at 4.5 V, and all other inputs grounded.

| CC = 5 V, TA = 25 C |                              |        |        |                        | $(1, \dots, n, n) \in \mathbb{R}^{n} \times \mathbb{R}^{n} \times \mathbb{R}^{n} \times \mathbb{R}^{n}$ |     |     |      |
|---------------------|------------------------------|--------|--------|------------------------|---|-----|-----|------|
| PARAMETER           | FROM                         | то     | FIGURE | TEST CONDITIONS        | MIN   | TYP | MAX | UNIT |
| <sup>t</sup> PLH    | STB, $\overline{S}1$ , or S2 | Any    | 1      | CL = 30 pF             |   | 18  | 27  | ns   |
| ΨHL                 |                              | DO     |        |                        |   | 15  | 25  |      |
| <sup>t</sup> PHL    | CLR                          | Any DO | 2      |                        |   | 18  | 27  | ns   |
| <sup>t</sup> PLH    | DIi                          | DOi    | 3      |                        |   | 12  | 20  | ns   |
| <sup>t</sup> PHL    |                              |        |        |                        |   | 10  | 20  |      |
| <sup>t</sup> PLH    | S1 or S2                     | INT    | 4      | C <sub>L</sub> = 30 pF |   | 12  | 20  | ns   |
| <b>tPHL</b>         | STB                          | INT    | 4      |                        |   | 16  | 25  |      |
| <sup>t</sup> ZH     | 51, S2, or M                 | Any DO | 5      | C <sub>L</sub> = 30 pF |   | 21  | 35  | ns   |
| <sup>t</sup> ZL     |                              |        |        |                        |   | 25  | 40  |      |
| tHZ                 | 51, S2, or M                 | Any DO | 5      | C <sub>L</sub> = 5 pF  |   | 9   | 20  | ns   |
| <sup>t</sup> LZ     |                              |        |        |                        |   | 12  | 20  |      |

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{PHL} = propagation delay time, high-to-low-level output$ 

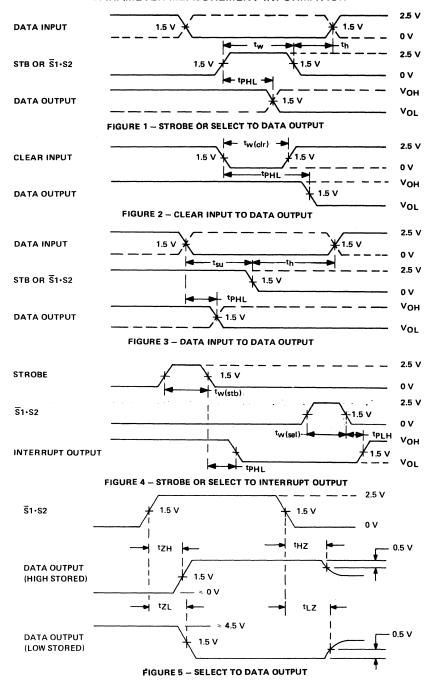
 $t_{ZH} \equiv output enable time to high level$ 

tZL ≡output enable time to low level

 $t_{HZ}^{--} \equiv$  output disable time from high level  $t_{LZ} \equiv$  output disable time from low level

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# TYPES SN54S412, SN74S412 (TIM8212) MULTI-MODE BUFFERED LATCHES



# PARAMETER MEASUREMENT INFORMATION

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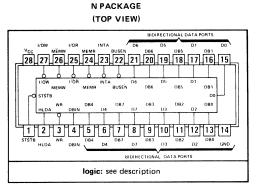
TYPES SN74S428(TIM8228), SN74S438(TIM8238)

CONTROLLER AND BUS DRIVER FOR 8080A SYSTEMS

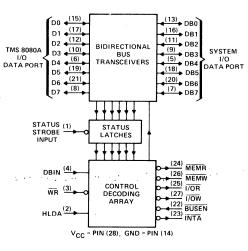
#### BULLETIN NO. DL-S 7612468, OCTOBER 1976

# Designed to Be Interchangeable with Intel 8228 and 8238

| PIN DESIGNATIONS |                 |                         |  |  |  |  |  |  |  |  |
|------------------|-----------------|-------------------------|--|--|--|--|--|--|--|--|
| DESIGNATION      | PIN NOS.        | FUNCTION                |  |  |  |  |  |  |  |  |
| D0 that D7       | 15, 17, 12, 10, | BIDIRECTIONAL DATA PORT |  |  |  |  |  |  |  |  |
| D0 thru D7       | 6, 19, 21, 8    | (TO TMS 8080A)          |  |  |  |  |  |  |  |  |
| DB0 thru DB7     | 13, 16, 11, 9,  | BIDIRECTIONAL DATA PORT |  |  |  |  |  |  |  |  |
|                  | 5, 18, 20, 7    | (TO SYSTEM BUS)         |  |  |  |  |  |  |  |  |
| I/OR             | 25              | READ OUTPUT TO I/O      |  |  |  |  |  |  |  |  |
|                  | 25              | (ACTIVE LOW)            |  |  |  |  |  |  |  |  |
| 10/W             | 27              | WRITE OUTPUT TO I/O     |  |  |  |  |  |  |  |  |
|                  |                 | (ACTIVE LOW)            |  |  |  |  |  |  |  |  |
| MEMB             | 24              | READ OUTPUT TO MEMORY   |  |  |  |  |  |  |  |  |
|                  |                 | (ACTIVE LOW)            |  |  |  |  |  |  |  |  |
| MEMW             | 26              | WRITE OUTPUT TO MEMORY  |  |  |  |  |  |  |  |  |
|                  | 20              | (ACTIVE LOW)            |  |  |  |  |  |  |  |  |
|                  |                 | INPUT TO INDICATE       |  |  |  |  |  |  |  |  |
| DBIN             | 4               | TMS 8080A IS IN INPUT   |  |  |  |  |  |  |  |  |
|                  |                 | MODE (ACTIVE HIGH)      |  |  |  |  |  |  |  |  |
| INTA             | 23              | INTERRUPT ACKNOWLEDGE   |  |  |  |  |  |  |  |  |
|                  |                 | OUTPUT (ACTIVE LOW)     |  |  |  |  |  |  |  |  |
|                  |                 | HOLD ACKNOWLEDGE        |  |  |  |  |  |  |  |  |
| HLDA             | 2               | INPUT (ACTIVE HIGH)     |  |  |  |  |  |  |  |  |
|                  |                 | FROM TMS 8080A          |  |  |  |  |  |  |  |  |
|                  |                 | INPUT TO INDICATE       |  |  |  |  |  |  |  |  |
| WR               | 3               | TMS 8080A IS IN WRITE   |  |  |  |  |  |  |  |  |
|                  |                 | MODE (ACTIVE LOW)       |  |  |  |  |  |  |  |  |
|                  |                 | SYSTEM DATA PORT        |  |  |  |  |  |  |  |  |
| BUSEN            | 22              | ENABLE INPUT (ACTIVE    |  |  |  |  |  |  |  |  |
|                  |                 | LOW)                    |  |  |  |  |  |  |  |  |
|                  | · . 5.          | SYNCHRONIZING STATUS    |  |  |  |  |  |  |  |  |
| STSTB            | 1               | STROBE INPUT FROM       |  |  |  |  |  |  |  |  |
|                  |                 | SN74LS424 (TIM8224)     |  |  |  |  |  |  |  |  |
| Vcc              | 28              | SUPPLY VOLTAGE (5 V)    |  |  |  |  |  |  |  |  |
| GND              | 14              | GROUND                  |  |  |  |  |  |  |  |  |
|                  |                 |                         |  |  |  |  |  |  |  |  |



#### functional block diagram



### description

TTL

LSI

These monolithic Schottky-clamped TTL system controllers are designed specifically to provide bus-driving and peripheral-control capabilities for interfacing memory and I/O devices with the 8080A in small to medium-large micro-computer systems.

A bidirectional eight-bit parallel bus driver is provided that isolates the 8080A bus from the memory and I/O data bus allowing the system designed to utilize cost-effective memory and peripheral devices while obtaining the maximum efficiency from the microprocessor. The TTL system drivers also provide increased fan-out with a lower impedance that enhances noise margins on the system bus.

Implementation of the status latches and control decoding array of the SN74S428/SN74S438 provides for using either a single-level interrupt vector RST7 for small systems, or multiple-byte call instructions for systems needing unlimited interrupt levels.

This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice. POST OFFICE BOX 5012 + DALLAS, TEXAS 75222

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### description (continued)

With respect to the system clocks, the SN74S438 is configured to generate an advanced response for I/O or memory write output signals to further simplify peripheral control implementation of complex systems. See Figure 3.

### 8-bit parrallel bus transceiver

The 8-bit parallel bus transceiver buffers the 8080A data bus from the memory and I/O system bus by providing one port (DO through D7) to interface with the 8080A and another port (DBO through DB7) to interface with the system devices. The 8080A side of the transceiver is designed specifically to interface with the microprocessor data bus ensuring not only that the processor output drive capabilities are adequate, but also that the inputs are driven with enhanced noise margins. The system bus side features high fan-out buffers designed to drive a number of system devices simultaneously and directly. The system port is rated to sink ten milliamperes of current and to source one milliampere of current at standard low-threshold voltage levels.

Status lines from the 8080A instruction-status decoder and the system bus enable input (BUSEN) provide complete transceiver directional and enable control to ensure integrity of both the processor data and the system bus data.

#### status latches

During the beginning of each machine cycle, the six status latches receive status information from the 8080A data bus indicating the type of operation that will be performed. When the STSTB input goes low, the latches store the status data and generate the signals needed to enable and sequence the memory and I/O control outputs. The status words and types of machine cycles are enumerated in Table A.

| STATUS |      |           |       | 808    | 0A   |       |     |      | TYPE OF                       | 'S428/'S438 |
|--------|------|-----------|-------|--------|------|-------|-----|------|-------------------------------|-------------|
| WORD   |      |           | ST    | ATUS   | OUTP | UT    |     |      | MACHINE CYCLE                 | COMMAND     |
| WOND   | D0   | D1        | D2    | D3     | D4   | D5    | D6  | D7   | MACHINE CTCLE                 | GENERATED   |
| . 1    | Ŀ    | Н         | L     | . L.   | L.   | н     | . L | н    | Instruction fetch             | MEMR        |
| 2      | L    | Ĥ         | L     | L      | L    | L     | Ĺ   | ́н́  | Memory read                   | MEMR        |
| 3      | L    | L         | L     | L      | L    | L     | L   | L    | Memory write                  | MEMW        |
| 4      | Γ.   | н         | Ή     | L      | L    | L     | L   | н    | Stack read                    | MEMR        |
| 5.     | L    | L         | н     | L      | L    | L     | L   | L    | Stack write                   | MEMW        |
| 6      | L    | н         | L     | L      | L    | L     | н   | L    | Input read                    | 1/OR        |
| 7      | L    | L         | L     | L      | н    | L     | L   | L    | Output write                  | I/OW        |
| 8      | н    | н         | L     | L      | L    | н     | L   | L    | Interrupt acknowledge         | INTA        |
| 9      | . L  | н         | L     | н      | L    | L     | L   | н    | Halt acknowledge              | NONE        |
| 10     | н    | н         | L     | н      | L    | н     | L   | L    | Interrupt acknowledge at halt | INTA        |
|        | INTA | <u>ow</u> | STACK | нгта   | OUT  | ۳     | N   | MEMR |                               |             |
|        |      |           | STAT  | JS INI | ORM  | ATION | J   |      |                               |             |

#### TABLE A - STATUS WORDS

#### decoding array

The decoding array receives enabling commands from the status latches and sequencing commands from the 8080A and generates memory and I/O read/write commands and an interrupt acknowledgement.

### description (continued)

The read commands ( $\overline{\text{MEMR}}$ ,  $\overline{I/OR}$ ) and the interrupt acknowledgement ( $\overline{\text{INTA}}$ ) are derived from the status bit(s) and the data bus input mode (DBIN) signal. The write commands ( $\overline{\text{MEMW}}$ ,  $\overline{I/OW}$ ) are derived from the status bit(s) and the write mode ( $\overline{\text{WR}}$ ) signal. (See Table A.) All control commands are active low to simplify interfacing with memory and I/O controllers.

The interrupt acknowledgement (INTA) command output is actually a dual function pin. As an output, its function is to provide the INTA command to the memory and I/O peripherals as decoded from the status inputs and latches. When CALL is used as an interrupt instruction, the SN74S428/SN74S428 generates the proper sequence of control signals. Additionally, the terminal includes high-threshold decoding logic that permits it to be biased through a one-kilohm series resistor to the 12-volt supply to implement an interrupt structure that automatically inserts an RST7 instruction on the bus when the DBIN input is active and an interrupt is acknowledged. This capability provides a single-level interrupt vector with minimal hardware.

The asynchronous bus enable (BUSEN) input to the decoding array is a control signal that protects the system bus. The system bus can be accessed and driven from the SN74S428/SN74S428 controller only when the BUSEN input is at a low voltage level.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1)  | 7 V  |
|---|------|
| nput voltage  |      |
| Operating free-air temperature range $\ldots$   | 70°C |
| Storage temperature range $\ldots$ | 50°C |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|   |                           | MIN  | NOM | MAX  | UNIT |
|---|---------------------------|------|-----|------|------|
| Supply voltage, V <sub>CC</sub>                     |                           | 4.75 | 5   | 5.25 | V    |
| High-level output current, IOH                      | D0 thru D7                |      |     | -10  | μA   |
| High level output current, IOH                      | All others                |      |     | 1    | mA   |
|   | D0 thru D7                |      |     | 2    |      |
| Low-level output current, IOL                       | All others                |      |     | 10   | mA   |
| Status strobe pulse width, tw(STSTB) (see Figure 3) |                           | 22   |     |      | ns   |
| Sotup time to (ee Figure 2)                         | Status inputs D0 thru D7  | 8    |     |      |      |
| Setup time, t <sub>su</sub> (see Figure 3)          | System bus inputs to HLDA | 10   |     |      | ns   |
|   | Status inputs D0 thru D7  | 5    |     |      |      |
| Hold time, t <sub>h</sub> (see Figure 3)            | System bus inputs to HLDA | 20   |     |      | ns   |
| Operating free-air temperature, TA                  |                           | 0    |     | 70   | °C   |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                    | PARAMETER                     |                   | TEST CON                 | DITIONS                 | MIN | TYP‡ | MAX  | UNIT |
|--------------------|-------------------------------|-------------------|--------------------------|-------------------------|-----|------|------|------|
| VIH                | High-level input voltage      |                   |                          |                         | 2   |      |      | V    |
| VIL                | Low-level input voltage       |                   |                          |                         |     |      | 0.8  | V    |
| VIK                | Input clamp voltage           |                   | V <sub>CC</sub> = MIN,   | l <sub>1</sub> = -5 mA  |     |      | -1   | V    |
| Val                | High-level output voltage     | D0 thru D7        | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | 3.6 | 4    |      | v    |
| Vон I              | High-level output voltage     | All other outputs | V <sub>IL</sub> = 0.8 V, | I <sub>OH</sub> = MAX   | 2.4 |      |      | 1    |
| V <sub>OL</sub> La | Low-level output voltage      |                   | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     |      | 0.45 | v    |
|                    |                               |                   | V <sub>IL</sub> = 0.8 V, | IOL = MAX               |     |      | 0.45 |      |
| 1                  | Off-state output current,     |                   |                          |                         |     |      | 100  |      |
| IOZH               | high-level voltage applied    |                   | V <sub>CC</sub> = MAX,   | v0 - 5.25 v             |     |      | 100  | μΑ   |
| 1                  | Off-state output current,     |                   |                          | N/ - 0.45 M             |     |      | 100  |      |
| IOZL               | low-level voltage applied     |                   | V <sub>CC</sub> = MAX,   | v <sub>O</sub> = 0.45 v |     |      | -100 | μA   |
|                    |                               | INTA              | V <sub>CC</sub> = MIN,   | See Figure 1            |     |      | 5    | mA   |
| Чн                 | High-level input current      | DO thru D7        | Vcc = MAX,               | V E 2E V                |     |      | 20   |      |
|                    |                               | All other inputs  | VCC - MAA,               | v] - 5.25 v             |     |      | 100  | μA   |
|                    |                               | D2 or D6          | 1                        |                         |     |      | -750 |      |
| ЧL                 | Low-level input current       | STSTB             | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.45 V |     |      | -500 | μA   |
|                    |                               | 1                 |                          |                         |     | -250 | 1    |      |
| los                | Short-circuit output current§ |                   | V <sub>CC</sub> = MAX    |                         | -15 |      | -90  | mA   |
| <sup>1</sup> CC    | Supply current                |                   | V <sub>CC</sub> = MAX    |                         |     | 140  | 190  | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>o</sup>C.

<sup>§</sup>Not more than one output should be shorted at a time.

| PARAMETER¶       | FROM<br>(INPUT)         | TO<br>(OUTPUT)                  | TEST COM                 | DITIONS      | MIN      | түр | MAX | UNIT |
|------------------|-------------------------|---------------------------------|--------------------------|--------------|----------|-----|-----|------|
| <sup>t</sup> PD  | D0 thru D7              | DB0 thru DB7                    | $C_{L} = 100  pF$ ,      | See Figure 2 | 5        |     | 40  | ns   |
| tPD              | DB0 thru DB7            | D0 thru D7                      | CL = 25 pF,              | See Figure 2 |          |     | 30  | ns   |
| <sup>t</sup> PHL | STSTB                   | INTA, I/OR, MEMR,<br>I/OW, MEMW |                          |              | 20       |     | 60  | ns   |
| <sup>t</sup> PD  | WR                      | 1/OW, MEMW                      | C <sub>L</sub> = 100 pF, | See Figure 2 | 5        |     | 45  | ns   |
| ΨLH              | DBIN                    | INTA, I/OR, MEMR                | 1                        |              |          | 30  | ns  |      |
| <sup>t</sup> PLH | HLDA                    | INTA, I/OR, MEMR                |                          |              |          |     | 25  | ns   |
| ΨZX              | DBIN                    | D0 thru D7                      | C <sub>I</sub> = 25 pF,  | S 5: 0       | <u> </u> |     | 45  | ns   |
| <sup>t</sup> PXZ | DBIN                    | D0 thru D7                      | - CL = 25 pF,            | See Figure 2 | <b> </b> |     | 45  | ns   |
| <sup>t</sup> PZX | STSTB, BUSEN            | DB0 thru DB7                    | C 100 - F                | Sec 5: 2     |          |     | 30  | ns   |
| <sup>t</sup> PXZ | tPXZ BUSEN DB0 thru DB7 |                                 | С <sub>L</sub> = 100 рF, | See Figure 2 |          |     | 30  | ns   |

# switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C, see figure 3

 $f_{\text{tp}\,\text{D}} \equiv \text{propagation delay time}$ 

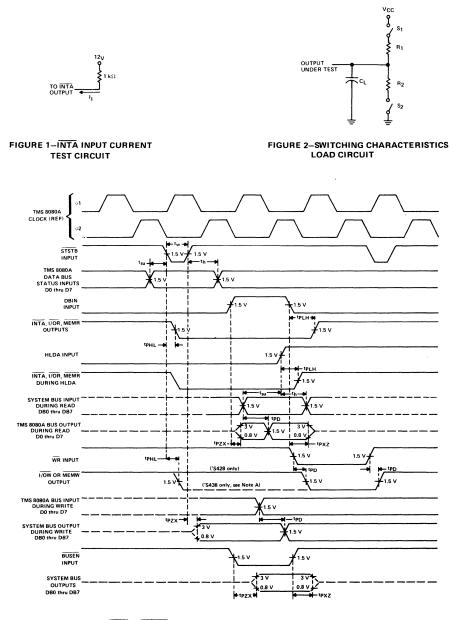
 $t_{PHL} \equiv propagation delay time, high-to-low-level output$ 

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{PZX} \equiv$  output enable time from high-impedance state

 $t_{PXZ} \equiv output disable time to high-impedance state$ 

# PARAMETER MEASUREMENT INFORMATION



NOTE A: Advanced response of I/OW or MEMW for the SN74S438 is indicated by the dashed line.

FIGURE 3-VOLTAGE WAVEFORMS

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TYPICAL APPLICATION DATA

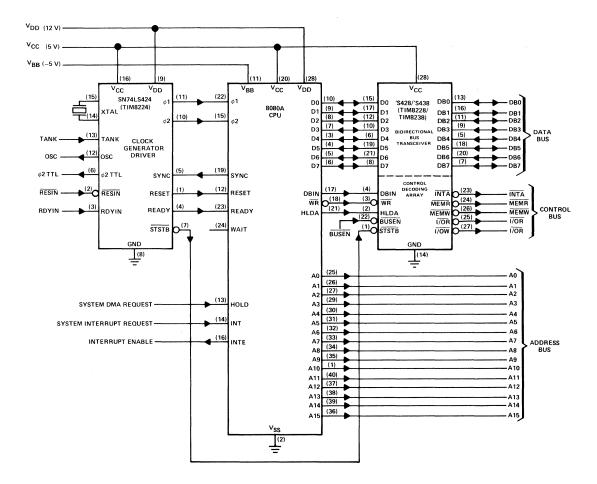


FIGURE 4-SYSTEM INTERFACING WITH CENTRAL PROCESSING UNIT

# TEXAS INSTRUMENTS

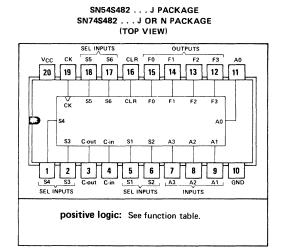
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# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

BULLETIN NO. DL-S 7612384, MARCH 1976

- 4-Bit Slice is Cascadable to N-Bits
- Designed Specifically for Microcontroller/ Next-Address Generator Functions
- Increment/Decrement by One (Immediate or Direct Symbolic Addressing Modes)
- Offset, Vector, or Branch (Indexed or Relative Addressing Modes)
- Store Up to Four Returns or Links (Program Return Address from Subroutine)
- Program Start or Initialize (Return to Zero or Clear Mode)
- On-Chip Edge-Triggered Output Register (Provides Steady-State Micro-Address/ Instruction)
- High-Density 20-Pin Dual-in-Line Package with 300-Mil Row Pin Spacing

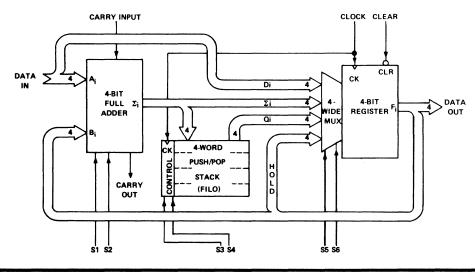


### description

The 'S482 is a high-performance Schottky TTL 4-bit-slice control element for use in any computer/control application requiring the coupling of high-performance bipolar speeds with the flexibility of microprogram control and bit-slice expandability. When used as a next-address generator, two 'S482 elements can address up to 256 words of microprogram; three elements can address up to 4096 words of microprogram; or a number of 'S482 elements can generate N words in multiples of four lines.

Comprised of an output register, push-pop stack, and a full adder, the 'S482 provides the capability to implement multiway testing needed to generate or to determine and select the source of the next function of microprogram address.

### functional block diagram



#### **TENTATIVE DATA SHEET**

This document provides tentative information TEXAS INSTRUMENTS on a new product. Texas Instruments reserves the right to change specifications for this POST OFFICE BOX 5012 • DALLAS, TEXAS 75222 product in any manner without notice. <sup>†</sup>Integrated Schottky-Barrier diode-41 clamped transistor is patented by Texas Instruments. U. S. Patent Number 3,463,975.

# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

# output register and source functions

The 4-bit edge-triggered register provides a steady-state output throughout each system clock cycle. An asynchronous clear extends the multiway testing to directly implement system initialization at ROM address zero.

Two source-select lines (S5, S6) provide the output register with access to either the current instruction (no change), an operand or address stored in the push-pop stack, the output of a four-function full adder, or a direct data-in address port. The sources and functions are summarized in Tables I and II.

| SEL | ECT | REGISTER INPUT SOURCE   |
|-----|-----|-------------------------|
| S5  | S6  | REGISTER INPUT SOURCE   |
| Ľ   | L   | DATA-IN PORT (Di)       |
| L   | н   | FULL ADDER OUTPUTS (Si) |

PUSH-POP STACK OUTPUTS (Qi)

**REGISTER OUTPUTS (HOLD)** 

TABLE I. REGISTER-SOURCE FUNCTIONS

 $H \equiv high level, L \equiv low level$ 

н

н

#### TABLE II. PUSH-POP STACK CONTROL AND REGISTER-SOURCE FUNCTIONS

|          |            |           |    | INF       | UTS        |       | INTERNAL          | OUTPUTS |
|----------|------------|-----------|----|-----------|------------|-------|-------------------|---------|
|          | <b>S</b> 3 | <b>S4</b> | S5 | <b>S6</b> | CLOCK      | CLEAR | QiA               | Fi      |
| HOLD     | X          | Х         | х  | х         | L          | н     | QiA0              | FiO     |
| CLEAR    | ×          | х         | х  | х         | ×          | L     | QiA0              | L       |
| PUSH-POP | L          | L         | L  | L         | <u>,</u> † | н     | QiA0*             | Di      |
| STACK    | L          | L         | L  | н         | 1          | н     | QiA0*             | Σί      |
| "HOLD"   | L          | L         | н  | L         | 1          | н     | QiA0*             | QiA0    |
|          | L          | L         | н  | н         | †          | Н     | QiA0*             | Fi0     |
| PUSH-POP | L          | Н         | L  | L         | †          | н     | Σi*               | Di      |
| STACK    | L          | Ħ         | L  | н         | 1          | н     | Σi*               | Σi      |
| "LOAD"   | L          | н         | н  | L         | 1          | н     | Σi*               | QiA0    |
|          | L          | н         | н  | н         | 1          | н     | Σi*               | Fi0     |
| PUSH-POP | н          | L         | L  | L         | 1          | н     | QiB0 <sup>†</sup> | Di      |
| STACK    | н          | L         | L  | н         | 1          | н     | QiB0 <sup>†</sup> | Σi      |
| "POP"    | н          | L         | н  | L         | 1          | н     | QiB0 <sup>†</sup> | QiA0    |
| '°' (    | н          | L         | н  | н         | 1          | н     | QiB0 <sup>†</sup> | FiO     |
|          | н          | н         | L  | L         | 1          | н     | Σi‡               | Di      |
| STACK    | н          | н         | L  | н         | 1          | н     | Σi‡               | Σi      |
| "PUSH"   | н          | н         | н  | L         | 1          | н     | Σi‡               | QiA0    |
| L L      | н          | н         | н  | н         | 1          | н     | Σi‡               | Fi0     |

Ai ≡ Data inputs

- $QiA \equiv Push-pop$  stack word A output (internal)
- $QiAO \equiv$  the level of Qi before the indicated inputs conditions were established.

Fi ≅ Device outputs
Fi0 ≡ the level of Fi before the indicated input conditions were established.

 $\Sigma i \equiv Adder outputs (internal)$ 

\*QiB, QiC, QiD do not change

 $\begin{tabular}{l} $ ^\dagger \end{tabular} \end{tabular} $ ^\dagger \end{tabular} \end{tabular} $ ^\dagger \end{tabular} \end{ta$ 

#### push-pop stack control

The 4-word push-pop stack can be used for nesting up to four levels of program or return (link) addresses. In the load mode, the first (top) word is filled with new data from the output of the full adder, and no push occurs meaning that previous data at that location is lost. However, all other word locations in the push-pop stack remain unchanged. In the push mode, the new word is again entered in the first (top) location; however, previous data residing in the top three words are pushed down one word location and retained at their new locations. The bottom word is written over and lost.

In the pop mode, words in the push-pop stack move up one location on each clock transition. A unique function is provided by the bottom (fourth) register as its content is retained during the pop mode, and after 3 clock transitions, all words in the stack are filled with the operand/address that occupied the bottom register.

The operand/address will remain available indefinitely if stack functions are limited to the pop or hold modes.

| TABLE III. PUSH-POP STACK FUNCTIONS |          |    |         |            |               |      |               |         |  |  |  |  |  |
|-------------------------------------|----------|----|---------|------------|---------------|------|---------------|---------|--|--|--|--|--|
|                                     | FUNCTION | SE | L.      | REG.       | REG.          | REG. | REG.          | INPUT/  |  |  |  |  |  |
|                                     | FUNCTION | S3 | S3 S4 D |            | С             | в    | A             | Ουτρυτ  |  |  |  |  |  |
| BIT 0                               | LOAD     | L  | н       | QiD0       | QiC0          | QiB0 | · ←           | Σί ΙΝ   |  |  |  |  |  |
|                                     |          |    | L       |            |               |      | Σί            |         |  |  |  |  |  |
| BIT 1                               | PUSH     | н  | н       | +          | ←             | ←    | -             | ΣΗΝ     |  |  |  |  |  |
| 011 1                               |          |    |         | QiC0       | QiB0          | QiA0 | Σί            | 2111    |  |  |  |  |  |
| BIT 2                               | POP      | н  | L       | <b>€</b> → | $\rightarrow$ | →    | $\rightarrow$ | O'A OUT |  |  |  |  |  |
| BIT 2                               | FOF      | п  | L       | QiD0       | QiD0          | QiC0 | QiB0          | QiA OUT |  |  |  |  |  |
| віт з                               | HOLD     | L  | L       | QiD0       | QiC0          | QiB0 | QiA0          | QiA OUT |  |  |  |  |  |

The push-pop stack functions are shown in Tables II and III.

µlink operations show previous data location after clock transition.

#### full adder

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The four-function full adder is controllable from select inputs S1 and S2 to perform:

A or B incrementation, or decrementation of B

Unconditional jumps or relative offsets

No change

Return to zero or one

Incrementation can be implemented by forcing a carry (high) into the ALU. In this mode either of the following options are possible:

- 1. Increment (A plus zero plus carry)
- 2. Increment B (zero plus B plus carry), or decrement B (all highs at A then A plus B with carry input low and disregard, don't use, carry out)
- 3. Increment the jump or offset (A plus B plus carry)

### full adder (continued)

- 4. Start at zero or one and increment on each clock (select zero plus zero plus carry, then select zero plus B plus carry), or set register to N and decrement B (see 2 above).
- 5. No change (carry input is always active and removal of carry combined with either the ALU or register hold mode will retain the current address).

Unconditional jumps can be implemented by applying and selecting the jump directly from the data inputs to the output register. Offset can be accomplished by summing the output register with the offset magnitude (A plus B) with carry low.

The ALU functions are shown in Table IV.

| INP | UTS | INTERNAL             |
|-----|-----|----------------------|
| S1  | S2  | Σί                   |
| н   | н   | 0 PLUS 0 PLUS C-in   |
| н   | L   | 0 PLUS Bi PLUS C-in  |
| L   | н   | Ai PLUS 0 PLUS C-in  |
| L   | L   | Ai PLUS Bi PLUS C-in |

#### TABLE IV. ADDRESS CONTROL FUNCTIONS

### compound generator functions

As the function-select lines of the register sources, push-pop stack, and adder are independent, compound functions can be selected to occur on the next clock transition.

Subroutine branches and returns can be simplified by saving the return or link addresses in the push-pop stack. This branch-and-save function can be accomplished on the same clock time as follows:

| DATA-IN        | ADDER                | PUSH-POP STACK | REGISTER SOURCE |
|----------------|----------------------|----------------|-----------------|
| Branch address | Zero plus B plus one | Push           | Data-in         |
|                | (S1 = H, S2 = L)     | (S3 = S4 = H)  | (S5 = S6 = L)   |

Up to four branches can be made with the return stored in the 4-word push-pop stack.

# absolute maximum ratings over operating free-air temperature (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) . |          |   |     |   |  |  | • | • |   | • |   | 7V               |
|--|----------|---|-----|---|--|--|---|---|---|---|---|------------------|
| Input voltage                                  |          |   |     | • |  |  |   |   | • | • | • | 5.5 V            |
| Off-state output voltage                       |          |   |     |   |  |  |   |   |   |   |   |                  |
| Operating free-air temperature range:          | SN54S482 |   | • • |   |  |  |   |   |   |   |   | . –55°C to 125°C |
|  | SN74S482 |   |     |   |  |  |   |   |   |   | • | 0°C to 70°C      |
| Storage temperature range                      |          | • |     |   |  |  |   |   |   |   |   | . –65°C to 150°C |
|  |          |   |     |   |  |  |   |   |   |   |   |                  |

NOTE 1. All voltage values are with respect to network ground terminal.

# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

# recommended operating conditions

|                                    |                      | S   | N54S48  | 2   | S    | N74S48 | 32   |      |
|------------------------------------|----------------------|-----|---|-----|------|--------|------|------|
|                                    |                      | MIN | NOM   | MAX | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>    |                      | 4.5 | 5   | 5.5 | 4.75 | 5      | 5.25 | V    |
| High level entrut entrust terr     | Carry output         |     |   | -1  |      |        | -1   |      |
| High-level output current, IOH     | Any F output         |     |   | -2  |      |        | -2   | mA   |
|                                    | Carry output         |     |   | 10  |      |        | 10   | mA   |
| Low-level output current, IOL      | Any F output         |     |   | 16  |      |        | 16   |      |
|                                    | Data-in, S5, S6      | 01  | <u>}</u>  |     | o↑   |        |      |      |
|                                    | Data-in via adder    | 201 | ۱<br>۱  |     | 15↑  |        |      |      |
| Setup time, t <sub>su</sub>        | S1, S2               | 401 | ۱.  |     | 30↑  |        |      | ns   |
|                                    | S3, S4               | 201 |   |     | 15↑  |        |      | ]    |
|                                    | Clear-inactive state | 01  | •   |     | ^0   |        |      |      |
| Pulse width t                      | Clock (high or low)  | 50  |   |     | 30   |        |      |      |
| Pulse width, t <sub>W</sub>        | Clear (low)          | 15  |   |     | 15   |        |      | ns   |
| Clock input rise time, tr          |                      |     |   | 50  |      |        | 50   | ns   |
| <u> </u>                           | Data-in, S5, S6      | 301 | È la chianta anna anna anna anna anna anna anna |     | 25↑  |        |      |      |
|                                    | Data-in via adder    | 151 | 1   |     | 10↑  |        |      | ]    |
| lold time, t <sub>h</sub>          | S1, S2               | 151 |   |     | 10↑  |        |      | ns   |
|                                    | S3, S4               | 251 | •   |     | 201  |        |      |      |
| Operating free-air temperature, TA |                      | -55 |   | 125 | 0    | 25     | 70   | °C   |

 $\uparrow_{\mathsf{The}}$  arrow indicates that the rising edge of the clock pulse is used for reference,

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | D. D. A.M.F.T   |                          |  |                        | S   | N54S48 | 32   | S   | N74548 | 32   |      |
|-----|-----------------|--------------------------|--|------------------------|-----|--------|------|-----|--------|------|------|
|     | PARAMET         | EK                       | TEST CON   | DITIONS                | MIN | түрŧ   | MAX  | MIN | түрŧ   | MAX  | UNIT |
| VIH | High-level inpu | t voltage                |  |                        | 2   |        |      | 2   |        |      | V    |
| VIL | Low-level inpu  | t voltage                |  |                        |     |        | 0.8  |     |        | 0.8  | V    |
| Vik | Input clamp vo  | oltage                   | V <sub>CC</sub> = MIN,                             | I <sub>I</sub> =18 mA  |     |        | -1.2 |     |        | -1.2 | V    |
| ∨он | High-level outp | out voltage              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |                        | 2.5 | 3.4    |      | 2.7 | 3.4    |      | v    |
| VOL | Low-level outp  | out voltage              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, |                        |     |        | 0.5  |     |        | 0.5  | v    |
| 4   | Input current a | at maximum input voltage | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.5 V |     |        | 1    |     |        | 1    | mA   |
|     |                 | S1, S2, Cin              |  |                        |     |        | 50   |     |        | 50   |      |
| 1   | High-level      | S3, S4, S5, S6, clock    | V <sub>CC</sub> = MAX,                             | V 27V                  |     |        | 100  |     |        | 100  | ]    |
| Чн  | input current   | Clear                    |  | vi = 2.7 v             |     |        | 250  |     | _      | 250  | μΑ   |
|     |                 | Any A                    |  |                        |     |        | 150  |     |        | 150  |      |
|     |                 | S1, S2                   |  |                        |     |        | -1   |     |        | -1   |      |
|     |                 | C-in                     |  |                        |     |        | 0.8  |     |        | -0.8 | ]    |
| 1   | Low-level       | S3, S4                   |  |                        |     |        | -1.2 |     |        | -1.2 |      |
| 46  | input current   | Any A, S5, S6, CK        | V <sub>CC</sub> = MAX,                             | vi = 0.5 v             |     |        | 2    |     |        | -2   | - mA |
|     |                 | Clear                    |  |                        |     |        | -4   |     |        | -4   | 1    |
|     |                 | Clock                    |  |                        |     |        | -2.8 |     |        | -2.8 | 1    |
| los | Short-circuit o | utput current§           | V <sub>CC</sub> = MAX                              |                        | -40 |        | -110 | -40 |        | -110 | mA   |
| 1cc | Supply current  |                          | V <sub>CC</sub> = MAX                              |                        |     | 90     | 130  |     | 90     | 140  | mA   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

\$Not more than one output should be shorted at a time.

# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

# switching characteristics over recommended operating ranges of $T_A$ and $V_{CC}$ (unless otherwise noted)

| PARAMETER        | FROM     | то то     | TEST CONDITIONS                                  | 5   | SN54S4 | 32  | S   | SN74S482 |     |      |  |
|------------------|----------|-----------|--|-----|--------|-----|-----|----------|-----|------|--|
| FARAMETER        | FROM     | 10        | TEST CONDITIONS                                  | MIN | TYPŦ   | MAX | MIN | TYPŦ     | MAX | UNIT |  |
| tPLH             | CLOCK    | DATA OUT  |  | -   | 12     | 30  |     | 12       | 25  |      |  |
| <sup>t</sup> PHL | CLOCK    | DATA UUT  |  |     | 15     | 30  |     | 15       | 25  | ns   |  |
| <sup>t</sup> PHL | CLEAR    | DATA OUT  | $C_{1} = 15 \text{ pc}$                          |     | 12     | 25  |     | 12       | 20  | ns   |  |
| <sup>t</sup> PLH | CARRY IN | CARRY OUT | $C_{L} = 15 \text{ pF},$<br>$R_{L} = 280 \Omega$ |     | 12     | 22  |     | 12       | 18  |      |  |
| <sup>t</sup> PHL | CANTIN   | CANNI OUT | HL - 200 12                                      |     | 10     | 22  | [   | 10       | 18  | ns   |  |
| tPLH             | DATA IN  | CARRY OUT |  |     | 17     | 30  |     | 17       | 25  |      |  |
| <b>tPHL</b>      |          | CANNY OUT |  |     | 12     | 30  |     | 12       | 25  | - ns |  |

<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C.

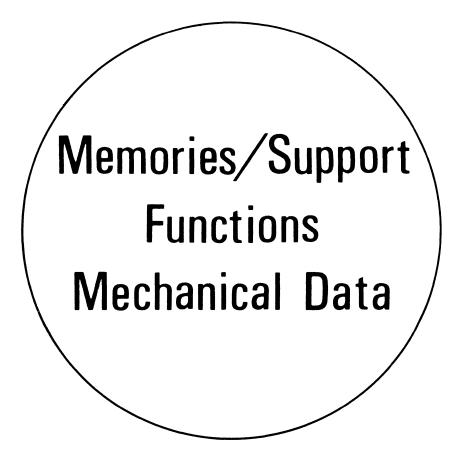
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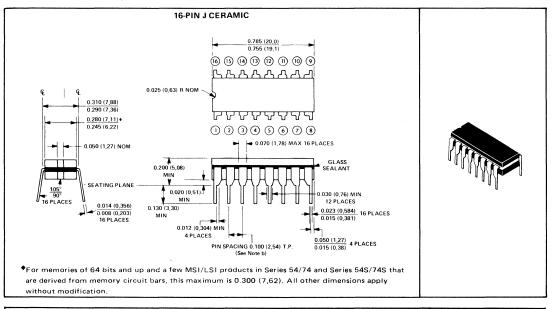
**DECEMBER 1976** 

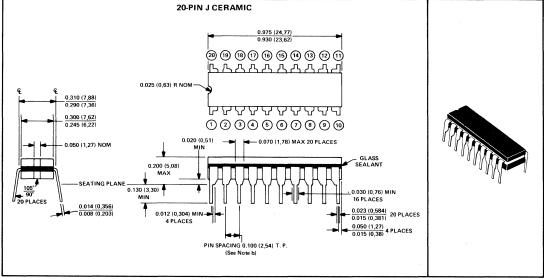
TEXAS INSTRUMENTS

# TTL INTEGRATED CIRCUITS MECHANICAL DATA

#### J ceramic dual-in-line package

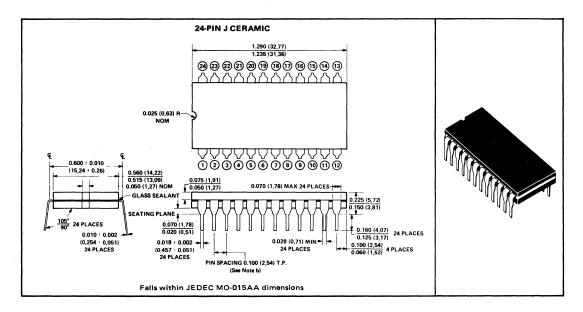
These hermetically sealed dual-in-line packages consist of a ceramic base, ceramic cap, and a 14-, 16-, 20-, or 24-lead frame. Hermetic sealing is accomplished with glass. The packages are intended for insertion in mounting-hole rows on 0.300 (7,62) or 0.600 (15,24) centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Tin-plated ("bright-dipped") leads (-00) require no additional cleaning or processing when used in soldered assembly.

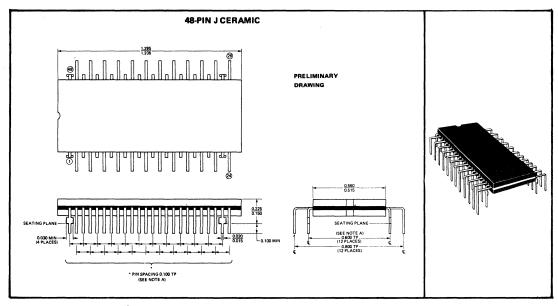




# TEXAS INSTRUMENTS POST OFFICE BOX 5012 . DALLAS, TEXAS 75222

# J ceramic dual-in-line packages (continued)



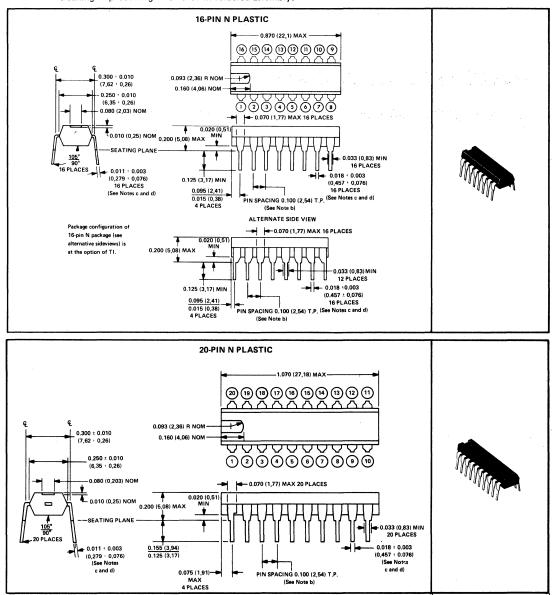


NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern. b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

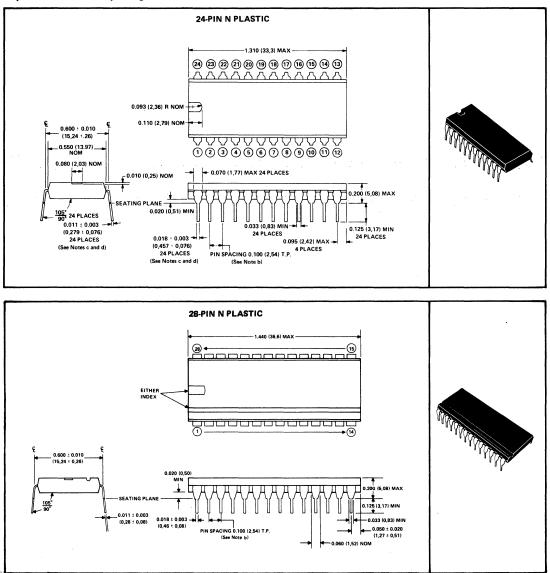
# TTL INTEGRATED CIRCUITS MECHANICAL DATA

### N plastic dual-in-line packages

These dual-in-line packages consist of a circuit mounted on a 14-, 16-, 20-, or 28-lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation and circuit performance characteristics remain stable when operated in high-humidity conditions. The packages are intended for insertion in mounting hole rows on 0.300 (7,62) or 0.600 (15,24) centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.



# N plastic dual-in-line packages (continued)



-

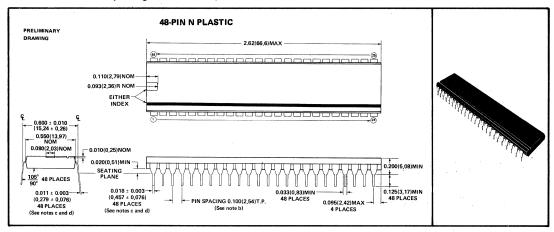
6

NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

- b. Each pin centerline is located within 0,010 (0,26) of its true longitudinal position.
- c. This dimension does not apply for solder dipped leads.
- d. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0.020 (0,50) above the seating plane.

# TTL INTEGRATED CIRCUITS MECHANICAL DATA

### N plastic dual-in-line packages (continued)



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

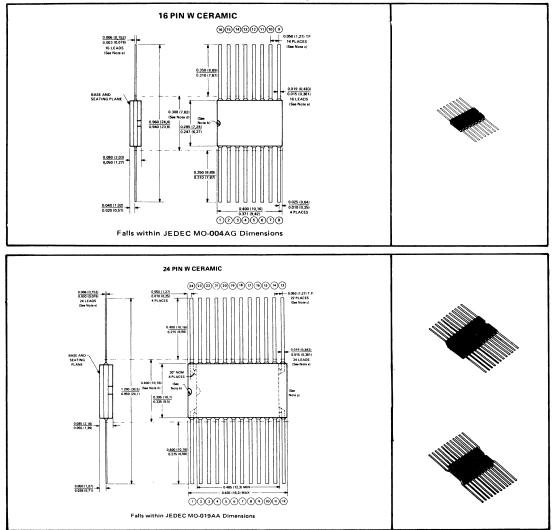
c. This dimension does not apply for solder dipped leads.

d. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0.020 (0,50) above the seating plane.

#### TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 5012 • DALLAS, TEXAS 75222

# W ceramic flat package

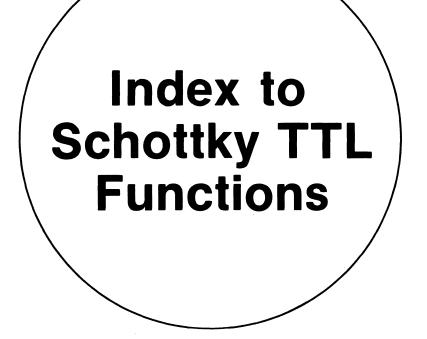
These hermetically sealed flat packages consist of an electrically nonconductive ceramic base and cap, and a 14-, 16-, or 24-lead frame. Hermetic sealing is accomplished with glass. Tin-plated ("bright-dipped") leads (-00) require no additional cleaning or processing when used in soldered assembly.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

- b. Index point is provided on cap for terminal identification only.
- c. Leads are within 0.005 (0,13) radius of true position (T.P.) at maximum material condition.
- d. This dimension determines a zone within which all body and lead irregularities lie.
- e. Not applicable for solder-dipped leads.
- f. When solder-dipped leads are specified, dipped area extends from lead tip to within 0.050 (1,27) of package body.
- g. End configuration of 24-pin package is at the option of TI.





**SEPTEMBER 1977** 

TEXAS INSTRUMENTS

# INDEX TO 54S/74S, 54LS/74LS, AND I<sup>2</sup>L FUNCTIONS

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| Gates, Buffer, Interface and Transceiver |      |
| Gates, NAND                              |      |
| Gates, NOR                               |      |
| Gates, OR                                |      |
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| Latches                                  |      |
|  |      |

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| Microprocessor Controllers and            |      |
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| 4-Bit-Slice Processor Elements            |      |
| 16-Bit I <sup>2</sup> L Microprocessor    |      |
| 50-Ohm/75-Ohm Line Drivers                | 11   |

### I<sup>2</sup>L 16-BIT MICROPROCESSORS

| DESCRIPTION                    |              | CLOCK<br>FREQUENCY | -           |     | E TYPE<br>ACKAGE |     | SEC.<br>PAGE |
|--------------------------------|--------------|--------------------|-------------|-----|------------------|-----|--------------|
|                                | INSTRUCTIONS | Theodeliet         | –55°C to 12 | 5°C | -40°C to 8       | 5°C | NO.          |
| MEMORY-TO-MEMORY ARCHITECTURE  | 60           |                    | SBP 9900M   |     | SBP 9900E        |     |              |
| SUPPORTED WITH SEPARATE MEMORY | 69           | 2 MHz              |             |     | 36F 9900E        | J   | 3-1          |
| AND CRU INTERRUPT BUSES        | (TI 990/4)   |                    | SBP 9900N‡  | J   |                  |     |              |

#### BIPOLAR BIT-SLICE PROCESSOR ELEMENTS

|             | CASCADABLE | TYPICAL     |                  |             | DEVIC  | Е ТҮРЕ    |      | SEC. |
|-------------|------------|-------------|------------------|-------------|--------|-----------|------|------|
| DESCRIPTION | то         | μ-OPERATION | TECHNOLOGY       |             | AND PA | ACKAGE    |      | PAGE |
|             | N-BITS     | TIME        |                  | -55°C to 12 | 5°C    | 0°C to 70 | °C   | NO.  |
|             | Yes        | 50 ns       | STTL             |             |        | SN74S481  | J, N | 1-1  |
| EXPANDABLE  | Yes        | 100 ns      | LSTTL            | SN54LS481   | J      | SN74LS481 | J, N | 1-1  |
| 4-BIT SLICE | Yes        | 300 ns      | 1 <sup>2</sup> L | SBP0400AM   | J      | SBP0400AC | J, N | 2-1  |
|             | Yes        | 300 ns      | 1 <sup>2</sup> L | SBP0401AM   | J      | SBP0401AC | J, N | 2-1  |

# EXPANDABLE FIELD-PROGRAMMABLE LOGIC ARRAYS

| DESCRIPTION      | ORGANI-     | TYPICAL<br>DELAY | OUTPUTS<br>TYPE/ |                | CE TYPE<br>ACKAGE |      | SEC.<br>PAGE |
|------------------|-------------|------------------|------------------|----------------|-------------------|------|--------------|
|                  | ZATION      | TIME             | NO.              | –55°C to 125°C | 0°C to 70         | NO.  |              |
| AUTOMATIC OR     | 12 X 50 X 6 | 35 ns            | 3-State/6        |                | SN74S330          | J, N | 5-13         |
| DEDICATED ENABLE | 12 ~ 30 ~ 6 | 30 NS            | O-C/6            |                | SN74S331          | J, N | 5-13         |

#### FIRST-IN FIRST-OUT MEMORY (FIFO)

|                     | ТҮРЕ    | TYPICAL   | TYP TOTAL   | DEVIC                      | E TYPE |      | SEC. |
|---------------------|---------|-----------|-------------|----------------------------|--------|------|------|
| DESCRIPTION         | OF      | CLOCK     | POWER       | AND PA                     |        | PAGE |      |
|                     | OUTPUT  | FREQUENCY | DISSIPATION | -55°C to 125°C 0°C to 70°C |        |      | NO.  |
| ASYNCHRONOUS 16 X 5 | 3-State | 20 MHz    | 400 mW      | SN74S225 J, N              |        | 4-39 |      |

#### PROGRAMMABLE READ-ONLY MEMORIES (PROM'S)

| DESCRIP   | TION,   | ORGANI   | TYPE    | TYPICAL | TYPICAL | TYP POWER   | [          | DEVIC       | Е ТҮРЕ    |      | SEC. |
|-----------|---------|----------|---------|---------|---------|-------------|------------|-------------|-----------|------|------|
| PKG. P    | INS,    | ZATION   | OF      | ADDRESS | ENABLE  | DISSIPATION | A          | AND PACKAGE |           |      | PAGE |
| AND ROW S | SPACING | ZATION   | OUTPUT  | TIME    | TIME    | PER BIT     | –55°C to 1 | 25°C        | 0°C to 70 | 0°C  | NO.  |
|           | 20-Pin  | 512 X 8  | 3-State | 55 ns   | 20 ns   | 0.14 mW     | SN54S472   | J           | SN74S472  | J, N |      |
|           | 300-Mil | 512 X 8  | 0-C     | 55 ns   | 20 ns   | 0.14 mW     | SN54S473   | J           | SN74S473  | J, N |      |
| 4096-BIT  | 24-Pin  | 512 X 8  | 3-State | 55 ns   | 20 ns   | 0.14 mW     | SN54S474   | J, W        | SN74S474  | J, N |      |
| ARRAYS    | 600-Mil | 512 X 8  | 0-C     | 55 ns   | 20 ns   | 0.14 mW     | SN54S475   | J, W        | SN74S475  | J, N | 4-1  |
|           | 18-Pin  | 1024 X 4 | 3-State | 35 ns   | 20 ns   | 0.14 mW     | SN54S476   | J           | SN74S476  | J, N | 1    |
|           | 300-Mil | 1024 X 4 | 0-C     | 35 ns   | 20 ns   | 0.14 mW     | SN54S477   | J           | SN74S477  | J, N |      |
| 2048-BIT  | 20-Pin  | 256 X 8  | 0-C     | 50 ns   | 20 ns   | 0.24 mW     | SN54S470   | J           | SN74S470  | J, N |      |
| ARRAYS    | 300-Mil | 256 X 8  | 3-State | 50 ns   | 20 ns   | 0.27 mW     | SN54S471   | J           | SN74S471  | J, N | 4-1  |
| 1024-BIT  | 16-Pin  | 256 X 4  | 3-State | 40 ns   | 15 ns   | 0.49 mW     | SN54S287   | J, W        | SN74S287  | J, N |      |
| ARRAYS    | 300-Mil | 256 X 4  | 0-C     | 40 ns   | 15 ns   | 0.49 mW     | SN54S387   | J, W        | SN74S387  | J, N | 4-1  |
| 256-BIT   | 16-Pin  | 32 X 8   | 0-C     | 25 ns   | 12 ns   | 1.56 mW     | SN54S188   | J, W        | SN74S188  | J, N |      |
| ARRAYS    | 300-Mil | 32 X 8   | 3-State | 25 ns   | 12 ns   | 1.56 mW     | SN54S288   | J, W        | SN74S288  | J, N | 4-1  |

<sup>‡</sup>MIL-STD-883 level B processing.

# SCHOTTKY TTL AND I<sup>2</sup>L FUNCTIONS FUNCTIONAL INDEX/SELECTION GUIDE

| an a | ORGANI-  | TYPE    | TYPICAL     | TYPICAL   | TYP POWER   | D           | EVIC | Е ТҮРЕ      |      | SEC. |
|--|----------|---------|-------------|-----------|-------------|-------------|------|-------------|------|------|
| DESCRIPTION                              | ZATION   | OF      | ADDRESS     | ENABLE    | DISSIPATION | A           |      | CKAGE       |      | PAGE |
|  | ZATION   | OUTPUT  | TIME        | TIME      | PER BIT     | –55°C to 12 | 5°C  | 0°C to 70°  | °C   | NO.  |
|  |          | O-C or  | 150(350) ns | 60(150)ns | 0.03 mW     |             |      |             |      |      |
| 16384-BIT ARRAYS                         | 2048 X 8 | 10K Ω   | to          | to        | to          | SBP 9818M   | J    | SBP 9818C   | J, N | 4-16 |
|  |          | Púllup  | 20 µs       | 8 μs      | 0.0002 mW   | (SBP 8316M) | J    | (SBP 8316C) | J, N |      |
|  | 512 X 4  | 0-C     | 45 ns       | 15 ns     | 0.26 mW     | SN54S270    | J    | SN74S270    | J, N |      |
| 2048-BIT ARRAYS                          | 256 X 8  | 0-C     | 45 ns       | 15 ns     | 0.26 mW     | SN54S271    | J    | SN74S271    | J, N | 4-9  |
| 2040-DIT ANNA 13                         | 512 X 4  | 3-State | 45 ns       | 15 ns     | 0.26 mW     | SN54S370    | J    | SN74S370    | J, N | 4-5  |
|  | 256 X 8  | 3-State | 45 ns       | 15 ns     | 0.26 mW     | SN54S371    | J    | SN74S371    | J, N |      |
| 1024-BIT ARRAYS                          | 256 X 4  | 0-C     | 40 ns       | 20 ns     | 0.46 mW     | SN54187     | J, W | SN74187     | J, N | 4-9  |
| 256-BIT ARRAYS                           | 32 X 8   | 0-C     | 26 ns       | 22 ns     | 1.1 mW      | SN5488A     | J, W | SN7488A     | J, N | 4-9  |

### READ-ONLY MEMORIES (ROM'S)

# RANDOM-ACCESS READ-WRITE MEMORIES (RAM'S)

| DESCRIPTION         | ORGANI-  | TYPE<br>OF | TYPICAL<br>ADDRESS |       | TYP POWER   | -           |      | E TYPE<br>ACKAGE |       | SEC.<br>PAGE |
|---------------------|----------|------------|--------------------|-------|-------------|-------------|------|------------------|-------|--------------|
|                     | ZATION   | OUTPUT     | TIME               | TIME  | PER BIT     | -55°C to 12 |      | 0°C to 70        | °c    | NO.          |
| 1024-BIT ARRAYS     | 1024 X 1 | 3-State    | 75 ns              | 75 ns | 0.2/0.07 mW |             |      | SN74LS215        | JD, N | 4-27         |
| WITH POWER-DOWN     | 1024 X 1 | 0-C        | 75 ns              | 75 ns | 0.2/0.07 mW |             |      | SN74LS315        | JD, N | 4-27         |
|                     | 1024 X 1 | 3-State    | 75 ns              | 35 ns | 0.2 mW      |             |      | SN74LS214        | JD, N |              |
|                     | 1024 X 1 | 3-State    | 40 ns              | 15 ns | 0.51 mW     |             |      | SN74S214         | JD, N | 4-27         |
|                     | 1024 X 1 | 0-C        | 75 ns              | 35 ns | 0.2 mW      |             |      | SN74LS314        | JD, N | 4-27         |
| 1024-BIT ARRAYS     | 1024 X 1 | O-C        | 40 ns              | 15 ns | 0.51 mW     |             |      | SN74S314         | JD, N |              |
| 1024-DIT ARRA 15    | 256 X 4  | 3-State    | 75 ns              | 20 ns | 0.3 mW      |             |      | SN74LS207        | J, N  |              |
|                     | 256 X 4  | 3-State    | 40 ns              | 15 ns | 0.59 mW     |             |      | SN74S207         | J, N  | 4-33         |
|                     | 256 X 4  | 3-State    | 75 ns              | 20 ns | 0.3 mW      |             |      | SN74LS208        | J, N  | 4-33         |
|                     | 256 X 4  | 3-State    | 40 ns              | 15 ns | 0.59 mW     |             |      | SN74S208         | J, N  |              |
| OF O DIT A D D A MO | 256 X 1  | 3-State    | 42 ns              | 17 ns | 1.9 mW      |             |      | SN74S201         | J, N  | 4-24         |
| 256-BIT ARRAYS      | 256 X 1  | 0-C        | 42 ns              | 13 ns | 1.9 mW      |             |      | SN74S301         | J, N  | 4-24         |
|                     | 16 X 4   | 3-State    | 25 ns              | 12 ns | 5.9 mW      | SN54S189    | J, W | SN74S189         | J, N  | 4-20         |
| 64-BIT ARRAYS       | 16 X 4   | O-C        | 25 ns              | 12 ns | 5.9 mW      | SN54S289    | J, W | SN74S289         | J, N  | 4-20         |

#### REGISTER FILES<sup>†</sup>

| DESCRIPTION                                  | TYPICAL<br>ADDRESS | TYP READ<br>ENABLE | DATA<br>INPUT | TYP TOTAL<br>POWER |                |      |             |      |
|--|--------------------|--------------------|---------------|--------------------|----------------|------|-------------|------|
|  | TIME TIME          |                    | RATE          | DISSIPATION        | -55°C to 125°C |      | 0°C to 70°C |      |
| FOUR WORDS OF FOUR BITS                      | 27 ns              | 15 ns              | 20 MHz        | 125 mW             | SN54LS170      | J, W | SN74LS170   | J, N |
| FOUR WORDS OF FOUR BITS<br>(3-STATE OUTPUTS) | 24 ns              | 19 ns              | 20 MHz        | 135 mW             | SN54LS670      | J, W | SN74LS670   | J, N |

 $^{\dagger}\textsc{See}$  the TTL Data Book for Design Engineers, Second Edition, LCC4112.

#### ACCUMULATORS, ARITHMETIC LOGIC UNITS, LOOK-AHEAD CARRY GENERATORS<sup>†</sup>

| DESCRIPTION  | TYPICAL<br>CARRY       | TYPICAL<br>ADD          | TYP TOTAL<br>POWER         | DEVICE TYPE<br>AND PACKAGE        |              |                                   |                      |  |
|--|------------------------|-------------------------|----------------------------|-----------------------------------|--------------|-----------------------------------|----------------------|--|
|  | TIME                   | TIME                    | DISSIPATION                | -55°C to 125°C                    |              | 0°C to 70°C                       |                      |  |
| 4BIT PARALLEL<br>BINARY ACCUMULATORS                 | 10 ns                  | 20 ns                   | 720 mW                     | SN54S281                          | J,W          | SN74S281                          | Э, N                 |  |
| 4-BIT ARITHMETIC LOGIC UNITS/<br>FUNCTION GENERATORS | 11 ns<br>7 ns<br>16 ns | 20 ns<br>11 ns<br>24 ns | 525 mW<br>600 mW<br>102 mW | SN54S381<br>SN54S181<br>SN54LS181 | J, W<br>J, W | SN74S381<br>SN74S181<br>SN74LS181 | J, N<br>J, N<br>J, N |  |
| LOOK-AHEAD CARRY GENERATORS                          | 7 ns                   |                         | 260 mW                     | SN54S182                          | J,W          | SN74S182                          | J, N                 |  |

#### ADDERS<sup>†</sup>

|                             | TYPICAL | TYPICAL | TYP POWER   | DEVICE TYPE     |             |      |  |
|-----------------------------|---------|---------|-------------|-----------------|-------------|------|--|
| DESCRIPTION                 | CARRY   | ADD     | DISSIPATION | ON AND PACKAG   |             |      |  |
|                             | TIME    | TIME    | PER BIT     | –55°C to 125°C  | 0°C to 70°C |      |  |
|                             | 20 ns   | 15 ns   | 24 mW       | \$N54LS83A J, W | SN74LS83A   | J, N |  |
| 4-BIT FULL ADDERS           | 10 ns   | 15 ns   | 24 mW       | SN54LS283 J, W  | SN74LS283   | J, N |  |
|                             | 11 ns   | 7 ns    | 124 mW      | SN54S283 J      | SN74S283    | J, N |  |
| DUAL CARRY-SAVE FULL ADDERS | 15 ns   | 15 ns   | 23 mW       | SN54LS183* J, W | SN74LS183*  | J, N |  |

#### MULTIPLIERS

| DESOBURTION                                | DEVICE TYPE AND PACKAGE |             |           |      |  |  |  |  |
|--|-------------------------|-------------|-----------|------|--|--|--|--|
| DESCRIPTION                                | –55°C to 12             | 0°C to 70°C |           |      |  |  |  |  |
| 2-BIT-BY-4-BIT PARALLEL BINARY MULTIPLIERS | SN54LS261               | J, W        | SN74LS261 | J, N |  |  |  |  |
| 4-BIT-BY-4-BIT PARALLEL BINARY MULTIPLIERS | SN54S274                | J           | SN74S274  | J, N |  |  |  |  |
| 7-BIT-SLICE WALLACE TREES                  | SN54LS275               | J           | SN74LS275 | J, N |  |  |  |  |
| 7-BIT-SLICE WALLACE TREES                  | SN54S275                | J           | SN74S275  | J, N |  |  |  |  |

#### COMPARATORS<sup>†</sup>

|                             | TYPICAL | TYP TOTAL   | DEVICE TYPE      |        |             |      |  |  |
|-----------------------------|---------|-------------|------------------|--------|-------------|------|--|--|
| DESCRIPTION                 | COMPARE | POWER       |                  | ACKAGE |             |      |  |  |
|                             | TIME    | DISSIPATION | -55°C to 1       | 25°C   | 0°C to 70°C |      |  |  |
|                             | 11.5 ns | 365 mW      | SN54 <b>S</b> 85 | J, W   | SN74S85     | J, N |  |  |
| 4-BIT MAGNITUDE COMPARATORS | 23.5 ns | 52 mW       | SN54LS85         | J, W   | SN74LS85    | J, N |  |  |

### OTHER ARITHMETIC OPERATORS<sup>†</sup>

| DESCRIPTION   | TYPICAL<br>DELAY | TYP TOTAL<br>POWER<br>DISSIPATION | DEVICE TYPE<br>AND PACKAGE |      |           |      |  |
|---|------------------|-----------------------------------|----------------------------|------|-----------|------|--|
|   | TIME             |                                   | -55°C to 12                | 25°C | 0°C to 70 | °C   |  |
| QUADRUPLE 2-INPUT EXCLUSIVE-OR                                      | 7 ns             | 250 mW                            | SN54S86                    | J, W | SN74S86   | J, N |  |
| GATES WITH TOTEM-POLE OUTPUTS                                       | 10 ns            | 30 mW                             | SN54LS86                   | J, W | SN74LS86  | J, N |  |
| GATES WITH TOTEM-FOLE OUTFUTS                                       | 10 ns            | 30 mW                             | SN54LS386                  | J, W | SN74LS386 | J, N |  |
| QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES<br>WITH OPEN-COLLECTOR OUTPUTS | 18 ns            | 30 mW                             | SN54LS136                  | J, W | SN74LS136 | J, N |  |
| QUADRUPLE 2-INPUT EXCLUSIVE-NOR GATES                               | 18 ns            | 40 mW                             | SN54LS266                  | J, W | SN74LS266 | J, N |  |
| QUADRUPLE EXCLUSIVE OR/NOR GATES                                    | 8 ns             | 325 mW                            | SN54S135                   | J, W | SN74S135  | J, N |  |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112. \*New Product in development as of August 1977.

### PARITY GENERATORS/CHECKERS<sup>†</sup>

| DESCRIPTION           | TYPICAL<br>DELAY | TYP TOTAL<br>POWER<br>DISSIPATION | DEVICE TYPE |      |            |      |  |
|-----------------------|------------------|-----------------------------------|-------------|------|------------|------|--|
|                       | TIME             |                                   | -55°C to 12 | 25°C | 0°C to 70° | °C   |  |
| 9-BIT ODD/EVEN PARITY | 31 ns            | 80 mW                             | SN54LS280   | J, W | SN74LS280  | J, N |  |
| GENERATORS/CHECKERS   | 13 ns            | 335 mW                            | SN54S280    | J, W | SN74S280   | J, N |  |

### MICROPROCESSOR CONTROLLERS AND SUPPORT FUNCTIONS

| DESCRIPTION        | SYSTEM     | TYP TOTAL<br>POWER |             |      | VICE TYPE<br>D PACKAGE |      | SEC.<br>PAGE |
|--------------------|------------|--------------------|-------------|------|------------------------|------|--------------|
|                    | ATEICATION | DISSIPATION        | -55°C to 12 | 5°C  | 0°C to 70°C            |      | NO.          |
|                    | 8080A      | 700 mW             |             |      | SN74S428 (TIM8228)     | N.   | 5-35         |
| SYSTEM CONTROLLERS | 8080A      | 700 mW             |             |      | SN74S438 (T1M8238)     | N    | 5-35         |
|                    | Universal  | 450 mW             | SN54S482    | J    | SN74S482               | J, N | 5-41         |
|                    | TMS 9900   | 110 mW             | SN54LS259   | J, W | SN74LS259 (TIM9906)    | J, N | t            |
| REGISTERS          | MOS        | 210 mW             | SN54LS363*  | J    | SN74LS363*             | J, N | t            |
|                    | WIUS       | 210 mW             | SN54LS364*  | L    | SN74LS364*             | J, N | 1            |
| MULTI-MODE LATCHES | 8080A      | 410 mW             | SN54S412    | J, W | SN74S412 (TIM8212)     | J, N | 5-30         |
| TRANSCEIVERS AND   | Universal  | 625 mW             | SN54S226    | J, W | SN74S226               | J, N | 5-1          |
| BUS DRIVERS        | Offiversal | 207 mW             | SN54LS245   | J    | SN74LS245              | J, N | †            |
|                    |            | 98 mW              | SN54LS240   | J    | SN74LS240              | J, N | t            |
|                    |            | 450 mW             | SN54S240    | J    | SN74S240               | J, N | 5-5          |
| TRANSCEIVERS AND   |            | 100 mW             | SN54LS241   | J    | SN74LS241              | J, N | t            |
|                    | Universal  | 538 mW             | SN54S241    | J    | SN74S241               | J, N | 5-5          |
| BUS DRIVERS (SSI)  |            | 128 mW             | SN54LS242   | J, W | SN74LS242              | J, N | †            |
|                    |            | 128 mW             | SN54LS243   | J, W | SN74LS243              | J, N | t            |
|                    |            | 100 mW             | SN54LS244   | J    | SN74LS244              | J, N | t            |
| CLOCK ELEMENTS     | TMS 9900   | 669 mW             |             |      | SN74LS362 (TIM9904)    | J, N | †            |
| OLOUN ELEWIEN13    | 8080A      | 719 mW             |             |      | SN74LS424 (TIM8224)    | J, N | †            |
|                    | TMS 9900   | 190 mW             | SN54LS148   | J, W | SN74LS148 (TIM9907)    | J, N | t            |
| LOGIC ELEMENTS     | TMS 9900   | 35 mW              | SN54LS251   | J, W | SN74LS251 (TIM9905)    | J, N | t            |
|                    | TMS 9900   | 63 mW              | SN54LS348   | J,W  | SŃ74LS348 (T1M9908)    | J, N | †            |

# QUAD, HEX, AND OCTAL FLIP-FLOP/REGISTERS<sup>†</sup>

|                            | F-F |         | POWER     | DATA  | TIMES |             | DEVIC | Е ТҮРЕ     |      |
|----------------------------|-----|---------|-----------|-------|-------|-------------|-------|------------|------|
| DESCRIPTION                | PER | FREQ    | PER       | SETUP | HOLD  | AND PACKAGE |       |            |      |
|                            | PKG |         | FLIP-FLOP | ns    | ns    | -55°C to 12 | 5°C   | 0°C to 70° | °C   |
|                            |     | 50 MHz  | 26 mW     | 20↑   | 01    | SN54LS364*  | J     | SN74LS364* | J, N |
| D TYPE 3-STATE WITH ENABLE | 8   | 50 MHz  | 17 mW     | 20↑   | o†    | SN54LS374   | J     | SN74LS374  | J, N |
|                            |     | 100 MHz | 56 mW     | 5↑    | 21    | SN54S374    | J     | SN74S374   | J, N |
|                            | 8   | 40 MHz  | 10.6 mW   | 20↑   | 51    | SN54LS377   | J     | SN74LS377  | J, N |
| D TYPE WITH ENABLE         | 6   | 40 MHz  | 10.6 mW   | 20↑   | 51    | SN54LS378   | J, W  | SN74LS378  | J, N |
|                            | 4   | 40 MHz  | 10.6 mW   | 20↑   | 51    | SN54LS379   | J     | SN74LS379  | J, N |
|                            | 8   | 40 MHz  | 10.6 mW   | 20↑   | 5↑    | SN54LS273   | J     | SN74LS273  | J, N |
|                            | 6   | 40 MHz  | 10.6 mW   | 20↑   | 5↑    | SN54LS174   | J, W  | SN74LS174  | J, N |
| D TYPE WITH CLEAR          | 0   | 110 MHz | 75 mW     | 5↑    | 31    | SN54S174    | J, W  | SN74S174   | J, N |
|                            | 4   | 40 MHz  | 10.6 mW   | 201   | 5↑    | SN54LS175   | J, W  | SN74LS175  | J, N |
|                            | 4   | 110 MHz | 75 mW     | 51    | 31    | SN54S175    | J, W  | SN74S175   | J, N |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

\*New product in development as of August 1977.

|                  | ТҮРЕ    | ТҮРІС          | AL DELAY T         | IMES           | TYP TOTAL                         |             |       |                 |      |
|------------------|---------|----------------|--------------------|----------------|-----------------------------------|-------------|-------|-----------------|------|
| DESCRIPTION      | OF      | DATA TO<br>INV | DATA TO<br>NON-INV | FROM<br>ENABLE | TYP TOTAL<br>POWER<br>DISSIPATION | A           | ND PA | E TYPE<br>CKAGE |      |
|                  |         | OUTPUT         | OUTPUT             |                |                                   | -55°C to 12 |       | 0°C to 70°      | 1    |
|                  | 3-State | 4.5ns          | 8 ns               | 14 ns          | 275 mW                            | SN54S251    | J, W  | SN74S251        | J, N |
|                  | 3-State | 17 ns          | 21 ns              | 21 ns          | 35 mW                             | SN54LS251   | J, W  | SN74LS251       | J, N |
| 8-LINE-TO-1-LINE | 2-State | 4.5 ns         | 8 ns               | 9 ns           | 225 mW                            | SN54S151    | J, W  | SN74S151        | J, N |
|                  | 2-State | 11 ns          | 18 ns              | 27 ns          | 30 mW                             | SN54LS151   | J, W  | SN74LS151       | J, N |
|                  | 2-State | 11 ns          |                    | 18 ns          | 28 mW                             | SN54LS152   | w     |                 |      |
|                  | 3-State |                | 12 ns              | 16 ns          | 35 mW                             | SN54LS253   | J, W  | SN74LS253       | J, N |
| DUAL             | 2-State | 15 ns          |                    | 22 ns          | 31 mW                             | SN54LS352   | J, W  | SN74LS352       | J, N |
| DUAL             | 3-State | 12 ns          |                    | 21 ns          | 43 mW                             | SN54LS353   | J, W  | SN74LS353       | J, N |
| 4-LINE-TO-1-LINE | 2-State |                | 6 ns               | 9.5 ns         | 225 mW                            | SN54S153    | J, W  | SN74S153        | J, N |
|                  | 2-State |                | 14 ns              | 17 ns          | 31 mW                             | SN54LS153   | J, W  | SN74LS153       | J, N |
| QUADRUPLE        | 2-State |                | 20 ns§             |                | 65 mW                             | SN54LS298   | J,W   | SN74LS298       | J, N |
| 2-LINE-TO-1-LINE | 2-State |                | 20 ns <sup>§</sup> |                | 32 mW                             | SN54LS398 🖇 | J     | SN74LS398       | J, N |
| WITH STORAGE     | 2-State | 20 ns §        | 20 ns <sup>§</sup> |                | 37 mW                             | SN54LS399   | J, W  | SN74LS399       | J, N |
|                  | 3-State | 4 ns           |                    | 14 ns          | 280 mW                            | SN54S258    | J, W  | SN74S258        | J, N |
|                  | 3-State |                | 5 ns               | 14 ns          | 320 mW                            | SN54S257    | J, W  | SN74S257        | J, N |
|                  | 2-State | 4 ns           |                    | 7 ns           | 195 mW                            | SN54S158    | J, W  | SN74S158        | J, N |
| QUADRUPLE        | 2-State |                | 5 ns               | 8 ns           | 250 mW                            | SN54S157    | J, W  | SN74S157        | J, N |
| 2-LINE-TO-1-LINE | 3-State | 12 ns          |                    | 20 ns          | 60 mW                             | SN54LS258A* | J, W  | SN74LS258A*     | J, N |
|                  | 3-State |                | 12 ns              | 20 ns          | 60 mW                             | SN54LS257A* | J, W  | SN74LS257A*     | J, N |
|                  | 2-State | 7 ns           |                    | 12 ns          | 24 mW                             | SN54LS158   | J, W  | SN74LS158       | J, N |
|                  | 2-State |                | 9 ns               | 14 ns          | 49 mW                             | SN54LS157   | J, W  | SN74LS157       | J, N |

### DATA SELECTORS/MULTIPLEXERS<sup>†</sup>

# DECODERS/DEMULTIPLEXERS<sup>†</sup>

| DESCRIPTION                          | TYPE OF<br>OUTPUT | TYPICAL<br>SELECT<br>TIME | TYPICAL<br>ENABLE<br>TIME | TYP TOTAL<br>POWER<br>DISSIPATION | DEVICE TYPE<br>AND PACKAGE<br>-55°C to 125°C 0°C t |      |           | °C   |
|--------------------------------------|-------------------|---------------------------|---------------------------|-----------------------------------|--|------|-----------|------|
| 4-LINE-TO-10-LINE,<br>BCD-TO-DECIMAL | Totem-Pole        | 17 ns                     |                           | 35 mW                             | SN54LS42   | J, W | SN74LS42  | J, N |
| 3-LINE-TO-8-LINE                     | Totem-Pole        | 8 ns                      | 7 ns                      | 245 mW                            | SN54S138   | J, W | SN74S138  | J, N |
|                                      | Totem-Pole        | 22 ns                     | 21 ns                     | 31 mW                             | SN54LS138  | J, W | SN74LS138 | J, N |
| DUAL 2-LINE-TO-4-LINE                | Totem-Pole        | 7.5 ns                    | 6 ns                      | 300 mW                            | SN54S139   | W, L | SN74S139  | J, N |
|                                      | Totem-Pole        | 22 ns                     | 19 ns                     | 34 mW                             | SN54LS139  | W, L | SN74LS139 | J, N |
|                                      | Totem-Pole        | 18 ns                     | 15 ns                     | 30 mW                             | SN54LS155  | W, L | SN74LS155 | J, N |
|                                      | Open-Collector    | 33 ns                     | 26 ns                     | 31 mW                             | SN54LS156  | W, L | SN74LS156 | J, N |

### CURRENT-SENSING-GATES<sup>†</sup>

|             | TYPICAL             | TYP POWER   | DEVICE TYPE    |      |             |      |  |
|-------------|---------------------|-------------|----------------|------|-------------|------|--|
| DESCRIPTION | PROPAGATION         | DISSIPATION | AND PACKAGES   |      |             |      |  |
|             | DELAY TIME PER GATE |             | –55°C to 125°C |      | 0°C to 70°C |      |  |
| HEX         | 21 ns               | 3.3 mW      | SN54LS63       | J, W | SN74LS63    | J, N |  |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

§From clock.

\*New Product in development as of August 1977.

### BUS TRANSCEIVERS AND DRIVERS

| DESCRIPTION               | TYPICAL<br>PROPAGATION | MAXIMUM<br>SOURCE | MAXIMUM<br>SINK |             |      | E TYPE<br>CKAGE |      | SEC.<br>PAGE |
|---------------------------|------------------------|-------------------|-----------------|-------------|------|-----------------|------|--------------|
|                           | DELAY TIMES            | CURRENT           | CURRENT         | -55°C to 12 | 25°C | 0°C to 70       | °C   | NO.          |
| CONTROLLER AND BUS DRIVER |                        | —1 mA             | 10 mA           |             |      | SN74S428        | N    | 5-35         |
| FOR 8080A SYSTEMS         |                        | —1 mA             | 10 mA           |             |      | SN 74S438       | N    | 5-35         |
| OCTAL BUS TRANSCEIVERS    | 8 ns                   | —12 mA            | 12 mA           | SN54LS245   | J    | SN74LS245       | J, N | t            |
| 4-BIT BUS TRANCEIVERS     | 10 ns                  | CE A              | 20 mA           | SN54S226    | J, W | SN 74S226       | J.N  | 5-1          |
| WITH STORAGE              | iuns                   | — <b>6.</b> 5 mA  | 20 mA           | 511545226   | J, W | 311/45220       | J, N | 5-1          |

# ASYNCHRONOUS COUNTERS (RIPPLE CLOCK) - NEGATIVE-EDGE TRIGGERED<sup>†</sup>

| DESCRIPTION       |         | PARALLEL | CLEAR | TYP TOTAL<br>POWER |             | DEVICE  |            |      |
|-------------------|---------|----------|-------|--------------------|-------------|---|------------|------|
|                   | FREU    | LUAD     |       | DISSIPATION        | -55°C to 12 | J,W         SN74S196           J,W         SN74LS90           0         J,W         SN74LS20           6         J,W         SN74LS196           J,W         SN74LS196           J,W         SN74LS196           J,W         SN74LS197           J,W         SN74LS93           3         J,W         SN74LS233           7         J,W         SN74LS197           J,W         SN74LS197 | С          |      |
|                   | 100 MHz | Yes      | Low   | 375 mW             | SN54S196    | J, W  | SN 74S 196 | J, N |
| DEGADE            | 32 MHz  | Set-to-9 | High  | 40 mW              | SN54LS90    | J, W  | SN74LS90   | J, N |
| DECADE            | 32 MHz  | Set-to-9 | High  | 40 mW              | SN54LS290   | J, W  | SN74LS290  | J, N |
|                   | 30 MHz  | Yes      | Low   | 60 mW              | SN54LS196   | J, W  | SN74LS196  | J, N |
|                   | 100 MHz | Yes      | Low   | 375 mW             | SN54S197    | J, W  | SN74S197   | J, N |
|                   | 32 MHz  | None     | High  | .39 mW             | SN54LS93    | J, W  | SN74LS93   | Ј, N |
| 4-BIT BINARY      | 32 MHz  | None     | High  | 39 mW              | SN54LS293   | J, W  | SN74LS293  | J, N |
|                   | 30 MHz  | Yes      | Low   | 60 mW              | SN54LS197   | J, W  | SN74LS197  | J, N |
| DIVIDE-BY-12      | 32 MHz  | None     | High  | 39 mW              | SN54LS92    | J, W  | SN74LS92   | J, N |
|                   | 35 MHz  | None     | High  | 75 mW              | SN54LS390   | J, W  | SN74LS390  | J, N |
| DUAL DECADE       | 35 MHz  | Set-to-9 | High  | 75 mW              | SN54LS490   | J, W  | SN74LS490  | J, N |
| DUAL 4-BIT BINARY | 35 MHz  | None     | High  | 75 mW              | SN54LS393   | J, W  | SN74LS393  | J, N |

#### SYNCHRONOUS COUNTERS - POSITIVE-EDGE TRIGGERED<sup>†</sup>

|              | COUNT  | PARALLEL |         | TYP TOTAL   | 1           | DEVIC  | Е ТҮРЕ     |      |
|--------------|--------|----------|---------|-------------|-------------|--------|------------|------|
| DESCRIPTION  | FREQ   | LOAD     | CLEAR   | POWER       |             | AND PA | CKAGE      |      |
|              | THE    | LUAD     |         | DISSIPATION | -55°C to 12 | 5°C    | 0°C to 70° | C    |
|              | 40 MHz | Sync     | Sync-L  | 475 mW      | SN54S162    | J, W   | SN74S162   | J, N |
| DECADE       | 25 MHz | Sync     | Sync-L  | 93 mW       | SN54LS162A  | J, W   | SN74LS162A | J, N |
|              | 25 MHz | Sync     | Async-L | 93 mW       | SN54LS160A  | J, W   | SN74LS160A | J, N |
|              | 40 MHz | Sync     | None    | 500 mW      | SN54S168    | J, W   | SN74S168   | J, N |
| DECADE       | 25 MHz | Sync     | None    | 100 mW      | SN54LS168A  | J, W   | SN74LS168A | J, N |
| UP/DOWN      | 25 MHz | Async    | Async-H | 85 mW       | SN54LS192   | J, W   | SN74LS192  | J, N |
|              | 20 MHz | Async    | None    | 100 mW      | SN54LS190   | J, W   | SN74LS190  | J, N |
|              | 40 MHz | Sync     | Sync-L  | 475 mW      | SN54S163    | J, W   | SN74S163   | J, N |
| 4-BIT BINARY | 25 MHz | Sync     | Sync-L  | 93 mW       | SN54LS163A  | J, W   | SN74LS163A | J, N |
|              | 25 MHz | Sync     | Async-L | 93 mW       | SN54LS161A  | J, W   | SN74LS161A | J, N |
|              | 40 MHz | Sync     | None    | 500 mW      | SN54S169    | J, W   | SN74S169   | J, N |
| 4-BIT BINARY | 25 MHz | Sync     | None    | 100 mW      | SN54LS169A  | J, W   | SN74LS169A | J, N |
| UP/DOWN      | 25 MHz | Async    | Async-H | 85 mW       | SN54LS193   | J,W    | SN74LS193  | J, N |
|              | 20 MHz | Async    | None    | 90 mW       | SN54LS191   | J, W   | SN74LS191  | J, N |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

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| ſ               | NO.  | SHIFT    | SERIAL  | ASYNC  |   | NOD  | ES   |    | TYP TOTAL     | D               | EVICE  | ТҮРЕ        |      |
|-----------------|------|----------|---------|--------|---|------|------|----|---------------|-----------------|--------|-------------|------|
| DESCRIPTION     | OF   | FREQ     | DATA    | CLEAR  | # | s-L‡ | LOAD | LD | POWER '       | AN              | ID PAG | CKAGE       |      |
|                 | BITS | Theu     | INPUT   | CLEAN  | 5 | Ś    | 2    | P  | DISSIPATION   | -55°C to 125    | i°C    | 0°C to 70°C | :    |
|                 |      | 50 MHz   | D       | Low    | X | X    | X    | х  | 750 mW        | SN54S299        | J, W   | SN74S299    | J, N |
| PARALLEL-IN,    | 8    | 35 MHz   | D       | Low    | x | X    | X    | x  | 175 mW        | SN54LS299*      | J      | SN74LS299*  | J, N |
| PARALLEL-OUT    |      | 35 MHz   | D       | Sync L | X | x    | X    | X  | 175 mW        | SN54LS323*      | J      | SN74LS323*  | J, N |
| (BIDIRECTIONAL) | 4    | 70 MHz   | D       | Low    | X | x    | X    | X  | 450 mW        | SN54S194        | J, W   | SN74S194    | J, N |
|                 | -    | 25 MHz   | D       | Low    | × | х    | X    | x  | 75 mW         | SN54LS194A      | J, W   | SN74LS194A  | J, N |
|                 | 5    | 10 MHz   | D       | Low    | х |      | Х    |    | 60 mW         | SN54LS96        | J, W   | SN74LS96    | J, N |
|                 |      | 70 MHz   | J-K     | Low    | X |      | х    |    | 375 mW        | SN54S195        | J, W   | SN74S195    | J, N |
| PARALLEL-IN,    |      | 30 MHz   | D       | Low    | x |      | x    |    | 75 mW         | SN54LS395A      | J, W   | SN74LS395A  | J, N |
| PARALLEL-OUT    | 4    | 30 MHz   | J-₩     | Low    | × |      | x    |    | 70 mW         | SN54LS195A      | J, W   | SN74LS195A  | J, N |
|                 |      | 30 MHz   | D       | None   | × |      | x    |    | 65 mW         | SN54LS95B       | J, W   | SN74LS95B   | J, N |
|                 |      | 25 MHz   | D       | None   | × |      | x    |    | 70 mW         | SN54LS295B      | J, W   | SN74LS295B  | J, N |
| SERIAL-IN,      | 8    | 25 MHz   | Court   | 1      | x |      |      |    | 00.111        | 0.15 41 0.4 0.4 |        |             |      |
| PARALLEL-OUT    | °    | 25 MHZ   | Gated D | Low    | ^ |      |      |    | 80 mW         | SN54LS164       | J, W   | SN74LS164   | J, N |
| PARALLEL-IN,    | 8    | 35 MHz   | D       | None   | х |      | х    | X  | 105 mW        | SN54LS165       | J, W   | SN74LS165   | J, N |
| SERIAL-OUT      | đ    | 35 MHz   | D       | Low    | х |      | х    | x  | 110 mW        | SN54LS166       | J, W   | SN74LS166   | J, N |
| SERIAL-IN,      | 8    | 25 1411- | 0-1-1-0 | AL.    | ~ |      |      |    | <b>20</b> 111 | 0.15 41 0.04    |        |             |      |
| SERIAL-OUT      | ő    | 25 MHz   | Gated D | None   | × |      |      |    | 60 mW         | SN54LS91        | J, W   | SN74LS91    | Ј, N |

#### SHIFT REGISTERS<sup>†</sup>

 $\ddagger_{S-R} \equiv_{shift \ right, \ S-L} \equiv_{shift \ left}$ 

# OTHER REGISTERS<sup>†</sup>

| DESCRIPTION                    | FREQ ASYNC |       | TYP TOTAL<br>POWER | DEVIC<br>AND P  | SEC.<br>PAGE    |     |
|--------------------------------|------------|-------|--------------------|-----------------|-----------------|-----|
|                                |            | CLEAR | DISSIPATION        | –55°C to 125°C  | 0°C to 70°C     | NO. |
| QUADRUPLE MULTIPLEXERS         | 30 MHz     | None  | 36.5 mW            | SN54LS398 J     | SN74LS398 J, N  | †   |
| WITH STORAGE                   | 30 MHz     | None  | 36.5 mW            | SN54LS399 J, W  | SN74LS399 J, N  | † † |
|                                | 25 MHz     | None  | 65 mW              | SN54LS298 J, W  | SN74LS298 J, N  | †   |
| 8-BIT UNIVERSAL SHIFT/STORAGE  | 35 MHz     | Low   | 175 mW             | SN54LS299* J    | SN74LS299* J, N | t   |
| REGISTERS                      | 50 MHz     | Low   | 750 mW             | SN54S299 J, W   | SN74S299 J, N   | 5-9 |
| QUADRUPLE BUS-BUFFER REGISTERS | 50 MHz     | High  | 85 mW              | SN54LS173* J, W | SN74LS173* J, N | t   |

# PRIORITY ENCODERS/REGISTERS<sup>†</sup>

| DESCRIPTION  | TYPICAL<br>DELAY | TYP TOTAL<br>POWER | DEVICE TYPE<br>AND PACKAGE |      |           |      |  |
|--|------------------|--------------------|----------------------------|------|-----------|------|--|
|  | TIME             | DISSIPATION        | -55°C to 12                | 25°C | 0°C to 70 | °C   |  |
| FULL BCD PRIORITY ENCODERS                                 | 15 ns            | 60 mW              | SN54LS147                  | J, W | SN74LS147 | J, N |  |
| CASCADABLE OCTAL PRIORITY ENCODERS                         | 15 ns            | 60 mW              | SN54LS148                  | J, W | 9N74LS148 | J, N |  |
| CASCADABLE OCTAL PRIORITY ENCODERS<br>WITH 3-STATE OUTPUTS | 16 ns            | 63 mW              | SN54LS348                  | J, W | SN74LS348 | J, N |  |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.
 New product in development as of August 1977.

### LATCHES<sup>†</sup>

| DESCRIPTION          | NO.<br>OF | CLEAR | OUTPUTS | TYPICAL<br>DELAY | TYP TOTAL<br>POWER | DEVICI<br>AND PA |                 | SEC.<br>PAGE |
|----------------------|-----------|-------|---------|------------------|--------------------|------------------|-----------------|--------------|
|                      | BITS      |       |         | TIME             | DISSIPATION        | –55°C to 125°C   | 0°C to 70°C     | -            |
| MULTI-MODE BUFFERED  | 8         | Low   | Q       | 11 ns            | 410 mW             | SN54S412 J       | SN74S412 J, f   | J t          |
| ADDRESSABLE          | 8         | Low   | Q       | 17 ns            | 110 mW             | SN54LS259 J, W   | SN74LS259 J, I  | N †          |
|                      |           | None  | Q       | 17 ns            | 210 mW             | SN54LS363* J     | SN74LS363* J, I | N t          |
| TRANSPARENT          | 8         | None  | ٥       | 19 ns            | 120 mW             | SN54LS373 J      | SN74LS373 J, I  | v   †        |
|                      |           | None  | ۵       | 7 ns             | 525 mW             | SN54S373 J       | SN74S373 J, I   | 5-26         |
| DUAL 2-BIT WITH      |           | None  | ۵, ۵    | 11 ns            | 32 mW              | SN54LS75 J, W    | SN74LS75 J, I   | 1 t          |
| INDEPENDENT ENABLE   | 4         | None  | Q       | 10 ns            | 35 mW              | SN54LS77 W       |                 | t            |
| INDER CINDENT ENABLE |           | None  | a, ā    | 12 ns            | 32 mW              | SN54LS375 J, W   | SN74LS375 J,    | N †          |
| QUAD 3-R (SSI)       | 4         | None  | Q       | 13 ns            | 19 mW              | SN54LS279 J, W   | SN74LS279 J, I  | V t          |

# S-R LATCHES<sup>†</sup>

|                       | TYPICAL           | TYP TOTAL   |             | DEVIC | ТҮРЕ       |      |
|-----------------------|-------------------|-------------|-------------|-------|------------|------|
| DESCRIPTION           | PROPAGATION POWER |             | AND PACKAGE |       |            |      |
|                       | DELAY TIME        | DISSIPATION | –55°C to 12 | !5°C  | 0°C to 70° | °C   |
| QUADRUPLE S-R LATCHES | 13 ns             | 19 mW       | SN54LS279   | J, W  | SN74LS279  | J, N |

# MONOSTABLE MULTIVIBRATORS WITH SCHMITT-TRIGGER INPUTS<sup>†</sup>

| DESCRIPTION | NO. OF            | NO. OF INPUTS OUTPUT TYP TOTAL<br>PULSE POWER |            | DEVICE TYPE<br>AND PACKAGE |             |      |           |      |
|-------------|-------------------|---|------------|----------------------------|-------------|------|-----------|------|
|             | POSITIVE NEGATIVE |   | RANGE      | DISSIPATION                | –55°C to 12 | !5°C | 0°C to 70 | °C   |
| DUAL        | 1                 | 1   | 20 ns-70 s | 23 mW                      | 1           |      | SN74LS221 | J, N |
| DUAL        | 1 📸               | 1   | 20 ns-49 s | 23 mW                      | SN54LS221   | J,W  |           |      |

# RETRIGGERABLE MONOSTABLE MULTIVIBRATORS<sup>†</sup>

| DESCRIPTION | NO. OF   | NO. OF INPUTS |       | OUTPUT<br>PULSE | TYP<br>TOTAL |             |      | E TYPE<br>ACKAGE |      |
|-------------|----------|---------------|-------|-----------------|--------------|-------------|------|------------------|------|
|             | POSITIVE | NEGATIVE      | CLEAR | RANGE           | POWER        | -55°C to 12 | 25°C | 0°C to 70        | °C   |
| SINGLE      | 2        | 2             | Yes   | 45 ns–∞         | 30 mW        | SN54LS122   | J, W | SN74LS122        | J, N |
| DUAL        | 1        | 1             | Yes   | 45 ns-∞         | 60 mW        | SN54LS123   | J, W | SN74LS123        | J, N |

#### CLOCK GENERATOR CIRCUITS<sup>†</sup>

| DESCRIPTION                                    |                 | TYP TOTAL<br>POWER | DEVICE TYPE<br>AND PACKAGE |           |           |      |  |
|--|-----------------|--------------------|----------------------------|-----------|-----------|------|--|
|  |                 | DISSIPATION        | -55°C to 12                | 25°C      | 0°C to 70 | °C   |  |
| CLOCK GENERATOR/DRIVERS                        | (FOR TMS 9900)  | 669 mW             |                            |           | SN74LS362 | J, N |  |
| CLOCK GENERATOR/DRIVERS                        | (FOR TMS 8080A) | 719 mW             |                            |           | SN74LS424 | J, N |  |
| ·  | 90 mW           | SN54LS124          | J, W                       | SN74LS124 | J, N      |      |  |
| DUAL VOLTAGE-CONTROLLED OSCILLATOR WITH ENABLE |                 | 525 mW             | SN54S124                   | J, W      | SN74S124  | J, N |  |
|  |                 | 90 mW              | SN54LS326                  | J, W      | SN74LS326 | J, N |  |
|  | 4700            | 150 mW             | SN54LS325                  | J, W      | SN74LS325 | J, N |  |
| UAL VOLTAGE-CONTROLLED OSCILLATOR              |                 | 150 mW             | SN54LS327                  | J, W      | SN74LS327 | J, N |  |
| VOLTAGE-CONTROLLED OSCILLATOR WITH ENABLE      |                 | 90 mW              | SN54LS324                  | J,W       | SN74LS324 | J, N |  |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

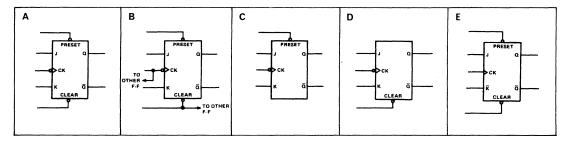
# AND-OR-INVERT GATES WITH TOTEM-POLE OUTPUTS<sup>†</sup>

|                      | TYPICAL     | TYP POWER   | DEVICE TYPE |      |             |      |  |  |
|----------------------|-------------|-------------|-------------|------|-------------|------|--|--|
| DESCRIPTION          | PROPAGATION | DISSIPATION | AND PACKAGE |      |             |      |  |  |
|                      | DELAY TIME  | PER GATE    | -55°C to 1  | 25°C | 0°C to 70°C |      |  |  |
| 2-WIDE 4-INPUT       | 12.5 ns     | 2.75 mW     | SN54LS55    | J, W | SN74LS55    | J, N |  |  |
| 4-WIDE 4-2-3-2-INPUT | 3.5 ns      | 29 mW       | SN54S64     | J,W  | SN74S64     | J, N |  |  |
| 4-WIDE 2-3-3-2-INPUT | 12.5 ns     | 4.5 mW      | SN54LS54    | J,W  | SN74LS54    | J, N |  |  |
| DUAL 2-WIDE 2-INPUT  | 3.5 ns      | 28 mW       | SN54S51     | J, W | SN74S51     | J, N |  |  |
| DOAL 2-WIDE 2-INPUT  | 12.5 ns     | 2.75 mW     | SN54LS51    | J,W  | SN74LS51 .  | J, N |  |  |

### AND-OR-INVERT GATES WITH OPEN-COLLECTOR OUTPUTS<sup>†</sup>

|                      | TYPICAL                     | TYPICAL TYP POWER |                | DEVICE TYPE |          |             |  |  |
|----------------------|-----------------------------|-------------------|----------------|-------------|----------|-------------|--|--|
| DESCRIPTION          | PROPAGATION DISSIPATION AND |                   | AND PA         | ACKAGE      |          |             |  |  |
|                      | DELAY TIME                  | PER GATE          | -55°C to 125°C |             | 0°C to 7 | 0°C to 70°C |  |  |
| 4-WIDE 4-2-3-2-INPUT | 5,5 ns                      | 36 mW             | SN54S65        | J, W        | SN74S65  | J, N        |  |  |

# DUAL J-K EDGE-TRIGGERED FLIP-FLOPS †



| DWG.       | TYPICAL CHA      | RACTERISTICS | DATA  | TIMES  | DEVICE TYPE     |                 |  |  |
|------------|------------------|--------------|-------|--------|-----------------|-----------------|--|--|
| BEF.       | f <sub>max</sub> | Pwr/F-F      | SETUP | HOLD   | AND P           | ACKAGE          |  |  |
| MEF. (MHz) |                  | (mW)         | (ns)  | (ns) · | –55°C to 125°C  | 0°C to 70°C     |  |  |
|            | 125              | 75           | 3↓    | 01     | SN54S112 J, W   | SN74S112 J, N   |  |  |
| A          | 45               | 10           | 20↓   | o↓     | SN54LS76A J, W  | SN74LS76A J, N  |  |  |
|            | 45               | 10           | 20↓   | o↓     | SN54LS112A J, W | SN74LS112A J, N |  |  |
|            | 125              | 75           | 3↓    | o↓     | SN54S114 J, W   | SN74S114 J, N   |  |  |
| в          | 45               | 10           | 20↓   | o↓     | SN54LS78A J, W  | SN74LS78A J, N  |  |  |
|            | 45               | 10           | 20↓   | o↓     | SN54LS114A J, W | SN74LS114A J, N |  |  |
| с          | 125              | 75           | 3↓    | 01     | SN54S113 J, W   | SN74S113 J, N   |  |  |
|            | 45               | 10           | 20↓   | o↓     | SN54LS113A J, W | SN74LS113A J, N |  |  |
| D          | 45               | 10           | 20↓   | o↓     | SN54LS73A J, W  | SN74LS73A J, N  |  |  |
|            | 45               | 10           | 20↓   | o↓     | SN54LS107A J    | SN74LS107A J, N |  |  |
| E          | 33               | 10           | 201   | 5↑     | SN54LS109A J, W | SN74LS109A J, N |  |  |

↑↓The arrow indicates the edge of the clock pulse used for reference: ↑ for the rising edge, ↓ for the falling edge. ↑See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

| DESCRIPTION                    | HIGH-LEVEL<br>OUTPUT | LOW-LEVEL<br>OUTPUT | TYPICAL<br>DELAY | TYP POWER<br>PER | DEVICE TYPE<br>AND PACKAGE |      |          |           |
|--------------------------------|----------------------|---------------------|------------------|------------------|----------------------------|------|----------|-----------|
|                                | VOLTAGE CURRENT TIME |                     |                  | GATE             | -55°C to 125°C 0°C         |      |          | C to 70°C |
| QUADRUPLE                      | 15 V                 | 8 mA                | 16 ns            | 2 mW             |                            |      | SN74LS26 | J, N      |
| 2-INPUT                        | 15 V                 | 4 mA                | 16 ns            | 2 mW             | SN54LS26                   | J, W |          |           |
| POSITIVE-NAND                  | 5.5 V                | 60 mA               | 6.5 ns           | 41 mW            | SN54S38                    | J, W | SN74S38  | J, N      |
|                                | 5.5 V                | 24 mA               | 19 ns            | 4.3 mW           | -<br>                      |      | SN74LS38 | J, N      |
| BUFFERS                        | 5.5 V                | 12 mA               | 19 ns            | 4.3 mW           | SN54LS38                   | J, W |          |           |
| QUADRUPLE<br>2-INPUT POSITIVE- | 5.5 V                | 24 mA               | 19 ns            | 5.45 mW          |                            |      | SN74LS33 | J, N      |
| NOR BUFFERS                    | 5,5 V                | ·12 mA              | 19 ns            | 5.45 mW          | SN54LS33                   | J, W |          |           |

### BUFFER AND INTERFACE GATES WITH OPEN-COLLECTOR OUTPUTS<sup>†</sup>

GATES, BUFFERS, DRIVERS, AND BUS TRANSCEIVERS WITH 3-STATE OUTPUTS<sup>†</sup>

|                            | TYPICAL     | MAXIMUM | MAXIMUM | DEVICE TYPE    |            |         |  |
|----------------------------|-------------|---------|---------|----------------|------------|---------|--|
| DESCRIPTION                | PROPAGATION | SOURCE  | SINK    |                | PACKAGE    |         |  |
|                            | DELAY TIME  | CURRENT | CURRENT | –55°C to 125°C | 0°C to 70  | °C      |  |
| 12-INPUT NAND GATE         | 4.5 ns      | -6.5 mA | 20 mA   |                | SN74S134   | J, N    |  |
| 12-INFOT NAND GATE         | 4.5 ns      | —2 mA   | 20 mA   | SN54S134 J,    | w          |         |  |
| QUADRUPLE                  | 8 ns        | -2.6 mA | 24 mA   |                | SN74LS125A | J, N    |  |
| BUS BUFFERS/DRIVERS        | 8 ns        | —1 mA   | 12 mA   | SN54LS125A J,  | w          |         |  |
| WITH INDEPENDENT           | 8.5 ns      | -2.6 mA | 24 mA   |                | SN74LS126A | ( J, N  |  |
| OUTPUT CONTROLS            | 8.5 ns      | —1 mA   | 12 mA   | SN54LS126A J,  | w          |         |  |
|                            | 9.5 ns      | -2.6 mA | 24 mA   |                | SN74LS365A | J, N    |  |
|                            | 9.5 ns      | —1 mA   | 12 mA   | SN54LS365A J,  | w          |         |  |
|                            | 9.5 ns      | -2.6 mA | 24 mA   |                | SN74LS366A | J, N    |  |
| HEX BUS<br>BUFFERS/DRIVERS | 9.5 ns      | —1 mA   | 12 mA   | SN54LS366A J,  | w          |         |  |
|                            | 9.5 ns      | 2.6 mA  | 24 mA   |                | SN74LS367A | (J, N   |  |
|                            | 9.5 ns      | —1 mA   | 12 mA   | SN54LS367A J,  | w          |         |  |
|                            | 9.5 ns      | -2.6 mA | 24 mA   |                | SN74LS368A | , IJ, N |  |
|                            | 9.5 ns      | -1 mA   | 12 mA   | SN54LS368A J,  | w          |         |  |
|                            | 5 ns        | -15 mA  | 64 mA   |                | SN74S240   | J, N    |  |
|                            | 5 ns        | -12 mA  | 48 mA   | SN54S240 J     | ı          |         |  |
|                            | 5 ns        | —15 mA  | 64 mA   |                | SN74S241   | J, N    |  |
|                            | 5 ns        | —12 mA  | 48 mA   | SN54S241 J     |            |         |  |
| OCTAL BUS                  | 10 ns       | —15 mA  | 24 mA   |                | SN74LS240  | J, N    |  |
| BUFFERS/DRIVERS            | 10 ns       | -12 mA  | 12 mA   | SN54LS240 J    |            |         |  |
|                            | 10 ns       | —15 mA  | 24 mA   |                | SN74LS241  | J, N    |  |
|                            | 10 ns       | —12 mA  | 12 mA   | SN54LS241 J    |            |         |  |
|                            | 10 ns       | -15 mA  | 24 mA   |                | SN74LS244  | J, N    |  |
|                            | 10 ns       | -12 mA  | 12 mA   | SN54LS244 J    |            |         |  |
| CONTROLLER AND BUS DRIVER  |             | -1 mA   | 10 mA   |                | SN74S428   | N       |  |
| FOR 8080A SYSTEMS          |             | —1 mA   | 10 mA   |                | SN74S438   | N       |  |
|                            | 11 ns       | -15 mA  | 24 mA   |                | SN74LS242  | J, N    |  |
|                            | 11 ns       | -12 mA  | 12 mA   | SN54LS242 J,   | w          |         |  |
| QUADRUPLE TRANSCEIVERS     | 12 ns       | -15 mA  | 24 mA   |                | SN74LS243  | J, N    |  |
|                            | 12 ns       | -12 mA  | 12 mA   | SN54LS243 J,   | w          |         |  |
| QUADRUPLE TRANSCEIVERS     | 10 ns       |         | 20 mA   |                | SN74S226   | J, N    |  |
| WITH STORAGE               | 10 ns       | -6.5 mA | 20 mA   | SN54S226 J,    | w          |         |  |
|                            | 12 ns       | —15 mA  | 24 mA   |                | SN74LS245  | J, N    |  |
| OCTAL TRANSCEIVERS         | 12 ns       | -12 mA  | 12 mA   | SN54LS245      |            | 1       |  |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

### BUFFERS;CLOCK DRIVERS WITH TOTEM-POLE OUTPUTS<sup>†</sup>

| DESCRIPTION          | LOW-LEVEL<br>OUTPUT | HIGH-LEVEL<br>OUTPUT | TYPICAL<br>DELAY | TYP POWER<br>PER | DEVICE TYPE<br>AND PACKAGE |      |             |      |
|----------------------|---------------------|----------------------|------------------|------------------|----------------------------|------|-------------|------|
|                      | CURRENT             | CURRENT              | TIME             | GATE             | –55°C to 125°C             |      | 0°C to 70°C |      |
| QUADRUPLE            |                     |                      |                  |                  |                            |      |             |      |
| 2-INPUT              | 24 mA               | —1.2 mA              | 12 ns            | 5.5 mW           |                            |      | SN74LS28    | J, N |
| POSITIVE-NOR         | 12 mA               | —1.2 mA              | 12 ns            | 5.5 mW           | SN54LS28                   | J, W |             |      |
| BUFFERS              |                     |                      |                  |                  |                            |      | ]           |      |
| QUADRUPLE<br>2-INPUT | 60 mA               | —3 mA                | 4 ns             | 41 mW            | SN54S37                    | J, W | SN74S37     | J, N |
| POSITIVE-NAND        | 24 mA               | —1.2 mA              | 12 ns            | 4.3 mW           |                            |      | SN74LS37    | J, N |
| BUFFERS              | 12 mA               | —1.2 mA              | 12 ns            | 4.3 mW           | SN54LS37                   | J, W |             |      |
| DUAL 4-INPUT         | 60 mA               | -3 mA                | 4 ns             | 44 mW            | SN54S40                    | J,W  | SN74S40     | J, N |
| POSITIVE-NAND        | 24 mA               | —1.2 mA              | 12 ns            | 4.3 mW           |                            |      | SN74LS40    | J, N |
| BUFFERS              | 12 mA               | —1.2 mA              | 12 ns            | 4.3 mW           | SN54LS40                   | J, W | ł           |      |

#### 50-OHM/75-OHM LINE DRIVERST

| DESCRIPTION   | LOW-LEVEL<br>OUTPUT | HIGH-LEVEL<br>OUTPUT | TYPICAL<br>DELAY | TYP POWER<br>PER | DEVICE TYPE<br>AND PACKAGE |      |           |      |
|---------------|---------------------|----------------------|------------------|------------------|----------------------------|------|-----------|------|
|               | CURRENT             | CURRENT              | TIME             | GATE             | 55°C to 1                  | 25°C | 0°C to 70 | 0°C  |
| DUAL 4-INPUT  |                     |                      |                  |                  |                            |      |           |      |
| POSITIVE-NAND | 60 mA               | —40 mA               | 4 ns             | 44 mW            | SN54S140                   | J, W | SN74S140  | J, N |
| LINE DRIVERS  |                     |                      |                  |                  |                            |      |           |      |

### OPEN-COLLECTOR DISPLAY DECODERS/DRIVERS<sup>†</sup>

| · · · ·                               | OUTPUT      | OFF-STATE | TYP TOTAL      |               | Γ           | DEVÍC | Е ТҮРЕ      |      |
|---------------------------------------|-------------|-----------|----------------|---------------|-------------|-------|-------------|------|
| DESCRIPTION                           | SINK OUTPUT |           | POWER BLANKING |               | AND PACKAGE |       |             |      |
|                                       | CURRENT     | VOLTAGE   | DISSIPATION    | 1             | -55°C to 12 | 25°C  | 0°C to 70°C |      |
| BCD-TO-DECIMAL                        | 80 mA       | 15 V      | 35 mW          | Invalid Codes |             |       | SN74LS145   | J, N |
| DECODERS/DRIVERS                      | 12 mA       | 15 V      | 35 mW          | Invalid Codes | SN54LS145   | J, W  |             |      |
| i i i i i i i i i i i i i i i i i i i | 24 mA       | 15 V      | 35 mW          | Ripple        |             |       | SN74LS47    | J, N |
|                                       | 24 mA       | 15 V      | 35 mW          | Ripple        |             |       | SN74LS247   | J, N |
|                                       | 12 mA       | 15 V      | 35 mW          | Ripple        | SN54LS47    | J, W  |             | }    |
|                                       | 12 mA       | 15 V      | 35 mW          | Ripple        | SN54LS247   | J, W  |             |      |
| BCD-TO-                               | 6 mA        | 5.5 V     | 125 mW         | Ripple        |             |       | SN74LS48    | J, N |
| SEVEN-SEGMENT                         | 6 mA        | 5.5 V     | 125 mW         | Ripple        |             |       | SN74LS248   | J, N |
| DECODERS/DRIVERS                      | 2 mA        | 5.5 V     | 125 mW         | Ripple        | SN54LS48    | J, W  |             |      |
| DECODERS/DRIVERS                      | 2 mA        | 5.5 V     | 125 mW         | Ripple        | SN54LS248   | J, W  |             |      |
|                                       | 8 mA        | 5.5 V     | 40 mW          | Direct        |             |       | SN74LS249   | J, N |
|                                       | 8 mA        | 5.5 V     | 40 mW          | Direct        |             |       | SN74LS49    | J, N |
|                                       | 4 mA        | 5.5 V     | 40 mW          | Direct        | SN54LS49    | J,W   |             |      |
|                                       | 4 mA        | 5.5 V     | 40 mW          | Direct        | SN54LS249   | J, W  |             |      |

<sup>†</sup>See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

| DESCRIPTION    | AND            | NAND           | NOR           | OR            |
|----------------|----------------|----------------|---------------|---------------|
| QUAD 2-INPUT   | SN54S/74S08    | SN54S/74S00    | SN54S/74S02   | SN54S/74S32   |
|                | SN54LS/74LS08  | SN54LS/74LS00  | SN54LS/74LS02 | SN54LS/74LS32 |
|                | SN54S/74S09*   | SN54S/74S03*   |               |               |
|                | SN54LS/74LS09* | SN54LS/74LS03* |               | 10 A          |
|                | х<br>х         | SN54S/74S132-  |               |               |
|                |                | SN54LS/74LS132 |               |               |
| HEX INVERTERS  |                | SN54S/74S04    |               |               |
|                |                | SN54LS/74LS04  |               |               |
|                |                | SN54S/74S05*   |               |               |
|                | •              | SN54LS/74LS04* |               |               |
|                |                | SN54LS/74LS14  |               |               |
| TRIPLE 3-INPUT | SN54S/74S11    | SN54S/74S10    | SN54LS/74LS27 |               |
|                | SN54LS/74LS11  | SN54LS/74LS10  |               |               |
|                | SN54S/74S15*   | SN54LS/74LS12* |               |               |
|                | SN54LS/74LS15* |                |               |               |
| DUAL 4-INPUT   | SN54LS/74LS21  | SN54S/74S20    |               |               |
|                |                | SN54LS/74LS20  |               |               |
|                |                | SN54S/74S22*   |               |               |
|                |                | SN54LS/74LS22* |               |               |
|                |                | SN54LS/74LS13  |               |               |
| DUAL 5-INPUT   |                |                | SN54S/74S260  |               |
| 8-INPUT        |                | SN54S/74S30    |               |               |
|                |                | SN54LS/74LS30  |               |               |
| 13-INPUT       |                | SN54S/74S133   |               |               |

# SCHOTTKY TTL GATE SUMMARY†

†See the TTL Data Book for Design Engineers, Second Edition, LCC4112.

D<sub>Schmitt</sub>-trigger inputs

\*Open-Collector

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